

RX72N Group Renesas MCUs

R01DS0343EJ0111

Rev.1.11

Feb 26, 2021

240-MHz 32-bit RX MCU, on-chip double-precision FPU, 1396 CoreMark,

Arithmetic unit for trigonometric functions, up to 4-MB flash memory (supportive of the dual bank function), 1-MB SRAM, various communications interfaces including Ethernet MAC compliant with IEEE 1588, SD host interface, quad SPI, and CAN, 12-bit A/D converter, RTC, Encryption functions (optional), Serial sound interface, CMOS camera interface, Graphic-LCD controller, 2D drawing engine

Features

■ 32-bit RXv3 CPU core

- · Maximum operating frequency: 240 MHz Capable of 1396 CoreMark in operation at 240 MHz

 • Double-precision 64-bit IEEE-754 floating point
- A collective register bank save function is available.
- Supports the memory protection unit (MPU)
- JTAG and FINE (one-line) debugging interfaces

■ Low-power design and architecture

- Operation from a single 2.7- to 3.6-V supply
- · RTC is capable of operation from a dedicated power supply.
- Four low-power modes

■ On-chip code flash memory

- Supports versions with up to 4 Mbytes of ROM
- No wait cycles at up to 120 MHz or when the ROM cache is hit, one-wait state at above 120 MHz
- User code is programmable by on-board or off-board programming.
- Programming/erasing as background operations (BGOs)
- A dual-bank structure allows exchanging the start-up bank.

■ On-chip data flash memory

- 32 Kbytes, reprogrammable up to 100,000 times
- Programming/erasing as background operations (BGOs)

■ On-chip SRAM

- 1 Mbyte of SRAM (no wait states; however, if ICLK is at a frequency above 120 MHz, access to locations in the 512 Kbytes of SRAM from 0080 0000h to 0087 FFFFh requires one cycle of waiting)
- 32 Kbytes of RAM with ECC (single error correction/double error
- 8 Kbytes of standby RAM (backup on deep software standby)

■ Data transfer

- · DMACAa: 8 channels
- DTCb: 1 channel
- EXDMAC: 2 channels
- · DMAC for the Ethernet controller: 3 channels

Reset and supply management

- Power-on reset (POR)
- · Low voltage detection (LVD) with voltage settings

Clock functions

- · External crystal resonator or internal PLL for operation at 8 to 24 MHz
- PLL for specific purposes
- Internal 240-kHz LOCO and HOCO selectable from 16, 18, and 20 MHz
- · 120-kHz clock for the IWDTa

■ Real-time clock

- Adjustment functions (30 seconds, leap year, and error)
- · Real-time clock counting and binary counting modes are selectable
- Time capture function (for capturing times in response to event-signal input)

■ Independent watchdog timer

120-kHz clock operation

■ Useful functions for IEC60730 compliance

- Oscillation-stoppage detection, frequency measurement, CRCA, IWDTa, self-diagnostic function for the A/D converter, etc.
- Register write protection function can protect values in important registers against overwriting.



PLQP0176KB-C 24 \times 24 mm, 0.5-mm pitch PLQP0144KA-B 20 \times 20 mm, 0.5-mm pitch PLQP0100KB-B 14 \times 14 mm, 0.5-mm pitch



PTLG0145KA-A 7 x 7 mm, 0.5-mm pitch



PLBG0224GA-A 13 × 13 mm, 0.8-mm pitch PLBG0176GA-A 13 × 13 mm, 0.8-mm pitch

■ Various communications interfaces

- Ethernet MAC compliant with IEEE 1588 (2 channels)
- · PHY layer (1 channel) for host/function or OTG controller (1 channel) with full-speed USB 2.0 transfer
- CAN (compliant with ISO11898-1), incorporating 32 mailboxes (up to 3 channels)
- SCIj and SCIh with multiple functionalities (up to 8 channels) Choose from among asynchronous mode, clock-synchronous mode, smart-card interface mode, simplified SPI, simplified I2C, and extended serial mode.
- SCIi with 16-byte transmission and reception FIFOs (up to 5 channels)
- I²C bus interface for transfer at up to 1 Mbps (3 channels)
- Four-wire QSPI (1 channel) in addition to RSPIc (3 channels)
- Parallel data capture unit (PDC) for the CMOS camera interface (except for 100-pin products)
- Graphic-LCD controller (GLCDC)
- 2D drawing engine (DRW2D)
- SD host interface (1 channel) with a 1- or 4-bit SD bus for use with SD memory or SDIO
- MMCIF with 1-, 4-, or 8-bit transfer bus width

■ External address space

- · Buses for full-speed data transfer (max. operating frequency of 80 MHz)
- 8 CS areas
- 8-, 16-, or 32-bit bus space is selectable per area
- Independent SDRAM area (128 Mbytes)

■ Up to 29 extended-function timers

- 32-bit GPTW (4 channels)
- 16-bit TPUa (6 channels), MTU3a (9 channels)
- 8-bit TMRa (4 channels), 16-bit CMT (4 channels), 32-bit CMTW (2 channels)

■ 12-bit A/D converter

- Two 12-bit units (8 channels for unit 0; 21 channels for unit 1)
- Self diagnosis, detection of analog input disconnection

■ 12-bit D/A converter: 2 channels

- Temperature sensor for measuring temperature within the chip
- Arithmetic unit for trigonometric functions

■ Encryption functions (optional)

- AES (key lengths: 128, 192, and 256 bits)
- Trusted Secure IP (TSIP)

■ Up to 182 pins for general I/O ports

• 5-V tolerance, open drain, input pull-up, switchable driving ability

Operating temp. range

- D-version: -40°C to +85°C
- G-version: -40°C to +105°C

1. Overview

1.1 Outline of Specifications

Table 1.1 lists the specifications in outline, and Table 1.2 give a comparison of the functions of products in different packages.

Table 1.1 is an outline of maximum specifications, and the peripheral modules and the number of channels of the modules differ depending on the number of pins on the package and the capacity of the code flash memory. For details, refer to Table 1.2, Comparison of Functions for Different Packages.

Table 1.1 Outline of Specifications (1/11)

Classification	Module/Function	Description		
CPU	CPU	 Maximum operating frequency: 240 MHz 32-bit RX CPU (RXv3) Minimum instruction execution time: One instruction per state (cycle of the system clock) Address space: 4-Gbyte linear Register set of the CPU General purpose: Sixteen 32-bit registers Control: Ten 32-bit registers Accumulator: Two 72-bit registers 113 instructions Instructions installed as standard: 111 Basic instructions: 77 Single-precision floating-point operation instructions: 11 DSP instructions: 23 Instructions for register bank save function: 2 Addressing modes: 11 Data arrangement Instructions: Little endian Data: Selectable as little endian or big endian On-chip 32-bit multiplier: 32 × 32 → 64 bits On-chip divider: 32 / 32 → 32 bits Barrel shifter: 32 bits 		
	FPU	 Single-precision floating-point numbers (32 bits) and double-precision floating-point numbers (64 bits) Data types and floating-point exceptions in conformance with the IEEE754 standard 		
	Double-precision floating point coprocessor	Double-precision floating-point register set Double-precision floating-point data registers: 16, each with 64-bit width Double-precision floating-point control registers: Four, each with 32-bit width Double-precision floating-point processing instructions: 21 Notifying the interrupt controller of double-precision floating-point exceptions		
	Register bank save function	Fast collective saving and restoration of the values of CPU registers 16 save register banks		

Table 1.1 Outline of Specifications (2/11)

Classification	Module/Function	Description				
Memory	Code flash memory	 Capacity: 2 Mbytes/4 Mbytes ROM cache: 8 Kbytes 120 MHz ≤ No-wait cycle access, 120 MHz > One-wait cycle access Instructions hitting the ROM cache or operand = 240 MHz: No-wait access On-board programming: Four types Off-board programming (parallel programmer mode) Instructions are executable only for the program stored in the TM target area by using the Trusted Memory (TM) function and protection against data reading is realized. A dual-bank structure allows programming during reading or exchanging the start-up areas 				
	Data flash memory	Capacity: 32 Kbytes Programming/erasing: 100,000 times				
	Unique ID	16-byte unique ID for each device				
	RAM	Capacity: 512 Kbytes Up to 240 MHz, no-wait access				
	Expansion RAM	Capacity: 512 Kbytes 120 MHz ≤ No-wait cycle access, 120 MHz > One-wait cycle access				
	ECC RAM	Capacity: 32 Kbytes If the operating frequency is no greater than 120 MHz, one-wait cycle access, if greater than 120MHz, two-wait cycle access in the case of reading, and three-wait cycle access in the case of writing SEC-DED (single-bit error correction and double-bit error detection)				
	Standby RAM	Capacity: 8 Kbytes Operation synchronized with PCLKB: Up to 60 MHz, two-cycle access				
Operating modes	S	 Operating modes by the mode-setting pins at the time of release from the reset state Single-chip mode Boot mode (for the SCI interface) Boot mode (for the USB interface) Boot mode (for the FINE interface) Selection of operating mode by register setting Single-chip mode On-chip ROM disabled extended mode On-chip ROM enabled extended mode Endian selectable 				
Clock Generation circuit		 Main clock oscillator, sub-clock oscillator, low-speed/high-speed on-chip oscillator frequency synthesizer (two circuits), and IWDT-dedicated on-chip oscillator The peripheral module clocks can be set to frequencies above that of the system of Main-clock oscillation stoppage detection Separate frequency-division and multiplication settings for the system clock (ICLK peripheral module clocks (PCLKA, PCLKB, PCLKC, PCLKD), flash-IF clock (FCLK external bus clock (BCLK) The CPU and other bus masters run in synchronization with the system clock (ICLK to 240 MHz Peripheral modules of MTU, RSPI, SCIi, ETHERC, EPTPC, PMGI, EDMAC, GPT GLCDC, and DRW2D, run in synchronization with PCLKA, which operates at up to MHz. Other peripheral modules run in synchronization with PCLKB: Up to 60 MHz ADCLK in the S12AD (unit 0) runs in synchronization with PCLKC: Up to 60 MHz Flash IF run in synchronization with the flash-IF clock (FCLK): Up to 60 MHz Devices connected to the external bus run in synchronization with the external bus (BCLK): Up to 80 MHz The high-speed on-chip oscillator (HOCO) can be obtained through frequency-multiplication of the PLL or PPLL reference clock External clock input frequency: 30 MHz (max) Clock output function 				

Table 1.1 Outline of Specifications (3/11)

Classification	Module/Function	Description			
Reset		 Nine types of reset RES# pin reset: Generated when the RES# pin is driven low. Power-on reset: Generated when the RES# pin is driven high and VCC = AVCC0 = AVCC1 rises. Voltage-monitoring 0 reset: Generated when VCC = AVCC0 = AVCC1 falls. Voltage-monitoring 1 reset: Generated when VCC = AVCC0 = AVCC1 falls. Voltage-monitoring 2 reset: Generated when VCC = AVCC0 = AVCC1 falls. Deep software standby reset: Generated in response to an interrupt to trigger release from deep software standby. Independent watchdog timer reset: Generated when the independent watchdog timer underflows, or a refresh error occurs. Watchdog timer reset: Generated when the watchdog timer underflows, or a refresh error occurs. Software reset: Generated by register setting. 			
Power-on reset		If the RES# pin is at the high level when power is supplied, an internal reset is generated. After VCC = AVCC0 = AVCC1 has exceeded the voltage detection level and the specified period has elapsed, the reset is cancelled.			
Voltage detection circuit (LVDA)		 Monitors the voltage being input to the VCC = AVCC0 = AVCC1 pins and generates an internal reset or interrupt. Voltage detection circuit 0 Capable of generating an internal reset The option-setting memory can be used to select enabling or disabling of the reset. Voltage detection level: Selectable from three different levels (2.94 V, 2.87 V, 2.80 V) Voltage detection circuits 1 and 2 Voltage detection level: Selectable from three different levels (2.99 V, 2.92 V, 2.85 V) Digital filtering (1/2, 1/4, 1/8, and 1/16 LOCO frequency) Capable of generating an internal reset Two types of timing are selectable for release from reset An internal interrupt can be requested. Detection of voltage rising above and falling below thresholds is selectable. Maskable or non-maskable interrupt is selectable Voltage detection monitoring Event linking 			
Low power consumption	Low power consumption function	Module stop function Four low power consumption modes Sleep mode, all-module clock stop mode, software standby mode, and deep software standby mode			
	Battery backup function	 When the voltage on the VCC pin drops, battery power from the VBATT pin is supplied to keep the real-time clock (RTC) operating. 			
Interrupt	Interrupt controller (ICUD)	 Number of interrupt vectors: 256 External interrupts: 16 (pins IRQ0 to IRQ15) Software interrupts: 2 sources Non-maskable interrupts: 8 sources Sixteen levels specifiable for the order of priority Method of interrupt source selection: The interrupt vectors consist of 256 vectors (128 sources are fixed. The remaining 128 vectors are selected from among the other 163 sources.) 			
External bus ex	tension	The external address space can be divided into eight areas (CS0 to CS7), each with independent control of access settings. Capacity of each area: 16 Mbytes (CS0 to CS7) A chip-select signal (CS0# to CS7#) can be output for each area. Each area is specifiable as an 8-, 16-, or 32-bit bus space. The data arrangement in each area is selectable as little or big endian (only for data). SDRAM interface connectable Bus format: Separate bus, multiplex bus Wait control Write buffer facility			

Table 1.1 Outline of Specifications (4/11)

Classification	Module/Function	Description			
DMA	DMA controller (DMACAa)	8 channels Three transfer modes: Normal transfer, repeat transfer, and block transfer Activation sources: Software trigger and interrupt requests from peripheral functions			
	EXDMA controller (EXDMACa)	2 channels Four transfer modes: Normal transfer, repeat transfer, block transfer, and cluster transfer Single-address transfer enabled with the EDACKn signal Request sources: Software trigger, external DMA requests (EDREQn), and interrupt requests from peripheral functions			
	Data transfer controller (DTCb)	 Three transfer modes: Normal transfer, repeat transfer, and block transfer Request sources: External interrupts and interrupt requests from peripheral functions Sequence transfer 			
I/O ports Programmable I/O ports		 Sequence transfer I/O ports for the 224-pin LFBGA I/O pins: 182 Input pin: 1 Pull-up resistors: 182 Open-drain outputs: 182 5-V tolerance: 19 I/O ports for the 176-pin LFBGA and 176-pin LFQFP I/O pins: 136 Input pin: 1 Pull-up resistors: 136 Open-drain outputs: 136 5-V tolerance: 19 I/O ports for the 145-pin TFLGA and 144-pin LFQFP I/O pins: 111 Input pin: 1 Pull-up resistors: 111 Open-drain outputs: 111 5-V tolerance: 18 I/O ports for the 100-pin LFQFP I/O pins: 78 Input pin: 1 Pull-up resistors: 78 Open-drain outputs: 78 5-V tolerance: 17 			
Event link controller (ELC)		 Event signals such as interrupt request signals can be interlinked with the operation of functions such as timer counting, eliminating the need for intervention by the CPU to control the functions. 135 internal event signals can be freely combined for interlinked operation with connected functions. Event signals from peripheral modules can be used to change the states of output pins (of ports B and E). Changes in the states of pins (of ports B and E) being used as inputs can be interlinked with the operation of peripheral modules. 			

Table 1.1 Outline of Specifications (5/11)

Classification	Module/Function	Description		
Timers	16-bit timer pulse unit (TPUa)	(16 bits × 6 channels) × 1 unit Maximum of 16 pulse-input/output possible Select from among seven or eight counter-input clock signals for each channel Input capture/output compare function Output of PWM waveforms in up to 15 phases in PWM mode Support for buffered operation, phase-counting mode (two phase encoder input) and cascade-connected operation (32 bits × 2 channels) depending on the channel. PPG output trigger can be generated Capable of generating conversion start triggers for the A/D converters Digital filtering of signals from the input capture pins Event linking by the ELC		
	Multifunction timer pulse unit (MTU3a)	 9 channels (16 bits x 8 channels, 32 bits x 1 channel) Maximum of 28 pulse-input/output and 3 pulse-input possible Select from among 14 counter-input clock signals for each channel (PCLKA/1, PCLKA/2, PCLKA/4, PCLKA/8, PCLKA/16, PCLK/A32, PCLKA/64, PCLKA/256, PCLKA/1024, MTCLKA, MTCLKB, MTCLKC, MTCLKD, MTIOC1A) 14 of the signals are available for channel 0, 11 are available for channels 1, 3, 4, 6 to 8, 12 are available for channel 2, and 10 are available for channel 5. Input capture function 39 output compare/input capture registers Counter clear operation (synchronous clearing by compare match/input capture) Simultaneous writing to multiple timer counters (TCNT) Simultaneous register input/output by synchronous counter operation Buffered operation Support for cascade-connected operation 43 interrupt sources Automatic transfer of register data Pulse output mode Toggle/PWM/complementary PWM/reset-synchronized PWM Complementary PWM output mode Outputs non-overlapping waveforms for controlling 3-phase inverters Automatic specification of dead times PWM duty cycle: Selectable as any value from 0% to 100% Delay can be applied to requests for A/D conversion. Non-generation of interrupt requests at peak or trough values of counters can be selected. Double buffer configuration Reset synchronous PWM mode Three phases of positive and negative PWM waveforms can be output with desired duty cycles. Phase-counting mode: 16-bit mode (channels 1 and 2); 32-bit mode (channels 1 and 2) Counter functionality for dead-time compensation Generation of triggers for A/D converter conversion A/D converter start triggers can be skipped Digital filter function for signals on the input capture and external counter clock pins PPG output trigger can be generated Even		
	Port output enable 3 (POE3a)	Control of the high-impedance state of the MTU waveform output pins 5 pins for input from signal sources: POE0#, POE4#, POE8#, POE10#, POE11# Initiation on detection of short-circuited outputs (detection of simultaneous PWM output to the active level) Initiation by oscillation-stoppage detection or software Additional programming of output control target pins is enabled		

Table 1.1 Outline of Specifications (6/11)

Classification	Module/Function Description						
Timers	General PWM timer (GPTW)	 32 bits x 4 channels (GPTW0 to GPTW3) Counting up or down (sawtooth-wave), counting up and down (triangle-wave) selectable for all channels Clock sources independently selectable for each channel 2 input/output pins per channel 2 output compare/input capture registers per channel For the 2 output compare/input capture registers of each channel, 4 registers are provided as buffer registers and are capable of operating as comparison registers when buffering is not in use. In output compare operation, buffer switching can be at crests or troughs, enabling the generation of laterally asymmetrically PWM waveforms. Registers for setting up frame intervals on each channel (with capability for generating interrupts on overflow or underflow) Generation of dead times in PWM operation Capable of synchronous start, stop, or clearing of counter for any channel Capable of a start, stop, clearing, or up-/down-counting of the counter supporting input level comparison Capable of a start, stop, clearing, or up-/down-counting of the counter supporting maximum of 4 external triggers Output pin disabling function by a dead time error or a short circuit detection among output pins Capable of generating conversion start triggers for the A/D converters as well as monitoring external pins for a start timing of conversion. Capable of outputting events, such as compare-match from A to F and overflow/ underflow, to ELC 					
	Port output enable for GPTW (POEG)	 Capable of using noise filter of input capture Controlling the output disable for GPTW waveform output Initiation by input level detection of GTETRG pins Initiation by output disable request from GPTW Initiation by detection of oscillation stop or by software 					
	Programmable pulse generator (PPG)	 (4 bits × 4 groups) × 2 units Pulse output with the MTU or TPU output as a trigger Maximum of 32 pulse-output possible 					
	8-bit timers (TMR)	(8 bits × 2 channels) × 2 units Select from among seven internal clock signals (PCLKB/1, PCLKB/2, PCLKB/8, PCLKB/32, PCLKB/64, PCLKB/1024, PCLKB/8192) and one external clock signal Capable of output of pulse trains with desired duty cycles or of PWM signals The 2 channels of each unit can be cascaded to create a 16-bit timer Generation of triggers for A/D converter conversion Capable of generating baud-rate clocks for SCI5, SCI6, and SCI12 Event linking by the ELC					
	Compare match timer (CMT)	(16 bits x 2 channels) x 2 units Select from among four internal clock signals (PCLKB/8, PCLKB/32, PCLKB/128, PCLKB/512)					
	Compare match timer W (CMTW)	(32 bits x 1 channel) x 2 units Compare-match, input-capture input, and output-comparison output are available. Select from among four internal clock signals (PCLKB/8, PCLKB/32, PCLKB/128, PCLKB/512) Interrupt requests can be output in response to compare-match, input-capture, and output-comparison events. Event linking by the ELC					
	Realtime clock (RTCd)*1	 Clock sources: Main clock, sub-clock Selection of the 32-bit binary count in time count/second unit possible Clock and calendar functions Interrupt sources: Alarm interrupt, periodic interrupt, and carry interrupt Battery backup operation Time-capture facility for three values Event linking by the ELC 					
	Watchdog timer (WDTA)	 14 bits x 1 channel Select from among 6 counter-input clock signals (PCLKB/4, PCLKB/64, PCLKB/128, PCLKB/512, PCLKB/2048, PCLKB/8192) 					

Table 1.1 Outline of Specifications (7/11)

Classification	Module/Function	Description		
Timers	Independent watchdog timer (IWDTa)	14 bits × 1 channel Counter-input clock: IWDT-dedicated on-chip oscillator Dedicated clock/1, dedicated clock/16, dedicated clock/32, dedicated clock/64, dedicated clock/128, dedicated clock/256 Window function: The positions where the window starts and ends are specifiable (the window defines the timing with which refreshing is enabled and disabled). Event linking by the ELC		
Communication function	Ethernet controller (ETHERC)	 2 channels Input and output of Ethernet/IEEE 802.3 frames Transfer at 10 or 100 Mbps Full- and half-duplex modes MII (Media Independent Interface) and RMII (Reduced Media Independent Interface) as defined in IEEE 802.3u Detection of Magic Packets^{TM*2} or output of a "wake-on-LAN" signal (WOL) Compliance with flow control as defined in IEEE 802.3x standards Filtering of multicast frames is supported. Frame data can be directly transferred between 2 channels by cut-through switching. 		
	PHY management interface (PMGI)	 2 channels This module is compliant with the MII (Media Independent Interface) as defined in the IEEE 802.3u standard. Transmission and reception of management frames through PHY-LSI chips having an MII or RMII interface is supported. Alleviates load on the CPU by shifting it to dedicated hardware The timing of management data is adjustable. Preambles can be deleted. 		
	PTP module for the ethernet controller (EPTPCb)	 In connection with the Ethernet controller (ETHERC), this module is compliant with the IEEE1588 standard. Matching with time stamps can be used to trigger counting by the MTU and GPTW. 		
	DMA controller for ethernet controller (EDMACa)	 3 channels (each EDMAC determines the order of priority by a round-robin algorithm) For ETHERC: 2 channels, for EPTPC: 1 channel Alleviation of CPU load by the descriptor control method Transmission FIFO: 2 Kbytes; Reception FIFO: 4 Kbytes 		
	USB 2.0 FS host/ function module (USBb)	 Includes a UDC (USB Device Controller) and transceiver for USB 2.0 FS One port Compliance with the USB 2.0 specification Transfer rate: Full speed (12 Mbps), low speed (1.5 Mbps) (host only) Both self-power mode and bus-power mode are supported OTG (On the Go) operation is possible (low-speed is not supported) Incorporates 2 Kbytes of RAM as a transfer buffer External pull-up and pull-down resistors are not required 		

Table 1.1 Outline of Specifications (8/11)

Classification	Module/Function	cription		
Communication function	Serial communications interfaces (SCIj, SCIi, SCIh)	 13 channels (SCIj: 7 channels + SCIi: 5 channels + SCIh: 1 channel) SCIj, SCIi, SCIh Serial communications modes: Asynchronous, clock synchronous, and smart-card interface Multi-processor function On-chip baud rate generator allows selection of the desired bit rate Choice of LSB-first or MSB-first transfer Start-bit detection: Level or edge detection is selectable. Simple I²C Simple SPI 7- to 9-bit transfer mode Bit rate modulation Double-speed mode Detecting matches of data is supported (other than for SCI12) SCIj, SCIh Average transfer rate clock can be input from TMR timers for SCI5, SCI6, and SCI12 Event linking by the ELC (only on channel 5) SCIh Supports the serial communications protocol, which contains the start frame and information frame Supports the LIN format SCIi Data can be transmitted or received in sequence by the 16-byte FIFO buffers of the transmission and recention unit 		
	I ² C bus interface (RIICa)	transmission and reception unit 3 channels (only channel 0 can be used in fast-mode plus) Communication formats I ² C bus format/SMBus format Supports the multi-master Max. transfer rate: 1 Mbps (channel 0) Event linking by the ELC		
	CAN module (CAN)	 3 channels Compliance with the ISO11898-1 specification (standard frame and extended frame) 32 mailboxes per channel 		
	Serial peripheral interface (RSPIc)	 3 channels RSPI transfer facility Using the MOSI (master out, slave in), MISO (master in, slave out), SSL (slave select), and RSPCK (RSPI clock) signals enables serial transfer through SPI operation (four lines) or clock-synchronous operation (three lines) Capable of handling serial transfer as a master or slave Data formats Switching between MSB first and LSB first The number of bits in each transfer can be changed to any number of bits from 8 to 16, or to 20, 24, or 32 bits. 128-bit buffers for transmission and reception Up to four frames can be transmitted or received in a single transfer operation (with each frame having up to 32 bits) Transit/receive data can be swapped in byte units Buffered structure Double buffers for both transmission and reception RSPCK can be stopped with the receive buffer full for master reception. Event linking by the ELC 		
	Quad serial peripheral interface (QSPI)	 1 channel Connectable with serial flash memory equipped with multiple input and output lines (i.e. for single, dual, or quad operation) Programmable bit length and selectable active sense and phase of the clock signal Sequential execution of transfer LSB or MSB first is selectable 		

Table 1.1 Outline of Specifications (9/11)

Classification	Module/Function	Description			
Extended serial	sound interface (SSIE)	 2 channels Full-duplex transmission (only for channel 0) Various types of serial audio formatting are supported. Master and slave operations are supported. The bit-clock frequency is selectable from among 13 frequencies (1/1, 1/2, 1/4, 1/6, 1/8, 1/12, 1/16, 1/24, 1/32, 1/48, 1/64, 1/96, or 1/128). Data formats with 8, 16, 18, 20, 22, 24, and 32 bits are supported. 32-stage FIFO buffers for transmission and reception Stopping or not stopping the SSILRCK signal on stopping of data transmission is selectable. 			
SD host interface (SDHI)		 1 channel Transfer speed: Supports high-speed mode (25 MB/s) and default speed mode (12.5 MB/s) One interface for SD memory and I/O cards (supporting 1- and 4-bit SD buses) SD specifications Part 1: Physical Layer Specification Ver. 3.01 compliant (DDR not supported) Part E1: SDIO Specification Ver. 3.00 Error checking: CRC7 for commands and CRC16 for data Interrupt requests: Card access interrupt, SDIO access interrupt, card detection interrupt, interrupt of SD buffer access DMA transfer requests: SD_BUF write and SD_BUF read Support for card detection and write protection 			
MMC host interface (MMCIF)		 1 channel Transfer speed: Data transfer mode (30 MB/s), backward compatible mode (25 MB/s) Compliant with JEDEC STANDARD JESD84-A441 (DDR is not supported) Interface for Multimedia Cards (MMCs) Data buses: Support for 1-, 4-, and 8-bit MMC buses Interrupt requests: Card detection interrupt, error/timeout interrupt, normal operation interrupt, interrupt of MMCIF buffer access DMA transfer requests: CE_DATA write and CE_DATA read Support for card detection, boot operation, high priority interrupt (HPI) 			
The arithmetic ufunctions (TFU)	init for trigonometric	• Sine, cosine, arctangent, $\sqrt{x^2+y^2}$ Simultaneous calculation of sine and cosine Simultaneous calculation of arctangent and $\sqrt{x^2+y^2}$			
Parallel data ca	pture unit (PDC)	 1 channel Acquisition of synchronization through external 8-bit horizontal and vertical synchronization signals Setting of the image size when clipping of the output for a one-frame image is required 			
Graphic-LCD controller (GLCDC) 2D drawing engine (DRW2D)		 1 channel Various data formats and LCD panels are supported Superposition of 3 planes (single-color background, graphic 1, graphic 2) 32- and 16-bpp graphics data and 8-, 4-, and 1-bit CLUT data formats are supported 			
		 1 channel Vector drawing (straight lines, triangles, and circles) Bit blitting (with support for filling, copying, stretching, and rotation) Bus master function for input and output of frame buffer data 32-, 16-, and 8-bit pixel graphics data are supported Bus master function for input of texture data Input of texture data (32, 24, 16, 8, 4, 2, or 1 bit) are supported. Run length encoding is supported A CLUT is installed and index data can be converted into color data Two rendering modes are supported (register mode and display list mode) Performance counting Interrupts in response to completion of rendering and processing of the display list 			

Table 1.1 Outline of Specifications (10/11)

Classification	Module/Function	Description			
12-bit A/D converter (S12ADFa)		 12 bits × 2 units (unit 0: 8 channels; unit 1: 21 channels) 12-bit resolution (switchable between 8, 10, and 12 bits) Conversion time 0.48 µs per channel (for 12-bit conversion) 0.45 µs per channel (for 10-bit conversion) 0.42 µs per channel (for 8-bit conversion) Operating mode Scan mode (single scan mode, continuous scan mode, or 3 group scan mode) Group priority control (only for 3 group scan mode) Sample-and-hold function Common sample-and-hold circuit included In addition, channel-dedicated sample-and-hold function (3 channels: in unit 0 only) included Sampling variable Sampling time can be set up for each channel. Digital comparison Method: Comparison to detect voltages above or below thresholds and window comparison Measurement: Comparison of two results of conversion or comparison of a value in the comparison register and a result of conversion Self-diagnostic function The self-diagnostic function internally generates three analog input voltages (unit 0: VREFLO, VREFHO x 1/2, VREFHO; unit 1: AVSS1, AVCC1 x 1/2, AVCC1) Double trigger mode (A/D conversion data duplicated) Detection of analog input disconnection Three ways to start A/D conversion Software trigger, timer (MTU, TMR, TPU) trigger, external trigger 			
12-bit D/A converter (R12DAa)		Event linking by the ELC 2 channels 12-bit resolution Output voltage: 0.2 V to AVCC1 – 0.2 V (buffered output), 0 V to AVCC1 (unbuffered output) Buffered output or unbuffered output can be selected. Event linking by the ELC			
Temperature ser	nsor	 1 channel Relative precision: ± 1°C The voltage of the temperature is converted into a digital value by the 12-bit A/D converter (unit 1). 			
Safety	Memory protection unit (MPU)	 Protection area: Eight areas (max.) can be specified in the range from 0000 0000h to FFFF FFFFh. Minimum protection unit: 16 bytes Reading from, writing to, and enabling the execution access can be specified for each area. An access exception occurs when the detected access is not in the permitted area. 			
	Trusted Memory (TM) Function	 Programs in the TM target area in the code flash memory are protected against reading Instruction fetching by the CPU is the only form of access to these areas when the TM function is enabled. 			
	Register write protection function	Protects important registers from being overwritten for in case a program runs out of control.			
	CRC calculator (CRCA)	 Generation of CRC codes for 8-/32-bit data 8-bit data Selectable from the following three polynomials X⁸ + X² + X + 1, X¹⁶ + X¹⁵ + X² + 1, X¹⁶ + X¹² + X⁵ + 1 32-bit data Selectable from the following two polynomials X³² + X²⁶ + X²³ + X²² + X¹⁶ + X¹² + X¹¹ + X¹⁰ + X⁸ + X⁷ + X⁵ + X⁴ + X² + X + 1, X³² + X²⁸ + X²⁷ + X²⁶ + X²⁵ + X²³ + X²² + X²⁰ + X¹⁹ + X¹⁸ + X¹⁴ + X¹³ + X¹¹ + X¹⁰ + X⁹ + X⁸ + X⁶ + 1 Generation of CRC codes for use with LSB-first or MSB-first communications is selectable 			
	Main clock oscillation stop detection	Main clock oscillation stop detection: Available			

Table 1.1 Outline of Specifications (11/11)

Classification Module/Function		Description			
Safety	Clock frequency accuracy measurement circuit (CAC)	Monitors the clock output from the main clock oscillator, sub-clock oscillator, low- and high-speed on-chip oscillators, IWDT-dedicated on-chip oscillator, USB clock, Ethernet-PHY external clock, and PCLKB, and generates interrupts when the setting range is exceeded.			
	Data operation circuit (DOC)	The function to compare, add, or subtract 16-bit data			
Encryption function	Trusted Secure IP (TSIP)*3	Security algorithm Common key encryption: AES (compliant with NIST FIPS PUB 197), TDES, ARC4 Non-common key encryption: RSA Other features TRNG (true-random number generator) Hash value generation: SHA1, SHA224, SHA256, MD5, GHASH Prevention of the illicit copying of keys			
Operating frequency		Up to 240 MHz			
Power supply vo	ltage	VCC = AVCC0 = AVCC1 = VCC_USB = 2.7 to 3.6 V, $2.7 \le VREFH0 \le AVCC0$, $V_{BATT} = 2.0$ to 3.6 V			
Operating temperature		D-version: -40 to +85°C G-version: -40 to +105°C			
Package		224-pin LFBGA (PLBG0224GA-A) 176-pin LFBGA (PLBG0176GA-A) 176-pin LFQFP (PLQP0176KB-C) 145-pin TFLGA (PTLG0145KA-A) 144-pin LFQFP (PLQP0144KA-B) 100-pin LFQFP (PLQP0100KB-B)			
On-chip debuggi	ing system	E1 emulator (JTAG and FINE interfaces)			

Note 1. When the realtime clock is not used, initialize the registers in the time clock according to description in section 33.6.7, Initialization Procedure When the Realtime Clock is Not to be Used in the User's Manual: Hardware.

Note 2. Magic PacketTM is a registered trademark of Advanced Micro Devices, Inc.

Note 3. The product part number differs according to whether or not the MCU includes the encryption function.

Table 1.2 Comparison of Functions for Different Packages (1/2)

Functions		RX72N				
Package		224 Pins	176 Pins	144 Pins/145 Pins	100 Pins	
External bus	External bus width	32 bits/16	32 bits/16 bits/8 bits		16 bits/8 bits	
	SDRAM area controller	Available N			Not available	
DMA	DMA controller			Ch. 0 to 7		
	Data transfer controller			Available		
	EXDMA controller			Ch. 0 and 1		
Timers	16-bit timer pulse unit			Ch. 0 to 5		
	Multi-function timer pulse unit 3			Ch. 0 to 8		
	General PWM timer			Ch. 0 to 3		
	Port output enable 3			Available		
	Port output enable for GPTW			Available		
	Programmable pulse generator			Ch. 0 and 1		
	8-bit timers			Ch. 0 to 3		
	Compare match timer			Ch. 0 to 3		
	Compare match timer W			Ch. 0 and 1		
	Realtime clock			Available		
	Watchdog timer			Available		
	Independent watchdog timer			Available		
Communication	Ethernet controller		Ch. 0 an	d 1	Ch. 0	
function	PHY management interface		Ch. 0 an	d 1	Ch. 0	
	PTP controller for the ethernet controller			Available	1	
	DMA controller for the ethernet controller	Ch. 0 and 1 (ETHERC) and 2 (EPTPC)		Ch. 0 (ETHERC and 2 (EPTPC)		
	USB2.0 FS host/function module	Ch. 0			•	
	Serial communications interfaces (SCIj)		Ch. 0 to	6	Ch. 0 to 3, 5, and 6	
	Serial communications interfaces (SCIi)		Ch. 7 to	11	Ch. 8 to 11	
	Serial communications interfaces (SCIh)			Ch. 12		
	I ² C bus interfaces	Ch. 0 to 2				
	Serial peripheral interface	Ch. 0 to 2				
	CAN module		Ch. 0 to	2	Ch. 0 and 1	
	Quad serial peripheral interface			Ch. 0	·	
	Expansion serial sound interface	Ch. 0 and 1				
	SD host interface	Ch. 0				
	Multimediacard interface	Ch. 0				
	Parallel data capture unit	Available Not availa			Not available	
Graphics	Graphic-LCD controller	Available				
	2D drawing engine	Available				
12-bit A/D	Unit 0	AN000 to AN007 (8 channels)				
converter	Unit 1	AN100 to AN120		21 channels)	AN100 to AN113 (14 channels)	
12-bit D/A convert	er		Ch. 0 an	d 1	Ch. 1	
Temperature sensor				Available	1	
Arithmetic unit for	trigonometric functions			Available		

Table 1.2 Comparison of Functions for Different Packages (2/2)

Functions	RX72N	RX72N								
Package	224 Pins	224 Pins 176 Pins 144 Pins/145 Pins 100 Pin								
CRC calculator	Available									
Data operation circuit	Available									
Clock frequency accuracy measurement circuit			Available							
Trusted Secure IP		Available/Not available								
Event link controller			Available							

1.2 List of Products

Table 1.3 is a list of products, and Figure 1.1 shows how to read the product part no.

Table 1.3 List of Products (1/2)

Group	Part No.	Package	Code Flash Memory Capacity	RAM Capacity	Data Flash Memory Capacity	Operating Frequency (Max.)	Encryption Module	Operating temperature (°C)
RX72N	R5F572NNDDFC	PLQP0176KB-C	4 Mbytes	1 Mbyte	32 Kbytes	240 MHz	Not available	-40 to +85
(D-version)	R5F572NNHDFC	PLQP0176KB-C	4 Mbytes	1 Mbyte	32 Kbytes	240 MHz	Available	-40 to +85
	R5F572NDDDFC	PLQP0176KB-C	2 Mbytes	1 Mbyte	32 Kbytes	240 MHz	Not available	-40 to +85
	R5F572NDHDFC	PLQP0176KB-C	2 Mbytes	1 Mbyte	32 Kbytes	240 MHz	Available	-40 to +85
	R5F572NNDDFB	PLQP0144KA-B	4 Mbytes	1 Mbyte	32 Kbytes	240 MHz	Not available	-40 to +85
	R5F572NNHDFB	PLQP0144KA-B	4 Mbytes	1 Mbyte	32 Kbytes	240 MHz	Available	-40 to +85
	R5F572NDDDFB	PLQP0144KA-B	2 Mbytes	1 Mbyte	32 Kbytes	240 MHz	Not available	-40 to +85
	R5F572NDHDFB	PLQP0144KA-B	2 Mbytes	1 Mbyte	32 Kbytes	240 MHz	Available	-40 to +85
	R5F572NNDDFP	PLQP0100KB-B	4 Mbytes	1 Mbyte	32 Kbytes	240 MHz	Not available	-40 to +85
	R5F572NNHDFP	PLQP0100KB-B	4 Mbytes	1 Mbyte	32 Kbytes	240 MHz	Available	-40 to +85
	R5F572NDDDFP	PLQP0100KB-B	2 Mbytes	1 Mbyte	32 Kbytes	240 MHz	Not available	-40 to +85
	R5F572NDHDFP	PLQP0100KB-B	2 Mbytes	1 Mbyte	32 Kbytes	240 MHz	Available	-40 to +85
	R5F572NNDDBD	PLBG0224GA-A	4 Mbytes	1 Mbyte	32 Kbytes	240 MHz	Not available	-40 to +85
	R5F572NNHDBD	PLBG0224GA-A	4 Mbytes	1 Mbyte	32 Kbytes	240 MHz	Available	-40 to +85
	R5F572NDDDBD	PLBG0224GA-A	2 Mbytes	1 Mbyte	32 Kbytes	240 MHz	Not available	-40 to +85
	R5F572NDHDBD	PLBG0224GA-A	2 Mbytes	1 Mbyte	32 Kbytes	240 MHz	Available	-40 to +85
	R5F572NNDDBG	PLBG0176GA-A	4 Mbytes	1 Mbyte	32 Kbytes	240 MHz	Not available	-40 to +85
	R5F572NNHDBG	PLBG0176GA-A	4 Mbytes	1 Mbyte	32 Kbytes	240 MHz	Available	-40 to +85
	R5F572NDDDBG	PLBG0176GA-A	2 Mbytes	1 Mbyte	32 Kbytes	240 MHz	Not available	-40 to +85
	R5F572NDHDBG	PLBG0176GA-A	2 Mbytes	1 Mbyte	32 Kbytes	240 MHz	Available	-40 to +85
	R5F572NNDDLK	PTLG0145KA-A	4 Mbytes	1 Mbyte	32 Kbytes	240 MHz	Not available	-40 to +85
	R5F572NNHDLK	PTLG0145KA-A	4 Mbytes	1 Mbyte	32 Kbytes	240 MHz	Available	-40 to +85
	R5F572NDDDLK	PTLG0145KA-A	2 Mbytes	1 Mbyte	32 Kbytes	240 MHz	Not available	-40 to +85
	R5F572NDHDLK	PTLG0145KA-A	2 Mbytes	1 Mbyte	32 Kbytes	240 MHz	Available	-40 to +85
RX72N (G-version)	R5F572NNDGFC	PLQP0176KB-C	4 Mbytes	1 Mbyte	32 Kbytes	240 MHz	Not available	-40 to +105
(0 10101011)	R5F572NNHGFC	PLQP0176KB-C	4 Mbytes	1 Mbyte	32 Kbytes	240 MHz	Available	-40 to +105
	R5F572NDDGFC	PLQP0176KB-C	2 Mbytes	1 Mbyte	32 Kbytes	240 MHz	Not available	-40 to +105
	R5F572NDHGFC	PLQP0176KB-C	2 Mbytes	1 Mbyte	32 Kbytes	240 MHz	Available	-40 to +105
	R5F572NNDGFB	PLQP0144KA-B	4 Mbytes	1 Mbyte	32 Kbytes	240 MHz	Not available	-40 to +105
	R5F572NNHGFB	PLQP0144KA-B	4 Mbytes	1 Mbyte	32 Kbytes	240 MHz	Available	-40 to +105
	R5F572NDDGFB	PLQP0144KA-B	2 Mbytes	1 Mbyte	32 Kbytes	240 MHz	Not available	-40 to +105
	R5F572NDHGFB	PLQP0144KA-B	2 Mbytes	1 Mbyte	32 Kbytes	240 MHz	Available	-40 to +105
	R5F572NNDGFP	PLQP0100KB-B	4 Mbytes	1 Mbyte	32 Kbytes	240 MHz	Not available	-40 to +105
	R5F572NNHGFP	PLQP0100KB-B	4 Mbytes	1 Mbyte	32 Kbytes	240 MHz	Available	-40 to +105
	R5F572NDDGFP	PLQP0100KB-B	2 Mbytes	1 Mbyte	32 Kbytes	240 MHz	Not available	-40 to +105
	R5F572NDHGFP	PLQP0100KB-B	2 Mbytes	1 Mbyte	32 Kbytes	240 MHz	Available	-40 to +105
	R5F572NNDGBD	PLBG0224GA-A	4 Mbytes	1 Mbyte	32 Kbytes	240 MHz	Not available	-40 to +105
	R5F572NNHGBD	PLBG0224GA-A	4 Mbytes	1 Mbyte	32 Kbytes	240 MHz	Available	-40 to +105
	R5F572NDDGBD	PLBG0224GA-A	2 Mbytes	1 Mbyte	32 Kbytes	240 MHz	Not available	-40 to +105
	R5F572NDHGBD	PLBG0224GA-A	2 Mbytes	1 Mbyte	32 Kbytes	240 MHz	Available	-40 to +105
	R5F572NNDGBG	PLBG0176GA-A	4 Mbytes	1 Mbyte	32 Kbytes	240 MHz	Not available	-40 to +105
	R5F572NNHGBG	PLBG0176GA-A	4 Mbytes	1 Mbyte	32 Kbytes	240 MHz	Available	-40 to +105
	R5F572NDDGBG	PLBG0176GA-A	2 Mbytes	1 Mbyte	32 Kbytes	240 MHz	Not available	-40 to +105
	R5F572NDHGBG	PLBG0176GA-A	2 Mbytes	1 Mbyte	32 Kbytes	240 MHz	Available	-40 to +105

Table 1.3 List of Products (2/2)

Group	Part No. Package		Code Flash Memory Capacity	RAM Capacity	Data Flash Memory Capacity	Operating Frequency (Max.)	Encryption Module	Operating temperature (°C)
RX72N	R5F572NNDGLK	PTLG0145KA-A	4 Mbytes	1 Mbyte	32 Kbytes	240 MHz	Not available	-40 to +105
(G-version)	R5F572NNHGLK	PTLG0145KA-A	4 Mbytes	1 Mbyte	32 Kbytes	240 MHz	Available	-40 to +105
	R5F572NDDGLK	PTLG0145KA-A	2 Mbytes	1 Mbyte	32 Kbytes	240 MHz	Not available	-40 to +105
	R5F572NDHGLK	PTLG0145KA-A	2 Mbytes	1 Mbyte	32 Kbytes	240 MHz	Available	-40 to +105

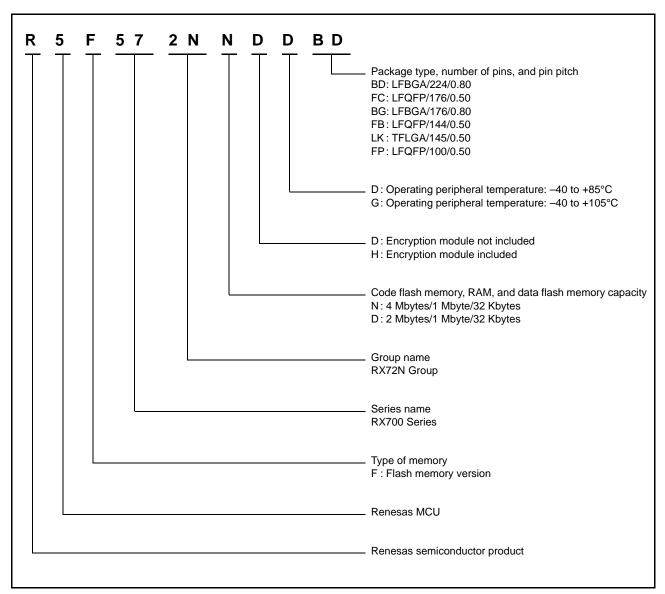


Figure 1.1 How to Read the Product Part Number

1.3 Block Diagram

Figure 1.2 shows a block diagram.

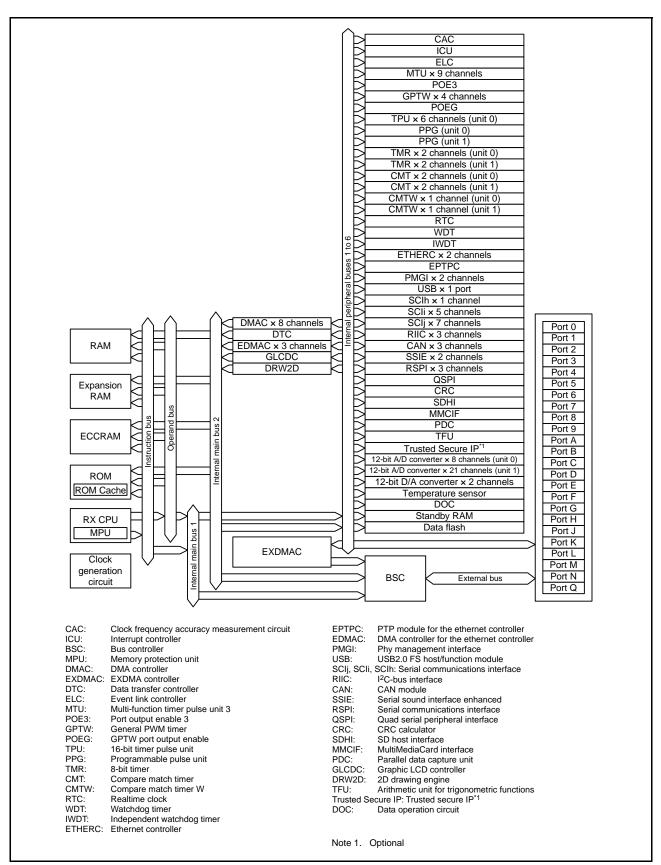


Figure 1.2 Block Diagram

1.4 Pin Functions

Table 1.4 lists the pin functions.

Table 1.4 Pin Functions (1/8)

Classifications	Pin Name	I/O	Description
Digital power supply	VCC	Input	Power supply pin. Connect this pin to the system power supply. Connect the pin to VSS via a 0.1-µF multilayer ceramic capacitor. The capacitor should be placed close to the pin.
	VCL	Input	Connect this pin to VSS via a 0.22-µF multilayer ceramic capacitor. The capacitor should be placed close to the pin.
	VSS	Input	Ground pin. Connect it to the system power supply (0 V).
	VBATT	Input	Backup power pin
Clock	XTAL	Output	Input/output pins for a crystal resonator. An external clock signa
	EXTAL	Input	can be input through the EXTAL pin.
	BCLK	Output	Outputs the external bus clock for external devices.
	SDCLK	Output	Outputs the SDRAM-dedicated clock.
	XCOUT	Output	Input/output pins for the sub-clock oscillator. Connect a crystal
	XCIN	Input	resonator between XCOUT and XCIN.
	CLKOUT	Output	Clock output pin.
Clock frequency accuracy measurement	CACREF	Input	Reference clock input pin for the clock frequency accuracy measurement circuit
Operating mode control	MD	Input	Input pin for setting the operating mode. The signal level on this pin must not be changed during operation.
	UB	Input	USB boot mode enable pin
	UPSEL	Input	Selects the power supply method in USB boot mode. The low level selects self-power mode and the high level selects bus power mode.
System control	RES#	Input	Reset signal input pin. This MCU enters the reset state when this signal goes low.
	EMLE	Input	Input pin for the on-chip emulator enable signal. When the on- chip emulator is used, this pin should be driven high. When not used, it should be driven low.
	BSCANP	Input	Boundary scan enable pin. Boundary scan is enabled when this pin goes high. When not used, it should be driven low.
On-chip emulator	FINED	I/O	FINE interface pin
	TRST#	Input	On-chip emulator or boundary scan pins. When the EMLE pin is
	TMS	Input	driven high, these pins are dedicated for the on-chip emulator.
	TDI	Input	
	TCK	Input	
	TDO	Output	
	TRCLK	Output	This pin outputs the clock for synchronization with the trace data.
	TRSYNC, TRSYNC1	Output	These pins indicate that output from the TRDATA0 to TRDATA7 pins is valid.
	TRDATA0 to TRDATA7	Output	These pins output the trace information.
Address bus	A0 to A23	Output	Output pins for the address
Data bus	D0 to D31	I/O	Input and output pins for the bidirectional data bus
Multiplexed bus	A0/D0 to A15/D15	I/O	Address/data multiplexed bus

Table 1.4 Pin Functions (2/8)

Classifications	Pin Name	I/O	Description
Bus control	RD#	Output	Strobe signal which indicates that reading from the external bus interface space is in progress
	WR#	Output	Strobe signal which indicates that writing to the external bus interface space is in progress, in 1-write strobe mode
	WR0# to WR3#	Output	Strobe signals which indicate that either group of data bus pins (D7 to D0, D15 to D8, D23 to D16 and D31 to D24) is valid in writing to the external bus interface space, in byte strobe mode
	BC0# to BC3#	Output	Strobe signals which indicate that either group of data bus pins (D7 to D0, D15 to D8, D23 to D16 and D31 to D24) is valid in access to the external bus interface space, in 1-write strobe mode
	ALE	Output	Address latch signal when address/data multiplexed bus is selected
	WAIT#	Input	Input pin for wait request signals in access to the external space
	CS0# to CS7#	Output	Select signals for CS areas
SDRAM interface	CKE	Output	SDRAM clock enable signal
	SDCS#	Output	SDRAM chip select signal
	RAS#	Output	SDRAM row address strobe signal
	CAS#	Output	SDRAM column address strove signal
	WE#	Output	SDRAM write enable pin
	DQM0 to DQM3	Output	SDRAM I/O data mask enable signals
EXDMA controller	EDREQ0, EDREQ1	Input	External DMA transfer request pins
	EDACKO, EDACK1	Output	Single address transfer acknowledge signals
Interrupt	NMI	Input	Non-maskable interrupt request pin
	IRQ0 to IRQ15, IRQ0-DS to IRQ15-DS	Input	Maskable interrupt request pins
Multi-function timer pulse unit 3	MTIOCOA, MTIOCOB, MTIOCOC, MTIOCOD	I/O	The TGRA0 to TGRD0 input capture input/output compare output/PWM output pins
	MTIOC1A, MTIOC1B	I/O	The TGRA1 and TGRB1 input capture input/output compare output/PWM output pins
	MTIOC2A, MTIOC2B	I/O	The TGRA2 and TGRB2 input capture input/output compare output/PWM output pins
	MTIOC3A, MTIOC3B, MTIOC3C, MTIOC3D	I/O	The TGRA3 to TGRD3 input capture input/output compare output/PWM output pins
	MTIOC4A, MTIOC4B, MTIOC4C, MTIOC4D	I/O	The TGRA4 to TGRD4 input capture input/output compare output/PWM output pins
	MTIC5U, MTIC5V, MTIC5W	Input	The TGRU5, TGRV5, and TGRW5 input capture input/dead time compensation input pins
	MTIOC6A, MTIOC6B, MTIOC6C, MTIOC6D	I/O	The TGRA6 to TGRD6 input capture input/output compare output/PWM output pins
	MTIOC7A, MTIOC7B, MTIOC7C, MTIOC7D	I/O	The TGRA7 to TGRD7 input capture input/output compare output/PWM output pins
	MTIOC8A, MTIOC8B, MTIOC8C, MTIOC8D	I/O	The TGRA8 to TGRD8 input capture input/output compare output/PWM output pins
	MTCLKA, MTCLKB, MTCLKC, MTCLKD	Input	Input pins for external clock signals or for phase counting mode clock signals
Port output enable 3	POE0#, POE4#, POE8#, POE10#, POE11#	Input	Input pins for request signals to place the MTU in the high impedance state

Table 1.4 Pin Functions (3/8)

Classifications	Pin Name	I/O	Description			
General PWM timer W	GTETRGA, GTETRGB, GTETRGC, GTETRGD	Input	Input pins for the external trigger signals			
	GTIOC0A to GTIOC3A, GTIOC0B to GTIOC3B	I/O	Input capture input/output compare output/PWM output pins			
	GTADSM0, GTADSM1	Output	Output pins for monitoring A/D conversion start requests.			
16-bit timer pulse unit	TIOCA0, TIOCB0, TIOCC0, TIOCD0					
	TIOCA1, TIOCB1	I/O	The TGRA1 and TGRB1 input capture input/output compare output/PWM output pins			
	TIOCA2, TIOCB2	I/O	The TGRA2 and TGRB2 input capture input/output compare output/PWM output pins			
	TIOCA3, TIOCB3, TIOCC3, TIOCD3	I/O	The TGRA3 to TGRD3 input capture input/output compare output/PWM output pins			
	TIOCA4, TIOCB4	I/O	The TGRA4 and TGRB4 input capture input/output compare output/PWM output pins			
	TIOCA5, TIOCB5	I/O	The TGRA5 and TGRB5 input capture input/output compare output/PWM output pins			
	TCLKA, TCLKB, TCLKC, TCLKD	Input	Input pins for external clock signals or for phase counting mode clock signals			
Programmable pulse generator	PO0 to PO31	Output	Output pins for the pulse signals			
8-bit timer	TMO0 to TMO3	Output	Compare match output pins			
	TMCI0 to TMCI3	Input	Input pins for external clocks to be input to the counter			
	TMRI0 to TMRI3	Input	Input pins for the counter reset			
Compare match timer W	TIC0 to TIC3	Input	Input pins for CMTW			
	TOC0 to TOC3	Output	Output pins for CMTW			
Serial communications	Asynchronous mode/clock sy	nchronou	s mode			
interface (SCIj)	SCK0 to SCK6	I/O	Input/output pins for the clock			
	RXD0 to RXD6	Input	Input pins for received data			
	TXD0 to TXD6	Output	Output pins for transmitted data			
	CTS0# to CTS6#	Input	Input pins for controlling the start of transmission and reception			
	RTS0# to RTS6#	Output	Output pins for controlling the start of transmission and reception			
	Simple I ² C mode					
	SSCL0 to SSCL6	I/O	Input/output pins for the I ² C clock			
	SSDA0 to SSDA6	I/O	Input/output pins for the I ² C data			
	Simple SPI mode	•				
	SCK0 to SCK6	I/O	Input/output pins for the clock			
	SMISO0 to SMISO6	I/O	Input/output pins for slave transmission of data			
	SMOSI0 to SMOSI6	I/O	Input/output pins for master transmission of data			
	SS0# to SS6#	Input	Chip-select input pins			

Table 1.4 Pin Functions (4/8)

Classifications	Pin Name	I/O	Description
Serial communications	Asynchronous mode/clock s	synchronou	s mode
interface (SCIh)	SCK12	I/O	Input/output pin for the clock
	RXD12	Input	Input pin for received data
	TXD12	Output	Output pin for transmitted data
	CTS12#	Input	Input pin for controlling the start of transmission and reception
	RTS12#	Output	Output pin for controlling the start of transmission and receptio
	Simple I ² C mode	•	
	SSCL12	I/O	Input/output pin for the I ² C clock
	SSDA12	I/O	Input/output pin for the I ² C data
	Simple SPI mode	•	
	SCK12	I/O	Input/output pin for the clock
	SMISO12	I/O	Input/output pin for slave transmission of data
	SMOSI12	I/O	Input/output pin for master transmission of data
	SS12#	Input	Chip-select input pin
	Extended serial mode		
	RXDX12	Input	Input pin for received data
	TXDX12	Output	Output pin for transmitted data
	SIOX12	I/O	Input/output pin for received or transmitted data
Serial communications	Asynchronous mode/clock s	synchronou	s mode
interface (SCIi)	SCK7 to SCK11	I/O	Input/output pins for the clock
	RXD7 to RXD11	Input	Input pins for received data
	TXD7 to TXD11	Output	Output pins for transmitted data
	CTS7# to CTS11#	Input	Input pins for controlling the start of transmission and reception
	RTS7# to RTS11#	Output	Output pins for controlling the start of transmission and reception
	Simple I ² C mode		
	SSCL7 to SSCL11	I/O	Input/output pins for the I ² C clock
	SSDA7 to SSDA11	I/O	Input/output pins for the I ² C data
	Simple SPI mode		
	SCK7 to SCK11	I/O	Input/output pins for the clock
	SMISO7 to SMISO11	I/O	Input/output pins for slave transmission of data
	SMOSI7 to SMOSI11	I/O	Input/output pins for master transmission of data
	SS7# to SS11#	Input	Chip-select input pins
I ² C bus interface	SCL0[FM+], SCL1, SCL2, SCL2-DS	I/O	Input/output pins for clocks. Bus can be directly driven by the N-channel open drain
	SDA0[FM+], SDA1, SDA2, SDA2-DS	I/O	Input/output pins for data. Bus can be directly driven by the N-channel open drain

Table 1.4 Pin Functions (5/8)

Classifications	Pin Name	I/O	Description
Ethernet controller	REF50CK0, REF50CK1	Input	50-MHz reference clocks. These pins input reference signals for transmission/reception timings in RMII mode.
	RMII0_CRS_DV, RMII1_CRS_DV	Input	These pins indicate that there are carrier detection signals and valid receive data on RMIIn_RXD1 and RMIIn_RXD0 in RMII mode.
	RMII0_TXD0, RMII0_TXD1, RMII1_TXD0, RMII1_TXD1	Output	2-bit transmit data in RMII mode
	RMII0_RXD0, RMII0_RXD1, RMII1_RXD0, RMII1_RXD1	Input	2-bit receive data in RMII mode
	RMII0_TXD_EN, RMII1_TXD_EN	Output	Output pins for data transmit enable signals in RMII mode
	RMII0_RX_ER, RMII1_RX_ER	Input	These pins indicate an error has occurred during reception of data in RMII mode.
	ET0_CRS, ET1_CRS	Input	Carrier detection/data reception enable pins
	ET0_RX_DV, ET1_RX_DV	Input	These pins indicate that there are valid receive data on ETn_ERXD3 to ETn_ERXD0.
	ET0_EXOUT, ET1_EXOUT	Output	General-purpose external output pins
	ET0_LINKSTA, ET1_LINKSTA	Input	Input link status from the PHY-LSI.
	ET0_ETXD0 to ET0_ETXD3, ET1_ETXD0 to ET1_ETXD3	Output	4 bits of MII transmit data
	ET0_ERXD0 to ET0_ERXD3, ET1_ERXD0 to ET1_ERXD3	Input	4 bits of MII receive data
	ET0_TX_EN, ET1_TX_EN	Output	Transmit enable pins. These pins function as signals indicating that transmit data are ready on ETn_ETXD3 to ETn_ETXD0.
	ET0_TX_ER, ET1_TX_ER	Output	Transmit error pins. These pins function as signals notifying the PHY-LSI of an error during transmission.
	ET0_RX_ER, ET1_RX_ER	Input	Receive error pins. These pins function as signals to recognize an error during reception.
	ET0_TX_CLK, ET1_RX_CLK	Input	Transmit clock pins. These pins input reference signals for output timings from ETn_TX_EN, ETn_ETXD3 to ETn_ETXD0 and ETn_TX_ER.
	ET0_RX_CLK, ET1_RX_CLK	Input	Receive clock pins. These pins input reference signals for input imings to ETn_RX_DV, ETn_ERXD3 to ETn_ERXD0, and ETn_RX_ER.
	ET0_COL, ET1_COL	Input	Input collision detection signals.
	ET0_WOL, ET1_WOL	Output	Receive Magic packets.
	ET0_MDC, ET1_MDC	Output	Output reference clock signals for information transfer via ETn_MDIO.
	ET0_MDIO, ET1_MDIO	I/O	Input or output bidirectional signals for exchange of management information between this MCU and the PHY-LSI.
	CLKOUT25M	Output	25-MHz clock output pin for PHY clock input
	EPLSOUT0, EPLSOUT1	Output	Pulse output signals for time synchronization
PHY management interface	PMGI0_MDC, PMGI1_MDC	Output	Reference clock signals for information transfer by PMGIn_MDIO
	PMGI0_MDIO, PMGI1_MDIO	I/O	Bi-directional signals for the exchange of management information between the PHY LSI chip and this MCU

Table 1.4 Pin Functions (6/8)

Classifications	Pin Name	I/O	Description					
USB 2.0 host/function	VCC_USB	Input	Power supply pin					
module	VSS_USB	Input	Ground pin					
	USB0_DP	I/O	Input or output USB transceiver D+ data.					
	USB0_DM	I/O	Input or output USB transceiver D- data.					
	USB0_EXICEN	Output	Connect to the OTG power IC.					
	USB0_ID	Input	Connect to the OTG power IC.					
	USB0_VBUSEN	Output	USB VBUS power enable pin					
	USB0_OVRCURA/ USB0_OVRCURB	Input	USB overcurrent pins					
	USB0_VBUS	Input	USB cable connection/disconnection detection input pin					
CAN module	CRX0, CRX1, CRX2, CRX1-DS	Input	Input pins					
	CTX0, CTX1, CTX2	Output	Output pins					
Serial peripheral interface	RSPCKA-A/RSPCKA-B/ RSPCKB-A/RSPCKB-B/ RSPCKC-A/RSPCKC-B	I/O	Clock input/output pins					
	MOSIA-A/MOSIA-B/ MOSIB-A/MOSIB-B/ MOSIC-A/MOSIC-B	I/O	Input or output data output from the master					
	MISOA-A/MISOA-B/ MISOB-A/MISOB-B/ MISOC-A/MISOC-B	I/O	Input or output data output from the slave					
	SSLA0-A/SSLA0-B/ SSLB0-A/SSLB0-B/ SSLC0-A/SSLC0-B	I/O	Input or output pins for slave selection					
	SSLA1-A/SSLA1-B/ SSLB1-A/SSLB1-B/ SSLC1-A/SSLC1-B, SSLA2-A/SSLA2-B/ SSLB2-A/SSLB2-B/ SSLC2-A/SSLC2-B, SSLA3-A/SSLA3-B/ SSLB3-A/SSLB3-B/ SSLC3-A/SSLC3-B	Output	Output pins for slave selection					
Quad serial peripheral	QSPCLK-A/QSPCLK-B	Output	QSPI clock output pins					
interface	QSSL-A/QSSL-B	Output	QSPI slave output pins					
	QMO-A/QMO-B, QIO0-A/QIO0-B	I/O	Master transmit data/data 0					
	QMI-A/QMI-B, QIO1-A/QIO1-B	I/O	Master input data/data 1					
	QIO2-A/QIO2-B, QIO3-A/QIO3-B	I/O	Data 2, data 3					
Serial sound interface	SSIBCK0, SSIBCK1	I/O	SSIE serial bit-clock pins					
enhanced	SSILRCK0, SSILRCK1	I/O	LR clock					
	SSITXD0	Output	Serial data output pin					
	SSIRXD0	Input	Serial data input pin					
	SSIDATA1	I/O	Serial data input/output pin					
	AUDIO_CLK	Input	External clock pin for audio (input for an oversampling clock)					

Table 1.4 Pin Functions (7/8)

Classifications	Pin Name	I/O	Description
MMC host interface	MMC_CLK-A/MMC_CLK-B	Output	MMC clock pins
	MMC_CMD-A/MMC_CMD-B	I/O	Command/response pins
	MMC_D7-A/MMC_D7-B to MMC_D0-A/MMC_D0-B	I/O	Transmit data/receive data
	MMC_CD-A/MMC_CD-B	Input	Card detection pins
	MMC_RES#-A/MMC_RES#-B	Output	MMC reset output pins
SD host interface	SDHI_CLK-A/SDHI_CLK-B/ SDHI_CLK-C	Output	SD clock output pins
	SDHI_CMD-A/SDHI_CMD-B/ SDHI_CMD-C	I/O	SD command output, response input signal pins
	SDHI_D3-A/SDHI_D3-B/ SDHI_D3-C to SDHI_D0-A/ SDHI_D0-B/SDHI_D0-C	I/O	SD data bus pins
	SDHI_CD	Input	SD card detection pin
	SDHI_WP	Input	SD write-protect signal
Parallel data capture unit	PIXCLK	Input	Image transfer clock pin
	VSYNC	Input	Vertical synchronization signal pin
	HSYNC	Input	Horizontal synchronization signal pin
	PIXD0 to PIXD7	Input	8-bit image data pins
	PCKO	Output	Output pin for dot clock
Graphic-LCD controller	LCD_CLK-A, LCD_CLK-B	Output	Panel clock output pins
	LCD_TCON3-A/ LCD_TCON3-B to LCD_TCON0-A/ LCD_TCON0-B	Output	Control signal output pins
	LCD_DATA23-A/ LCD_DATA23-B to LCD_DATA0-A/ LCD_DATA0-B	Output	LCD signal output pins
	LCD_EXTCLK-A, LCD_EXTCLK-B	Input	Panel clock source input pins
Realtime clock	RTCOUT	Output	Output pin for 1-Hz/64-Hz clock
	RTCIC0 to RTCIC2	Input	Time capture event input pins
12-bit A/D converter	AN000 to AN007, AN100 to AN120	Input	Input pins for the analog signals to be processed by the A/D converter
	ADTRG0#, ADTRG1#	Input	Input pins for the external trigger signals that start the A/D conversion
	ANEX0	Output	Extended analog output pin
	ANEX1	Input	Extended analog input pin
12-bit D/A converter	DA0, DA1	Output	Output pins for the analog signals to be processed by the D/A converter

Table 1.4 Pin Functions (8/8)

Classifications	Pin Name	I/O	Description
Analog power supply	AVCC0	Input	Analog voltage supply pin for the 12-bit A/D converter (unit 0). Connect this pin to a branch from the VCC power supply. Connect the pin to AVSS0 via a 0.1-µF multilayer ceramic capacitor. The capacitor should be placed close to the pin.
	AVSS0	Input	Analog ground pin for the 12-bit A/D converter (unit 0). Connect this pin to a branch from the VSS ground power supply. Connect the pin to AVCC0 via a 0.1-µF multilayer ceramic capacitor. The capacitor should be placed close to the pin.
	VREFH0	Input	Analog reference voltage supply pin for the 12-bit A/D converter (unit 0). Connect this pin to VCC if the 12-bit A/D converter is not to be used.
	VREFL0	Input	Analog reference ground pin for the 12-bit A/D converter (unit 0). Connect this pin to VSS if the 12-bit A/D converter is not to be used.
	AVCC1	Input	Analog voltage supply and reference voltage supply pin for the 12-bit A/D converter (unit 1) and D/A converter. This pin also supplies the analog voltage to the temperature sensor. Connect this pin to a branch from the VCC power supply. Connect the pin to AVSS1 via a 0.1-µF multilayer ceramic capacitor. The capacitor should be placed close to the pin.
	AVSS1	Input	Analog voltage supply and reference voltage supply pin for the 12-bit A/D converter (unit 1) and D/A converter. This pin also supplies the analog ground voltage to the temperature sensor. Connect this pin to a branch from the VSS ground power supply. Connect the pin to AVCC1 via a 0.1-µF multilayer ceramic capacitor. The capacitor should be placed close to the pin.
I/O ports	P00 to P03, P05, P07	I/O	6-bit input/output pins
	P10 to P17	I/O	8-bit input/output pins
	P20 to P27	I/O	8-bit input/output pins
	P30 to P37	I/O	8-bit input/output pins (P35: input pin)
	P40 to P47	I/O	8-bit input/output pins
	P50 to P57	I/O	8-bit input/output pins
	P60 to P67	I/O	8-bit input/output pins
	P70 to P77	I/O	8-bit input/output pins
	P80 to P87	I/O	8-bit input/output pins
	P90 to P97	I/O	8-bit input/output pins
	PA0 to PA7	I/O	8-bit input/output pins
	PB0 to PB7	I/O	8-bit input/output pins
	PC0 to PC7	I/O	8-bit input/output pins
	PD0 to PD7	I/O	8-bit input/output pins
	PE0 to PE7	I/O	8-bit input/output pins
	PF0 to PF5	I/O	6-bit input/output pins
	PG0 to PG7	I/O	8-bit input/output pins
	PJ0 to PJ3, PJ5	I/O	5-bit input/output pins
	PH0 to PH7	I/O	8-bit input/output pins
	PK0 to PK7	I/O	8-bit input/output pins
	PL0 to PL7	I/O	8-bit input/output pins
	PM0 to PM7	I/O	8-bit input/output pins
	PN0 to PN5	I/O	6-bit input/output pins
	PQ0 to PQ7	I/O	8-bit input/output pins

Note the following regarding pin names. For details, refer to section 1.5, Pin Assignments.

- We recommend using pins that have a letter ("-A", "-B", etc.) to indicate group membership appended to their names as

groups.
For the RSPI, QSPI, SDHI, MMC, and GLCDC interfaces, the AC portion of the electrical characteristics is measured for each

- group.
 When the pin functions have "-DS" appended to their names, they can also be used as triggers for release from deep software standby.

 - RIIC pin functions that have [FM+] appended to their names support fast-mode plus.



1.5 Pin Assignments

1.5.1 224-Pin LFBGA

RX72N Group PLBG0224GA-A (224-pin LFBGA) (Upper Perspective View) D Е G 15 P70 PE7 P66 P67 PG4 PG7 PA4 PA5 PA7 P72 PB4 PB6 PB7 РМ3 PM5 15 PB0 14 PE1 PE4 P65 PG2 PG5 PG6 PA3 PA6 PB3 PB2 PC0 PC1 PM4 P74 14 PF2 PF5 PF6 VSS P71 PR5 VCC PC2 P62 VSS PG3 PA2 РМ7 PM6 P75 13 13 VSS PF3 VCC VCC PB1 VSS PN4 P76 12 P61 P63 PAO PA1 PL6 PL2 PL4 12 VCC 11 PD7 P64 PF0 PQ4 PM1 PM0 PL0 PN5 PM2 P77 PL5 PK2 PC4 PC3 11 10 PG0 PD6 P60 PG1 PQ5 VSS VCC P73 PL1 PL3 PL7 PK0 P80 P82 PC5 10 9 PD3 PD4 P97 PD5 PQ3 PQ6 PN2 PN3 PK3 PK1 P81 P83 PC7 VSS PC6 9 P96 VCC vss PQ1 PN1 PQ2 PQ7 P53*1 P51 VCC P11 8 8 7 PD2 PD1 PQ0 RES# VCC P54 VSS_US USB0_D **EMLE** BSCANP PJ1 6 PD0 VCC P90 P02 PN0 PF5 PH2 PH1 PJ2 P84 VCC_US USB0_D VSS P07 PJ5 P32 P30 PF0 VCC P13 5 5 P92 P91 P01 PK5 PJ0 MD/ P40 P33 P31 PH5 P24 VSS P85 P41 P46 P44 P43 PK4 P14 P12 4 FINED VCC 3 VREFL0 P42 P05 P03 P00 PF4 P35 PF3 PH4 PF1 P25 P86 P20 P16 3 2 VREFH0 AVCC0 AVCC1 P47 VSS VBATT VSS PH6 P27 P17 P34 PF2 P23 PH0 P87 2 AVSS0 AVSS1 VCL XCIN XCOUT **EXTAL** 1 NC P45 XTAL PH7 PH3 P26 P22 PK7 P21 1 С F G Н Р R

Note: This figure indicates the power supply pins and I/O port pins. For the pin configuration, refer to Table 1.5, List of Pin and Pin Functions (224-Pin LFBGA).

Note 1. P53 is multiplexed with the BCLK pin function, so cannot be used as an I/O port pin when the external bus is enabled.

Figure 1.3 Pin Assignment (224-Pin LFBGA)

1.5.2 176-Pin LFBGA

ı	Α	В	С	D	E	F	G	Н	J	K	L	М	N	Р	R	7
15	PE2	PE3	P70	P65	P67	VSS	VCC	PG7	PA6	PB0	P72	PB4	VSS	VCC	PC1	
14	PE1	PE0	VSS	PE7	PG3	PA0	PA1	PA2	PA7	VCC	PB1	PB5	P73	P75	P74	
13	P63	P64	PE4	VCC	PG2	PG4	PG6	PA3	VSS	P71	PB3	PB7	PC0	PC2	P76	
12	P60	VSS	P62	PE5	PE6	P66	PG5	PA4	PA5	PB2	PB6	P77	PC3	PC4	P80	
11	PD6	PG1	VCC	P61								P81	P82	PC6	VCC	
10	P97	PD4	PG0	PD7								PC5	PC7	P83	VSS	
9	vcc	P96	PD3	PD5			RX7	2N G	roup			P50	P51	P52	P53*1	
8	P94	PD1	PD2	VSS		(176-p	oin LF	GA-A BGA	.)		P55	P54	P10	P11	
7	VSS	P92	PD0	P95		(Upp	er Pe	rspe	ctive '	view)		P85	P84	P57	P56	
6	VCC	P91	P90	P93								PJ1	PJ0	VSS_ USB	USB0_ DP	
5	P46	P47	P45	P44								PJ2	P12	VCC_ USB	USB0_ DM	
4	P42	P41	P43	P00	VSS	BSCANP	PF4	P35	PF3	PF1	P25	P86	P15	P14	P13	
3	VREFL0	P40	VREFH0	P03	PF5	PJ3	MD/ FINED	RES#	P34	PF2	PF0	P24	P22	P87	P16	
2	AVCC0	P07	AVCC1	P02	EMLE	VCL	XCOUT	VSS	VCC	P32	P30	P26	P23	P17	P20	
1	AVSS0	P05	AVSS1	P01	PJ5	VBATT	XCIN	XTAL	EXTAL	P33	P31	P27	VCC	VSS	P21	_
	A	В	С	D	E	F	G	Н	J	K	L	M	N	P	R	J

Note 1. P53 is multiplexed with the BCLK pin function, so cannot be used as an I/O port pin when the external bus is enabled.

Figure 1.4 Pin Assignment (176-Pin LFBGA)

1.5.3 176-Pin LFQFP

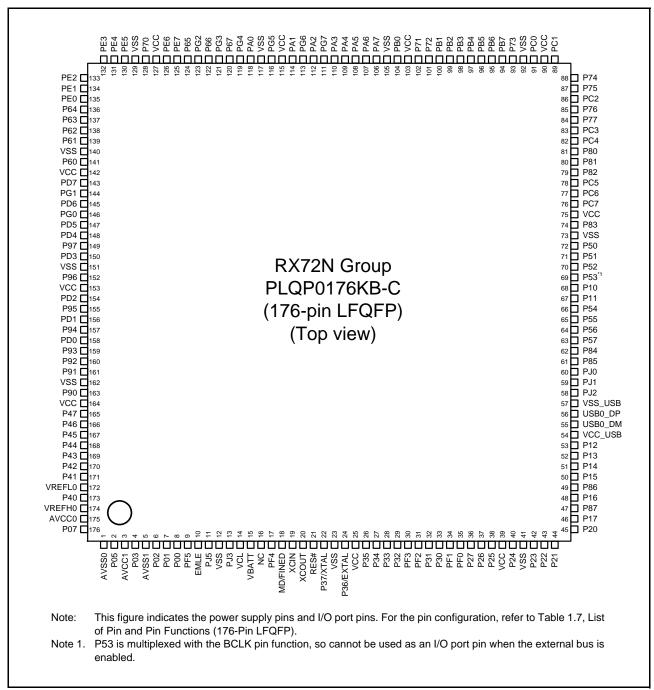


Figure 1.5 Pin Assignment (176-Pin LFQFP)

1.5.4 145-Pin TFLGA

	Α	В	С	D	Е	F	G	Н	J	К	L	М	N	_
13	PE3	PE4	VSS	PE6	P67	PA2	PA4	PA7	PB1	PB5	VSS	VCC	P74	1
12	PE1	PE2	P70	PE5	P65	PA1	VCC	PB0	PB2	PB6	P73	PC1	P75	1
11	P62	P61	PE0	VCC	P66	VSS	PA6	P71	PB4	PB7	PC2	PC0	PC3	1
10	VSS	vcc	P63	PE7	PA0	PA3	PA5	P72	PB3	P76	PC4	P77	P82	1
9	PD6	PD4	PD7	P64			<u> </u>			P80	PC5	P81	PC7	g
8	PD2	PD0	PD3	P60			'2N G			VCC	P83	PC6	VSS	8
7	P92	P91	PD1	PD5	(Hr	(145-	30145 pin TF erspec	LGA)		P51	P52	P50	P55	7
6	P90	P47	VSS	P93	(0)	реп	сторес	tive vi	GW)	P53*1	P56	VSS_ USB	USB0_ DP	6
5	P45	P43	P46	VCC	P44					P54	P13	VCC_ USB	USB0_ DM	5
4	P42	VREFL0	P41	P01	EMLE	VBATT	BSCANP	P35	P30	P15	P24	P12	P14	4
3	P40	P05	VREFH0	P03	PJ5	PJ3	MD/ FINED	VSS	P32	P31	P16	P86	P87	3
2	P07	AVCC0	P02	PF5	VCL	XCOUT	RES#	VCC	P33	P26	P23	P17	P20	2
1	AVSS0	AVCC1	AVSS1	P00	VSS	XCIN	XTAL	EXTAL	P34	P27	P25	P22	P21	1
	A	В	С	D	E	F	G	Н	J	K	L L	M	N	1

This figure indicates the power supply pins and I/O port pins. For the pin configuration, refer to Table 1.8, List of Pin and Pin Functions (145-Pin TFLGA). Note:

Note 1. P53 is multiplexed with the BCLK pin function, so cannot be used as an I/O port pin when the external bus is enabled.

Pin Assignment (145-Pin TFLGA) Figure 1.6

1.5.5 144-Pin LFQFP

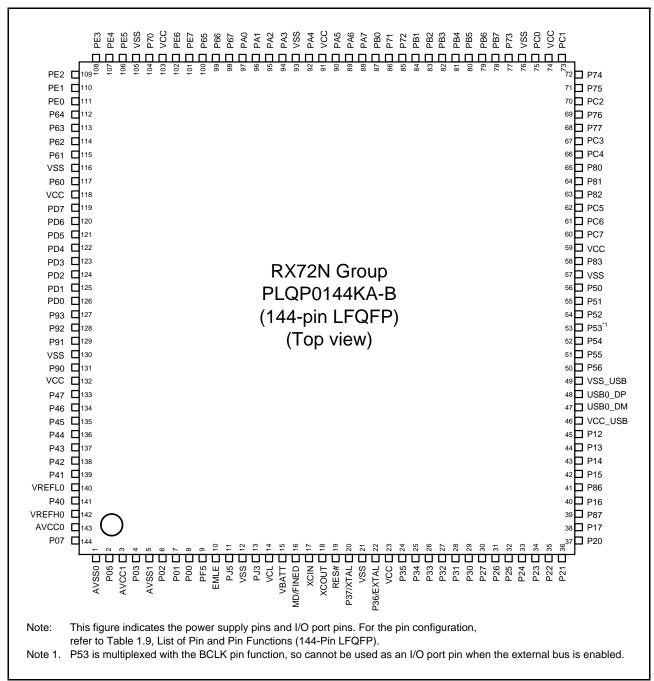


Figure 1.7 Pin Assignment (144-Pin LFQFP)

1.5.6 100-Pin LFQFP

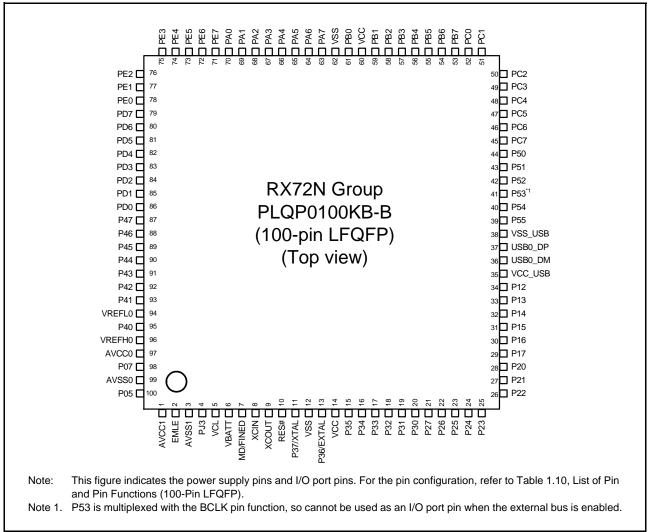


Figure 1.8 Pin Assignment (100-Pin LFQFP)

1.6 List of Pin and Pin Functions

1.6.1 224-Pin LFBGA

Table 1.5 List of Pin and Pin Functions (224-Pin LFBGA) (1/11)

Pin Number	Power			Timer		Communica	tion	Memory I/F Camera I/F			
224-Pin LFBGA	Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	(MTU, TPU, TMR, PPG, RTC, CMTW, POE, CAC)	(GPTW, POEG)	(SCI, RSPI, RIIC, CAN, USB, SSIE)	(ETHERC, PMGI)	(QSPI, SDHI, MMCIF, PDC)	GLCDC Interrupt	Interrupt	A/D D/A
A1	NC										
A2	VREFH0										
А3	VREFL0										
A4		P41								IRQ9-DS	AN001
A5		P92	D18/A18	POE4#		RXD7/ SMISO7/ SSCL7	ET1_CRS/ RMII1_CR S_DV				AN116
A6		PD0	D0[A0/D0]	POE4#	GTIOC1B				LCD_EXT CLK-B	IRQ0	AN108
A7		PD2	D2[A2/D2]	MTIOC4D/ TIC2	GTIOC0B	MISOC-A/ CRX0	ET1_EXOU T	QIO2-B/ SDHI_D2-B/ MMC_D2-B	LCD_DAT A22-B	IRQ2	AN110
A8	TRDATA5	P96	D22/A22				ET1_ERXD				
A9		PD3	D3[A3/D3]	MTIOC8D/ TOC2/POE8#	GTIOC0A	RSPCKC-A	ET1_WOL	QIO3-B/ SDHI_D3-B/ MMC_D3-B	LCD_DAT A21-B	IRQ3	AN111
A10	TRDATA6	PG0	D24				ET1_RX_C LK/ REF50CK1				
A11		PD7	D7[A7/D7]	MTIC5U/ POE0#		SSLC3-A	R/	QMI-B/QIO1- B/SDHI_D1-B/ MMC_D1-B	LCD_DAT A17-B	IRQ7	AN107
A12		P61	SDCS#/ D0[A0/D0]/ CS1#				ET1_ERXD 1/ RMII1_RX D1				
A13		P62	RAS#/ D1[A1/D1]/ CS2#				ET1_ERXD 0/ RMII1_RX D0				
A14		PE1	D9[A9/D9]/ D1[A1/D1]	MTIOC4C/ MTIOC3B/ PO18	GTIOC1B	TXD12/ SMOSI12/ SSDA12/ TXDX12/ SIOX12/ SSLB2-B		MMC_D5-B	LCD_DAT A15-B		ANEX ²
A15		P70	SDCLK								
B1	AVSS0										
B2	AVCC0										
В3		P42								IRQ10-DS	AN002
B4		P46								IRQ14-DS	AN006
B5		P91	D17/A17			SCK7	ET1_COL		1	1	AN115
B6	VCC								1	1	
B7		P94	D20/A20				ET1_ERXD 0/ RMII1_RX D0				
B8	TRDATA4	P95	D21/A21				ET1_ERXD 1/ RMII1_RX D1				

Table 1.5 List of Pin and Pin Functions (224-Pin LFBGA) (2/11)

Pin Number	Power			Timer	_	Communica	tion	Memory I/F Camera I/F		ı	
224-Pin LFBGA	Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	(MTU, TPU, TMR, PPG, RTC, CMTW, POE, CAC)	(GPTW, POEG)	(SCI, RSPI, RIIC, CAN, USB, SSIE)	(ETHERC, PMGI)	(QSPI, SDHI, MMCIF, PDC)	LCD_DAT IRQ4 LCD_DAT IRQ6 A18-B IRQ7-DS LCD_DAT A14-B IRQ7-DS LCD_DAT A12-B IRQ7 A9-B IRQ7 IRQ13	A/D D/A	
B9		PD4	D4[A4/D4]	MTIOC8B/ POE11#		SSLC0-A	ET1_MDIO / PMGI1_MD IO	QSSL-B/ SDHI_CMD-B/ MMC_CMD-B		IRQ4	AN112
B10		PD6	D6[A6/D6]	MTIC5V/ MTIOC8A/ POE4#		SSLC2-A	LK/	QMO-B/QIO0- B/SDHI_D0-B/ MMC_D0-B		IRQ6	AN106
B11	VCC										
B12		P63	CAS#/ D2[A2/D2]/ CS3#				ET1_ETXD 1/ RMII1_TXD 1				
B13		PE2	D10[A10/ D10]/D2[A2/ D2]	MTIOC4A/ PO23/TIC3	GTIOC0B	RXD12/ SMISO12/ SSCL12/ RXDX12/ SSLB3-B		MMC_D6-B		IRQ7-DS	AN100
B14		PE4	D12[A12/ D12]/D4[A4/ D4]	MTIOC4D/ MTIOC1A/ PO28	GTIOC1A	SSLB0-B	ET0_ERXD 2				AN102
B15		PE7	D15[A15/ D15]/D7[A7/ D7]	MTIOC6A/ TOC1	GTIOC3A	MISOB-B		SDHI_WP/ MMC_RES#-B		IRQ7	AN105
C1	AVSS1										
C2	AVCC1										
C3		P05				SSILRCK1				IRQ13	DA1
C4		P44								IRQ12-DS	AN004
C5	VSS										
C6		P90	D16/A16			TXD7/ SMOSI7/ SSDA7	ET1_RX_D V				AN114
C7		PD1	D1[A1/D1]	MTIOC4B/ POE0#	GTIOC1A	MOSIC-A/ CTX0			LCD_DAT A23-B	IRQ1	AN109
C8	VCC										
C9	TRSYNC1		D23/A23				ET1_ERXD 3				
C10		P60	CS0#				ET1_TX_E N/ RMII1_TXD _EN				
C11		P64	WE#/D3[A3/ D3]/CS4#				ET1_ETXD 0/ RMII1_TXD 0				
C12	VSS										
C13		PE5	D13[A13/ D13]/D5[A5/ D5]	MTIOC4C/ MTIOC2B	GTIOC0A	RSPCKB-B	ET0_RX_C LK/ REF50CK0		LCD_DAT A11-B	IRQ5	AN103
C14		P65	CKE/CS5#								
C15		P66	DQM0/ CS6#	MTIOC7D	GTIOC2B	CTX2					
D1		P45								IRQ13-DS	
D2		P47								IRQ15-DS	
D3		P03				SSIDATA1				IRQ11	DA0
D4		P40								IRQ8-DS	AN000
D5		P01		TMCI0		RXD6/ SMISO6/ SSCL6/ SSIBCK0		QIO3-C		IRQ9	AN119

Table 1.5 List of Pin and Pin Functions (224-Pin LFBGA) (3/11)

Pin Number	Power			Timer		Communicat	ion	Memory I/F Camera I/F			
224-Pin LFBGA	Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	(MTU, TPU, TMR, PPG, RTC, CMTW, POE, CAC)	(GPTW, POEG)	(SCI, RSPI, RIIC, CAN, USB, SSIE)	(ETHERC, PMGI)	(QSPI, SDHI, MMCIF, PDC)	GLCDC	Interrupt	A/D D/A
D6		P02		TMCI1		SCK6/ SSIBCK1				IRQ10	AN120
D7		P93	D19/A19	POE0#		CTS7#/ RTS7#/SS7#	ET1_LINK STA				AN117
D8	VSS										
D9		PD5	D5[A5/D5]	MTIC5W/ MTIOC8C/ MTCLKA/ POE10#		SSLC1-A	ET1_MDC/ PMGI1_MD C	QSPCLK-B/ SDHI_CLK-B/ MMC_CLK-B	LCD_DAT A19-B	IRQ5	AN113
D10	TRDATA7	PG1	D25				ET1_RX_E R/ RMII1_RX_ ER				
D11		PE0	D8[A8/D8]/ D0[A0/D0]	MTIOC3D	GTIOC2B	SCK12/ SSLB1-B		MMC_D4-B	LCD_DAT A16-B		ANEX0
D12		PE3	D11[A11/ D11]/D3[A3/ D3]	MTIOC4B/ PO26/TOC3/ POE8#	GTIOC2A	CTS12#/ RTS12#/ SS12#	ET0_ERXD 3	MMC_D7-B	LCD_DAT A13-B		AN101
D13	VSS		1								
D14	TRDATA0	PG2	D26				ET1_TX_C LK				
D15		P67	DQM1/ CS7#	MTIOC7C	GTIOC1B	CRX2	EPLSOUT1			IRQ15	
E1	VCL										
E2	VSS										
E3		P00		TMRI0		TXD6/ SMOSI6/ SSDA6/ AUDIO_CLK		QIO2-C		IRQ8	AN118
E4		P43								IRQ11-DS	AN003
E5		P07								IRQ15	ADTRG0#
E6		PN0					ET1_ETXD 2				
E7		PQ0				SCK11	ET1_CRS/ RMII1_CR S_DV				
E8		PQ1				SMISO11/ SSCL11/ RXD11	ET1_COL				
E9		PQ3				RTS11#/ CTS11#/ SS11#	ET1_TX_E R				
E10		PQ5					ET1_ETXD 0/ RMII1_TXD 0				
E11		PQ4					ET1_RX_C LK/ REF50CK1				
E12	VCC										
E13		PE6	D14[A14/ D14]/D6[A6/ D6]	MTIOC6C/ TIC1	GTIOC3B	MOSIB-B		SDHI_CD/ MMC_CD-B	LCD_DAT A10-B	IRQ6	AN104
E14	TRCLK	PG5	D29				ET1_ETXD 2				
E15	TRSYNC	PG4	D28				ET1_ETXD 1/ RMII1_TXD 1				
F1	XCIN		+								
-	1	<u> </u>							<u> </u>	<u> </u>	<u> </u>

Table 1.5 List of Pin and Pin Functions (224-Pin LFBGA) (4/11)

Pin Number	Power			Timer		Communica	tion	Memory I/F Camera I/F			
224-Pin LFBGA	Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	(MTU, TPU, TMR, PPG, RTC, CMTW, POE, CAC)	(GPTW, POEG)	(SCI, RSPI, RIIC, CAN, USB, SSIE)	(ETHERC, PMGI)	(QSPI, SDHI, MMCIF, PDC)	GLCDC	Interrupt	A/D D/A
F2	VBATT										
F3	TRST#	PF4									
F4		PK4			GTADSM0	SSLB1	ET0_ERXD 2				
F5		PK5			GTADSM1	SSLB2	ET0_ERXD				
F6	EMLE										
F7		PK6			GTIOC1A	SSLB3					
F8		PN1					ET1_ETXD				
F9		PQ6					ET1_ETXD 1/ RMII1_TXD 1				
F10	VSS										
F11		PM1		тосз	GTETRGB	SMISO10/ SSCL10/ RXD10	ET1_ERXD 1/ RMII1_RX D1	SDHI_CMD-D/ QSSL-A			
F12		PA0	DQM2/ BC0#/A0	MTIOC4A/ MTIOC6D/ TIOCA0/PO16/ CACREF	GTIOC0B	SSLA1-B	ET0_TX_E N/ RMII0_TXD _EN		LCD_DAT A8-B		
F13	TRDATA1	PG3	D27				ET1_ETXD 0/ RMII1_TXD 0				
F14	TRDATA2	PG6	D30				ET1_ETXD 3				
F15	TRDATA3	PG7	D31				ET1_TX_E R				
G1	XCOUT										
G2	VSS										
G3	VCC										
G4	MD/FINED										
G5		PJ5		POE8#		CTS2#/ RTS2#/ SS2#/ SSIRXD0	EPLSOUT0	QMI-C/QIO1-C			
G6		PF5	WAIT#			SSILRCK0				IRQ4	
G7	RES#										
G8		PQ2				SMOSI11/ SSDA11/ TXD11	ET1_RX_D V				
G 9		PN2					ET1_TX_C LK				
G10	VCC										
G11		PM0		TIC3	GTETRGA	SCK10	ET1_ERXD 0/ RMII1_RX D0	SDHI_CLK-D/ QSPCLK-A			
G12		PA1	DQM3/A1	MTIOC0B/ MTCLKC/ MTIOC7B/ TIOCB0/PO17	GTIOC2A	SCK5/ SSLA2-B	ET0_WOL		LCD_DAT A7-B	IRQ11	
G13		PA2	A2	MTIOC7A/ PO18	GTIOC1A	RXD5/ SMISO5/ SSCL5/ SSLA3-B			LCD_DAT A6-B		

Table 1.5 List of Pin and Pin Functions (224-Pin LFBGA) (5/11)

Pin Number				Timer		Communicat	ion	Memory I/F Camera I/F			
224-Pin LFBGA	Power Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	(MTU, TPU, TMR, PPG, RTC, CMTW, POE, CAC)	(GPTW, POEG)	(SCI, RSPI, RIIC, CAN, USB, SSIE)	(ETHERC, PMGI)	(QSPI, SDHI, MMCIF, PDC)	GLCDC	Interrupt	A/D D/A
G14		PA3	A3	MTIOCOD/ MTCLKD/ TIOCDO/ TCLKB/PO19		RXD5/ SMISO5/ SSCL5	ET0_MDIO / PMGI0_MD IO		LCD_DAT A5-B	IRQ6-DS	
G15		PA4	A4	MTIC5U/ MTCLKA/ TIOCA1/ TMRI0/PO20		TXD5/ SMOSI5/ SSDA5/ SSLA0-B	ET0_MDC/ PMGI0_MD C		LCD_DAT A4-B	IRQ5-DS	
H1	XTAL	P37									
H2		P34		MTIOC0A/ TMCI3/PO12/ POE10#		SCK6/SCK0	ET0_LINK STA			IRQ4	
НЗ	UPSEL	P35								NMI	
H4		P33	EDREQ1	MTIOCOD/ TIOCDO/ TMR13/PO11/ POE4#/ POE11#		RXD6/ SMISO6/ SSCL6/ RXD0/ SMISO0/ SSCL0/ CRX0		РСКО		IRQ3-DS	
H5		P32		MTIOCOC/ TIOCCO/ TMO3/PO10/ RTCIC2/ RTCOUT/ POE0#/ POE10#		TXD6/ SMOSI6/ SSDA6/ TXD0/ SMOSI0/ SSDA0/ CTX0/ USB0_VBUS EN		VSYNC		IRQ2-DS	
H6	BSCANP										
H7		PJ3	EDACK1	МТІОСЗС		CTS6#/ RTS6#/ SS6#/ CTS0#/ RTS0#/ SS0#/ SSITXD0	ET0_EXOU T	QMO-C/QIO0- C			
H8		PQ7					ET1_TX_E N/ RMII1_TXD _EN				
H9		PN3					ET1_RX_E				
							R/ RMII1_RX_ ER				
H10		P73	CS3#	PO16			ET0_WOL		LCD_EXT CLK-A		
H11		PL0		TIC2	GTETRGA	SCK9/ RSPCKC	ET0_ERXD 0/ RMII0_RX D0				
H12	VCC										
H13	VSS	1									
H14		PA6	A6	MTIC5V/ MTCLKB/ TIOCA2/ TMCI3/PO22/ POE10#	GTETRGB	CTS5#/ RTS5#/ SS5#/ MOSIA-B	ET0_EXOU T		LCD_DAT A2-B		
H15		PA5	A5	MTIOC6B/ TIOCB1/PO21	GTIOC0A	RSPCKA-B	ET0_LINK STA		LCD_DAT A3-B		
J1	EXTAL	P36									
J2	TDI	PF2				RXD1/ SMISO1/ SSCL1					

Table 1.5 List of Pin and Pin Functions (224-Pin LFBGA) (6/11)

Pin Number	Power			Timer		Communicat	ion	Memory I/F Camera I/F			
224-Pin LFBGA	Power Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	(MTU, TPU, TMR, PPG, RTC, CMTW, POE, CAC)	(GPTW, POEG)	(SCI, RSPI, RIIC, CAN, USB, SSIE)	(ETHERC, PMGI)	(QSPI, SDHI, MMCIF, PDC)	GLCDC	Interrupt	A/D D/A
J3	TMS	PF3									
J4		P31		MTIOC4D/ TMCI2/PO9/ RTCIC1		CTS1#/ RTS1#/ SS1#/ SSLB0-A	ET1_MDC/ PMGI1_MD C			IRQ1-DS	
J5		P30		MTIOC4B/ TMRI3/PO8/ RTCIC0/ POE8#		RXD1/ SMISO1/ SSCL1/ MISOB-A	ET1_MDIO / PMGI1_MD IO			IRQ0-DS	
J6		PH2			GTETRG C	SMOSI7/ SSDA7/ TXD7/MISOA					
J7		P15		MTIOC0B/ MTCLKB/ TIOCB2/ TCLKB/TMCI2/ PO13	GTETRGA	RXD1/ SMISO1/ SSCL1/ SCK3/CRX1- DS/ SSILRCK1		PIXD0		IRQ5	
J8		P53*1	BCLK								
J9		PK3			GTETRG D	RTS8#/ CTS8#/ SS8#/SSLB0	ET0_TX_E R				
J10		PL1		TOC2	GTETRGB	SMISO9/ SSCL9/ RXD9/ MOSIC	ET0_ERXD 1/ RMII0_RX D1				
J11		PN5					ET1_MDC/ PMGI1_MD C	QSSL-C			
J12		PB1	A9	MTIOCOC/ MTIOC4C/ TIOCB3/ TMCI0/PO25		TXD4/ SMOSI4/ SSDA4/ TXD6/ SMOSI6/ SSDA6	ETO_ERXD 0/ RMIIO_RX D0		LCD_TCO N3-B	IRQ4-DS	
J13		P71	A18/CS1#				ET0_MDIO / PMGI0_MD IO				
J14		PB0	A8	MTIC5W/ TIOCA3/PO24		RXD4/ SMISO4/ SSCL4/ RXD6/ SMISO6/ SSCL6	ETO_ERXD 1/ RMIIO_RX D1		LCD_DAT A0-B	IRQ12	
J15		PA7	A7	TIOCB2/PO23		MISOA-B	ET0_WOL		LCD_DAT A1-B		
K1	CLKOUT2 5M	PH7			GTIOC0B				,,,,,		
K2	CLKOUT	PH6			GTIOC0A	SSLA3					
K3		PH4			GTADSM0	SSLA1					
K4		PH5			GTADSM1	SSLA2					1
K5	TDO	PF0				TXD1/ SMOSI1/ SSDA1					
K6		PH1		TOC0	GTETRGB						
K7		P10	ALE	MTIC5W/ TMRI3						IRQ0	

Table 1.5 List of Pin and Pin Functions (224-Pin LFBGA) (7/11)

Pin Number	Power			Timer		Communicat	ion	Memory I/F Camera I/F			
224-Pin LFBGA	Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	(MTU, TPU, TMR, PPG, RTC, CMTW, POE, CAC)	(GPTW, POEG)	(SCI, RSPI, RIIC, CAN, USB, SSIE)	(ETHERC, PMGI)	(QSPI, SDHI, MMCIF, PDC)	GLCDC	Interrupt	A/D D/A
K8		P50	WR0#/WR#			TXD2/ SMOSI2/ SSDA2/ SSLB1-A					
K9		PK1		TOC1	GTETRGB	SMISO8/ SSCL8/ RXD8/ MOSIB	ET0_COL				
K10		PL3			GTETRG D	RTS9#/ CTS9#/ SS9#/SSLC0	ET0_RX_C LK/ REF50CK0				
K11		PM2			GTETRG C	SMOSI10/ SSDA10/ TXD10	ET1_ERXD 2	SDHI_D0-D/ QMO-A/QIO0- A			
K12	VSS										
K13		PB5	A13	MTIOC2A/ MTIOC1B/ TIOCB4/ TMRI1/PO29/ POE4#		SCK9/ RTS9#/ SCK11	ET0_ETXD 0/ RMII0_TXD 0		LCD_CLK-B		
K14		PB3	A11	MTIOCOA/ MTIOC4A/ TIOCD3/ TCLKD/TMO0/ PO27/POE11#		SCK4/SCK6	ETO_RX_E R/ RMIIO_RX_ ER		LCD_TCO N1-B		
K15		P72	A19/CS2#				ET0_MDC/ PMGI0_MD C		LCD_DAT A23-A		
L1		PH3			GTETRG D	RTS7#/ CTS7#/ SS7#/SSLA0					
L2		P27	CS7#	MTIOC2B/ TMCI3/PO7		SCK1/ RSPCKB-A	ET1_WOL				
L3	TCK	PF1				SCK1					
L4		P24	CS4#/ EDREQ1	MTIOC4A/ MTCLKA/ TIOCB4/ TMRI1/PO4		SCK3/ USB0_VBUS EN/SSIBCK1		SDHI_WP/ PIXCLK			
L5	VCC										
L6	CLKOUT2 5M	PJ2				TXD8/ SMOSI8/ SSDA8/ SSLC3-B			LCD_TCO N2-A		
L7	VCC										
L8		P52	RD#			RXD2/ SMISO2/ SSCL2/ SSLB3-A					
L9		P81	EDACK0	MTIOC3D/ PO27	GTIOC0B	SMISO10/ SSCL10/ RXD10	ET0_ETXD 0/ RMII0_TXD 0	QIO3-A/ SDHI_CD/ MMC_D3-A	LCD_DAT A13-A		
L10		PL7			GTIOC2B		ET0_MDIO / PMGI0_MD IO				
L11		P77	CS7#	PO23		SMOSI11/ SSDA11/ TXD11	ET0_RX_E R/	QSPCLK-A/ SDHI_CLK-A/ MMC_CLK-A	LCD_DAT A17-A		
L12		PN4					ET1_MDIO / PMGI1_MD IO	QSPCLK-C			

Table 1.5 List of Pin and Pin Functions (224-Pin LFBGA) (8/11)

Pin Number	Do:			Timer		Communicat	ion	Memory I/F Camera I/F			
224-Pin LFBGA	Power Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	(MTU, TPU, TMR, PPG, RTC, CMTW, POE, CAC)	(GPTW, POEG)	(SCI, RSPI, RIIC, CAN, USB, SSIE)	(ETHERC, PMGI)	(QSPI, SDHI, MMCIF, PDC)	GLCDC	Interrupt	A/D D/A
L13	VCC										
L14		PB2	A10	TIOCC3/ TCLKC/PO26		CTS4#/ RTS4#/ SS4#/ CTS6#/ RTS6#/SS6#	ET0_RX_C LK/ REF50CK0		LCD_TCO N2-B		
L15		PB4	A12	TIOCA4/PO28		CTS9#/ SS9#/SS11#/ CTS11#/ RTS11#	ET0_TX_E N/ RMII0_TXD _EN		LCD_TCO N0-B		
M1		P26	CS6#	MTIOC2A/ TMO1/PO6		TXD1/ SMOSI1/ SSDA1/ CTS3#/ RTS3#/ SS3#/ MOSIB-A	ET1_EXOU T				
M2		P23	EDACK0	MTIOC3D/ MTCLKD/ TIOCD3/PO3	GTIOC0A	TXD3/ SMOSI3/ SSDA3/ CTS0#/ RTS0#/ SS0#/CTX1/ SSIBCK0		SDHI_D1-C/ PIXD7			
M3	CLKOUT	P25	CS5#/ EDACK1	MTIOC4C/ MTCLKB/ TIOCA4/PO5		RXD3/ SMISO3/ SSCL3/ SSIDATA1		SDHI_CD/ HSYNC			ADTRG0#
M4	VSS										
M5		PJ0		MTIOC6B		SCK8/ SSLC1-B	EPLSOUT0		LCD_DAT A0-A		
M6		P84		MTIOC6D			ET1_LINK STA		LCD_DAT A2-A		
M7	VSS										
M8		P51	WR1#/ BC1#/ WAIT#			SCK2/ SSLB2-A					
M9		P83	EDACK1	MTIOC4C	GTIOC0A	SCK10/ SS10#/ CTS10#	ET0_CRS/ RMII0_CR S_DV		LCD_DAT A8-A		
M10		PK0		TIC1	GTETRGA	SCK8/ RSPCKB	ET0_MDC/ PMGI0_MD C				
M11		PL5			GTADSM1	SSLC2	ET0_ETXD 1/ RMII0_TXD 1				
M12		PL6			GTIOC2A	SSLC3	ET0_TX_E N/ RMII0_TXD _EN				
M13		PM7			GTIOC3B		ET0_CRS/ RMII0_CR S_DV	SDHI_WP			
M14		PC0	A16	MTIOC3C/ TCLKC/PO17		CTS5#/ RTS5#/ SS5#/ SSLA1-A	ETO_ERXD 3			IRQ14	
M15		PB6	A14	MTIOC3D/ TIOCA5/PO30		RXD9/ SMISO9/ SSCL9/ SMISO11/ SSCL11/ RXD11	ETO_ETXD 1/ RMIIO_TXD 1				

Table 1.5 List of Pin and Pin Functions (224-Pin LFBGA) (9/11)

Pin Number	Power			Timer		Communicat	ion	Memory I/F Camera I/F			
224-Pin LFBGA	Power Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	(MTU, TPU, TMR, PPG, RTC, CMTW, POE, CAC)	(GPTW, POEG)	(SCI, RSPI, RIIC, CAN, USB, SSIE)	(ETHERC, PMGI)	(QSPI, SDHI, MMCIF, PDC)	GLCDC	Interrupt	A/D D/A
N1		P22	EDREQ0	MTIOC3B/ MTCLKC/ TIOCC3/ TMO0/PO2	GTIOC1A	SCK0/ USB0_OVRC URB/ AUDIO_CLK		SDHI_D0-C/ PIXD6			
N2		PH0		TIC0	GTETRGA	SCK7/ RSPCKA					
N3		P86		MTIOC4D/ TIOCA0	GTIOC2B	SMISO10/ SSCL10/ RXD10		PIXD1			
N4		P85		MTIOC6C/ TIOCC0					LCD_DAT A1-A		
N5		P13	WR2#/BC2#	MTIOC0B/ TIOCA5/ TMO3/PO13	GTADSM1	TXD2/ SMOSI2/ SSDA2/ SDA0[FM+]			LCD_TCO N0-A	IRQ3	ADTRG1#
N6		PJ1		MTIOC6A		RXD8/ SMISO8/ SSCL8/ SSLC2-B	EPLSOUT1		LCD_TCO N3-A		
N7	CLKOUT2 5M	P56	EDACK1	MTIOC3C/ TIOCA1		SCK7/ RSPCKC-B			LCD_DAT A4-A		
N8	VCC										
N9	UB	PC7	A23/CS0#	MTIOC3A/ MTCLKB/ TMO2/PO31/ TOC0/ CACREF	GTIOC3A	TXD8/ SMOSI8/ SSDA8/ SMOSI10/ SSDA10/ TXD10/ MISOA-A	ET0_COL	MMC_D7-A	LCD_DAT A9-A	IRQ14	
N10		P80	EDREQ0	MTIOC3B/ PO26		SCK10/ RTS10#	N/	QIO2-A/ SDHI_WP/ MMC_D2-A	LCD_DAT A14-A		
N11		PK2			GTETRG C	SMOSI8/ SSDA8/ TXD8/MISOB	ET0_RX_D V				
N12		P76	CS6#	PO22		SMISO11/ SSCL11/ RXD11	ET0_RX_C LK/ REF50CK0	QSSL-A/ SDHI_CMD-A/ MMC_CMD-A	LCD_DAT A18-A		
N13		PM6			GTIOC3A		ET0_TX_C LK	SDHI_CD			
N14		PC1	A17	MTIOC3A/ TCLKD/PO18		SCK5/ SSLA2-A	ET0_ERXD 2		LCD_DAT A22-A	IRQ12	
N15		PB7	A15	MTIOC3B/ TIOCB5/PO31		TXD9/ SMOSI9/ SSDA9/ SMOSI11/ SSDA11/ TXD11	ETO_CRS/ RMIIO_CR S_DV				
P1		PK7			GTIOC1B						
P2		P17		MTIOC3A/ MTIOC3B/ MTIOC4B/ TIOCB0/ TCLKD/TMO1/ PO15/POE8#	GTIOC0B	SCK1/TXD3/ SMOSI3/ SSDA3/ SDA2-DS/ SSITXD0	EPLSOUT0	SDHI_D3-C/ PIXD3		IRQ7	ADTRG1#
P3		P20		MTIOC1A/ TIOCB3/ TMRI0/PO0		TXD0/ SMOSI0/ SSDA0/ SDA1/ USB0_ID/ SSIRXD0		SDHI_CMD-C/ PIXD4		IRQ8	

Table 1.5 List of Pin and Pin Functions (224-Pin LFBGA) (10/11)

Pin Number	Power			Timer		Communicat	ion	Memory I/F Camera I/F			
224-Pin LFBGA	Power Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	(MTU, TPU, TMR, PPG, RTC, CMTW, POE, CAC)	(GPTW, POEG)	(SCI, RSPI, RIIC, CAN, USB, SSIE)	(ETHERC, PMGI)	(QSPI, SDHI, MMCIF, PDC)	GLCDC	Interrupt	A/D D/A
P4		P14		MTIOC3A/ MTCLKA/ TIOCB5/ TCLKA/TMRI2/ PO15	GTETRG D	CTS1#/ RTS1#/ SS1#/CTX1/ USB0_OVRC URA			LCD_CLK- A	IRQ4	
P5	VCC_USB										
P6	VSS_USB										
P7		P57				RXD7/ SMISO7/ SSCL7/ SSLC0-B			LCD_DAT A3-A		
P8		P11		MTIC5V/ TMCI3		SCK2	EPLSOUT1		LCD_DAT A7-A	IRQ1	
P9	VSS			Timolo					, , , ,		
P10		P82	EDREQ1	MTIOC4A/ PO28	GTIOC2A	SMOSI10/ SSDA10/ TXD10	ET0_ETXD 1/ RMII0_TXD 1	MMC_D4-A	LCD_DAT A12-A		
P11		PC4	A20/CS3#	MTIOC3D/ MTCLKC/ TMCI1/PO25/ POE0#	GTETRG C	SCK5/ CTS8#/ SS8#/SS10#/ CTS10#/ RTS10#/ SSLA0-A	ET0_TX_C LK	QMI-A/QIO1- A/SDHI_D1-A/ MMC_D1-A	LCD_DAT A15-A		
P12		PL2			GTETRG C	SMOSI9/ SSDA9/ TXD9/ MISOC	ET0_RX_E R/ RMII0_RX_ ER				
P13		PC2	A18	MTIOC4B/ TCLKA/PO21	GTIOC2B	RXD5/ SMISO5/ SSCL5/ SSLA3-A	ET0_RX_D V	SDHI_D3-A/ MMC_CD-A	LCD_DAT A19-A		
P14		PM4			GTADSM0		ET0_ETXD 2	SDHI_D2-D/ QIO2-A			
P15		PM3			GTETRG D	RTS10#/ CTS10#/ SS10#	ET1_ERXD 3	SDHI_D1-D/ QMI-A/QIO1-A			
R1		P21		MTIOC1B/ MTIOC4A/ TIOCA3/ TMCI0/PO1	GTIOC2A	RXD0/ SMISO0/ SSCL0/ SCL1/ USB0_EXIC EN/ SSILRCK0		SDHI_CLK-C/ PIXD5		IRQ9	
R2		P87		MTIOC4C/ TIOCA2	GTIOC1B	SMOSI10/ SSDA10/ TXD10	EPLSOUT1	SDHI_D2-C/ PIXD2			
R3		P16		MTIOC3C/ MTIOC3D/ TIOCB1/ TCLKC/TMO2/ PO14/ RTCOUT		TXD1/ SMOSI1/ SSDA1/ RXD3/ SMISO3/ SSCL3/ SCL2-DS/ USB0_VBUS EN/ USB0_VBUS / USB0_OVRC				IRQ6	ADTRG0#
R4		P12	WR3#/BC3#		GTADSM0	URB RXD2/			LCD_TCO	IRQ2	
				TMCI1		SMISO2/ SSCL2/ SCL0[FM+]			N1-A		
R5						USB0_DM					
R6						USB0_DP					

Table 1.5 List of Pin and Pin Functions (224-Pin LFBGA) (11/11)

Pin Number	Power			Timer		Communicat	ion	Memory I/F Camera I/F			
224-Pin LFBGA	Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	(MTU, TPU, TMR, PPG, RTC, CMTW, POE, CAC)	(GPTW, POEG)	(SCI, RSPI, RIIC, CAN, USB, SSIE)	(ETHERC, PMGI)	(QSPI, SDHI, MMCIF, PDC)	GLCDC	Interrupt	A/D D/A
R7		P54	D1[A1/D1]/ EDACK0/ ALE	MTIOC4B/ TMCI1		CTS2#/ RTS2#/ SS2#/ MOSIC-B/ CTX1	ETO_LINK STA		LCD_DAT A6-A		
R8		P55	D0[A0/D0]/ EDREQ0/ WAIT#	MTIOC4D/ TMO3		TXD7/ SMOSI7/ SSDA7/ MISOC-B/ CRX1	ET0_EXOU T		LCD_DAT A5-A	IRQ10	
R9		PC6	D2[A2/D2]/ A22/CS1#	MTIOC3C/ MTCLKA/ TMCI2/PO30/ TIC0	GTIOC3B	RXD8/ SMISO8/ SSCL8/ SMISO10/ SSCL10/ RXD10/ MOSIA-A	ETO_ETXD 3	MMC_D6-A	LCD_DAT A10-A	IRQ13	
R10		PC5	D3[A3/D3]/ A21/CS2#/ WAIT#	MTIOC3B/ MTCLKD/ TMRI2/PO29	GTIOC1A	SCK8/ RTS8#/ SCK10/ RSPCKA-A	ET0_ETXD 2	MMC_D5-A	LCD_DAT A11-A		
R11		PC3	A19	MTIOC4D/ TCLKB/PO24	GTIOC1B	TXD5/ SMOSI5/ SSDA5	ET0_TX_E R	QMO-A/QIO0- A/SDHI_D0-A/ MMC_D0-A	LCD_DAT A16-A		
R12		PL4			GTADSM0	SSLC1	ETO_ETXD 0/ RMIIO_TXD 0				
R13		P75	CS5#	PO20		SCK11/ RTS11#	ET0_ERXD 0/ RMII0_RX D0	SDHI_D2-A/ MMC_RES#-A	LCD_DAT A20-A		
R14		P74	A20/CS4#	PO19		SS11#/ CTS11#	ET0_ERXD 1/ RMII0_RX D1		LCD_DAT A21-A		
R15	DEO is see	PM5	ith the DOLL		GTADSM1		ETO_ETXD	SDHI_D3-D/ QIO3-A		ia anabia	

Note 1. P53 is multiplexed with the BCLK pin function, so cannot be used as an I/O port pin when the external bus is enabled.

1.6.2 176-Pin LFBGA

Table 1.6 List of Pin and Pin Functions (176-Pin LFBGA) (1/9)

Pin Number	Power			Timer		Communica	tion	Memory I/F Camera I/F			
176-Pin LFBGA	Power Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	(MTU, TPU, TMR, PPG, RTC, CMTW, POE, CAC)	(GPTW, POEG)	(SCI, RSPI, RIIC, CAN, USB, SSIE)	(ETHERC, PMGI)	(QSPI, SDHI, MMCIF, PDC)	GLCDC	Interrupt	A/D D/A
A1	AVSS0										
A2	AVCC0										
A3	VREFL0										
A4		P42								IRQ10-DS	AN002
A5		P46								IRQ14-DS	AN006
A6	VCC										
A7	VSS										
A8		P94	D20/A20				ET1_ERXD 0/ RMII1_RX D0				
A9	VCC										
A10	TRSYNC1	P97	D23/A23				ET1_ERXD 3				
A11		PD6	D6[A6/D6]	MTIC5V/ MTIOC8A/ POE4#		SSLC2-A	ET1_RX_C LK/ REF50CK1	QMO-B/QIO0- B/SDHI_D0-B/ MMC_D0-B	LCD_DAT A18-B	IRQ6	AN106
A12		P60	CS0#				ET1_TX_E N/ RMII1_TXD _EN				
A13		P63	CAS#/ D2[A2/D2]/ CS3#				ET1_ETXD 1/ RMII1_TXD 1				
A14		PE1	D9[A9/D9]/ D1[A1/D1]	MTIOC4C/ MTIOC3B/ PO18	GTIOC1B	TXD12/ SMOSI12/ SSDA12/ TXDX12/ SIOX12/ SSLB2-B		MMC_D5-B	LCD_DAT A15-B		ANEX1
A15		PE2	D10[A10/ D10]/D2[A2/ D2]	MTIOC4A/ PO23/TIC3	GTIOC0B	RXD12/ SMISO12/ SSCL12/ RXDX12/ SSLB3-B		MMC_D6-B	LCD_DAT A14-B	IRQ7-DS	AN100
B1		P05				SSILRCK1				IRQ13	DA1
B2		P07								IRQ15	ADTRG0#
B3		P40								IRQ8-DS	AN000
B4		P41								IRQ9-DS	AN001
B5		P47								IRQ15-DS	AN007
B6		P91	D17/A17			SCK7	ET1_COL				AN115
B7		P92	D18/A18	POE4#		RXD7/ SMISO7/ SSCL7	ET1_CRS/ RMII1_CR S_DV				AN116
B8		PD1	D1[A1/D1]	MTIOC4B/ POE0#	GTIOC1A	MOSIC-A/ CTX0			LCD_DAT A23-B	IRQ1	AN109
B9	TRDATA5	P96	D22/A22				ET1_ERXD 2				
B10		PD4	D4[A4/D4]	MTIOC8B/ POE11#		SSLC0-A	ET1_MDIO / PMGI1_MD IO	QSSL-B/ SDHI_CMD-B/ MMC_CMD-B	LCD_DAT A20-B	IRQ4	AN112

Table 1.6 List of Pin and Pin Functions (176-Pin LFBGA) (2/9)

	Power			Timer		Communicat	ion	Memory I/F Camera I/F			
176-Pin LFBGA	Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	(MTU, TPU, TMR, PPG, RTC, CMTW, POE, CAC)	(GPTW, POEG)	(SCI, RSPI, RIIC, CAN, USB, SSIE)	(ETHERC, PMGI)	(QSPI, SDHI, MMCIF, PDC)	GLCDC	Interrupt	A/D D/A
B11	TRDATA7	PG1	D25				ET1_RX_E R/ RMII1_RX_ ER				
B12	VSS										
B13		P64	WE#/D3[A3/ D3]/CS4#				ET1_ETXD 0/ RMII1_TXD 0				
B14		PE0	D8[A8/D8]/ D0[A0/D0]	MTIOC3D	GTIOC2B	SCK12/ SSLB1-B		MMC_D4-B	LCD_DAT A16-B		ANEX0
B15		PE3	D11[A11/ D11]/D3[A3/ D3]	MTIOC4B/ PO26/TOC3/ POE8#	GTIOC2A	CTS12#/ RTS12#/ SS12#	ET0_ERXD	MMC_D7-B	LCD_DAT A13-B		AN101
C1	AVSS1										
C2	AVCC1										
C3	VREFH0										
C4		P43								IRQ11-DS	AN003
C5		P45								IRQ13-DS	AN005
C6		P90	D16/A16			TXD7/ SMOSI7/ SSDA7	ET1_RX_D V				AN114
C7		PD0	D0[A0/D0]	POE4#	GTIOC1B				LCD_EXT CLK-B	IRQ0	AN108
C8		PD2	D2[A2/D2]	MTIOC4D/ TIC2	GTIOC0B	MISOC-A/ CRX0	ET1_EXOU T	QIO2-B/ SDHI_D2-B/ MMC_D2-B	LCD_DAT A22-B	IRQ2	AN110
C9		PD3	D3[A3/D3]	MTIOC8D/ TOC2/POE8#	GTIOC0A	RSPCKC-A	ET1_WOL	QIO3-B/ SDHI_D3-B/ MMC_D3-B	LCD_DAT A21-B	IRQ3	AN111
C10	TRDATA6	PG0	D24				ET1_RX_C LK/ REF50CK1				
C11	VCC										
C12		P62	RAS#/ D1[A1/D1]/ CS2#				ET1_ERXD 0/ RMII1_RX D0				
C13		PE4	D12[A12/ D12]/D4[A4/ D4]	MTIOC4D/ MTIOC1A/ PO28	GTIOC1A	SSLB0-B	ET0_ERXD 2		LCD_DAT A12-B		AN102
C14	VSS										
C15		P70	SDCLK								
D1		P01		TMCI0		RXD6/ SMISO6/ SSCL6/ SSIBCK0				IRQ9	AN119
D2		P02		TMCI1		SCK6/ SSIBCK1				IRQ10	AN120
D3		P03				SSIDATA1				IRQ11	DA0
D4		P00		TMRI0		TXD6/ SMOSI6/ SSDA6/ AUDIO_CLK				IRQ8	AN118
D5		P44	1							IRQ12-DS	AN004
D6		P93	D19/A19	POE0#		CTS7#/ RTS7#/SS7#	ET1_LINK STA				AN117

Table 1.6 List of Pin and Pin Functions (176-Pin LFBGA) (3/9)

Pin Number	Power			Timer		Communica	tion	Memory I/F Camera I/F			
176-Pin LFBGA	Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	(MTU, TPU, TMR, PPG, RTC, CMTW, POE, CAC)	(GPTW, POEG)	(SCI, RSPI, RIIC, CAN, USB, SSIE)	(ETHERC, PMGI)	(QSPI, SDHI, MMCIF, PDC)	GLCDC	Interrupt	A/D D/A
D7	TRDATA4	P95	D21/A21				ET1_ERXD 1/ RMII1_RX D1				
D8	VSS										
D9		PD5	D5[A5/D5]	MTIC5W/ MTIOC8C/ MTCLKA/ POE10#		SSLC1-A	ET1_MDC/ PMGI1_MD C	QSPCLK-B/ SDHI_CLK-B/ MMC_CLK-B	LCD_DAT A19-B	IRQ5	AN113
D10		PD7	D7[A7/D7]	MTIC5U/ POE0#		SSLC3-A	R/	QMI-B/QIO1- B/SDHI_D1-B/ MMC_D1-B	LCD_DAT A17-B	IRQ7	AN107
D11		P61	SDCS#/ D0[A0/D0]/ CS1#				ET1_ERXD 1/ RMII1_RX D1				
D12		PE5	D13[A13/ D13]/D5[A5/ D5]	MTIOC4C/ MTIOC2B	GTIOC0A	RSPCKB-B	ET0_RX_C LK/ REF50CK0		LCD_DAT A11-B	IRQ5	AN103
D13	VCC										
D14		PE7	D15[A15/ D15]/D7[A7/ D7]	MTIOC6A/ TOC1	GTIOC3A	MISOB-B		SDHI_WP/ MMC_RES#-B	LCD_DAT A9-B	IRQ7	AN105
D15		P65	CKE/CS5#								
E1		PJ5		POE8#		CTS2#/ RTS2#/ SS2#/ SSIRXD0	EPLSOUT0				
E2	EMLE										
E3		PF5	WAIT#			SSILRCK0				IRQ4	
E4	VSS										
E12		PE6	D14[A14/ D14]/D6[A6/ D6]	MTIOC6C/ TIC1	GTIOC3B	MOSIB-B		SDHI_CD/ MMC_CD-B	LCD_DAT A10-B	IRQ6	AN104
E13	TRDATA0	PG2	D26				ET1_TX_C LK				
E14	TRDATA1	PG3	D27				ET1_ETXD 0/ RMII1_TXD 0				
E15		P67	DQM1/ CS7#	MTIOC7C	GTIOC1B	CRX2	EPLSOUT1			IRQ15	
F1	VBATT										
F2	VCL										
F3		PJ3	EDACK1	МТІОСЗС		CTS6#/ RTS6#/ SS6#/ CTS0#/ RTS0#/ SS0#/ SSITXD0	ET0_EXOU T				
F4	BSCANP										L
F12		P66	DQM0/ CS6#	MTIOC7D	GTIOC2B	CTX2					
F13	TRSYNC	PG4	D28				ET1_ETXD 1/ RMII1_TXD 1				

Table 1.6 List of Pin and Pin Functions (176-Pin LFBGA) (4/9)

Pin Number	Power			Timer		Communica	tion	Memory I/F Camera I/F			
176-Pin LFBGA	Power Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	(MTU, TPU, TMR, PPG, RTC, CMTW, POE, CAC)	(GPTW, POEG)	(SCI, RSPI, RIIC, CAN, USB, SSIE)	(ETHERC, PMGI)	(QSPI, SDHI, MMCIF, PDC)	GLCDC	Interrupt	A/D D/A
F14		PA0	DQM2/ BC0#/A0	MTIOC4A/ MTIOC6D/ TIOCA0/PO16/ CACREF	GTIOC0B	SSLA1-B	ET0_TX_E N/ RMII0_TXD _EN		LCD_DAT A8-B		
F15	VSS										
G1	XCIN										
G2	XCOUT										
G3	MD/FINED										
G4	TRST#	PF4									
G12	TRCLK	PG5	D29				ET1_ETXD 2				
G13	TRDATA2	PG6	D30				ET1_ETXD 3				
G14		PA1	DQM3/A1	MTIOC0B/ MTCLKC/ MTIOC7B/ TIOCB0/PO17	GTIOC2A	SCK5/ SSLA2-B	ET0_WOL		LCD_DAT A7-B	IRQ11	
G15	VCC										
H1	XTAL	P37									
H2	VSS										
H3	RES#										
H4	UPSEL	P35								NMI	
H12		PA4	A4	MTIC5U/ MTCLKA/ TIOCA1/ TMRI0/PO20		TXD5/ SMOSI5/ SSDA5/ SSLA0-B	ET0_MDC/ PMGI0_MD C		LCD_DAT A4-B	IRQ5-DS	
H13		PA3	A3	MTIOCOD/ MTCLKD/ TIOCDO/ TCLKB/PO19		RXD5/ SMISO5/ SSCL5	ET0_MDIO / PMGI0_MD IO		LCD_DAT A5-B	IRQ6-DS	
H14		PA2	A2	MTIOC7A/ PO18	GTIOC1A	RXD5/ SMISO5/ SSCL5/ SSLA3-B			LCD_DAT A6-B		
H15	TRDATA3	PG7	D31				ET1_TX_E R				
J1	EXTAL	P36									
J2	VCC										
J3		P34		MTIOC0A/ TMCI3/PO12/ POE10#		SCK6/SCK0	ET0_LINK STA			IRQ4	
J4	TMS	PF3									
J12		PA5	A5	MTIOC6B/ TIOCB1/PO21	GTIOC0A	RSPCKA-B	ET0_LINK STA		LCD_DAT A3-B		
J13	VSS				1						
J14		PA7	A7	TIOCB2/PO23		MISOA-B	ET0_WOL		LCD_DAT A1-B		
J15		PA6	A6	MTIC5V/ MTCLKB/ TIOCA2/ TMCI3/PO22/ POE10#	GTETRGB	CTS5#/ RTS5#/ SS5#/ MOSIA-B	ET0_EXOU T		LCD_DAT A2-B		
K1		P33	EDREQ1	MTIOCOD/ TIOCDO/ TMRI3/PO11/ POE4#/ POE11#		RXD6/ SMISO6/ SSCL6/ RXD0/ SMISO0/ SSCL0/ CRX0		PCKO		IRQ3-DS	

Table 1.6 List of Pin and Pin Functions (176-Pin LFBGA) (5/9)

Pin Number				Timer		Communicat	ion	Memory I/F Camera I/F			
176-Pin LFBGA	Power Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	(MTU, TPU, TMR, PPG, RTC, CMTW, POE, CAC)	(GPTW, POEG)	(SCI, RSPI, RIIC, CAN, USB, SSIE)	(ETHERC, PMGI)	(QSPI, SDHI, MMCIF, PDC)	GLCDC	Interrupt	A/D D/A
K2		P32		MTIOCOC/ TIOCCO/ TMO3/PO10/ RTCIC2/ RTCOUT/ POE0#/ POE10#		TXD6/ SMOSI6/ SSDA6/ TXD0/ SMOSI0/ SSDA0/ CTX0/ USB0_VBUS EN		VSYNC		IRQ2-DS	
К3	TDI	PF2				RXD1/ SMISO1/ SSCL1					
K4	TCK	PF1				SCK1					
K12		PB2	A10	TIOCC3/ TCLKC/PO26		CTS4#/ RTS4#/ SS4#/ CTS6#/ RTS6#/SS6#	ET0_RX_C LK/ REF50CK0		LCD_TCO N2-B		
K13		P71	A18/CS1#				ET0_MDIO / PMGI0_MD IO				
K14	VCC										
K15		PB0	A8	MTIC5W/ TIOCA3/PO24		RXD4/ SMISO4/ SSCL4/ RXD6/ SMISO6/ SSCL6	ET0_ERXD 1/ RMII0_RX D1		LCD_DAT A0-B	IRQ12	
L1		P31		MTIOC4D/ TMCI2/PO9/ RTCIC1		CTS1#/ RTS1#/ SS1#/ SSLB0-A	ET1_MDC/ PMGI1_MD C			IRQ1-DS	
L2		P30		MTIOC4B/ TMRI3/PO8/ RTCICO/ POE8#		RXD1/ SMISO1/ SSCL1/ MISOB-A	ET1_MDIO / PMGI1_MD IO			IRQ0-DS	
L3	TDO	PF0				TXD1/ SMOSI1/ SSDA1					
L4	CLKOUT	P25	CS5#/ EDACK1	MTIOC4C/ MTCLKB/ TIOCA4/PO5		RXD3/ SMISO3/ SSCL3/ SSIDATA1		SDHI_CD/ HSYNC			ADTRG0#
L12		PB6	A14	MTIOC3D/ TIOCA5/PO30		RXD9/ SMISO9/ SSCL9/ SMISO11/ SSCL11/ RXD11	ETO_ETXD 1/ RMIIO_TXD 1				
L13		PB3	A11	MTIOC0A/ MTIOC4A/ TIOCD3/ TCLKD/TMO0/ PO27/POE11#		SCK4/SCK6	ET0_RX_E R/ RMII0_RX_ ER		LCD_TCO N1-B		
L14		PB1	A9	MTIOCOC/ MTIOC4C/ TIOCB3/ TMCI0/PO25		TXD4/ SMOSI4/ SSDA4/ TXD6/ SMOSI6/ SSDA6	ETO_ERXD 0/ RMIIO_RX D0		LCD_TCO N3-B	IRQ4-DS	
L15		P72	A19/CS2#				ET0_MDC/ PMGI0_MD C		LCD_DAT A23-A		
M1		P27	CS7#	MTIOC2B/ TMCI3/PO7		SCK1/ RSPCKB-A	ET1_WOL				

Table 1.6 List of Pin and Pin Functions (176-Pin LFBGA) (6/9)

LFBGA	Power			Timer		Communicat	ion	Memory I/F Camera I/F			
176-Pin LFBGA	Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	(MTU, TPU, TMR, PPG, RTC, CMTW, POE, CAC)	(GPTW, POEG)	(SCI, RSPI, RIIC, CAN, USB, SSIE)	(ETHERC, PMGI)	(QSPI, SDHI, MMCIF, PDC)	GLCDC	Interrupt	A/D D/A
M2		P26	CS6#	MTIOC2A/ TMO1/PO6		TXD1/ SMOSI1/ SSDA1/ CTS3#/ RTS3#/ SS3#/ MOSIB-A	ET1_EXOU T				
M3		P24	CS4#/ EDREQ1	MTIOC4A/ MTCLKA/ TIOCB4/ TMRI1/PO4		SCK3/ USB0_VBUS EN/SSIBCK1		SDHI_WP/ PIXCLK			
M4		P86		MTIOC4D/ TIOCA0	GTIOC2B	SMISO10/ SSCL10/ RXD10		PIXD1			
M5	CLKOUT2 5M	PJ2				TXD8/ SMOSI8/ SSDA8/ SSLC3-B			LCD_TCO N2-A		
M6		PJ1		MTIOC6A		RXD8/ SMISO8/ SSCL8/ SSLC2-B	EPLSOUT1		LCD_TCO N3-A		
M7		P85		MTIOC6C/ TIOCC0					LCD_DAT A1-A		
M8		P55	D0[A0/D0]/ EDREQ0/ WAIT#	MTIOC4D/ TMO3		TXD7/ SMOSI7/ SSDA7/ MISOC-B/ CRX1	ET0_EXOU T		LCD_DAT A5-A	IRQ10	
M9		P50	WR0#/WR#			TXD2/ SMOSI2/ SSDA2/ SSLB1-A					
M10		PC5	D3[A3/D3]/ A21/CS2#/ WAIT#	MTIOC3B/ MTCLKD/ TMRI2/PO29	GTIOC1A	SCK8/ RTS8#/ SCK10/ RSPCKA-A	ET0_ETXD 2	MMC_D5-A	LCD_DAT A11-A		
M11		P81	EDACK0	MTIOC3D/ PO27	GTIOC0B	SMISO10/ SSCL10/ RXD10	ET0_ETXD 0/ RMII0_TXD 0	QIO3-A/ SDHI_CD/ MMC_D3-A	LCD_DAT A13-A		
M12		P77	CS7#	PO23		SMOSI11/ SSDA11/ TXD11	R/	QSPCLK-A/ SDHI_CLK-A/ MMC_CLK-A	LCD_DAT A17-A		
M13		PB7	A15	MTIOC3B/ TIOCB5/PO31		TXD9/ SMOSI9/ SSDA9/ SMOSI11/ SSDA11/ TXD11	ETO_CRS/ RMIIO_CR S_DV				
M14		PB5	A13	MTIOC2A/ MTIOC1B/ TIOCB4/ TMRI1/PO29/ POE4#		SCK9/ RTS9#/ SCK11	ET0_ETXD 0/ RMII0_TXD 0		LCD_CLK- B		
M15		PB4	A12	TIOCA4/PO28		CTS9#/ SS9#/SS11#/ CTS11#/ RTS11#	ET0_TX_E N/ RMII0_TXD _EN		LCD_TCO N0-B		
N1	VCC										

Table 1.6 List of Pin and Pin Functions (176-Pin LFBGA) (7/9)

Pin Number				Timer		Communicat	ion	Memory I/F Camera I/F			
176-Pin LFBGA	Power Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	(MTU, TPU, TMR, PPG, RTC, CMTW, POE, CAC)	(GPTW, POEG)	(SCI, RSPI, RIIC, CAN, USB, SSIE)	(ETHERC, PMGI)	(QSPI, SDHI, MMCIF, PDC)	GLCDC	Interrupt	A/D D/A
N2		P23	EDACK0	MTIOC3D/ MTCLKD/ TIOCD3/PO3	GTIOC0A	TXD3/ SMOSI3/ SSDA3/ CTS0#/ RTS0#/ SS0#/CTX1/ SSIBCK0		SDHI_D1-C/ PIXD7			
N3		P22	EDREQ0	MTIOC3B/ MTCLKC/ TIOCC3/ TMO0/PO2	GTIOC1A	SCK0/ USB0_OVRC URB/ AUDIO_CLK		SDHI_D0-C/ PIXD6			
N4		P15		MTIOCOB/ MTCLKB/ TIOCB2/ TCLKB/TMCI2/ PO13	GTETRGA	RXD1/ SMISO1/ SSCL1/ SCK3/CRX1- DS/ SSILRCK1		PIXD0		IRQ5	
N5		P12	WR3#/BC3#	MTIC5U/ TMCI1	GTADSM0	RXD2/ SMISO2/ SSCL2/ SCL0[FM+]			LCD_TCO N1-A	IRQ2	
N6		PJ0		MTIOC6B		SCK8/ SSLC1-B	EPLSOUT0		LCD_DAT A0-A		
N7		P84		MTIOC6D			ET1_LINK STA		LCD_DAT A2-A		
N8		P54	D1[A1/D1]/ EDACK0/ ALE	MTIOC4B/ TMCI1		CTS2#/ RTS2#/ SS2#/ MOSIC-B/ CTX1	ETO_LINK STA		LCD_DAT A6-A		
N9		P51	WR1#/ BC1#/ WAIT#			SCK2/ SSLB2-A					
N10	UB	PC7	A23/CS0#	MTIOC3A/ MTCLKB/ TMO2/PO31/ TOC0/ CACREF	GTIOC3A	TXD8/ SMOSI8/ SSDA8/ SMOSI10/ SSDA10/ TXD10/ MISOA-A	ET0_COL	MMC_D7-A	LCD_DAT A9-A	IRQ14	
N11		P82	EDREQ1	MTIOC4A/ PO28	GTIOC2A	SMOSI10/ SSDA10/ TXD10	ET0_ETXD 1/ RMII0_TXD 1	MMC_D4-A	LCD_DAT A12-A		
N12		PC3	A19	MTIOC4D/ TCLKB/PO24	GTIOC1B	TXD5/ SMOSI5/ SSDA5		QMO-A/QIO0- A/SDHI_D0-A/ MMC_D0-A	LCD_DAT A16-A		
N13		PC0	A16	MTIOC3C/ TCLKC/PO17		CTS5#/ RTS5#/ SS5#/ SSLA1-A	ET0_ERXD 3			IRQ14	
N14		P73	CS3#	PO16			ET0_WOL		LCD_EXT CLK-A		
N15	VSS								<u> </u>		
P1	VSS										
P2		P17		MTIOC3A/ MTIOC3B/ MTIOC4B/ TIOCB0/ TCLKD/TMO1/ PO15/POE8#	GTIOC0B	SCK1/TXD3/ SMOSI3/ SSDA3/ SDA2-DS/ SSITXD0	EPLSOUT0	SDHI_D3-C/ PIXD3		IRQ7	ADTRG1#
P3		P87		MTIOC4C/ TIOCA2	GTIOC1B	SMOSI10/ SSDA10/ TXD10	EPLSOUT1	SDHI_D2-C/ PIXD2			

Table 1.6 List of Pin and Pin Functions (176-Pin LFBGA) (8/9)

Pin Number	Power.			Timer		Communicat	ion	Memory I/F Camera I/F			
176-Pin LFBGA	Power Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	(MTU, TPU, TMR, PPG, RTC, CMTW, POE, CAC)	(GPTW, POEG)	(SCI, RSPI, RIIC, CAN, USB, SSIE)	(ETHERC, PMGI)	(QSPI, SDHI, MMCIF, PDC)	GLCDC	Interrupt	A/D D/A
P4		P14		MTIOC3A/ MTCLKA/ TIOCB5/ TCLKA/TMRI2/ PO15	GTETRG D	CTS1#/ RTS1#/ SS1#/CTX1/ USB0_OVRC URA			LCD_CLK- A	IRQ4	
P5	VCC_USB										
P6	VSS_USB										
P7		P57				RXD7/ SMISO7/ SSCL7/ SSLC0-B			LCD_DAT A3-A		
P8		P10	ALE	MTIC5W/ TMRI3						IRQ0	
P9		P52	RD#			RXD2/ SMISO2/ SSCL2/ SSLB3-A					
P10		P83	EDACK1	MTIOC4C	GTIOC0A	SCK10/ SS10#/ CTS10#	ET0_CRS/ RMII0_CR S_DV		LCD_DAT A8-A		
P11		PC6	D2[A2/D2]/ A22/CS1#	MTIOC3C/ MTCLKA/ TMCI2/PO30/ TIC0	GTIOC3B	RXD8/ SMISO8/ SSCL8/ SMISO10/ SSCL10/ RXD10/ MOSIA-A	ETO_ETXD 3	MMC_D6-A	LCD_DAT A10-A	IRQ13	
P12		PC4	A20/CS3#	MTIOC3D/ MTCLKC/ TMCI1/PO25/ POE0#	GTETRG C	SCK5/ CTS8#/ SS8#/SS10#/ CTS10#/ RTS10#/ SSLA0-A	ET0_TX_C LK	QMI-A/QIO1- A/SDHI_D1-A/ MMC_D1-A	LCD_DAT A15-A		
P13		PC2	A18	MTIOC4B/ TCLKA/PO21	GTIOC2B	RXD5/ SMISO5/ SSCL5/ SSLA3-A	ET0_RX_D V	SDHI_D3-A/ MMC_CD-A	LCD_DAT A19-A		
P14		P75	CS5#	PO20		SCK11/ RTS11#	ET0_ERXD 0/ RMII0_RX D0	SDHI_D2-A/ MMC_RES#-A	LCD_DAT A20-A		
P15	VCC										
R1		P21		MTIOC1B/ MTIOC4A/ TIOCA3/ TMCI0/PO1	GTIOC2A	RXD0/ SMISO0/ SSCL0/ SCL1/ USB0_EXIC EN/ SSILRCK0		SDHI_CLK-C/ PIXD5		IRQ9	
R2		P20		MTIOC1A/ TIOCB3/ TMRI0/PO0		TXD0/ SMOSI0/ SSDA0/ SDA1/ USB0_ID/ SSIRXD0		SDHI_CMD-C/ PIXD4		IRQ8	
R3		P16		MTIOC3C/ MTIOC3D/ TIOCB1/ TCLKC/TMO2/ PO14/ RTCOUT		TXD1/ SMOSI1/ SSDA1/ RXD3/ SMISO3/ SSCL3/ SCL2-DS/ USB0_VBUS EN/ USB0_VBUS / USB0_OVRC URB0_OVRC				IRQ6	ADTRG0

Table 1.6 List of Pin and Pin Functions (176-Pin LFBGA) (9/9)

Pin Number	Power			Timer		Communicat	ion	Memory I/F Camera I/F			
176-Pin LFBGA	Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	(MTU, TPU, TMR, PPG, RTC, CMTW, POE, CAC)	(GPTW, POEG)	(SCI, RSPI, RIIC, CAN, USB, SSIE)	(ETHERC, PMGI)	(QSPI, SDHI, MMCIF, PDC)	GLCDC	Interrupt	A/D D/A
R4		P13	WR2#/BC2#	MTIOC0B/ TIOCA5/ TMO3/PO13	GTADSM1	TXD2/ SMOSI2/ SSDA2/ SDA0[FM+]			LCD_TCO N0-A	IRQ3	ADTRG1#
R5						USB0_DM					
R6						USB0_DP					
R7	CLKOUT2 5M	P56	EDACK1	MTIOC3C/ TIOCA1		SCK7/ RSPCKC-B			LCD_DAT A4-A		
R8		P11		MTIC5V/ TMCI3		SCK2	EPLSOUT1		LCD_DAT A7-A	IRQ1	
R9		P53*1	BCLK								
R10	VSS										
R11	VCC										
R12		P80	EDREQ0	MTIOC3B/ PO26		SCK10/ RTS10#	ET0_TX_E N/ RMII0_TXD _EN	QIO2-A/ SDHI_WP/ MMC_D2-A	LCD_DAT A14-A		
R13		P76	CS6#	PO22		SMISO11/ SSCL11/ RXD11	ET0_RX_C LK/ REF50CK0	QSSL-A/ SDHI_CMD-A/ MMC_CMD-A	LCD_DAT A18-A		
R14		P74	A20/CS4#	PO19		SS11#/ CTS11#	ET0_ERXD 1/ RMII0_RX D1		LCD_DAT A21-A		
R15		PC1	A17	MTIOC3A/ TCLKD/PO18		SCK5/ SSLA2-A	ET0_ERXD 2	:b th	A22-A	IRQ12	

Note 1. P53 is multiplexed with the BCLK pin function, so cannot be used as an I/O port pin when the external bus is enabled.

1.6.3 176-Pin LFQFP

Table 1.7 List of Pin and Pin Functions (176-Pin LFQFP) (1/9)

Pin Number	Power			Timer		Communicat	ion	Memory I/F Camera I/F			
176-Pin LFQFP	Power Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	(MTU, TPU, TMR, PPG, RTC, CMTW, POE, CAC)	(GPTW, POEG)	(SCI, RSPI, RIIC, CAN, USB, SSIE)	(ETHERC, PMGI)	(QSPI, SDHI, MMCIF, PDC)	GLCDC	Interrupt	A/D D/A
1	AVSS0										
2		P05				SSILRCK1				IRQ13	DA1
3	AVCC1										
4		P03				SSIDATA1				IRQ11	DA0
5	AVSS1										
6		P02		TMCI1		SCK6/ SSIBCK1				IRQ10	AN120
7		P01		TMCI0		RXD6/ SMISO6/ SSCL6/ SSIBCK0				IRQ9	AN119
8		P00		TMRI0		TXD6/ SMOSI6/ SSDA6/ AUDIO_CLK				IRQ8	AN118
9		PF5	WAIT#			SSILRCK0				IRQ4	
10	EMLE										
11		PJ5		POE8#		CTS2#/ RTS2#/ SS2#/ SSIRXD0	EPLSOUT0				
12	VSS										
13		PJ3	EDACK1	МТІОСЗС		CTS6#/ RTS6#/ SS6#/ CTS0#/ RTS0#/ SS0#/ SSITXD0	ET0_EXOU T				
14	VCL										
15	VBATT										
16	NC										
17	TRST#	PF4									
18	MD/FINED										
19	XCIN										1
20	XCOUT										1
21	RES#										
22	XTAL	P37									1
23	VSS										1
24	EXTAL	P36					İ				
25	VCC										
26	UPSEL	P35								NMI	
27		P34		MTIOC0A/ TMCI3/PO12/ POE10#		SCK6/SCK0	ETO_LINK STA			IRQ4	
28		P33	EDREQ1	MTIOCOD/ TIOCDO/ TMRI3/PO11/ POE4#/ POE11#		RXD6/ SMISO6/ SSCL6/ RXD0/ SMISO0/ SSCL0/ CRX0		РСКО		IRQ3-DS	

Table 1.7 List of Pin and Pin Functions (176-Pin LFQFP) (2/9)

Pin Number	D			Timer		Communicat	ion	Memory I/F Camera I/F			
176-Pin LFQFP	Power Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	(MTU, TPU, TMR, PPG, RTC, CMTW, POE, CAC)	(GPTW, POEG)	(SCI, RSPI, RIIC, CAN, USB, SSIE)	(ETHERC, PMGI)	(QSPI, SDHI, MMCIF, PDC)	GLCDC	Interrupt	A/D D/A
29		P32		MTIOCOC/ TIOCCO/ TMO3/PO10/ RTCIC2/ RTCOUT/ POE0#/ POE10#		TXD6/ SMOSI6/ SSDA6/ TXD0/ SMOSI0/ SSDA0/ CTX0/ USB0_VBUS EN		VSYNC		IRQ2-DS	
30	TMS	PF3									
31	TDI	PF2				RXD1/ SMISO1/ SSCL1					
32		P31		MTIOC4D/ TMCI2/PO9/ RTCIC1		CTS1#/ RTS1#/ SS1#/ SSLB0-A	ET1_MDC/ PMGI1_MD C			IRQ1-DS	
33		P30		MTIOC4B/ TMRI3/PO8/ RTCIC0/ POE8#		RXD1/ SMISO1/ SSCL1/ MISOB-A	ET1_MDIO / PMGI1_MD IO			IRQ0-DS	
34	TCK	PF1				SCK1					
35	TDO	PF0				TXD1/ SMOSI1/ SSDA1					
36		P27	CS7#	MTIOC2B/ TMCI3/PO7		SCK1/ RSPCKB-A	ET1_WOL				
37		P26	CS6#	MTIOC2A/ TMO1/PO6		TXD1/ SMOSI1/ SSDA1/ CTS3#/ RTS3#/ SS3#/ MOSIB-A	ET1_EXOU T				
38	CLKOUT	P25	CS5#/ EDACK1	MTIOC4C/ MTCLKB/ TIOCA4/PO5		RXD3/ SMISO3/ SSCL3/ SSIDATA1		SDHI_CD/ HSYNC			ADTRG0#
39	VCC										
40		P24	CS4#/ EDREQ1	MTIOC4A/ MTCLKA/ TIOCB4/ TMRI1/PO4		SCK3/ USB0_VBUS EN/SSIBCK1		SDHI_WP/ PIXCLK			
41	VSS										
42		P23	EDACK0	MTIOC3D/ MTCLKD/ TIOCD3/PO3	GTIOC0A	TXD3/ SMOSI3/ SSDA3/ CTS0#/ RTS0#/ SS0#/CTX1/ SSIBCK0		SDHI_D1-C/ PIXD7			
43		P22	EDREQ0	MTIOC3B/ MTCLKC/ TIOCC3/ TMO0/PO2	GTIOC1A	SCK0/ USB0_OVRC URB/ AUDIO_CLK		SDHI_D0-C/ PIXD6			
44		P21		MTIOC1B/ MTIOC4A/ TIOCA3/ TMCI0/PO1	GTIOC2A	RXD0/ SMISO0/ SSCL0/ SCL1/ USB0_EXIC EN/ SSILRCK0		SDHI_CLK-C/ PIXD5		IRQ9	

Table 1.7 List of Pin and Pin Functions (176-Pin LFQFP) (3/9)

Pin Number	Power			Timer		Communicat	ion	Memory I/F Camera I/F			
176-Pin LFQFP	Power Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	(MTU, TPU, TMR, PPG, RTC, CMTW, POE, CAC)	(GPTW, POEG)	(SCI, RSPI, RIIC, CAN, USB, SSIE)	(ETHERC, PMGI)	(QSPI, SDHI, MMCIF, PDC)	GLCDC	Interrupt	A/D D/A
45		P20		MTIOC1A/ TIOCB3/ TMRI0/PO0		TXD0/ SMOSI0/ SSDA0/ SDA1/ USB0_ID/ SSIRXD0		SDHI_CMD-C/ PIXD4		IRQ8	
46		P17		MTIOC3A/ MTIOC3B/ MTIOC4B/ TIOCB0/ TCLKD/TMO1/ PO15/POE8#	GTIOC0B	SCK1/TXD3/ SMOSI3/ SSDA3/ SDA2-DS/ SSITXD0	EPLSOUT0	SDHI_D3-C/ PIXD3		IRQ7	ADTRG1#
47		P87		MTIOC4C/ TIOCA2	GTIOC1B	SMOSI10/ SSDA10/ TXD10	EPLSOUT1	SDHI_D2-C/ PIXD2			
48		P16		MTIOC3C/ MTIOC3D/ TIOCB1/ TCLKC/TMO2/ PO14/ RTCOUT		TXD1/ SMOSI1/ SSDA1/ RXD3/ SMISO3/ SSCL3/ SCL2-DS/ USB0_VBUS EN/ USB0_VBUS / USB0_OVRC URB				IRQ6	ADTRG0#
49		P86		MTIOC4D/ TIOCA0	GTIOC2B	SMISO10/ SSCL10/ RXD10		PIXD1			
50		P15		MTIOC0B/ MTCLKB/ TIOCB2/ TCLKB/TMCI2/ PO13	GTETRGA	RXD1/ SMISO1/ SSCL1/ SCK3/CRX1- DS/ SSILRCK1		PIXD0		IRQ5	
51		P14		MTIOC3A/ MTCLKA/ TIOCB5/ TCLKA/TMRI2/ PO15	GTETRG D	CTS1#/ RTS1#/ SS1#/CTX1/ USB0_OVRC URA			LCD_CLK- A	IRQ4	
52		P13	WR2#/BC2#	MTIOC0B/ TIOCA5/ TMO3/PO13	GTADSM1	TXD2/ SMOSI2/ SSDA2/ SDA0[FM+]			LCD_TCO N0-A	IRQ3	ADTRG1#
53		P12	WR3#/BC3#	MTIC5U/ TMCI1	GTADSM0	RXD2/ SMISO2/ SSCL2/ SCL0[FM+]			LCD_TCO N1-A	IRQ2	
54	VCC_USB										
55						USB0_DM					
56						USB0_DP					
57	VSS_USB										
58	CLKOUT2 5M	PJ2				TXD8/ SMOSI8/ SSDA8/ SSLC3-B			LCD_TCO N2-A		
59		PJ1		MTIOC6A		RXD8/ SMISO8/ SSCL8/ SSLC2-B	EPLSOUT1		LCD_TCO N3-A		
60		PJ0		MTIOC6B		SCK8/ SSLC1-B	EPLSOUT0		LCD_DAT A0-A		
61		P85		MTIOC6C/ TIOCC0					LCD_DAT A1-A		

Table 1.7 List of Pin and Pin Functions (176-Pin LFQFP) (4/9)

Pin Number	Power			Timer		Communica	tion	Memory I/F Camera I/F			
176-Pin LFQFP	Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	(MTU, TPU, TMR, PPG, RTC, CMTW, POE, CAC)	(GPTW, POEG)	(SCI, RSPI, RIIC, CAN, USB, SSIE)	(ETHERC, PMGI)	(QSPI, SDHI, MMCIF, PDC)	GLCDC	Interrupt	A/D D/A
62		P84		MTIOC6D			ET1_LINK STA		LCD_DAT A2-A		
63		P57				RXD7/ SMISO7/ SSCL7/ SSLC0-B			LCD_DAT A3-A		
64	CLKOUT2 5M	P56	EDACK1	MTIOC3C/ TIOCA1		SCK7/ RSPCKC-B			LCD_DAT A4-A		
65		P55	D0[A0/D0]/ EDREQ0/ WAIT#	MTIOC4D/ TMO3		TXD7/ SMOSI7/ SSDA7/ MISOC-B/ CRX1	ET0_EXOU T		LCD_DAT A5-A	IRQ10	
66		P54	D1[A1/D1]/ EDACK0/ ALE	MTIOC4B/ TMCI1		CTS2#/ RTS2#/ SS2#/ MOSIC-B/ CTX1	ETO_LINK STA		LCD_DAT A6-A		
67		P11		MTIC5V/ TMCI3		SCK2	EPLSOUT1		LCD_DAT A7-A	IRQ1	
68		P10	ALE	MTIC5W/ TMRI3						IRQ0	
69		P53*1	BCLK								
70		P52	RD#			RXD2/ SMISO2/ SSCL2/ SSLB3-A					
71		P51	WR1#/ BC1#/ WAIT#			SCK2/ SSLB2-A					
72		P50	WR0#/WR#			TXD2/ SMOSI2/ SSDA2/ SSLB1-A					
73	VSS										
74		P83	EDACK1	MTIOC4C	GTIOC0A	SCK10/ SS10#/ CTS10#	ET0_CRS/ RMII0_CR S_DV		LCD_DAT A8-A		
75	VCC										
76	UB	PC7	A23/CS0#	MTIOC3A/ MTCLKB/ TMO2/PO31/ TOC0/ CACREF	GTIOC3A	TXD8/ SMOSI8/ SSDA8/ SMOSI10/ SSDA10/ TXD10/ MISOA-A	ET0_COL	MMC_D7-A	LCD_DAT A9-A	IRQ14	
77		PC6	D2[A2/D2]/ A22/CS1#	MTIOC3C/ MTCLKA/ TMCI2/PO30/ TIC0	GTIOC3B	RXD8/ SMISO8/ SSCL8/ SMISO10/ SSCL10/ RXD10/ MOSIA-A	ETO_ETXD 3	MMC_D6-A	LCD_DAT A10-A	IRQ13	
78		PC5	D3[A3/D3]/ A21/CS2#/ WAIT#	MTIOC3B/ MTCLKD/ TMRI2/PO29	GTIOC1A	SCK8/ RTS8#/ SCK10/ RSPCKA-A	ET0_ETXD 2	MMC_D5-A	LCD_DAT A11-A		
79		P82	EDREQ1	MTIOC4A/ PO28	GTIOC2A	SMOSI10/ SSDA10/ TXD10	ET0_ETXD 1/ RMII0_TXD 1	MMC_D4-A	LCD_DAT A12-A		
80		P81	EDACK0	MTIOC3D/ PO27	GTIOC0B	SMISO10/ SSCL10/ RXD10	ET0_ETXD 0/ RMII0_TXD 0	QIO3-A/ SDHI_CD/ MMC_D3-A	LCD_DAT A13-A		

Table 1.7 List of Pin and Pin Functions (176-Pin LFQFP) (5/9)

Pin Number				Timer		Communicat	ion	Memory I/F Camera I/F			
176-Pin LFQFP	Power Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	(MTU, TPU, TMR, PPG, RTC, CMTW, POE, CAC)	(GPTW, POEG)	(SCI, RSPI, RIIC, CAN, USB, SSIE)	(ETHERC, PMGI)	(QSPI, SDHI, MMCIF, PDC)	GLCDC	Interrupt	A/D D/A
81		P80	EDREQ0	MTIOC3B/ PO26		SCK10/ RTS10#	ET0_TX_E N/ RMII0_TXD _EN	QIO2-A/ SDHI_WP/ MMC_D2-A	LCD_DAT A14-A		
82		PC4	A20/CS3#	MTIOC3D/ MTCLKC/ TMCI1/PO25/ POE0#	GTETRG C	SCK5/ CTS8#/ SS8#/SS10#/ CTS10#/ RTS10#/ SSLA0-A	ET0_TX_C LK	QMI-A/QIO1- A/SDHI_D1-A/ MMC_D1-A	LCD_DAT A15-A		
83		PC3	A19	MTIOC4D/ TCLKB/PO24	GTIOC1B	TXD5/ SMOSI5/ SSDA5	ET0_TX_E R	QMO-A/QIO0- A/SDHI_D0-A/ MMC_D0-A	LCD_DAT A16-A		
84		P77	CS7#	PO23		SMOSI11/ SSDA11/ TXD11	ETO_RX_E R/ RMIIO_RX_ ER	QSPCLK-A/ SDHI_CLK-A/ MMC_CLK-A	LCD_DAT A17-A		
85		P76	CS6#	PO22		SMISO11/ SSCL11/ RXD11	ET0_RX_C LK/ REF50CK0	QSSL-A/ SDHI_CMD-A/ MMC_CMD-A	LCD_DAT A18-A		
86		PC2	A18	MTIOC4B/ TCLKA/PO21	GTIOC2B	RXD5/ SMISO5/ SSCL5/ SSLA3-A	ET0_RX_D V	SDHI_D3-A/ MMC_CD-A	LCD_DAT A19-A		
87		P75	CS5#	PO20		SCK11/ RTS11#	ET0_ERXD 0/ RMII0_RX D0	SDHI_D2-A/ MMC_RES#-A	LCD_DAT A20-A		
88		P74	A20/CS4#	PO19		SS11#/ CTS11#	ET0_ERXD 1/ RMII0_RX D1		LCD_DAT A21-A		
89		PC1	A17	MTIOC3A/ TCLKD/PO18		SCK5/ SSLA2-A	ET0_ERXD 2		LCD_DAT A22-A	IRQ12	
90	VCC										
91		PC0	A16	MTIOC3C/ TCLKC/PO17		CTS5#/ RTS5#/ SS5#/ SSLA1-A	ET0_ERXD 3			IRQ14	
92	VSS										
93		P73	CS3#	PO16			ET0_WOL		LCD_EXT CLK-A		
94		PB7	A15	MTIOC3B/ TIOCB5/PO31		TXD9/ SMOSI9/ SSDA9/ SMOSI11/ SSDA11/ TXD11	ETO_CRS/ RMIIO_CR S_DV				
95		PB6	A14	MTIOC3D/ TIOCA5/PO30		RXD9/ SMISO9/ SSCL9/ SMISO11/ SSCL11/ RXD11	ETO_ETXD 1/ RMIIO_TXD 1				
96		PB5	A13	MTIOC2A/ MTIOC1B/ TIOCB4/ TMRI1/PO29/ POE4#		SCK9/ RTS9#/ SCK11	ETO_ETXD 0/ RMIIO_TXD 0		LCD_CLK-B		
97		PB4	A12	TIOCA4/PO28		CTS9#/ SS9#/SS11#/ CTS11#/ RTS11#	ETO_TX_E N/ RMIIO_TXD _EN		LCD_TCO N0-B		

Table 1.7 List of Pin and Pin Functions (176-Pin LFQFP) (6/9)

Pin Number	Power			Timer		Communicat	ion	Memory I/F Camera I/F			
176-Pin LFQFP	Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	(MTU, TPU, TMR, PPG, RTC, CMTW, POE, CAC)	(GPTW, POEG)	(SCI, RSPI, RIIC, CAN, USB, SSIE)	(ETHERC, PMGI)	(QSPI, SDHI, MMCIF, PDC)	GLCDC	Interrupt	A/D D/A
98		PB3	A11	MTIOC0A/ MTIOC4A/ TIOCD3/ TCLKD/TMO0/ PO27/POE11#		SCK4/SCK6	ET0_RX_E R/ RMII0_RX_ ER		LCD_TCO N1-B		
99		PB2	A10	TIOCC3/ TCLKC/PO26		CTS4#/ RTS4#/ SS4#/ CTS6#/ RTS6#/SS6#	ET0_RX_C LK/ REF50CK0		LCD_TCO N2-B		
100		PB1	A9	MTIOCOC/ MTIOC4C/ TIOCB3/ TMCI0/PO25		TXD4/ SMOSI4/ SSDA4/ TXD6/ SMOSI6/ SSDA6	ET0_ERXD 0/ RMII0_RX D0		LCD_TCO N3-B	IRQ4-DS	
101		P72	A19/CS2#				ET0_MDC/ PMGI0_MD C		LCD_DAT A23-A		
102		P71	A18/CS1#				ETO_MDIO / PMGIO_MD IO				
103	VCC										
104		PB0	A8	MTIC5W/ TIOCA3/PO24		RXD4/ SMISO4/ SSCL4/ RXD6/ SMISO6/ SSCL6	ET0_ERXD 1/ RMII0_RX D1		LCD_DAT A0-B	IRQ12	
105	VSS										
106		PA7	A7	TIOCB2/PO23		MISOA-B	ET0_WOL		LCD_DAT A1-B		
107		PA6	A6	MTIC5V/ MTCLKB/ TIOCA2/ TMCI3/PO22/ POE10#	GTETRGB	CTS5#/ RTS5#/ SS5#/ MOSIA-B	ET0_EXOU T		LCD_DAT A2-B		
108		PA5	A5	MTIOC6B/ TIOCB1/PO21	GTIOC0A	RSPCKA-B	ET0_LINK STA		LCD_DAT A3-B		
109		PA4	A4	MTIC5U/ MTCLKA/ TIOCA1/ TMRI0/PO20		TXD5/ SMOSI5/ SSDA5/ SSLA0-B	ET0_MDC/ PMGI0_MD C		LCD_DAT A4-B	IRQ5-DS	
110		PA3	A3	MTIOCOD/ MTCLKD/ TIOCDO/ TCLKB/PO19		RXD5/ SMISO5/ SSCL5	ET0_MDIO / PMGI0_MD IO		LCD_DAT A5-B	IRQ6-DS	
111	TRDATA3	PG7	D31				ET1_TX_E R				
112		PA2	A2	MTIOC7A/ PO18	GTIOC1A	RXD5/ SMISO5/ SSCL5/ SSLA3-B			LCD_DAT A6-B		
113	TRDATA2	PG6	D30				ET1_ETXD				
114		PA1	DQM3/A1	MTIOC0B/ MTCLKC/ MTIOC7B/ TIOCB0/PO17	GTIOC2A	SCK5/ SSLA2-B	ET0_WOL		LCD_DAT A7-B	IRQ11	
115	VCC										
116	TRCLK	PG5	D29				ET1_ETXD 2				
117	VSS										

Table 1.7 List of Pin and Pin Functions (176-Pin LFQFP) (7/9)

Pin Number				Timer		Communica	tion	Memory I/F Camera I/F			
176-Pin LFQFP	Power Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	(MTU, TPU, TMR, PPG, RTC, CMTW, POE, CAC)	(GPTW, POEG)	(SCI, RSPI, RIIC, CAN, USB, SSIE)	(ETHERC, PMGI)	(QSPI, SDHI, MMCIF, PDC)	GLCDC	Interrupt	A/D D/A
118		PA0	DQM2/ BC0#/A0	MTIOC4A/ MTIOC6D/ TIOCA0/PO16/ CACREF	GTIOC0B	SSLA1-B	ET0_TX_E N/ RMII0_TXD _EN		LCD_DAT A8-B		
119	TRSYNC	PG4	D28				ET1_ETXD 1/ RMII1_TXD 1				
120		P67	DQM1/ CS7#	MTIOC7C	GTIOC1B	CRX2	EPLSOUT1			IRQ15	
121	TRDATA1	PG3	D27				ET1_ETXD 0/ RMII1_TXD 0				
122		P66	DQM0/ CS6#	MTIOC7D	GTIOC2B	CTX2					
123	TRDATA0	PG2	D26				ET1_TX_C LK				
124		P65	CKE/CS5#								
125		PE7	D15[A15/ D15]/D7[A7/ D7]	MTIOC6A/ TOC1	GTIOC3A	MISOB-B		SDHI_WP/ MMC_RES#-B	LCD_DAT A9-B	IRQ7	AN105
126		PE6	D14[A14/ D14]/D6[A6/ D6]	MTIOC6C/ TIC1	GTIOC3B	MOSIB-B		SDHI_CD/ MMC_CD-B	LCD_DAT A10-B	IRQ6	AN104
127	VCC										
128		P70	SDCLK								
129	VSS										
130		PE5	D13[A13/ D13]/D5[A5/ D5]	MTIOC4C/ MTIOC2B	GTIOC0A	RSPCKB-B	ET0_RX_C LK/ REF50CK0		LCD_DAT A11-B	IRQ5	AN103
131		PE4	D12[A12/ D12]/D4[A4/ D4]	MTIOC4D/ MTIOC1A/ PO28	GTIOC1A	SSLB0-B	ET0_ERXD 2		LCD_DAT A12-B		AN102
132		PE3	D11[A11/ D11]/D3[A3/ D3]	MTIOC4B/ PO26/TOC3/ POE8#	GTIOC2A	CTS12#/ RTS12#/ SS12#	ET0_ERXD	MMC_D7-B	LCD_DAT A13-B		AN101
133		PE2	D10[A10/ D10]/D2[A2/ D2]	MTIOC4A/ PO23/TIC3	GTIOC0B	RXD12/ SMISO12/ SSCL12/ RXDX12/ SSLB3-B		MMC_D6-B	LCD_DAT A14-B	IRQ7-DS	AN100
134		PE1	D9[A9/D9]/ D1[A1/D1]	MTIOC4C/ MTIOC3B/ PO18	GTIOC1B	TXD12/ SMOSI12/ SSDA12/ TXDX12/ SIOX12/ SSLB2-B		MMC_D5-B	LCD_DAT A15-B		ANEX1
135		PE0	D8[A8/D8]/ D0[A0/D0]	MTIOC3D	GTIOC2B	SCK12/ SSLB1-B		MMC_D4-B	LCD_DAT A16-B		ANEX0
136		P64	WE#/D3[A3/ D3]/CS4#				ET1_ETXD 0/ RMII1_TXD 0				
137		P63	CAS#/ D2[A2/D2]/ CS3#				ET1_ETXD 1/ RMII1_TXD 1				
138		P62	RAS#/ D1[A1/D1]/ CS2#				ET1_ERXD 0/ RMII1_RX D0				

Table 1.7 List of Pin and Pin Functions (176-Pin LFQFP) (8/9)

Pin Number	Power			Timer		Communicat	ion	Memory I/F Camera I/F			
176-Pin LFQFP	Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	(MTU, TPU, TMR, PPG, RTC, CMTW, POE, CAC)	(GPTW, POEG)	(SCI, RSPI, RIIC, CAN, USB, SSIE)	(ETHERC, PMGI)	(QSPI, SDHI, MMCIF, PDC)	GLCDC	Interrupt	A/D D/A
139		P61	SDCS#/ D0[A0/D0]/ CS1#				ET1_ERXD 1/ RMII1_RX D1				
140	VSS										
141		P60	CS0#				ET1_TX_E N/ RMII1_TXD _EN				
142	VCC										
143		PD7	D7[A7/D7]	MTIC5U/ POE0#		SSLC3-A	ET1_RX_E R/ RMII1_RX_ ER	QMI-B/QIO1- B/SDHI_D1-B/ MMC_D1-B	LCD_DAT A17-B	IRQ7	AN107
144	TRDATA7	PG1	D25				ET1_RX_E R/ RMII1_RX_ ER				
145		PD6	D6[A6/D6]	MTIC5V/ MTIOC8A/ POE4#		SSLC2-A	ET1_RX_C LK/ REF50CK1	QMO-B/QIO0- B/SDHI_D0-B/ MMC_D0-B	LCD_DAT A18-B	IRQ6	AN106
146	TRDATA6	PG0	D24				ET1_RX_C LK/ REF50CK1				
147		PD5	D5[A5/D5]	MTIC5W/ MTIOC8C/ MTCLKA/ POE10#		SSLC1-A	ET1_MDC/ PMGI1_MD C	QSPCLK-B/ SDHI_CLK-B/ MMC_CLK-B	LCD_DAT A19-B	IRQ5	AN113
148		PD4	D4[A4/D4]	MTIOC8B/ POE11#		SSLC0-A	ET1_MDIO / PMGI1_MD IO	QSSL-B/ SDHI_CMD-B/ MMC_CMD-B	LCD_DAT A20-B	IRQ4	AN112
149	TRSYNC1	P97	D23/A23				ET1_ERXD 3				
150		PD3	D3[A3/D3]	MTIOC8D/ TOC2/POE8#	GTIOC0A	RSPCKC-A	ET1_WOL	QIO3-B/ SDHI_D3-B/ MMC_D3-B	LCD_DAT A21-B	IRQ3	AN111
151	VSS										
152		P96	D22/A22				ET1_ERXD 2				
153 154	VCC	PD2	D2[A2/D2]	MTIOC4D/ TIC2	GTIOC0B	MISOC-A/ CRX0	ET1_EXOU T	QIO2-B/ SDHI_D2-B/ MMC_D2-B	LCD_DAT A22-B	IRQ2	AN110
155	TRDATA4	P95	D21/A21				ET1_ERXD 1/ RMII1_RX D1				
156		PD1	D1[A1/D1]	MTIOC4B/ POE0#	GTIOC1A	MOSIC-A/ CTX0			LCD_DAT A23-B	IRQ1	AN109
157		P94	D20/A20				ET1_ERXD 0/ RMII1_RX D0				
158		PD0	D0[A0/D0]	POE4#	GTIOC1B				LCD_EXT CLK-B	IRQ0	AN108
159		P93	D19/A19	POE0#		CTS7#/ RTS7#/SS7#	ET1_LINK STA				AN117
160		P92	D18/A18	POE4#		RXD7/ SMISO7/ SSCL7	ET1_CRS/ RMII1_CR S_DV				AN116
161		P91	D17/A17			SCK7	ET1_COL				AN115

Table 1.7 List of Pin and Pin Functions (176-Pin LFQFP) (9/9)

Pin Number	Power			Timer		Communica	tion	Memory I/F Camera I/F			
176-Pin LFQFP	Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	(MTU, TPU, TMR, PPG, RTC, CMTW, POE, CAC)	(GPTW, POEG)	(SCI, RSPI, RIIC, CAN, USB, SSIE)	(ETHERC, PMGI)	(QSPI, SDHI, MMCIF, PDC)	GLCDC	Interrupt	A/D D/A
162	VSS										
163		P90	D16/A16			TXD7/ SMOSI7/ SSDA7	ET1_RX_D V				AN114
164	VCC										
165		P47								IRQ15-DS	AN007
166		P46								IRQ14-DS	AN006
167		P45								IRQ13-DS	AN005
168		P44								IRQ12-DS	AN004
169		P43								IRQ11-DS	AN003
170		P42								IRQ10-DS	AN002
171		P41								IRQ9-DS	AN001
172	VREFL0										
173		P40								IRQ8-DS	AN000
174	VREFH0										
175	AVCC0										
176		P07								IRQ15	ADTRG0#

Note 1. P53 is multiplexed with the BCLK pin function, so cannot be used as an I/O port pin when the external bus is enabled.

1.6.4 145-Pin TFLGA

Table 1.8 List of Pin and Pin Functions (145-Pin TFLGA) (1/7)

Pin Number	Bower			Timer		Communica	tion	Memory I/F Camera I/F			
145-Pin TFLGA	Power Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	(MTU, TPU, TMR, PPG, RTC, CMTW, POE, CAC)	(GPTW, POEG)	(SCI, RSPI, RIIC, CAN, USB, SSIE)	(ETHERC, PMGI)	(QSPI, SDHI, MMCIF, PDC)	GLCDC	Interrupt	A/D D/A
A1	AVSS0										
A2		P07								IRQ15	ADTRG0#
А3		P40								IRQ8-DS	AN000
A4		P42								IRQ10-DS	AN002
A5		P45								IRQ13-DS	AN005
A6		P90	A16			TXD7/ SMOSI7/ SSDA7					AN114
A7		P92	A18	POE4#		RXD7/ SMISO7/ SSCL7	RMII1_CR S_DV				AN116
A8		PD2	D2[A2/D2]	MTIOC4D/ TIC2	GTIOC0B	MISOC-A/ CRX0	ET1_EXOU T	QIO2-B/ SDHI_D2-B/ MMC_D2-B	LCD_DAT A22-B	IRQ2	AN110
A9		PD6	D6[A6/D6]	MTIC5V/ MTIOC8A/ POE4#		SSLC2-A	REF50CK1	QMO-B/QIO0- B/SDHI_D0-B/ MMC_D0-B	LCD_DAT A18-B	IRQ6	AN106
A10	VSS										
A11		P62	RAS#/ D1[A1/D1]/ CS2#				RMII1_RX D0				
A12		PE1	D9[A9/D9]/ D1[A1/D1]	MTIOC4C/ MTIOC3B/ PO18	GTIOC1B	TXD12/ SMOSI12/ SSDA12/ TXDX12/ SIOX12/ SSLB2-B		MMC_D5-B	LCD_DAT A15-B		ANEX1
A13		PE3	D11[A11/ D11]/D3[A3/ D3]	MTIOC4B/ PO26/TOC3/ POE8#	GTIOC2A	CTS12#/ RTS12#/ SS12#	ET0_ERXD	MMC_D7-B	LCD_DAT A13-B		AN101
B1	AVCC1										
B2	AVCC0										
B3		P05				SSILRCK1				IRQ13	DA1
B4	VREFL0										
B5		P43								IRQ11-DS	AN003
B6		P47								IRQ15-DS	AN007
B7		P91	A17			SCK7					AN115
B8		PD0	D0[A0/D0]	POE4#	GTIOC1B				CLK-B	IRQ0	AN108
B9		PD4	D4[A4/D4]	MTIOC8B/ POE11#		SSLC0-A	ET1_MDIO / PMGI1_MD IO	QSSL-B/ SDHI_CMD-B/ MMC_CMD-B	LCD_DAT A20-B	IRQ4	AN112
B10	VCC										
B11		P61	SDCS#/ D0[A0/D0]/ CS1#				RMII1_RX D1				
B12		PE2	D10[A10/ D10]/D2[A2/ D2]	MTIOC4A/ PO23/TIC3	GTIOC0B	RXD12/ SMISO12/ SSCL12/ RXDX12/ SSLB3-B		MMC_D6-B	LCD_DAT A14-B	IRQ7-DS	AN100
B13		PE4	D12[A12/ D12]/D4[A4/ D4]	MTIOC4D/ MTIOC1A/ PO28	GTIOC1A	SSLB0-B	ET0_ERXD		LCD_DAT A12-B		AN102
C1	AVSS1						1				

Table 1.8 List of Pin and Pin Functions (145-Pin TFLGA) (2/7)

Pin Number	Power			Timer		Communicat	ion	Memory I/F Camera I/F			
145-Pin TFLGA	Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	(MTU, TPU, TMR, PPG, RTC, CMTW, POE, CAC)	(GPTW, POEG)	(SCI, RSPI, RIIC, CAN, USB, SSIE)	(ETHERC, PMGI)	(QSPI, SDHI, MMCIF, PDC)	GLCDC	Interrupt	A/D D/A
C2		P02		TMCI1		SCK6/				IRQ10	AN120
C3	VREFH0					SSIBCK1					
C4	VIXEITIO	P41								IRQ9-DS	AN001
C5		P46								IRQ14-DS	AN006
C6	VSS										
C7		PD1	D1[A1/D1]	MTIOC4B/ POE0#	GTIOC1A	MOSIC-A/ CTX0			LCD_DAT A23-B	IRQ1	AN109
C8		PD3	D3[A3/D3]	MTIOC8D/ TOC2/POE8#	GTIOC0A	RSPCKC-A	ET1_WOL	QIO3-B/ SDHI_D3-B/ MMC_D3-B	LCD_DAT A21-B	IRQ3	AN111
C9		PD7	D7[A7/D7]	MTIC5U/ POE0#		SSLC3-A	RMII1_RX_ ER	QMI-B/QIO1- B/SDHI_D1-B/ MMC_D1-B	LCD_DAT A17-B	IRQ7	AN107
C10		P63	CAS#/ D2[A2/D2]/ CS3#				RMII1_TXD 1				
C11		PE0	D8[A8/D8]/ D0[A0/D0]	MTIOC3D	GTIOC2B	SCK12/ SSLB1-B		MMC_D4-B	LCD_DAT A16-B		ANEX
C12		P70	SDCLK								
C13	VSS										
D1		P00		TMRI0		TXD6/ SMOSI6/ SSDA6/ AUDIO_CLK				IRQ8	AN118
D2		PF5	WAIT#			SSILRCK0				IRQ4	
D3		P03				SSIDATA1				IRQ11	DA0
D4		P01		TMCI0		RXD6/ SMISO6/ SSCL6/ SSIBCK0				IRQ9	AN119
D5	VCC										
D6		P93	A19	POE0#		CTS7#/ RTS7#/SS7#	ET1_LINK STA				AN117
D7		PD5	D5[A5/D5]	MTIC5W/ MTIOC8C/ MTCLKA/ POE10#		SSLC1-A	ET1_MDC/ PMGI1_MD C	QSPCLK-B/ SDHI_CLK-B/ MMC_CLK-B	LCD_DAT A19-B	IRQ5	AN113
D8		P60	CS0#				RMII1_TXD _EN				
D9		P64	WE#/ D3[A3/D3]/ CS4#				RMII1_TXD 0				
D10		PE7	D15[A15/ D15]/D7[A7/ D7]	MTIOC6A/ TOC1	GTIOC3A	MISOB-B		SDHI_WP/ MMC_RES#-B	LCD_DAT A9-B	IRQ7	AN105
D11	VCC										
D12		PE5	D13[A13/ D13]/D5[A5/ D5]	MTIOC4C/ MTIOC2B	GTIOC0A	RSPCKB-B	ET0_RX_C LK/ REF50CK0		LCD_DAT A11-B	IRQ5	AN103
D13		PE6	D14[A14/ D14]/D6[A6/ D6]	MTIOC6C/ TIC1	GTIOC3B	MOSIB-B		SDHI_CD/ MMC_CD-B	LCD_DAT A10-B	IRQ6	AN104
E1	VSS	1	= =1								
E2	VCL										
E3		PJ5		POE8#		CTS2#/ RTS2#/ SS2#/ SSIRXD0	EPLSOUT0				
E4	EMLE										

Table 1.8 List of Pin and Pin Functions (145-Pin TFLGA) (3/7)

Pin Number				Timer		Communica	tion	Memory I/F Camera I/F			
145-Pin TFLGA	Power Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	(MTU, TPU, TMR, PPG, RTC, CMTW, POE, CAC)	(GPTW, POEG)	(SCI, RSPI, RIIC, CAN, USB, SSIE)	(ETHERC, PMGI)	(QSPI, SDHI, MMCIF, PDC)	GLCDC	Interrupt	A/D D/A
E5		P44								IRQ12-DS	AN004
E10		PA0	BC0#/A0	MTIOC4A/ MTIOC6D/ TIOCA0/PO16/ CACREF	GTIOC0B	SSLA1-B	ET0_TX_E N/ RMII0_TXD _EN		LCD_DAT A8-B		
E11		P66	DQM0/ CS6#	MTIOC7D	GTIOC2B	CTX2					
E12		P65	CKE/CS5#								
E13		P67	DQM1/ CS7#	MTIOC7C	GTIOC1B	CRX2	EPLSOUT1			IRQ15	
F1	XCIN										
F2	XCOUT										
F3		PJ3	EDACK1	мтіосзс		CTS6#/ RTS6#/ SS6#/ CTS0#/ RTS0#/ SS0#/ SSITXD0	ET0_EXOU T				
F4	VBATT										
F10		PA3	A3	MTIOCOD/ MTCLKD/ TIOCDO/ TCLKB/PO19		RXD5/ SMISO5/ SSCL5	ET0_MDIO / PMGI0_MD IO		LCD_DAT A5-B	IRQ6-DS	
F11	VSS										
F12		PA1	A1	MTIOC0B/ MTCLKC/ MTIOC7B/ TIOCB0/PO17	GTIOC2A	SCK5/ SSLA2-B	ET0_WOL		LCD_DAT A7-B	IRQ11	
F13		PA2	A2	MTIOC7A/ PO18	GTIOC1A	RXD5/ SMISO5/ SSCL5/ SSLA3-B			LCD_DAT A6-B		
G1	XTAL	P37									
G2	RES#										
G3	MD/FINED										
G4	BSCANP										
G10		PA5	A5	MTIOC6B/ TIOCB1/PO21	GTIOC0A	RSPCKA-B	ET0_LINK STA		LCD_DAT A3-B		
G11		PA6	A6	MTIC5V/ MTCLKB/ TIOCA2/ TMCI3/PO22/ POE10#	GTETRGB	CTS5#/ RTS5#/ SS5#/ MOSIA-B	ET0_EXOU T		LCD_DAT A2-B		
G12	VCC										
G13		PA4	A4	MTIC5U/ MTCLKA/ TIOCA1/ TMRI0/PO20		TXD5/ SMOSI5/ SSDA5/ SSLA0-B	ET0_MDC/ PMGI0_MD C		LCD_DAT A4-B	IRQ5-DS	
H1	EXTAL	P36									
H2	VCC										
НЗ	VSS										
H4	UPSEL	P35								NMI	
H10		P72	A19/CS2#				ET0_MDC/ PMGI0_MD C				
H11		P71	A18/CS1#				ET0_MDIO / PMGI0_MD IO				

Table 1.8 List of Pin and Pin Functions (145-Pin TFLGA) (4/7)

Pin Number	Bower			Timer		Communicat	ion	Memory I/F Camera I/F			
145-Pin TFLGA	Power Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	(MTU, TPU, TMR, PPG, RTC, CMTW, POE, CAC)	(GPTW, POEG)	(SCI, RSPI, RIIC, CAN, USB, SSIE)	(ETHERC, PMGI)	(QSPI, SDHI, MMCIF, PDC)	GLCDC	Interrupt	A/D D/A
H12		PB0	A8	MTIC5W/ TIOCA3/PO24		RXD4/ SMISO4/ SSCL4/ RXD6/ SMISO6/ SSCL6	ET0_ERXD 1/ RMII0_RX D1		LCD_DAT A0-B	IRQ12	
H13		PA7	A7	TIOCB2/PO23		MISOA-B	ET0_WOL		LCD_DAT A1-B		
J1	TRST#	P34		MTIOC0A/ TMCI3/PO12/ POE10#		SCK6/SCK0	ET0_LINK STA			IRQ4	
J2		P33	EDREQ1	MTIOCOD/ TIOCDO/ TMRI3/PO11/ POE4#/ POE11#		RXD6/ SMISO6/ SSCL6/ RXD0/ SMISO0/ SSCL0/ CRX0		PCKO		IRQ3-DS	
J3		P32		MTIOCOC/ TIOCCO/ TMO3/PO10/ RTCIC2/ RTCOUT/ POE0#/ POE10#		TXD6/ SMOSI6/ SSDA6/ TXD0/ SMOSI0/ SSDA0/ CTX0/ USB0_VBUS EN		VSYNC		IRQ2-DS	
J4	TDI	P30		MTIOC4B/ TMRI3/PO8/ RTCIC0/ POE8#		RXD1/ SMISO1/ SSCL1/ MISOB-A	ET1_MDIO / PMGI1_MD IO			IRQ0-DS	
J10		PB3	A11	MTIOC0A/ MTIOC4A/ TIOCD3/ TCLKD/TMO0/ PO27/POE11#		SCK4/SCK6	ETO_RX_E R/ RMIIO_RX_ ER		LCD_TCO N1-B		
J11		PB4	A12	TIOCA4/PO28		CTS9#/ SS9#/SS11#/ CTS11#/ RTS11#	ET0_TX_E N/ RMII0_TXD _EN		LCD_TCO N0-B		
J12		PB2	A10	TIOCC3/ TCLKC/PO26		CTS4#/ RTS4#/ SS4#/ CTS6#/ RTS6#/SS6#	ET0_RX_C LK/ REF50CK0		LCD_TCO N2-B		
J13		PB1	A9	MTIOCOC/ MTIOC4C/ TIOCB3/ TMCI0/PO25		TXD4/ SMOSI4/ SSDA4/ TXD6/ SMOSI6/ SSDA6	ETO_ERXD 0/ RMIIO_RX D0		LCD_TCO N3-B	IRQ4-DS	
K1	TCK	P27	CS7#	MTIOC2B/ TMCI3/PO7		SCK1/ RSPCKB-A	ET1_WOL				
K2	TDO	P26	CS6#	MTIOC2A/ TMO1/PO6		TXD1/ SMOSI1/ SSDA1/ CTS3#/ RTS3#/ SS3#/ MOSIB-A	ET1_EXOU T				
К3	TMS	P31		MTIOC4D/ TMCI2/PO9/ RTCIC1		CTS1#/ RTS1#/ SS1#/ SSLB0-A	ET1_MDC/ PMGI1_MD C			IRQ1-DS	
K4		P15		MTIOC0B/ MTCLKB/ TIOCB2/ TCLKB/TMCI2/ PO13	GTETRGA	RXD1/ SMISO1/ SSCL1/ SCK3/CRX1- DS/ SSILRCK1		PIXD0		IRQ5	

Table 1.8 List of Pin and Pin Functions (145-Pin TFLGA) (5/7)

Pin Number	Bows.			Timer		Communicat	ion	Memory I/F Camera I/F			
145-Pin TFLGA	Power Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	(MTU, TPU, TMR, PPG, RTC, CMTW, POE, CAC)	(GPTW, POEG)	(SCI, RSPI, RIIC, CAN, USB, SSIE)	(ETHERC, PMGI)	(QSPI, SDHI, MMCIF, PDC)	GLCDC	Interrupt	A/D D/A
K5	TRDATA2	P54	ALE/ D1[A1/D1]/ EDACK0	MTIOC4B/ TMCI1		CTS2#/ RTS2#/ SS2#/CTX1	ET0_LINK STA				
K6		P53*1	BCLK								
K7		P51	WR1#/ BC1#/ WAIT#			SCK2/ SSLB2-A					
K8	VCC										
K9	TRDATA0	P80	EDREQ0	MTIOC3B/ PO26		SCK10/ RTS10#	ETO_TX_E N/ RMIIO_TXD _EN	QIO2-A/ SDHI_WP/ MMC_D2-A			
K10	TRDATA6	P76	CS6#	PO22		SMISO11/ SSCL11/ RXD11	ET0_RX_C LK/ REF50CK0	SDHI_CMD-A/			
K11		PB7	A15	MTIOC3B/ TIOCB5/PO31		TXD9/ SMOSI9/ SSDA9/ SMOSI11/ SSDA11/ TXD11	ETO_CRS/ RMIIO_CR S_DV				
K12		PB6	A14	MTIOC3D/ TIOCA5/PO30		RXD9/ SMISO9/ SSCL9/ SMISO11/ SSCL11/ RXD11	ET0_ETXD 1/ RMII0_TXD 1				
K13		PB5	A13	MTIOC2A/ MTIOC1B/ TIOCB4/ TMRI1/PO29/ POE4#		SCK9/ RTS9#/ SCK11	ETO_ETXD 0/ RMIIO_TXD 0		LCD_CLK-B		
L1	CLKOUT	P25	CS5#/ EDACK1	MTIOC4C/ MTCLKB/ TIOCA4/PO5		RXD3/ SMISO3/ SSCL3/ SSIDATA1		SDHI_CD/ HSYNC			ADTRG0#
L2		P23	EDACK0	MTIOC3D/ MTCLKD/ TIOCD3/PO3	GTIOC0A	TXD3/ SMOSI3/ SSDA3/ CTS0#/ RTS0#/ SS0#/CTX1/ SSIBCK0		SDHI_D1-C/ PIXD7			
L3		P16		MTIOC3C/ MTIOC3D/ TIOCB1/ TCLKC/TMO2/ PO14/ RTCOUT		TXD1/ SMOSI1/ SSDA1/ RXD3/ SMISO3/ SSCL3/ SCL2-DS/ USB0_VBUS EN/ USB0_VBUS				IRQ6	ADTRG0#
						/ USB0_OVRC URB					
L4		P24	CS4#/ EDREQ1	MTIOC4A/ MTCLKA/ TIOCB4/ TMRI1/PO4		SCK3/ USB0_VBUS EN/SSIBCK1		SDHI_WP/ PIXCLK			
L5		P13		MTIOC0B/ TIOCA5/ TMO3/PO13	GTADSM1	TXD2/ SMOSI2/ SSDA2/ SDA0[FM+]				IRQ3	ADTRG1#
L6	CLKOUT2 5M	P56	EDACK1	MTIOC3C/ TIOCA1		SCK7					

Table 1.8 List of Pin and Pin Functions (145-Pin TFLGA) (6/7)

Pin Number	Power			Timer		Communicat	ion	Memory I/F Camera I/F			
145-Pin TFLGA	Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	(MTU, TPU, TMR, PPG, RTC, CMTW, POE, CAC)	(GPTW, POEG)	(SCI, RSPI, RIIC, CAN, USB, SSIE)	(ETHERC, PMGI)	(QSPI, SDHI, MMCIF, PDC)	GLCDC	Interrupt	A/D D/A
L7		P52	RD#			RXD2/ SMISO2/ SSCL2/ SSLB3-A					
L8	TRCLK	P83	EDACK1	MTIOC4C	GTIOC0A	SCK10/ SS10#/ CTS10#	ET0_CRS/ RMII0_CR S_DV				
L9		PC5	D3[A3/D3]/ A21/CS2#/ WAIT#	MTIOC3B/ MTCLKD/ TMRI2/PO29	GTIOC1A	SCK8/ RTS8#/ SCK10/ RSPCKA-A	ET0_ETXD 2	MMC_D5-A			
L10		PC4	A20/CS3#	MTIOC3D/ MTCLKC/ TMCI1/PO25/ POE0#	GTETRG C	SCK5/ CTS8#/ SS8#/SS10#/ CTS10#/ RTS10#/ SSLA0-A	ET0_TX_C LK	QMI-A/ QIO1-A/ SDHI_D1-A/ MMC_D1-A			
L11		PC2	A18	MTIOC4B/ TCLKA/PO21	GTIOC2B	RXD5/ SMISO5/ SSCL5/ SSLA3-A	ET0_RX_D V	SDHI_D3-A/ MMC_CD-A			
L12	TRDATA4	P73	CS3#	PO16			ET0_WOL				
L13	VSS										
M1		P22	EDREQ0	MTIOC3B/ MTCLKC/ TIOCC3/ TMO0/PO2	GTIOC1A	SCK0/ USB0_OVRC URB/ AUDIO_CLK		SDHI_D0-C/ PIXD6			
M2		P17		MTIOC3A/ MTIOC3B/ MTIOC4B/ TIOCB0/ TCLKD/TMO1/ PO15/POE8#	GTIOC0B	SCK1/TXD3/ SMOSI3/ SSDA3/ SDA2-DS/ SSITXD0	EPLSOUT0	SDHI_D3-C/ PIXD3		IRQ7	ADTRG1#
M3		P86		MTIOC4D/ TIOCA0	GTIOC2B	SMISO10/ SSCL10/ RXD10		PIXD1			
M4		P12		TMCI1	GTADSM0	RXD2/ SMISO2/ SSCL2/ SCL0[FM+]				IRQ2	
M5	VCC_USB										
M6	VSS_USB										
M7		P50	WR0#/WR#			TXD2/ SMOSI2/ SSDA2/ SSLB1-A					
M8		PC6	D2[A2/D2]/ A22/CS1#	MTIOC3C/ MTCLKA/ TMCI2/PO30/ TIC0	GTIOC3B	RXD8/ SMISO8/ SSCL8/ SMISO10/ SSCL10/ RXD10/ MOSIA-A	ETO_ETXD 3	MMC_D6-A		IRQ13	
M9	TRDATA1	P81	EDACK0	MTIOC3D/ PO27	GTIOC0B	SMISO10/ SSCL10/ RXD10	ET0_ETXD 0/ RMII0_TXD 0	QIO3-A/ SDHI_CD/ MMC_D3-A			
M10	TRDATA7	P77	CS7#	PO23		SMOSI11/ SSDA11/ TXD11	-	QSPCLK-A/ SDHI_CLK-A/ MMC_CLK-A			
M11		PC0	A16	MTIOC3C/ TCLKC/PO17		CTS5#/ RTS5#/ SS5#/ SSLA1-A	ET0_ERXD 3			IRQ14	

Table 1.8 List of Pin and Pin Functions (145-Pin TFLGA) (7/7)

145-Pin TFLGA	Power			Timer		Communicati	ion	Memory I/F Camera I/F			
	Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	(MTU, TPU, TMR, PPG, RTC, CMTW, POE, CAC)	(GPTW, POEG)	(SCI, RSPI, RIIC, CAN, USB, SSIE)	(ETHERC, PMGI)	(QSPI, SDHI, MMCIF, PDC)	GLCDC	Interrupt	A/D D/A
M12		PC1	A17	MTIOC3A/ TCLKD/PO18		SCK5/ SSLA2-A	ET0_ERXD 2			IRQ12	
M13	VCC										
N1		P21		MTIOC1B/ MTIOC4A/ TIOCA3/ TMCI0/PO1	GTIOC2A	RXD0/ SMISO0/ SSCL0/ SCL1/ USB0_EXIC EN/ SSILRCK0		SDHI_CLK-C/ PIXD5		IRQ9	
N2		P20		MTIOC1A/ TIOCB3/ TMRI0/PO0		TXD0/ SMOSI0/ SSDA0/ SDA1/ USB0_ID/ SSIRXD0		SDHI_CMD-C/ PIXD4		IRQ8	
N3		P87		MTIOC4C/ TIOCA2	GTIOC1B	SMOSI10/ SSDA10/ TXD10	EPLSOUT1	SDHI_D2-C/ PIXD2			
N4		P14		MTIOC3A/ MTCLKA/ TIOCB5/ TCLKA/TMRI2/ PO15	GTETRG D	CTS1#/ RTS1#/ SS1#/CTX1/ USB0_OVRC URA				IRQ4	
N5						USB0_DM					
N6						USB0_DP					
N7	TRDATA3	P55	D0[A0/D0]/ WAIT#/ EDREQ0	MTIOC4D/ TMO3		TXD7/ SMOSI7/ SSDA7/ CRX1	ET0_EXOU T			IRQ10	
N8	VSS										
N9	UB	PC7	A23/CS0#	MTIOC3A/ MTCLKB/ TMO2/PO31/ TOC0/ CACREF	GTIOC3A	TXD8/ SMOSI8/ SSDA8/ SMOSI10/ SSDA10/ TXD10/ MISOA-A	ET0_COL	MMC_D7-A		IRQ14	
N10	TRSYNC	P82	EDREQ1	MTIOC4A/ PO28	GTIOC2A	SMOSI10/ SSDA10/ TXD10	ET0_ETXD 1/ RMII0_TXD 1	MMC_D4-A			
N11		PC3	A19	MTIOC4D/ TCLKB/PO24	GTIOC1B	TXD5/ SMOSI5/ SSDA5	ET0_TX_E R	QMO-A/QIO0- A/SDHI_D0-A/ MMC_D0-A			
N12	TRSYNC1	P75	CS5#	PO20		SCK11/ RTS11#	ET0_ERXD 0/ RMII0_RX D0	SDHI_D2-A/ MMC_RES#-A			
N13	TRDATA5	P74	A20/CS4#	PO19		SS11#/ CTS11#	ET0_ERXD 1/ RMII0_RX D1				

Note 1. P53 is multiplexed with the BCLK pin function, so cannot be used as an I/O port pin when the external bus is enabled.

1.6.5 144-Pin LFQFP

Table 1.9 List of Pin and Pin Functions (144-Pin LFQFP) (1/7)

Pin Number	Power			Timer		Communicat	ion	Memory I/F Camera I/F			
144-Pin LFQFP	Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	(MTU, TPU, TMR, PPG, RTC, CMTW, POE, CAC)	(GPTW, POEG)	(SCI, RSPI, RIIC, CAN, USB, SSIE)	(ETHERC, PMGI)	(QSPI, SDHI, MMCIF, PDC)	GLCDC	Interrupt	A/D D/A
1	AVSS0										
2		P05				SSILRCK1				IRQ13	DA1
3	AVCC1										
4		P03				SSIDATA1				IRQ11	DA0
5	AVSS1										
6		P02		TMCI1		SCK6/ SSIBCK1				IRQ10	AN12
7		P01		TMCIO		RXD6/ SMISO6/ SSCL6/ SSIBCK0				IRQ9	AN11
8		P00		TMRI0		TXD6/ SMOSI6/ SSDA6/ AUDIO_CLK				IRQ8	AN11
9		PF5	WAIT#			SSILRCK0				IRQ4	
10	EMLE			1							
11		PJ5		POE8#		CTS2#/ RTS2#/ SS2#/ SSIRXD0	EPLSOUT0				
12	VSS										
13		PJ3	EDACK1	мтіосзс		CTS6#/ RTS6#/ SS6#/ CTS0#/ RTS0#/ SS0#/ SSITXD0	ET0_EXOU T				
14	VCL										
15	VBATT										
16	MD/FINED										
17	XCIN										1
18	XCOUT										1
19	RES#										1
20	XTAL	P37									
21	VSS										
22	EXTAL	P36									1
23	VCC										1
24	UPSEL	P35								NMI	1
25	TRST#	P34		MTIOC0A/ TMCI3/PO12/ POE10#		SCK6/SCK0	ETO_LINK STA			IRQ4	
26		P33	EDREQ1	MTIOCOD/ TIOCDO/ TMRI3/PO11/ POE4#/ POE11#		RXD6/ SMISO6/ SSCL6/ RXD0/ SMISO0/ SSCL0/ CRX0		РСКО		IRQ3-DS	

Table 1.9 List of Pin and Pin Functions (144-Pin LFQFP) (2/7)

Pin Number	Power			Timer		Communicat	ion	Memory I/F Camera I/F			
144-Pin LFQFP	Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	(MTU, TPU, TMR, PPG, RTC, CMTW, POE, CAC)	(GPTW, POEG)	(SCI, RSPI, RIIC, CAN, USB, SSIE)	(ETHERC, PMGI)	(QSPI, SDHI, MMCIF, PDC)	GLCDC	Interrupt	A/D D/A
27		P32		MTIOCOC/ TIOCCO/ TMO3/PO10/ RTCIC2/ RTCOUT/ POE0#/ POE10#		TXD6/ SMOSI6/ SSDA6/ TXD0/ SMOSI0/ SSDA0/ CTX0/ USB0_VBUS EN		VSYNC		IRQ2-DS	
28	TMS	P31		MTIOC4D/ TMCI2/PO9/ RTCIC1		CTS1#/ RTS1#/ SS1#/ SSLB0-A	ET1_MDC/ PMGI1_MD C			IRQ1-DS	
29	TDI	P30		MTIOC4B/ TMRI3/PO8/ RTCICO/ POE8#		RXD1/ SMISO1/ SSCL1/ MISOB-A	ET1_MDIO / PMGI1_MD IO			IRQ0-DS	
30	TCK	P27	CS7#	MTIOC2B/ TMCI3/PO7		SCK1/ RSPCKB-A	ET1_WOL				
31	TDO	P26	CS6#	MTIOC2A/ TMO1/PO6		TXD1/ SMOSI1/ SSDA1/ CTS3#/ RTS3#/ SS3#/ MOSIB-A	ET1_EXOU T				
32	CLKOUT	P25	CS5#/ EDACK1	MTIOC4C/ MTCLKB/ TIOCA4/PO5		RXD3/ SMISO3/ SSCL3/ SSIDATA1		SDHI_CD/ HSYNC			ADTRG0#
33		P24	CS4#/ EDREQ1	MTIOC4A/ MTCLKA/ TIOCB4/ TMRI1/PO4		SCK3/ USB0_VBUS EN/SSIBCK1		SDHI_WP/ PIXCLK			
34		P23	EDACK0	MTIOC3D/ MTCLKD/ TIOCD3/PO3	GTIOC0A	TXD3/ SMOSI3/ SSDA3/ CTS0#/ RTS0#/ SS0#/CTX1/ SSIBCK0		SDHI_D1-C/ PIXD7			
35		P22	EDREQ0	MTIOC3B/ MTCLKC/ TIOCC3/ TMO0/PO2	GTIOC1A	SCK0/ USB0_OVRC URB/ AUDIO_CLK		SDHI_D0-C/ PIXD6			
36		P21		MTIOC1B/ MTIOC4A/ TIOCA3/ TMCI0/PO1	GTIOC2A	RXD0/ SMISO0/ SSCL0/ SCL1/ USB0_EXIC EN/ SSILRCK0		SDHI_CLK-C/ PIXD5		IRQ9	
37		P20		MTIOC1A/ TIOCB3/ TMRI0/PO0		TXD0/ SMOSI0/ SSDA0/ SDA1/ USB0_ID/ SSIRXD0		SDHI_CMD-C/ PIXD4		IRQ8	
38		P17		MTIOC3A/ MTIOC3B/ MTIOC4B/ TIOCB0/ TCLKD/TMO1/ PO15/POE8#	GTIOC0B	SCK1/TXD3/ SMOSI3/ SSDA3/ SDA2-DS/ SSITXD0	EPLSOUT0	SDHI_D3-C/ PIXD3		IRQ7	ADTRG1#
39		P87		MTIOC4C/ TIOCA2	GTIOC1B	SMOSI10/ SSDA10/ TXD10	EPLSOUT1	SDHI_D2-C/ PIXD2			

Table 1.9 List of Pin and Pin Functions (144-Pin LFQFP) (3/7)

Pin Number				Timer		Communicat	ion	Memory I/F Camera I/F			
144-Pin LFQFP	Power Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	(MTU, TPU, TMR, PPG, RTC, CMTW, POE, CAC)	(GPTW, POEG)	(SCI, RSPI, RIIC, CAN, USB, SSIE)	(ETHERC, PMGI)	(QSPI, SDHI, MMCIF, PDC)	GLCDC	Interrupt	A/D D/A
40		P16		MTIOC3C/ MTIOC3D/ TIOCB1/ TICKC/TMO2/ PO14/ RTCOUT		TXD1/ SMOSI1/ SSDA1/ RXD3/ SMISO3/ SSCL3/ SCL2-DS/ USB0_VBUS EN/ USB0_VBUS / USB0_OVRC URB0_OVRC				IRQ6	ADTRG0#
41		P86		MTIOC4D/ TIOCA0	GTIOC2B	SMISO10/ SSCL10/ RXD10		PIXD1			
42		P15		MTIOCOB/ MTCLKB/ TIOCB2/ TCLKB/TMCI2/ PO13	GTETRGA			PIXD0		IRQ5	
43		P14		MTIOC3A/ MTCLKA/ TIOCB5/ TCLKA/TMRI2/ PO15	GTETRG D	CTS1#/ RTS1#/ SS1#/CTX1/ USB0_OVRC URA				IRQ4	
44		P13		MTIOC0B/ TIOCA5/ TMO3/PO13	GTADSM1	TXD2/ SMOSI2/ SSDA2/ SDA0[FM+]				IRQ3	ADTRG1#
45		P12		TMCI1	GTADSM0	RXD2/ SMISO2/ SSCL2/ SCL0[FM+]				IRQ2	
46	VCC_USB										
47						USB0_DM					
48	V/00 LI00					USB0_DP					
49 50	VSS_USB CLKOUT2	DEC	EDACK1	MTIOCOCI		CCV7					
50	5M	F36	EDACKI	MTIOC3C/ TIOCA1		SCK7					
51	TRDATA3	P55	D0[A0/D0]/ WAIT#/ EDREQ0	MTIOC4D/ TMO3		TXD7/ SMOSI7/ SSDA7/ CRX1	ET0_EXOU T			IRQ10	
52	TRDATA2	P54	ALE/D1[A1/ D1]/ EDACK0	MTIOC4B/ TMCI1		CTS2#/ RTS2#/ SS2#/CTX1	ET0_LINK STA				
53		P53*1	BCLK								
54		P52	RD#			RXD2/ SMISO2/ SSCL2/ SSLB3-A					
55		P51	WR1#/ BC1#/ WAIT#			SCK2/ SSLB2-A					
56		P50	WR0#/WR#			TXD2/ SMOSI2/ SSDA2/ SSLB1-A					
57	VSS										
58	TRCLK	P83	EDACK1	MTIOC4C	GTIOC0A	SCK10/ SS10#/ CTS10#	ET0_CRS/ RMII0_CR S_DV				
59	VCC									1	

Table 1.9 List of Pin and Pin Functions (144-Pin LFQFP) (4/7)

Pin Number	Power			Timer		Communicat	ion	Memory I/F Camera I/F			
144-Pin LFQFP	Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	(MTU, TPU, TMR, PPG, RTC, CMTW, POE, CAC)	(GPTW, POEG)	(SCI, RSPI, RIIC, CAN, USB, SSIE)	(ETHERC, PMGI)	(QSPI, SDHI, MMCIF, PDC)	GLCDC	Interrupt	A/D D/A
60	UB	PC7	A23/CS0#	MTIOC3A/ MTCLKB/ TMO2/PO31/ TOC0/ CACREF	GTIOC3A	TXD8/ SMOSI8/ SSDA8/ SMOSI10/ SSDA10/ TXD10/ MISOA-A	ET0_COL	MMC_D7-A		IRQ14	
61		PC6	D2[A2/D2]/ A22/CS1#	MTIOC3C/ MTCLKA/ TMCI2/PO30/ TIC0	GTIOC3B	RXD8/ SMISO8/ SSCL8/ SMISO10/ SSCL10/ RXD10/ MOSIA-A	ETO_ETXD 3	MMC_D6-A		IRQ13	
62		PC5	D3[A3/D3]/ A21/CS2#/ WAIT#	MTIOC3B/ MTCLKD/ TMRI2/PO29	GTIOC1A	SCK8/ RTS8#/ SCK10/ RSPCKA-A	ET0_ETXD 2	MMC_D5-A			
63	TRSYNC	P82	EDREQ1	MTIOC4A/ PO28	GTIOC2A	SMOSI10/ SSDA10/ TXD10	ET0_ETXD 1/ RMII0_TXD 1	MMC_D4-A			
64	TRDATA1	P81	EDACK0	MTIOC3D/ PO27	GTIOC0B	SMISO10/ SSCL10/ RXD10	ET0_ETXD 0/ RMII0_TXD 0	QIO3-A/ SDHI_CD/ MMC_D3-A			
65	TRDATA0	P80	EDREQ0	MTIOC3B/ PO26		SCK10/ RTS10#	N/	QIO2-A/ SDHI_WP/ MMC_D2-A			
66		PC4	A20/CS3#	MTIOC3D/ MTCLKC/ TMCI1/PO25/ POE0#	GTETRG C	SCK5/ CTS8#/ SS8#/SS10#/ CTS10#/ RTS10#/ SSLA0-A	ET0_TX_C LK	QMI-A/ QIO1-A/ SDHI_D1-A/ MMC_D1-A			
67		PC3	A19	MTIOC4D/ TCLKB/PO24	GTIOC1B	TXD5/ SMOSI5/ SSDA5	ET0_TX_E R	QMO-A/QIO0- A/SDHI_D0-A/ MMC_D0-A			
68	TRDATA7	P77	CS7#	PO23		SMOSI11/ SSDA11/ TXD11	R/	QSPCLK-A/ SDHI_CLK-A/ MMC_CLK-A			
69	TRDATA6	P76	CS6#	PO22		SMISO11/ SSCL11/ RXD11	ET0_RX_C LK/ REF50CK0	QSSL-A/ SDHI_CMD-A/ MMC_CMD-A			
70		PC2	A18	MTIOC4B/ TCLKA/PO21	GTIOC2B	RXD5/ SMISO5/ SSCL5/ SSLA3-A	ET0_RX_D V	SDHI_D3-A/ MMC_CD-A			
71	TRSYNC1	P75	CS5#	PO20		SCK11/ RTS11#	ET0_ERXD 0/ RMII0_RX D0	SDHI_D2-A/ MMC_RES#-A			
72	TRDATA5	P74	A20/CS4#	PO19		SS11#/ CTS11#	ET0_ERXD 1/ RMII0_RX D1				
73		PC1	A17	MTIOC3A/ TCLKD/PO18		SCK5/ SSLA2-A	ET0_ERXD 2			IRQ12	
74	VCC										
75		PC0	A16	MTIOC3C/ TCLKC/PO17		CTS5#/ RTS5#/ SS5#/ SSLA1-A	ET0_ERXD 3			IRQ14	
76	VSS										
77	TRDATA4	P73	CS3#	PO16			ET0_WOL				L

Table 1.9 List of Pin and Pin Functions (144-Pin LFQFP) (5/7)

Pin Number	Bower			Timer				Memory I/F Camera I/F			
144-Pin LFQFP	Power Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	(MTU, TPU, TMR, PPG, RTC, CMTW, POE, CAC)	(GPTW, POEG)	(SCI, RSPI, RIIC, CAN, USB, SSIE)	(ETHERC, PMGI)	(QSPI, SDHI, MMCIF, PDC)	GLCDC	Interrupt	A/D D/A
78		PB7	A15	MTIOC3B/ TIOCB5/PO31		TXD9/ SMOSI9/ SSDA9/ SMOSI11/ SSDA11/ TXD11	ETO_CRS/ RMIIO_CR S_DV				
79		PB6	A14	MTIOC3D/ TIOCA5/PO30		RXD9/ SMISO9/ SSCL9/ SMISO11/ SSCL11/ RXD11	ET0_ETXD 1/ RMII0_TXD 1				
80		PB5	A13	MTIOC2A/ MTIOC1B/ TIOCB4/ TMRI1/PO29/ POE4#		SCK9/ RTS9#/ SCK11	ET0_ETXD 0/ RMII0_TXD 0		LCD_CLK-B		
81		PB4	A12	TIOCA4/PO28		CTS9#/ SS9#/SS11#/ CTS11#/ RTS11#	ET0_TX_E N/ RMII0_TXD _EN		LCD_TCO N0-B		
82		РВ3	A11	MTIOC0A/ MTIOC4A/ TIOCD3/ TCLKD/TMO0/ PO27/POE11#		SCK4/SCK6	ET0_RX_E R/ RMII0_RX_ ER		LCD_TCO N1-B		
83		PB2	A10	TIOCC3/ TCLKC/PO26		CTS4#/ RTS4#/ SS4#/ CTS6#/ RTS6#/SS6#	ET0_RX_C LK/ REF50CK0		LCD_TCO N2-B		
84		PB1	A9	MTIOCOC/ MTIOC4C/ TIOCB3/ TMCI0/PO25		TXD4/ SMOSI4/ SSDA4/ TXD6/ SMOSI6/ SSDA6	ETO_ERXD 0/ RMIIO_RX D0		LCD_TCO N3-B	IRQ4-DS	
85		P72	A19/CS2#				ET0_MDC/ PMGI0_MD C				
86		P71	A18/CS1#				ET0_MDIO / PMGI0_MD IO				
87		PB0	A8	MTIC5W/ TIOCA3/PO24		RXD4/ SMISO4/ SSCL4/ RXD6/ SMISO6/ SSCL6	ET0_ERXD 1/ RMII0_RX D1		LCD_DAT A0-B	IRQ12	
88		PA7	A7	TIOCB2/PO23		MISOA-B	ET0_WOL		LCD_DAT A1-B		
89		PA6	A6	MTIC5V/ MTCLKB/ TIOCA2/ TMCI3/PO22/ POE10#	GTETRGB	CTS5#/ RTS5#/ SS5#/ MOSIA-B	ET0_EXOU T		LCD_DAT A2-B		
90		PA5	A5	MTIOC6B/ TIOCB1/PO21	GTIOC0A	RSPCKA-B	ET0_LINK STA		LCD_DAT A3-B		
91	VCC										
92		PA4	A4	MTIC5U/ MTCLKA/ TIOCA1/ TMRI0/PO20		TXD5/ SMOSI5/ SSDA5/ SSLA0-B	ET0_MDC/ PMGI0_MD C		LCD_DAT A4-B	IRQ5-DS	
93	VSS										

Table 1.9 List of Pin and Pin Functions (144-Pin LFQFP) (6/7)

Pin Number	Power			Timer		Communica	tion	Memory I/F Camera I/F			
144-Pin LFQFP	Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	(MTU, TPU, TMR, PPG, RTC, CMTW, POE, CAC)	(GPTW, POEG)	(SCI, RSPI, RIIC, CAN, USB, SSIE)	(ETHERC, PMGI)	(QSPI, SDHI, MMCIF, PDC)	GLCDC	Interrupt	A/D D/A
94		PA3	A3	MTIOC0D/ MTCLKD/ TIOCD0/ TCLKB/PO19		RXD5/ SMISO5/ SSCL5	ET0_MDIO / PMGI0_MD IO		LCD_DAT A5-B	IRQ6-DS	
95		PA2	A2	MTIOC7A/ PO18	GTIOC1A	RXD5/ SMISO5/ SSCL5/ SSLA3-B			LCD_DAT A6-B		
96		PA1	A1	MTIOC0B/ MTCLKC/ MTIOC7B/ TIOCB0/PO17	GTIOC2A	SCK5/ SSLA2-B	ET0_WOL		LCD_DAT A7-B	IRQ11	
97		PA0	BC0#/A0	MTIOC4A/ MTIOC6D/ TIOCA0/PO16/ CACREF	GTIOC0B	SSLA1-B	ET0_TX_E N/ RMII0_TXD _EN		LCD_DAT A8-B		
98		P67	DQM1/ CS7#	MTIOC7C	GTIOC1B	CRX2	EPLSOUT1			IRQ15	
99		P66	DQM0/ CS6#	MTIOC7D	GTIOC2B	CTX2					
100		P65	CKE/CS5#								
101		PE7	D15[A15/ D15]/D7[A7/ D7]	MTIOC6A/ TOC1	GTIOC3A	MISOB-B		SDHI_WP/ MMC_RES#-B	LCD_DAT A9-B	IRQ7	AN105
102		PE6	D14[A14/ D14]/D6[A6/ D6]	MTIOC6C/ TIC1	GTIOC3B	MOSIB-B		SDHI_CD/ MMC_CD-B	LCD_DAT A10-B	IRQ6	AN104
103	VCC										
104		P70	SDCLK								
105	VSS										
106		PE5	D13[A13/ D13]/D5[A5/ D5]	MTIOC4C/ MTIOC2B	GTIOC0A	RSPCKB-B	ET0_RX_C LK/ REF50CK0		LCD_DAT A11-B	IRQ5	AN103
107		PE4	D12[A12/ D12]/D4[A4/ D4]	MTIOC4D/ MTIOC1A/ PO28	GTIOC1A	SSLB0-B	ET0_ERXD 2		LCD_DAT A12-B		AN102
108		PE3	D11[A11/ D11]/D3[A3/ D3]	MTIOC4B/ PO26/TOC3/ POE8#	GTIOC2A	CTS12#/ RTS12#/ SS12#	ET0_ERXD 3	MMC_D7-B	LCD_DAT A13-B		AN101
109		PE2	D10[A10/ D10]/D2[A2/ D2]	MTIOC4A/ PO23/TIC3	GTIOC0B	RXD12/ SMISO12/ SSCL12/ RXDX12/ SSLB3-B		MMC_D6-B	LCD_DAT A14-B	IRQ7-DS	AN100
110		PE1	D9[A9/D9]/ D1[A1/D1]	MTIOC4C/ MTIOC3B/ PO18	GTIOC1B	TXD12/ SMOSI12/ SSDA12/ TXDX12/ SIOX12/ SSLB2-B		MMC_D5-B	LCD_DAT A15-B		ANEX1
111		PE0	D8[A8/D8]/ D0[A0/D0]	MTIOC3D	GTIOC2B	SCK12/ SSLB1-B		MMC_D4-B	LCD_DAT A16-B		ANEX0
112		P64	WE#/D3[A3/ D3]/CS4#				RMII1_TXD 0				
113		P63	CAS#/ D2[A2/D2]/ CS3#				RMII1_TXD 1				
114		P62	RAS#/ D1[A1/D1]/ CS2#				RMII1_RX D0				
115		P61	SDCS#/ D0[A0/D0]/ CS1#				RMII1_RX D1				
116	VSS	1	1								

Table 1.9 List of Pin and Pin Functions (144-Pin LFQFP) (7/7)

ower fupply clock bystem control	PD7 PD6 PD5	Bus EXDMAC SDRAMC CS0# D7[A7/D7] D6[A6/D6] D5[A5/D5]	MTIC5U/POE4# MTIC5W/MTIOC8A/POE4# MTIC5W/MTIOC8C/MTCLKA/POE10#	(GPTW, POEG)	(SCI, RSPI, RIIC, CAN, USB, SSIE) SSLC3-A	(ETHERC, PMGI) RMII1_TXD _EN RMII1_RX_ ER REF50CK1	(QSPI, SDHI, MMCIF, PDC) QMI-B/ QIO1-B/ SDHI_D1-B/ MMC_D1-B QMO-B/QIO0-B/SDHI_D0-B/	A17-B	Interrupt IRQ7	A/D D/A AN107
/CC	PD7 PD6 PD5	D7[A7/D7] D6[A6/D6] D5[A5/D5]	POE0# MTIC5V/ MTIOC8A/ POE4# MTIC5W/ MTIOC8C/ MTCLKA/		SSLC2-A	_EN RMII1_RX_ER	QIO1-B/ SDHI_D1-B/ MMC_D1-B QMO-B/QIO0-	A17-B		
rcc .	PD6	D6[A6/D6] D5[A5/D5]	POE0# MTIC5V/ MTIOC8A/ POE4# MTIC5W/ MTIOC8C/ MTCLKA/		SSLC2-A	ER	QIO1-B/ SDHI_D1-B/ MMC_D1-B QMO-B/QIO0-	A17-B		
	PD6	D6[A6/D6] D5[A5/D5]	POE0# MTIC5V/ MTIOC8A/ POE4# MTIC5W/ MTIOC8C/ MTCLKA/		SSLC2-A	ER	QIO1-B/ SDHI_D1-B/ MMC_D1-B QMO-B/QIO0-	A17-B		
	PD5	D5[A5/D5]	MTIOC8A/ POE4# MTIC5W/ MTIOC8C/ MTCLKA/			REF50CK1			IRQ6	AN106
			MTIOC8C/ MTCLKA/				MMC_D0-B	A10-D		
	PD4	D4[A4/D41	. 02.10#		SSLC1-A	ET1_MDC/ PMGI1_MD C	QSPCLK-B/ SDHI_CLK-B/ MMC_CLK-B	LCD_DAT A19-B	IRQ5	AN113
			MTIOC8B/ POE11#		SSLC0-A	ET1_MDIO / PMGI1_MD IO	QSSL-B/ SDHI_CMD-B/ MMC_CMD-B	LCD_DAT A20-B	IRQ4	AN112
	PD3	D3[A3/D3]	MTIOC8D/ TOC2/POE8#	GTIOC0A	RSPCKC-A	ET1_WOL	QIO3-B/ SDHI_D3-B/ MMC_D3-B	LCD_DAT A21-B	IRQ3	AN111
	PD2	D2[A2/D2]	MTIOC4D/ TIC2	GTIOC0B	MISOC-A/ CRX0	ET1_EXOU T	QIO2-B/ SDHI_D2-B/ MMC_D2-B	LCD_DAT A22-B	IRQ2	AN110
	PD1	D1[A1/D1]	MTIOC4B/ POE0#	GTIOC1A	MOSIC-A/ CTX0			LCD_DAT A23-B	IRQ1	AN109
	PD0	D0[A0/D0]	POE4#	GTIOC1B				LCD_EXT CLK-B	IRQ0	AN108
	P93	A19	POE0#		CTS7#/ RTS7#/SS7#	ET1_LINK STA				AN117
	P92	A18	POE4#		RXD7/ SMISO7/ SSCL7	RMII1_CR S_DV				AN116
	P91	A17			SCK7					AN115
'SS										
	P90	A16			TXD7/ SMOSI7/ SSDA7					AN114
CC C										
	P47		1							
			1							
			-							AN003
			1							AN002 AN001
/RFFI ∩	F#1		1						יועמא-חס	ANOUT
IVEL EO	P40								IRQ8-DS	AN000
REFH0			1							1000
VCC0			1							
	P07								IRQ15	ADTRG0#
'r'	REFLO //CC0	PD2 PD1 PD0 P93 P92 P91 SS P90 CC P47 P46 P45 P44 P43 P42 P41 REFL0 P40 REFH0 //CC0 P07	PD2 D2[A2/D2] PD1 D1[A1/D1] PD0 D0[A0/D0] P93 A19 P92 A18 P91 A17 SS P90 A16 CC P47 P46 P45 P44 P43 P42 P41 REFL0 P40 REFH0 /CC0 P07	PD2 D2[A2/D2] MTIOC4D/ TIC2 PD1 D1[A1/D1] MTIOC4B/ POE0# PD0 D0[A0/D0] POE4# P93 A19 POE0# P92 A18 POE4# P91 A17 SS P90 A16 CC P47 P46 P45 P44 P43 P42 P41 REFL0 P40 REFH0 POEA TOC2/POE8# ATTOC2/POE8# ATTOCA PD2 D2[A2/D2] MTIOC4D/ TIC2 GTIOC0B PD1	PD2 D2[A2/D2] MTIOC4D/ GTIOC0B MISOC-A/ CRX0 PD1 D1[A1/D1] MTIOC4B/ GTIOC1A MOSIC-A/ CTX0 PD0 D0[A0/D0] POE4# GTIOC1B P93 A19 POE0# CTS7#/ RTS7#/SS7# P92 A18 POE4# RXD7/ SMISO7/ SSCL7 P91 A17 SCK7 SS SS SSDA7 CC P47 P46 P45 P44 P43 P42 P41 REFL0 P40 REFH0 P40 REFH0 P40 REFH0 P07 P07 P10 MTIOC4B/ GTIOC1B MISOC-A/ CRX0 MISOC-A/ CRX0 MISOC-A/ CRX0	PD2 D2[A2/D2] MTIOC4D/ GTIOC0B MISOC-A/ ET1_EXOU T T T T T T T T T	PD2 D2[A2/D2] MTIOC4D/ GTIOC0B MISOC-A/ ET1_EXOU QIO2-B/ MMC_D3-B MISOC-A/ CRX0 T = SDHL_D3-B/ MMC_D3-B MISOC-A/ CRX0 T = SDHL_D3-B/ MMC_D2-B MISOC-A/ ET1_EXOU QIO2-B/ SDHL_D2-B/ MMC_D2-B MISOC-A/ CTX0 MOSIC-A/ CTX	PD2 D2[A2/D2] MTIOC4D/ GTIOC0B MISOC-A/ ET1_EXOU Q102-B/ MMC_D3-B A21-B MAC_D3-B A21-B MTIOC4D/ T1C2 GTIOC0B MISOC-A/ ET1_EXOU Q102-B/ SDHI_D2-B/ MMC_D2-B MMC	TOC2/POE8# SDHLD3-B/ MAC1-B- MMC_D3-B/ MAC1-B- MMC_D3-B/ MMC_D3-B/MC_D3-B/ MMC_D3-B/MC_D3-B/MC_D3-B/MC_D3-B/MC_D3-B/MC_D3-B/MC_D3-B/MC_D3-B/MC_D3-B/MC_D3-B/MC	

Note 1. P53 is multiplexed with the BCLK pin function, so cannot be used as an I/O port pin when the external bus is enabled.

1.6.6 100-Pin LFQFP

Table 1.10 List of Pin and Pin Functions (100-Pin LFQFP) (1/6)

Pin Number	Power			Timer		Communicat	ion	Memory I/F Camera I/F			
100-Pin LFQFP	Power Supply Clock System Control	I/O Port	Bus EXDMAC	(MTU, TPU, TMR, PPG, RTC, CMTW, POE, CAC)	(GPTW, POEG)	(SCI, RSPI, RIIC, CAN, USB, SSIE)	(ETHERC, PMGI)	(QSPI, SDHI, MMCIF)	GLCDC	Interrupt	A/D D/A
1	AVCC1										
2	EMLE										
3	AVSS1										
4		PJ3	EDACK1	MTIOC3C		CTS6#/ RTS6#/ SS6#/ CTS0#/ RTS0#/ SS0#/ SSITXD0	ET0_EXOU				
5	VCL										
6	VBATT										
7	MD/FINED										
8	XCIN								<u> </u>		igspace
9	XCOUT										1
10	RES#								<u> </u>		<u> </u>
11	XTAL	P37									
12	VSS										1
13	EXTAL	P36									
14	VCC										
15	UPSEL	P35								NMI	
16	TRST#	P34		MTIOC0A/ TMCI3/PO12/ POE10#		SCK6/SCK0	ET0_LINK STA			IRQ4	
17		P33	EDREQ1	MTIOCOD/ TIOCDO/ TMRI3/PO11/ POE4#/ POE11#		RXD6/ SMISO6/ SSCL6/ RXD0/ SMISO0/ SSCL0/ CRX0				IRQ3-DS	
18		P32		MTIOCOC/ TIOCCO/ TMO3/PO10/ RTCIC2/ RTCOUT/ POE0#/ POE10#		TXD6/ SMOSI6/ SSDA6/ TXD0/ SMOSI0/ SSDA0/ CTX0/ USB0_VBUS EN				IRQ2-DS	
19	TMS	P31		MTIOC4D/ TMCI2/PO9/ RTCIC1		CTS1#/ RTS1#/ SS1#/ SSLB0-A				IRQ1-DS	
20	TDI	P30		MTIOC4B/ TMRI3/PO8/ RTCIC0/ POE8#		RXD1/ SMISO1/ SSCL1/ MISOB-A				IRQ0-DS	
21	TCK	P27	CS7#	MTIOC2B/ TMCI3/PO7		SCK1/ RSPCKB-A					
22	TDO	P26	CS6#	MTIOC2A/ TMO1/PO6		TXD1/ SMOSI1/ SSDA1/ CTS3#/ RTS3#/ SS3#/ MOSIB-A					

Table 1.10 List of Pin and Pin Functions (100-Pin LFQFP) (2/6)

Pin Number	Power-			Timer		Communicat	ion	Memory I/F Camera I/F			
100-Pin LFQFP	Power Supply Clock System Control	I/O Port	Bus EXDMAC	(MTU, TPU, TMR, PPG, RTC, CMTW, POE, CAC)	(GPTW, POEG)	(SCI, RSPI, RIIC, CAN, USB, SSIE)	(ETHERC, PMGI)	(QSPI, SDHI, MMCIF)	GLCDC	Interrupt	A/D D/A
23	CLKOUT	P25	CS5#/ EDACK1	MTIOC4C/ MTCLKB/ TIOCA4/PO5		RXD3/ SMISO3/ SSCL3/ SSIDATA1					ADTRG0#
24		P24	CS4#/ EDREQ1	MTIOC4A/ MTCLKA/ TIOCB4/ TMRI1/PO4		SCK3/ USB0_VBUS EN/SSIBCK1					
25		P23	EDACK0	MTIOC3D/ MTCLKD/ TIOCD3/PO3	GTIOC0A	TXD3/ SMOSI3/ SSDA3/ CTS0#/ RTS0#/ SS0#/CTX1/ SSIBCK0					
26		P22	EDREQ0	MTIOC3B/ MTCLKC/ TIOCC3/ TMO0/PO2	GTIOC1A	SCK0/ USB0_OVRC URB/ AUDIO_CLK					
27		P21		MTIOC1B/ MTIOC4A/ TIOCA3/ TMCI0/PO1	GTIOC2A	RXD0/ SMISO0/ SSCL0/ USB0_EXIC EN/ SSILRCK0/ SCL1				IRQ9	
28		P20		MTIOC1A/ TIOCB3/ TMRI0/PO0		TXD0/ SMOSI0/ SSDA0/ USB0_ID/ SSIRXD0/ SDA1				IRQ8	
29		P17		MTIOC3A/ MTIOC3B/ MTIOC4B/ TIOCBO/ TCLKD/TMO1/ PO15/POE8#	GTIOC0B	SCK1/TXD3/ SMOSI3/ SSDA3/ SDA2-DS/ SSITXD0	EPLSOUT0			IRQ7	ADTRG1#
30		P16		MTIOC3C/ MTIOC3D/ TIOCB1/ TCLKC/TMO2/ PO14/ RTCOUT		TXD1/ SMOSI1/ SSDA1/ RXD3/ SMISO3/ SSCL3/ SCL2-DS/ USB0_VBUS EN/ USB0_VBUS				IRQ6	ADTRG0#
						USB0_OVRC URB					
31		P15		MTIOC0B/ MTCLKB/ TIOCB2/ TCLKB/TMCI2/ PO13	GTETRGA	RXD1/ SMISO1/ SSCL1/ SCK3/ CRX1-DS/ SSILRCK1				IRQ5	
32		P14		MTIOC3A/ MTCLKA/ TIOCB5/ TCLKA/TMRI2/ PO15	GTETRG D	CTS1#/ RTS1#/ SS1#/CTX1/ USB0_OVRC URA				IRQ4	
33		P13		MTIOC0B/ TIOCA5/ TMO3/PO13	GTADSM1	TXD2/ SMOSI2/ SSDA2/ SDA0[FM+]				IRQ3	ADTRG1#
34		P12		TMCI1	GTADSM0	RXD2/ SMISO2/ SSCL2/ SCL0[FM+]				IRQ2	

Table 1.10 List of Pin and Pin Functions (100-Pin LFQFP) (3/6)

Pin Number	Power			Timer		Communicat	ion	Memory I/F Camera I/F			
100-Pin LFQFP	Supply Clock System Control	I/O Port	Bus EXDMAC	(MTU, TPU, TMR, PPG, RTC, CMTW, POE, CAC)	(GPTW, POEG)	(SCI, RSPI, RIIC, CAN, USB, SSIE)	(ETHERC, PMGI)	(QSPI, SDHI, MMCIF)	GLCDC	Interrupt	A/D D/A
35	VCC_USB										
36						USB0_DM					
37						USB0_DP					
38	VSS_USB										
39		P55	D0[A0/D0]/ WAIT#/ EDREQ0	MTIOC4D/ TMO3		CRX1	ET0_EXOU T			IRQ10	
40		P54	ALE/ D1[A1/D1]/ EDACK0	MTIOC4B/ TMCI1		CTS2#/ RTS2#/ SS2#/CTX1	ET0_LINK STA				
41		P53*1	BCLK								
42		P52	RD#			RXD2/ SMISO2/ SSCL2/ SSLB3-A					
43		P51	WR1#/ BC1#/ WAIT#			SCK2/ SSLB2-A					
44		P50	WR0#/WR#			TXD2/ SMOSI2/ SSDA2/ SSLB1-A					
45	UB	PC7	A23/CS0#	MTIOC3A/ MTCLKB/ TMO2/PO31/ TOC0/ CACREF	GTIOC3A	TXD8/ SMOSI8/ SSDA8/ SMOSI10/ SSDA10/ TXD10/ MISOA-A	ET0_COL			IRQ14	
46		PC6	D2[A2/D2]/ A22/CS1#	MTIOC3C/ MTCLKA/ TMCI2/PO30/ TIC0	GTIOC3B	RXD8/ SMISO8/ SSCL8/ SMISO10/ SSCL10/ RXD10/ MOSIA-A	ETO_ETXD 3			IRQ13	
47		PC5	D3[A3/D3]/ A21/CS2#/ WAIT#	MTIOC3B/ MTCLKD/ TMRI2/PO29	GTIOC1A	SCK8/ RTS8#/ SCK10/ RSPCKA-A	ET0_ETXD 2				
48		PC4	A20/CS3#	MTIOC3D/ MTCLKC/ TMCI1/PO25/ POE0#	GTETRG C	SCK5/ CTS8#/ SS8#/SS10#/ CTS10#/ RTS10#/ SSLA0-A	ET0_TX_C LK				
49		PC3	A19	MTIOC4D/ TCLKB/PO24	GTIOC1B	TXD5/ SMOSI5/ SSDA5	ET0_TX_E R				
50		PC2	A18	MTIOC4B/ TCLKA/PO21	GTIOC2B	RXD5/ SMISO5/ SSCL5/ SSLA3-A	ET0_RX_D V				
51		PC1	A17	MTIOC3A/ TCLKD/PO18		SCK5/ SSLA2-A	ET0_ERXD 2			IRQ12	
52		PC0	A16	MTIOC3C/ TCLKC/PO17		CTS5#/ RTS5#/ SS5#/ SSLA1-A	ET0_ERXD 3			IRQ14	
53		PB7	A15	MTIOC3B/ TIOCB5/PO31		TXD9/ SMOSI9/ SSDA9/ SMOSI11/ SSDA11/ TXD11	ETO_CRS/ RMIIO_CR S_DV				

Table 1.10 List of Pin and Pin Functions (100-Pin LFQFP) (4/6)

Pin Number	Do			Timer		Communicat	ion	Memory I/F Camera I/F			
100-Pin LFQFP	Power Supply Clock System Control	I/O Port	Bus EXDMAC	(MTU, TPU, TMR, PPG, RTC, CMTW, POE, CAC)	(GPTW, POEG)	(SCI, RSPI, RIIC, CAN, USB, SSIE)	(ETHERC, PMGI)	(QSPI, SDHI, MMCIF)	GLCDC	Interrupt	A/D D/A
54		PB6	A14	MTIOC3D/ TIOCA5/PO30		RXD9/ SMISO9/ SSCL9/ SMISO11/ SSCL11/ RXD11	ETO_ETXD 1/ RMIIO_TXD 1				
55		PB5	A13	MTIOC2A/ MTIOC1B/ TIOCB4/ TMRI1/PO29/ POE4#		SCK9/ RTS9#/ SCK11	ET0_ETXD 0/ RMII0_TXD 0		LCD_CLK- B		
56		PB4	A12	TIOCA4/PO28		CTS9#/ SS9#/SS11#/ CTS11#/ RTS11#	ET0_TX_E N/ RMII0_TXD _EN		LCD_TCO N0-B		
57		РВ3	A11	MTIOC0A/ MTIOC4A/ TIOCD3/ TCLKD/TMO0/ PO27/POE11#		SCK6	ETO_RX_E R/ RMIIO_RX_ ER		LCD_TCO N1-B		
58		PB2	A10	TIOCC3/ TCLKC/PO26		CTS6#/ RTS6#/SS6#	ET0_RX_C LK/ REF50CK0		LCD_TCO N2-B		
59		PB1	A9	MTIOC0C/ MTIOC4C/ TIOCB3/ TMCI0/PO25		TXD6/ SMOSI6/ SSDA6	ET0_ERXD 0/ RMII0_RX D0		LCD_TCO N3-B	IRQ4-DS	
60	VCC										
61		PB0	A8	MTIC5W/ TIOCA3/PO24		RXD6/ SMISO6/ SSCL6	ET0_ERXD 1/ RMII0_RX D1		LCD_DAT A0-B	IRQ12	
62	VSS										
63		PA7	A7	TIOCB2/PO23		MISOA-B	ET0_WOL		LCD_DAT A1-B		
64		PA6	A6	MTIC5V/ MTCLKB/ TIOCA2/ TMCI3/PO22/ POE10#	GTETRGB	CTS5#/ RTS5#/ SS5#/ MOSIA-B	T ETO_EXOU		LCD_DAT A2-B		
65		PA5	A5	MTIOC6B/ TIOCB1/PO21	GTIOC0A	RSPCKA-B	ET0_LINK STA		LCD_DAT A3-B		
66		PA4	A4	MTIC5U/ MTCLKA/ TIOCA1/ TMRI0/PO20		TXD5/ SMOSI5/ SSDA5/ SSLA0-B	ET0_MDC/ PMGI0_MD C		LCD_DAT A4-B	IRQ5-DS	
67		PA3	A3	MTIOC0D/ MTCLKD/ TIOCD0/ TCLKB/PO19		RXD5/ SMISO5/ SSCL5	ET0_MDIO / PMGI0_MD IO		LCD_DAT A5-B	IRQ6-DS	
68		PA2	A2	MTIOC7A/ PO18	GTIOC1A	RXD5/ SMISO5/ SSCL5/ SSLA3-B			LCD_DAT A6-B		
69		PA1	A1	MTIOC0B/ MTCLKC/ MTIOC7B/ TIOCB0/PO17	GTIOC2A	SCK5/ SSLA2-B	ET0_WOL		LCD_DAT A7-B	IRQ11	
70		PA0	BC0#/A0	MTIOC4A/ MTIOC6D/ TIOCA0/PO16/ CACREF	GTIOC0B	SSLA1-B	ET0_TX_E N/ RMII0_TXD _EN		LCD_DAT A8-B		
71		PE7	D15[A15/ D15]/D7[A7/ D7]	MTIOC6A/ TOC1	GTIOC3A	MISOB-B		SDHI_WP/ MMC_RES#-B	LCD_DAT A9-B	IRQ7	AN10

Table 1.10 List of Pin and Pin Functions (100-Pin LFQFP) (5/6)

Pin Number	Power			Timer		Communica	tion	Memory I/F Camera I/F			
100-Pin LFQFP	Supply Clock System Control	I/O Port	Bus EXDMAC	(MTU, TPU, TMR, PPG, RTC, CMTW, POE, CAC)	(GPTW, POEG)	(SCI, RSPI, RIIC, CAN, USB, SSIE)	(ETHERC, PMGI)	(QSPI, SDHI, MMCIF)	GLCDC	Interrupt	A/D D/A
72		PE6	D14[A14/ D14]/D6[A6/ D6]	MTIOC6C/ TIC1	GTIOC3B	MOSIB-B		SDHI_CD/ MMC_CD-B	LCD_DAT A10-B	IRQ6	AN104
73		PE5	D13[A13/ D13]/D5[A5/ D5]	MTIOC4C/ MTIOC2B	GTIOC0A	RSPCKB-B	ET0_RX_C LK/ REF50CK0		LCD_DAT A11-B	IRQ5	AN103
74		PE4	D12[A12/ D12]/D4[A4/ D4]	MTIOC4D/ MTIOC1A/ PO28	GTIOC1A	SSLB0-B	ET0_ERXD 2		LCD_DAT A12-B		AN102
75		PE3	D11[A11/ D11]/D3[A3/ D3]	MTIOC4B/ PO26/TOC3/ POE8#	GTIOC2A	CTS12#/ RTS12#/ SS12#	ET0_ERXD	MMC_D7-B	LCD_DAT A13-B		AN101
76		PE2	D10[A10/ D10]/D2[A2/ D2]	MTIOC4A/ PO23/TIC3	GTIOC0B	RXD12/ SMISO12/ SSCL12/ RXDX12/ SSLB3-B		MMC_D6-B	LCD_DAT A14-B	IRQ7-DS	AN100
77		PE1	D9[A9/D9]/ D1[A1/D1]	MTIOC4C/ MTIOC3B/ PO18	GTIOC1B	TXD12/ SMOSI12/ SSDA12/ TXDX12/ SIOX12/ SSLB2-B		MMC_D5-B	LCD_DAT A15-B		ANEX1
78		PE0	D8[A8/D8]/ D0[A0/D0]	MTIOC3D	GTIOC2B	SCK12/ SSLB1-B		MMC_D4-B	LCD_DAT A16-B		ANEX0
79		PD7	D7[A7/D7]	MTIC5U/ POE0#		SSLC3-A		QMI-B/QIO1- B/SDHI_D1-B/ MMC_D1-B	LCD_DAT A17-B	IRQ7	AN107
80		PD6	D6[A6/D6]	MTIC5V/ MTIOC8A/ POE4#		SSLC2-A		QMO-B/QIO0- B/SDHI_D0-B/ MMC_D0-B	LCD_DAT A18-B	IRQ6	AN106
81		PD5	D5[A5/D5]	MTIC5W/ MTIOC8C/ MTCLKA/ POE10#		SSLC1-A		QSPCLK-B/ SDHI_CLK-B/ MMC_CLK-B	LCD_DAT A19-B	IRQ5	AN113
82		PD4	D4[A4/D4]	MTIOC8B/ POE11#		SSLC0-A		QSSL-B/ SDHI_CMD-B/ MMC_CMD-B	LCD_DAT A20-B	IRQ4	AN112
83		PD3	D3[A3/D3]	MTIOC8D/ TOC2/POE8#	GTIOC0A	RSPCKC-A		QIO3-B/ SDHI_D3-B/ MMC_D3-B	LCD_DAT A21-B	IRQ3	AN111
84		PD2	D2[A2/D2]	MTIOC4D/ TIC2	GTIOC0B	MISOC-A/ CRX0		QIO2-B/ SDHI_D2-B/ MMC_D2-B	LCD_DAT A22-B	IRQ2	AN110
85		PD1	D1[A1/D1]	MTIOC4B/ POE0#	GTIOC1A	MOSIC-A/ CTX0			LCD_DAT A23-B	IRQ1	AN109
86		PD0	D0[A0/D0]	POE4#	GTIOC1B				LCD_EXT CLK-B	IRQ0	AN108
87		P47								IRQ15-DS	AN007
88		P46								IRQ14-DS	AN006
89		P45								IRQ13-DS	AN005
90		P44								IRQ12-DS	AN004
91		P43								IRQ11-DS	AN003
92		P42								IRQ10-DS	AN002
93		P41								IRQ9-DS	AN001
94	VREFL0										
95		P40								IRQ8-DS	AN000
96	VREFH0										
97	AVCC0										
98	<u> </u>	P07								IRQ15	ADTRG0#

Table 1.10 List of Pin and Pin Functions (100-Pin LFQFP) (6/6)

Pin Number	Power		Timer	Timer		Communication					
	Supply Clock System Control	I/O Port	Bus EXDMAC	(MTU, TPU, TMR, PPG, RTC, CMTW, POE, CAC)		(SCI, RSPI, RIIC, CAN, USB, SSIE)	(ETHERC, PMGI)	(QSPI, SDHI, MMCIF)	GLCDC	Interrupt	A/D D/A
99	AVSS0										
100		P05				SSILRCK1				IRQ13	DA1

Note 1. P53 is multiplexed with the BCLK pin function, so cannot be used as an I/O port pin when the external bus is enabled.

2. Electrical Characteristics

2.1 Absolute Maximum Ratings

Table 2.1 Absolute Maximum Rating

Conditions: VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = 0 V

Item		Symbol	Value	Unit
Power supply voltage		VCC, VCC_USB	-0.3 to +4.0	V
V _{BATT} power supply voltage		V _{BATT}	-0.3 to +4.0	V
Input voltage (except for ports for 5 V tolerant*1)		V _{in}	-0.3 to VCC + 0.3 (up to 4.0)	V
Input voltage (ports for 5 V tolerant*1)		V _{in}	-0.3 to VCC + 4.0 (up to 5.8)	V
Reference power supply voltage	Э	VREFH0	-0.3 to AVCC0 + 0.3 (up to 4.0)	V
Analog power supply voltage		AVCC0, AVCC1*2	-0.3 to +4.0	V
Analog input voltage		V _{AN}	-0.3 to AVCC + 0.3 (up to 4.0)	V
Junction temperature	D version	T _j	-40 to +105	°C
G version		T _j	-40 to +125	°C
Storage temperature		T _{stg}	-55 to +125	°C

Caution: Permanent damage to the LSI may result if absolute maximum ratings are exceeded.

Note 1. P07, P11 to P17, P20, P21, P30 to P33, P67, and PC0 to PC3 are 5 V tolerant.

Note 2. Connect the AVCC0, AVCC1, and VCC_USB pins to VCC, and the AVSS0, AVSS1, and VSS_USB pins to VSS. When the A/D converter unit 0 is not to be used, connect the VREFH0 pin to VCC and the VREFL0 pin to VSS, respectively. Do not leave these pins open. Insert capacitors of high frequency characteristics between the AVCC0 and AVSS0 pins, or AVCC1 and AVSS1 pins. Place capacitors of about 0.1 μF as close as possible to every power supply pin and use the shortest and heaviest possible traces.

2.2 Recommended Operating Conditions

Table 2.2 Recommended Operating Conditions (1)

Item	Symbol	Min.	Тур.	Max.	Unit
Power supply voltage*1	VCC	2.7	_	3.6	V
	VSS	_	0	_	
V _{BATT} power supply voltage	V _{BATT}	2.0	_	3.6	V
USB power supply voltage	VCC_USB	_	VCC	_	V
	VSS_USB	_	0	_	
Analog power supply voltage*1, *2	AVCC0	_	VCC	_	V
	AVSS0	_	0	_	
	AVCC1	_	VCC	_	
	AVSS1	_	0	_	
	VREFH0	2.7	_	AVCC0	
	VREFL0	_	0	_	
Input voltage (except for 5 V tolerant ports, except for P03, P05 and P40 to P47)*3	V _{in}	-0.3	_	VCC + 0.3	V
Input voltage (P03, P05 and P40 to P47)	V _{in}	-0.3	_	AVCC0 + 0.3	V
Input voltage (5V tolerant ports: P11 to P17, P20, P21, P30 to P33, P67, and PC0 to PC3)*4	V _{in}	-0.3	_	VCC + 3.6 (up to 5.5)	V
Input voltage (5V tolerant port: P07)	V _{in}	-0.3	_	AVCC0 + 3.6 (up to 5.5)	V
Operating temperature (D version)	T _{opr}	-40	_	85	°C
Operating temperature (G version)	T _{opr}	-40	_	105	°C

Note 1. Comply with the following potential condition: VCC = AVCC0 = AVCC1 = VCC_USB

Table 2.3 Recommended Operating Conditions (2)

Item	Symbol	Value
Decoupling capacitance to stabilize the internal voltage	C_VCL	0.22 μF ± 30%* ¹

Note 1. Use a multilayer ceramic capacitor whose nominal capacitance is 0.22 µF and a capacitance tolerance is ±30% or better.

Note 2. For details, refer to section 56.6.11, Voltage Range of Analog Power Supply Pins in the User's Manual: Hardware.

Note 3. P07, P11 to P17, P20, P21, P30 to P33, P67, and PC0 to PC3 are 5 V tolerant.

Note 4. For P30 to P32, input as follows when the V_{BATT} power supply is selected. V_{in} Min. = -0.3, Max. = V_{BATT} + 0.3 (V_{BATT} = 2.0 to 3.6 V)

2.3 DC Characteristics

Table 2.4 DC Characteristics (1)

Conditions: VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 to 3.6 V, 2.7 V \leq VREFH0 \leq AVCC0, VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = 0 V,

	Item	Symbol	Min.	Тур.	Max.	Unit	Test Conditions
Schmitt trigger	IRQ input pin*1,	V _{IH}	0.8 × VCC	_	_	V	
input voltage	MTU input pin*1, POE input pin*1,	V _{IL}	_	_	0.2 × VCC		
	TPU input pin*1, TMR input pin*1, CMTW input pin*1, SCI input pin*1, CAN input pin*1, CAC input pin*1, ADTRG# input pin*1, QSPI input pin*1, SSIE input pin*1, SSIE input pin*1, GPTW input pin*1, POEG input pin*1, RES#, NMI, TCK	ΔV_{T}	0.06 × VCC	_			
	RIIC input pin	V _{IH}	0.7 × VCC	_	_		
	(except for SMBus)	V_{IL}	_	_	0.3 × VCC		
		ΔV_{T}	0.05 × VCC	_	_		
	Ports for 5 V tolerant*2	V _{IH}	0.8 × VCC	_	_		
		V _{IL}	_	_	0.2 × VCC		
	Other input pins excluding ports	V_{IH}	0.8 × VCC	_	_		
	for 5 V tolerant*3	V _{IL}	_	_	0.2 × VCC		
High level input	MD pin, EMLE	V_{IH}	0.9 × VCC	_	_	V	
voltage (except for Schmitt trigger input pin)	EXTAL, RSPI input pin, EXDMAC input pin, WAIT#, SDHI input pin, MMC input pin, PDC input pin, PMGI input pin		0.8 × VCC	_	_		
	ETHERC input pin		2.3	_	_		
	D0 to D31		0.7 × VCC	_	_		
	RIIC (SMBus)		2.1	_	_		
Low level input	MD pin, EMLE	V_{IL}	_	_	0.1 × VCC	V	
voltage (except for Schmitt trigger input pin)	EXTAL, RSPI input pin, ETHERC input pin, EXDMAC input pin, WAIT#, SDHI input pin, MMC input pin, PDC input pin, PMGI input pin		_	_	0.2 × VCC		
	D0 to D31		_		0.3 × VCC		
	RIIC (SMBus)		_	_	0.8		

Note 1. This does not include the pins, which are multiplexed as ports for 5 V tolerant.

Note 2. P07, P11 to P17, P20, P21, P30 to P33, P67, and PC0 to PC3 are 5 V tolerant. Note 3. For P30 to P32, input as follows when the V_{BATT} power supply is selected. V_{IH} Min. = $V_{BATT} \times 0.8$, V_{IL} Max. = $V_{BATT} \times 0.2$ ($V_{BATT} = 2.0$ to 3.6 V)

Table 2.5 DC Characteristics (2)

Conditions: $VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 \text{ to } 3.6 \text{ V}, 2.7 \text{ V} \le VREFH0 \le AVCC0}, VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = 0 \text{ V},$

	Item	Symbol	Min.	Тур.	Max.	Unit	Test Conditions
Output high voltage	All output pins	V _{OH}	VCC - 0.5	_	_	V	I _{OH} = -1 mA
Output low voltage	All output pins (except for RIIC pins and ETHERC output pin)	V _{OL}	_	_	0.5	V	I _{OL} = 1.0 mA
	RIIC output pin		_	_	0.4		I _{OL} = 3.0 mA
			_	_	0.6		I _{OL} = 6.0 mA
	RIIC output pin (only P12 and P13 in channel 0)	V _{OL}	_	_	0.4	V	I _{OL} = 15.0 mA (ICFER.FMPE = 1)
			_	0.4	_		I _{OL} = 20.0 mA (ICFER.FMPE = 1)
	ETHERC output pin	V _{OL}	_	_	0.4	V	I _{OL} = 1.0 mA
Input leakage current	RES#, MD pin, EMLE*1, BSCANP*1, NMI	I _{in}	_	_	1.0	μA	$V_{in} = 0 V$ $V_{in} = VCC$
Three-state leakage current (off state)	Other than ports for 5 V tolerant	I _{TSI}	_	_	1.0	μA	V _{in} = 0 V V _{in} = VCC
	Ports for 5 V tolerant		_	_	5.0		V _{in} = 0 V V _{in} = 5.5 V
Input pull-up resistor current	Other than P35	I _p	-300	_	-10	μA	VCC = 2.7 to 3.6 V V _{in} = 0 V
Input pull-down resistor current	EMLE, BSCANP	I _p	10	_	300	μA	V _{in} = VCC
Input capacitance	All input pins (except for P03, P05, P12, P13, P16, P17, P20, P21, EMLE, BSCANP, USB0_DP, and USB0_DM)	C _{in}	_	_	8	pF	Vbias = 0 V Vamp = 20 mV f = 1 MHz T _a = 25°C
	P03, P05, P12, P13, P16, P17, P20, P21, EMLE, BSCANP, USB0_DP, and USB0_DM		_	_	16		
Output voltage of the	VCL pin	V_{CL}	_	1.18	_	V	

Note 1. The input leakage current value at the EMLE and BSCANP pins are only when V_{in} = 0 V.

Table 2.6 DC Characteristics (3)

Conditions: VCC = AVCC0 = AVCC1 = VCC_USB = 2.7 to 3.6 V, 2.7 V ≤ VREFH0 ≤ AVCC0,

VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = 0 V,

			ltan		C: made al	D ve	rsion	G ve	rsion	l lait	Took Conditions
			Iten	1	Symbol	Тур.	Max.	Тур.	Max.	Unit	Test Conditions
Supply		Full opera	tion* ²		I _{CC} *3	_	261	_	319	mA	ICLK = 240 MHz,
current *1		Normal operation	Peripher	al module clocks are supplied		61	_	61	_		PCLKA = 120 MHz, PCLKB = 60 MHz,
	de		Peripher *4, *5	al module clocks are stopped		30	_	30	_		PCLKC = 60 MHz, PCLKD = 60 MHz, FCLK = 60 MHz,
	ing mo	Core Mark	Peripher *4, *5	al module clocks are stopped		37	_	37	_		BCLK = 120 MHz, BCLK pin = 60 MHz
	operating mode	Sleep mod supplied*4		eral module clocks are		42	144	42	196		·
	eq	All module	clock sto	pp mode (reference value)		14	115	14	167		
	operation*8 memory memory Reading memory mem		Reading from the code flash memory while the data flash memory is being programmed		6	_	6	_			
		Reading from the code flash memory while the code flash memory is being programmed		7	_	7	_				
		Increased	by Truste	d Secure IP operation		_	15	_	15		
	Low-speed operating mode 1: Peripheral module clocks are stopped*4 Low-speed operating mode 2: Peripheral module clocks are stopped*4			4.2	_	4.2	_		All clocks 1 MHz		
				4.2	_	4.2			All clocks 32.768 kHz		
	Sof	ware stand	-			3.95	107	3.95	155		
	qe			o the standby RAM and USB nit (USB0 only)		15.5	70	15.5	98	μA	
	standby mode	Power is r supplied to standby R	the AM and	Low power consumption function of the power-on reset circuit is disabled*6		11.5	42	11.5	58		
	tware sta	USB resur detecting ((USB0 onl	unit	Low power consumption function of the power-on reset circuit is enabled*7		4.9	32	4.9	47		
	Deep software	Increase of by operation		When a low C _L crystal is in use		1	_	1	_		
				When a standard C _L crystal is in use		2	_	2			
	ope	en the RTC rating while	VCC is	When a low C _L crystal is in use		0.9	_	0.9	_		V _{BATT} = 2.0 V, VCC = 0 V
	not supplied (Only the RTC and sub-clock oscillator operate with the battery backup				1.6	_	1.6			V _{BATT} = 3.3 V, VCC = 0 V	
			When a standard C _L crystal is in use		1.7	_	1.7	_		V _{BATT} = 2.0 V, VCC = 0 V	
	3.10	···,				3.3	_	3.3	_		V _{BATT} = 3.3 V, VCC = 0 V
	retu	ush current urning from tware stand	deep	Inrush current*9	I _{RUSH}		211	_	211	mA	

Supply current values are measured when all output pins are unloaded and all input pull-up resistors are disabled. Note 1.

Note 2.

Note 3.

Peripheral module clocks are supplied.

I_{CC} depends on the f (ICLK) as follows.

(when ICLK : PCLKA : PCLKB/PCLKC/PCLKD : BCLK : BCLK pin = 4 : 2 : 1 : 2 : 1 and EXTAL = 12 MHz)

 I_{CC} max. = 0.62 x f + 113 (full operation in high-speed operating mode)

 I_{CC} typ. = 0.22 x f + 7 (normal operation in high-speed operating mode)

 I_{CC} typ. = 0.50 x f + 3.7 (ICLK 1 MHz max) (low-speed operating mode 1)

 I_{CC} max. = 0.13 x f + 113 (sleep mode)

- - I_{CC} max. = 0.65 x f + 164 (full operation in high-speed operating mode)
 - I_{CC} typ. = 0.22 x f + 7 (normal operation in high-speed operating mode)
 - I_{CC} typ. = 0.50 x f + 3.7 (ICLK 1 MHz max) (low-speed operating mode 1)
 - I_{CC} max. = 0.13 x f + 164 (sleep mode)
- Note 4. Whether the peripheral module clocks are supplied or stopped is controlled only by the bit settings in the module stop control registers A to D.
- Note 5.
- When the peripheral module clock is stopped, the settings of the clock frequency are as follows: ICLK = 240 MHz and PCLKA = PCLKB = PCLKC = PCLKD = FCLK = BCLK = BCLK pin = 3.75 MHz (divided by 64).
- When the low power consumption function is disabled, the DEEPCUT[1:0] bits are set to 01b.
- When the low power consumption function is enabled, the DEEPCUT[1:0] bits are set to 11b.
- Note 8. These are the increases during programming of the code flash memory after the code flash memory (limitations apply to the combinations of address ranges of the program area and the readable area) or the data flash memory has been programmed or erased.
- Note 9. Reference value

Table 2.7 DC Characteristics (4)

 $VCC = AVCC0 = AVCC1 = VCC_USB = 2.7 \text{ to } 3.6 \text{ V}, 2.7 \text{ V} \le VREFH0 \le AVCC0,}$ Conditions:

VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = 0 V,

 $T_a = T_{opr}$

	Item		Symbol	l	D version	on	(G version	on	Unit	Test Conditions
	цеш		Symbol	Min.	Тур.	Max.	Min.	Тур.	Max.	Offic	Test Conditions
Analog	During 12-bit A	A/D conversion (unit 0)	Al _{CC}	_	0.8	1	_	0.8	1	mA	IAVCC0_AD
power supply current*1, *3		A/D conversion (unit 0) dedicated sample-and- 3 channels)		_	1.7	2.5	_	1.7	2.5		IAVCC0_AD + SH
	During 12-bit A	A/D conversion (unit 1)		_	0.6	1	_	0.6	1		IAVCC1_AD
	During 12-bit A + temperature	A/D conversion (unit 1) sensor		_	0.7	1.1	_	0.7	1.1		IAVCC1_AD + TEMP
	During D/A	Unbuffered output		_	0.25	0.4		0.25	0.4		IAVCC1_DA
	conversion (2 channels)	Buffered output		_	0.75	1.1	_	0.75	1.1		
	Waiting for A/D, D/A, and temperature sensor conversion (all units)			_	0.9	1.4	_	0.9	1.4		IAVCC0 + IAVCC1
	, ,	temperature sensor mode (all units)		_	1.4	6.7	_	1.4	9.0	μA	IAVCC0 + IAVCC1
Reference	During 12-bit A	A/D conversion (unit 0)	Al _{REFH}	_	38	60	_	38	60	μΑ	IVREFH0
power supply current	Waiting for 12 (unit 0)	-bit A/D conversion		_	0.07	0.5	_	0.07	0.6		IVREFH0
odiront	12-bit A/D con mode (unit 0)	verter in module stop		_	0.07	0.4	_	0.07	0.5		IVREFH0
USB	Low speed	USB0	I _{CCUSBLS}	_	3.7	6.5	_	3.7	6.5	mA	VCC_USB
operating current	Full speed	USB0	I _{CCUSBFS}	_	4.2	10	_	4.2	10	mA	VCC_USB
RAM retensi	on voltage		V_{RAM}	2.7	_	_	2.7	_	_	V	
VCC rising g	radient		SrVCC	8.4	_	20000	8.4	_	20000	µs/V	
VCC falling	gradient*2		SfVCC	8.4	_		8.4			µs/V	

Note 1. The reference power supply current is included in the power supply current value for 12-bit A/D converter (unit 1) and D/A converter.

Note 3. Supply current values are measured when all output pins are unloaded.

Note 2. This applies when V_{BATT} is used.

Table 2.8 **Permissible Output Currents**

Conditions: $VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 \text{ to } 3.6 \text{ V}, 2.7 \text{ V} \le VREFH0 \le AVCC0, VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = 0 V,$

 $T_a = T_{opr}$

	Item		Symbol	Min.	Тур.	Max.	Unit
Permissible output low current	All output pins*1	Normal drive	l _{OL}	_	_	2.0	mA
(average value per pin)	All output pins*2	High drive	Ī	_	_	3.8	
	All output pins*3	High-speed interface high-drive	1	_	_	7.5	
Permissible output low current	All output pins*1	Normal drive	l _{OL}	_	_	4.0	mA
(max. value per pin)	All output pins*2	High drive	1	_	_	7.6	
	All output pins*3	High-speed interface high-drive	1	_	_	15	
Permissible output low current (total)	Total of all output p	ins	ΣI _{OL}	_	_	80	mA
Permissible output high current	All output pins*1	Normal drive	I _{OH}	_	_	-2.0	mA
(average value per pin)	All output pins*2	High drive		_	_	-3.8	
	All output pins*3	High-speed interface high-drive		_	_	-7.5	
Permissible output high current	All output pins*1	Normal drive	I _{OH}	_	_	-4.0	mA
(max. value per pin)	All output pins*2	High drive	1	_	_	-7.6	
	All output pins*3	High-speed interface high-drive	1	_	_	-15	
Permissible output high current (total)	Total of all output p	ins	ΣI _{OH}	_	_	-80	mA

Caution: To protect the MCU's reliability, the output current values should not exceed the values in Table 2.8.

Note 3. This is the value when high-speed interface high-driving ability is set with a pin for which high-speed interface high-driving ability is selectable.

Table 2.9 Thermal Resistance Value (Reference)

Item	Package	Symbol	Max.	Unit	Test Conditions	
Thermal resistance	176-pin LFQFP (PLQP0176KB-C)	θ_{ja}	31.5	°C/W	JESD51-2 and	
	144-pin LFQFP (PLQP0144KA-B)		32.6		JESD51-7 compliant	
	100-pin LFQFP (PLQP0100KB-B)		34.0			
	224-pin LFBGA (PLBG0224GA-A)		23.1		JESD51-2 and	
	176-pin LFBGA (PLBG0176GA-A)		30.5		JESD51-9 compliant	
	145-pin TFLGA (PTLG0145KA-A)		22.9			
	176-pin LFQFP (PLQP0176KB-C)	Ψ_{jt}	0.4	°C/W	JESD51-2 and	
	144-pin LFQFP (PLQP0144KA-B)		0.5		JESD51-7 compliant	
	100-pin LFQFP (PLQP0100KB-B)		0.6			
	224-pin LFBGA (PLBG0224GA-A)		0.2		JESD51-2 and	
	176-pin LFBGA (PLBG0176GA-A)		0.3		JESD51-9 compliant	
	145-pin TFLGA (PTLG0145KA-A)		0.2	1		

The values are reference values when the 4-layer board is used. Thermal resistance depends on the number of layers or size of Note: the board. For details, refer to the JEDEC standards.

Note 1. This is the value when normal driving ability is set with a pin for which normal driving ability is selectable.

Note 2. This is the value when high driving ability is set with a pin for which normal driving ability is selectable or the value of the pin to which high driving ability is fixed.

2.4 **AC Characteristics**

Table 2.10 Operating Frequency (High-Speed Operating Mode)

Conditions: VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 to 3.6 V, 2.7 V \leq VREFH0 \leq AVCC0, VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = 0 V,

 $T_a = T_{opr}$

	Item		Symbol	Min.	Тур.	Max.	Unit		
Operating	System clock (ICLK)		f	_	_	240	MHz		
frequency	Peripheral module clock (PC	CLKA)		_	_	120			
	Peripheral module clock (PC	Peripheral module clock (PCLKB)				60			
	Peripheral module clock (PC			_	60				
	Peripheral module clock (PC			_	60				
	Flash-IF clock (FCLK)			_	60				
	External bus clock (BCLK)	Package of 144 pins or more			_	120			
		100-pin package		_	_	60			
	BCLK pin output	Package of 144 pins or more		_	T -	80			
		100-pin package		_	_	30			
	SDRAM clock (SDCLK)	Package of 144 pins or more		1		_	_	80	
	SDCLK pin output	Package of 144 pins or more		_	_	80			

Note 1. The FCLK must run at a frequency of at least 4 MHz when changing the flash memory contents.

Table 2.11 Operating Frequency (Low-Speed Operating Mode 1)

Conditions: $VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 \text{ to } 3.6 \text{ V}, 2.7 \text{ V} \le VREFH0 \le AVCC0,}$

VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = 0 V,

	Item		Symbol	Min.	Тур.	Max.	Unit
Operating	System clock (ICLK)		f	_	_	1	MHz
frequency	Peripheral module clock (Pe	CLKA)		_	_	1	
	Peripheral module clock (Pe	CLKB)		_	_	1	
	Peripheral module clock (Pe		_	_	1		
	Peripheral module clock (Po		_	_	1		
	Flash-IF clock (FCLK)			_	_	1	
	External bus clock (BCLK)			_	_	1	
	BCLK pin output		_	_	1		
	SDRAM clock (SDCLK) Package of 144 pins or more SDCLK pin output Package of 144 pins or more			_	_	1	
			1	_	_	1	

Note 1. When the 12-bit A/D converter is used, the frequency must be set to at least 1 MHz.

Table 2.12 Operating Frequency (Low-Speed Operating Mode 2)

Conditions: $VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 \text{ to } 3.6 \text{ V}, 2.7 \text{ V} \le VREFH0 \le AVCC0, VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = 0 V,$

	Item		Symbol	Min.	Тур.	Max.	Unit	
Operating	System clock (ICLK)		f	32	_	264	kHz	
frequency	Peripheral module clock (P	CLKA)		_	_	264		
	Peripheral module clock (P	Peripheral module clock (PCLKB)				264		
	Peripheral module clock (PCLKC)*1				_	264		
	Peripheral module clock (P		_	_	264			
	Flash-IF clock (FCLK)	Flash-IF clock (FCLK)				264		
	External bus clock (BCLK)			_	_	264		
	BCLK pin output			_	_	264		
	SDRAM clock (SDCLK)	Package of 144 pins or more	1		_	_	264	
	SDCLK pin output	SDCLK pin output Package of 144 pins or more			_	264		

Note 1. The 12-bit A/D converter cannot be used.

2.4.1 **Reset Timing**

Table 2.13 Reset Timing

Conditions: VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 to 3.6 V, 2.7 V \leq VREFH0 \leq AVCC0, VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = 0 V,

	Item	Symbol	Min.	Тур.	Max.	Unit	Test Conditions
RES# pulse	Power-on	t _{RESWP}	1	_	_	ms	Figure 2.1
width	Deep software standby mode	t _{RESWD}	0.6	_	_	ms	Figure 2.2
	Software standby mode, low-speed operating mode 2	t _{RESWS}	0.3	_	_	ms	
	Programming or erasure of the code flash memory, or programming, erasure or blank checking of the data flash memory	t _{RESWF}	200	_	_	μs	
	Other than above	t _{RESW}	200	_	_	μs	
Waiting time a	fter release from the RES# pin reset	t _{RESWT}	54	_	55	t _{Lcyc}	Figure 2.1
Internal reset time (independent watchdog timer reset, watchdog timer reset, software reset)		t _{RESW2}	100	_	108	t _{Lcyc}	

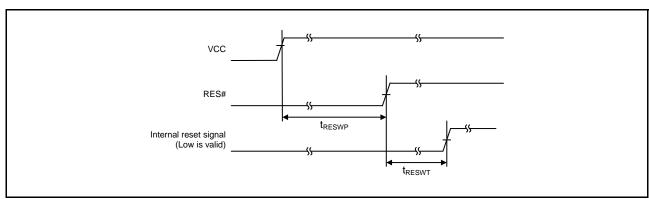


Figure 2.1 **Reset Input Timing at Power-On**

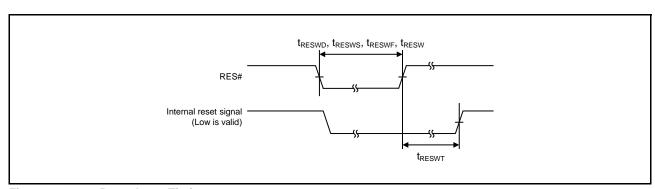


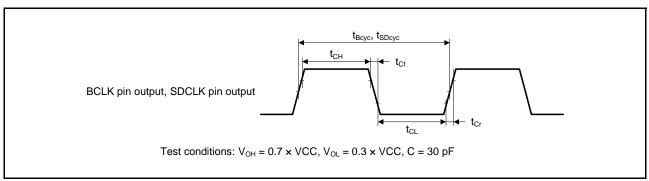
Figure 2.2 **Reset Input Timing**

Clock Timing 2.4.2

Table 2.14 BCLK Pin Output, SDCLK Pin Output Clock Timing

Conditions: VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 to 3.6 V, 2.7 V \leq VREFH0 \leq AVCC0, VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = 0 V,

Item		Symbol	Min.	Тур.	Max.	Unit	Test Conditions
BCLK pin output cycle time	Package of 144 pins or more	t _{Bcyc}	12.5	_	_	ns	Figure 2.3
	100-pin package		33.2	_	_		
BCLK pin output high pulse width		t _{CH}	3.25	_	_	ns	
BCLK pin output low pulse width		t _{CL}	3.25	_	_	ns	
BCLK pin output rising time		t _{Cr}	_	_	3	ns	
BCLK pin output falling time		t _{Cf}	_	_	3	ns	
SDCLK pin output cycle time	Package of 144 pins or	t _{Bcyc}	12.5	_	_	ns	
SDCLK pin output high pulse width	more	t _{CH}	3.25	_	_	ns	
SDCLK pin output low pulse width		t _{CL}	3.25	_	_	ns	
SDCLK pin output rising time		t _{Cr}	_	_	3	ns	
SDCLK pin output falling time		t _{Cf}	_	_	3	ns	



BCLK Pin and SDCLK Pin Output Timing Figure 2.3

Table 2.15 EXTAL Clock Timing

Conditions: $VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 \text{ to } 3.6 \text{ V}, 2.7 \text{ V} \le VREFH0 \le AVCC0, VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = 0 V,$

 $T_a = T_{opr}$

Item	Symbol	f _{EXM}	_{AIN} ≤ 24	MHz	f _{EXM}	_{AIN} > 24	MHz	Unit	Test	
item	Syllibol	Min.	Тур.	Max.	Min.	Тур.	Max.	Offic	Conditions	
EXTAL external clock input cycle time	t _{EXcyc}	41.66	_	_	33.33	_	_	ns	Figure 2.4	
EXTAL external clock input frequency	f _{EXMAIN}	_	_	24	_	_	30	MHz		
EXTAL external clock input high pulse width	t _{EXH}	15.83	_	_	13.33	_	_	ns		
EXTAL external clock input low pulse width	t _{EXL}	15.83	_	_	13.33	_	_	ns		
EXTAL external clock rising time	t _{EXr}		_	5			5	ns		
EXTAL external clock falling time	t _{EXf}		_	5		_	5	ns		

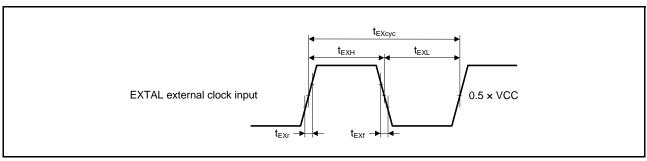


Figure 2.4 **EXTAL External Clock Input Timing**

Table 2.16 Main Clock Timing

Conditions: $VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 \text{ to } 3.6 \text{ V}, 2.7 \text{ V} \le VREFH0 \le AVCC0,$

VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = 0 V,

 $T_a = T_{opr}$

Item	Symbol	Min.	Тур.	Max.	Unit	Test Conditions
Main clock oscillation frequency	f _{MAIN}	8	_	24	MHz	
Main clock oscillator stabilization time (crystal)	t _{MAINOSC}	_	_	*1	ms	Figure 2.5
Main clock oscillation stabilization wait time (crystal)	t _{MAINOSCWT}	_	_	*2	ms	

Note 1. When using a main clock, ask the manufacturer of the oscillator to evaluate its oscillation. Refer to the results of evaluation provided by the manufacturer for the oscillation stabilization time.

The number of cycles selected by the value of the MOSCWTCR.MSTS[7:0] bits determines the main clock oscillation stabilization wait time in accord with the formula below.

 $t_{MAINOSCWT} = [(MSTS[7:0] bits \times 32) + 10] / f_{LOCO}$

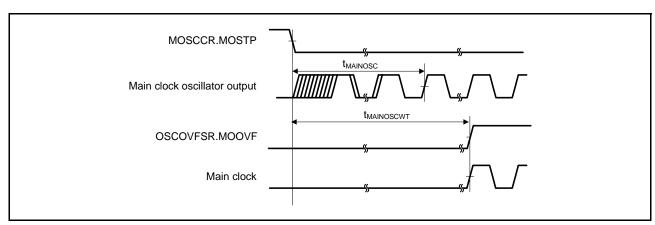


Figure 2.5 **Main Clock Oscillation Start Timing**

Table 2.17 LOCO and IWDT-Dedicated Low-Speed Clock Timing

Conditions: $VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 \text{ to } 3.6 \text{ V}, 2.7 \text{ V} \le VREFH0 \le AVCC0}, VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = 0 \text{ V},$

Item	Symbol	Min.	Тур.	Max.	Unit	Test Conditions
LOCO clock cycle time	t _{Lcyc}	4.63	4.16	3.78	μs	
LOCO clock oscillation frequency	f _{LOCO}	216	240	264	kHz	
LOCO clock oscillation stabilization wait time	t _{LOCOWT}	_	_	44	μs	Figure 2.6
IWDT-dedicated low-speed clock cycle time	t _{ILcyc}	9.26	8.33	7.57	μs	
IWDT-dedicated low-speed clock oscillation frequency	f _{ILOCO}	108	120	132	kHz	
IWDT-dedicated low-speed clock oscillation stabilization wait time	t _{ILOCOWT}	_	142	190	μs	Figure 2.7

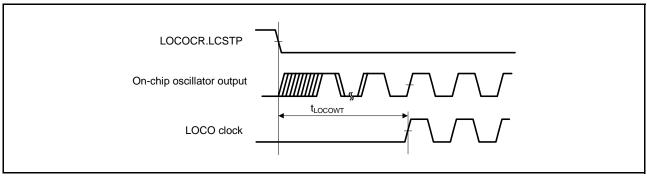


Figure 2.6 **LOCO Clock Oscillation Start Timing**

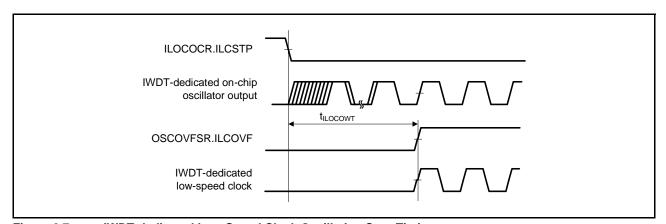


Figure 2.7 **IWDT-dedicated Low-Speed Clock Oscillation Start Timing**

Table 2.18 HOCO Clock Timing

Conditions: $VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 \text{ to } 3.6 \text{ V}, 2.7 \text{ V} \le VREFH0 \le AVCC0}, VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = 0 \text{ V},$

Item	Symbol	Min.	Тур.	Max.	Unit	Test Conditions
HOCO clock oscillation frequency	f _{HOCO}	15.61	16	16.39	MHz	T _a ≥ -20°C
		17.56	18	18.44		
		19.52	20	20.48		
		15.52	16	16.48		-40 °C $\leq T_a < -20$ °C
		17.46	18	18.54		
		19.4	20	20.6		
HOCO clock oscillation stabilization wait time	t _{HOCOWT}	_	105	149	μs	Figure 2.8
HOCO clock power supply stabilization time	t _{HOCOP}	_	_	150	μs	Figure 2.9

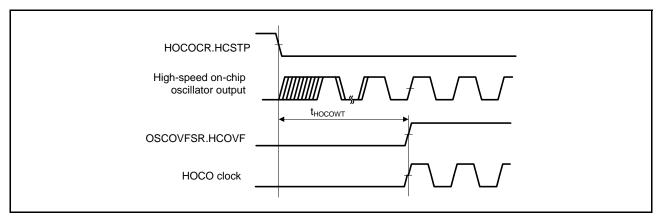


Figure 2.8 HOCO Clock Oscillation Start Timing (Oscillation is Started by Setting the HOCOCR.HCSTP Bit)

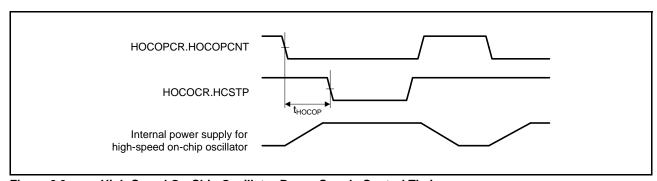


Figure 2.9 **High-Speed On-Chip Oscillator Power Supply Control Timing**

Table 2.19 PLL/PPLL Clock Timing

Conditions: $VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 \text{ to } 3.6 \text{ V}, 2.7 \text{ V} \leq VREFH0 \leq AVCC0,}$

VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = 0 V,

 $T_a = T_{opr}$

Item	Symbol	Min.	Тур.	Max.	Unit	Test Conditions
PLL/PPLL clock oscillation frequency	f _{PLL}	120	_	240	MHz	
PLL/PPLL clock oscillation stabilization wait time	t _{PLLWT}	_	259	320	μs	Figure 2.10

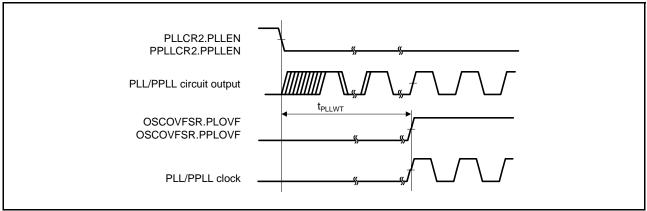


Figure 2.10 PLL/PPLL Clock Oscillation Start Timing

Table 2.20 Sub-Clock Timing

Conditions: $VCC = AVCC0 = AVCC1 = VCC_USB = 2.7 \text{ to } 3.6 \text{ V}, 2.7 \text{ V} \le VREFH0 \le AVCC0,}$

VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = 0 V,

 $V_{BATT} = 2.0 \text{ to } 3.6 \text{ V}, T_a = T_{opr}$

Item	Symbol	Min.	Тур.	Max.	Unit	Test Conditions
Sub-clock oscillation frequency	f _{SUB}	_	32.768	_	kHz	
Sub-clock oscillation stabilization time	t _{SUBOSC}	_	_	*1	s	Figure 2.11
Sub-clock oscillation stabilization wait time	t _{SUBOSCWT}	_	_	*2	s	

Note 1. When using a sub-clock, ask the manufacturer of the oscillator to evaluate its oscillation. Refer to the results of evaluation provided by the manufacturer for the oscillation stabilization time.

Note 2. The number of cycles selected by the value of the SOSCWTCR.SSTS[7:0] bits determines the sub-clock oscillation stabilization wait time in accord with the formula below.

 $t_{SUBOSCWT} = [(SSTS[7:0] \text{ bits } \times 16384) + 10] / f_{LOCO}$

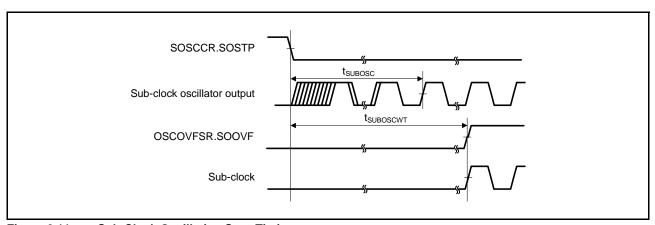


Figure 2.11 Sub-Clock Oscillation Start Timing

Table 2.21 CLKOUT Pin Output Timing

Conditions: VCC = AVCC0 = AVCC1 = VCC_USB = 2.7 to 3.6 V, 2.7 V ≤ VREFH0 ≤ AVCC0,

VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = 0 V,

 $V_{BATT} = 2.0 \text{ to } 3.6 \text{ V}, T_a = T_{opr},$

High-drive output is selected by the driving ability control register

Item	Symbol	Min.	Тур.	Max.	Unit	Test Conditions
CLKOUT pin output cycle time	t _{Ccyc}	25	_	_	ns	Figure 2.12
CLKOUT pin output high pulse width*1	t _{CH}	5	_	_	ns	$t_{Ccyc} = 25 \text{ ns}$
CLKOUT pin output low pulse width*1	t _{CL}	5	_	_	ns	
CLKOUT pin output rising time	t _{Cr}	_	_	5	ns	
CLKOUT pin output falling time	t _{Cf}	_	_	5	ns	

Note 1. If the main clock oscillator is selected by the CLKOUT output source select bit (CKOCR.CKOSEL[2:0]) and the external clock input is selected by the main clock oscillator switching bit (MOFCR.MOSEL), the pulse width depends on the input clock wave form.

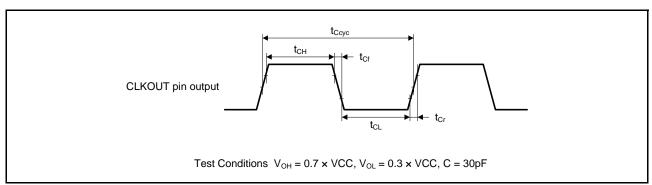


Figure 2.12 CLKOUT Pin Output Timing

Table 2.22 CLKOUT25M Pin Output Timing

Conditions: VCC = AVCC0 = AVCC1 = VCC_USB = 2.7 to 3.6 V, 2.7 V ≤ VREFH0 ≤ AVCC0,

VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = 0 V,

 $V_{BATT} = 2.0 \text{ to } 3.6 \text{ V}, T_a = T_{opr},$

High-speed interface high-drive is selected by the driving ability control register

Item	Symbol	Min.	Тур.	Max.	Unit	Test Conditions
CLKOUT25M pin output cycle time	t _{Ccyc}	_	40	_	ns	Figure 2.13
CLKOUT25M pin output high pulse width	t _{CH}	13	_	_	ns	-
CLKOUT25M pin output low pulse width	t _{CL}	13	_	_	ns	-
CLKOUT25M pin output rising time	t _{Cr}	_	_	3	ns	
CLKOUT25M pin output falling time	t _{Cf}	_	_	3	ns	1

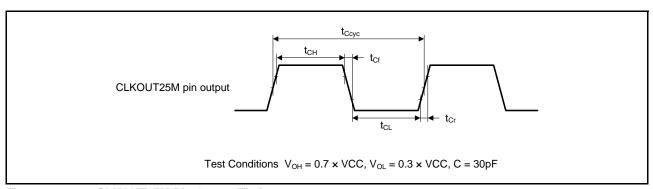


Figure 2.13 CLKOUT25M Pin Output Timing

2.4.3 Timing of Recovery from Low Power Consumption Modes

Table 2.23 Timing of Recovery from Low Power Consumption Modes (1)

Conditions: $VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 \text{ to } 3.6 \text{ V}, 2.7 \text{ V} \le VREFH0 \le AVCC0,}$

VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = 0 V,

	Item		Symbol	Min.	Typ	Max	ζ.	Unit	Test
	item		Symbol	IVIII I.	Тур.	t _{SBYOSCWT} *2	t _{SBYSEQ} *3	Offic	Conditions
Recovery time from software standby mode	Crystal resonator connected to	onator oscillator + 76} / 0.216		100 + 7 / f _{ICLK} + 2n / f _{MAIN}	μs	Figure 2.14			
*1	main clock oscillator	Main clock oscillator and PLL circuit operating	t _{SBYPC}			{(MSTS[7:0] bit × 32) + 138} / 0.216	100 + 7 / f _{ICLK} + 2n / f _{PLL}		
	External clock input to main clock oscillator	Main clock oscillator operating	t _{SBYEX}			352	100 + 7 / f _{ICLK} + 2n / f _{EXMAIN}		
		Main clock oscillator and PLL circuit operating	t _{SBYPE}			639	100 + 7 / f _{ICLK} + 2n / f _{PLL}		
	Sub-clock oscill	ator operating	t _{SBYSC}			{(SSTS[7:0] bit × 16384) + 13} / 0.216 + 10 / f _{FCLK}	100 + 4 / f _{ICLK} + 2n / f _{SUE}		
	High-speed on-chip oscillator operating	High-speed on-chip oscillator operating	t _{SBYHO}			454	100 + 7 / f _{ICLK} + 2n / f _{HOCO}		
		High-speed on-chip oscillator operating and PLL circuit operating				741	100 + 7 / f _{ICLK} + 2n / f _{PLL}		
	Low-speed on-operating*4	chip oscillator	t _{SBYLO}			338	100 + 7 / f _{ICLK} + 2n / f _{LOCO}		

Note 1. The time for recovery from software standby mode is determined by the value obtained by adding the oscillation stabilization waiting time (t_{SBYOSCWT}) and the time required for operations by the software standby release sequencer (t_{SBYSEQ}).

Note 2. When several oscillators were running before the transition to software standby, the greatest value of the oscillation stabilization waiting time $t_{SBYOSCWT}$ is selected.

Note 3. For n, the greatest value is selected from among the internal clock division settings.

Note 4. This condition applies when f_{ICLK} : $f_{FCLK} = 1:1$, 2:1, or 4:1.

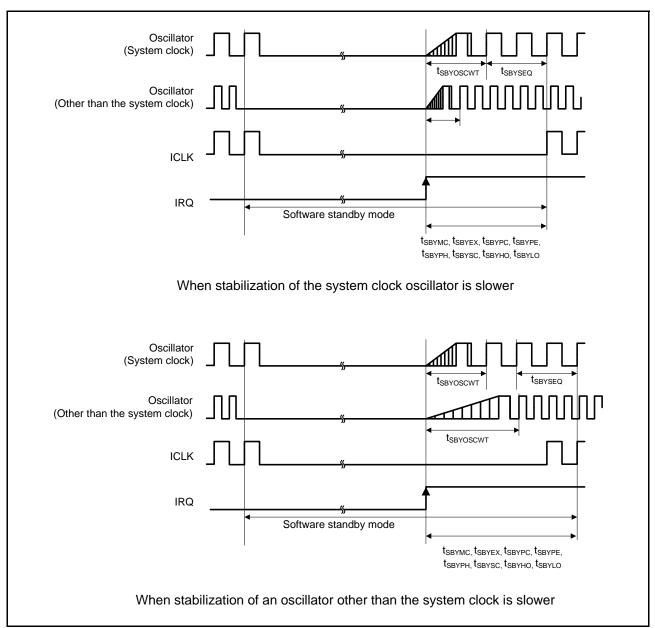


Figure 2.14 Software Standby Mode Recovery Timing

2. Electrical Characteristics RX72N Group

Table 2.24 Timing of Recovery from Low Power Consumption Modes (2)

Conditions: $VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 \text{ to } 3.6 \text{ V}, 2.7 \text{ V} \le VREFH0 \le AVCC0}, VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = 0 \text{ V},$

Item	Symbol	Min.	Тур.	Max.	Unit	Test Conditions
Recovery time from deep software standby mode	t _{DSBY}	_	_	0.9	ms	Figure 2.15
Wait time after recovery from deep software standby mode	t _{DSBYWT}	23	_	24	t _{Lcyc}	

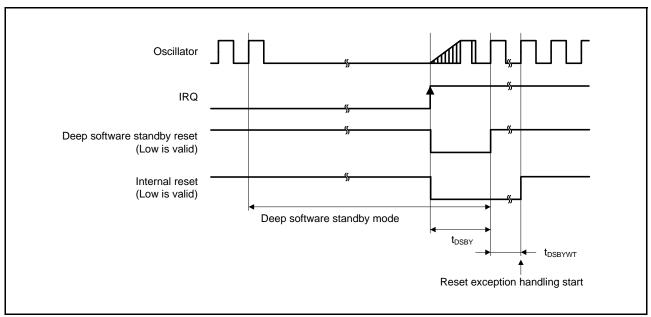


Figure 2.15 **Deep Software Standby Mode Recovery Timing**

2. Electrical Characteristics RX72N Group

Control Signal Timing 2.4.4

Table 2.25 Control Signal Timing

Conditions: VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 to 3.6 V, 2.7 V \leq VREFH0 \leq AVCC0, VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = 0 V,

PCLKB = 8 to 60 MHz, $T_a = T_{opr}$

Item	Symbol	Min.*1	Тур.	Max.	Unit	Test Conditions*1
NMI pulse width	t _{NMIW}	200	_	_	ns	t _{PBcyc} × 2 ≤ 200 ns, Figure 2.16
		t _{PBcyc} × 2	_	_		t _{PBcyc} × 2 > 200 ns, Figure 2.16
IRQ pulse width	t _{IRQW}	200	_	_	ns	t _{PBcyc} × 2 ≤ 200 ns, Figure 2.17
		t _{PBcyc} × 2	_	_		t _{PBcyc} × 2 > 200 ns, Figure 2.17

Note 1. t_{PBcyc} : PCLKB cycle

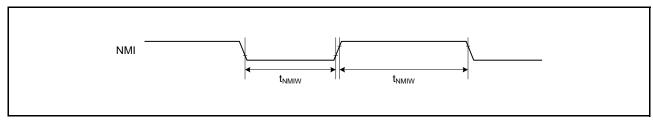


Figure 2.16 **NMI Interrupt Input Timing**

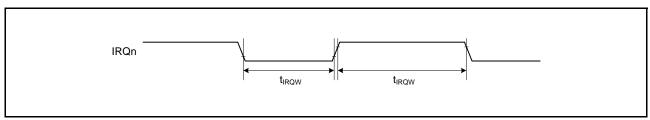


Figure 2.17 **IRQ Interrupt Input Timing**

2.4.5 Bus Timing

Table 2.26 Bus Timing

Conditions 1: VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 to 3.6 V, 2.7 V \leq VREFH0 \leq AVCC0,

VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = 0 V,

ICLK = 8 to 240 MHz, PCLKA = 8 to 120 MHz, PCLKB = BCLK = SDCLK = 8 to 60 MHz, $T_a = T_{opr}$,

Output load conditions: V_{OH} = 0.5 × VCC, V_{OL} = 0.5 × VCC, C = 30 pF,

High-drive output is selected by the driving ability control register.

Conditions 2: VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 3.0 to 3.6 V, 3.0 V \leq VREFH0 \leq AVCC0,

VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = 0 V,

ICLK = 60 to 240 MHz, PCLKA = 8 to 120 MHz, PCLKB = 8 to 60 MHz, 60 MHz < BCLK = SDCLK ≤ 80 MHz,

 $T_a = T_{opr}$

Output load conditions: $V_{OH} = 0.5 \times VCC$, $V_{OL} = 0.5 \times VCC$,

C = 15 pF for the SDCLK pin, C = 30 pF for other pins.

To control the drive capacity when using the SDRAM: set the PFBCR3.SDCLKDRV bit in external bus control register 1 to 1 to select the drive capacity of the SDCLK pin, and set the SDRAM pins other than the SDCLK pin as high-speed-interface driving outputs.

Item	Symbol	Condi	tions 1	Condi	tions 2	Unit	Test Conditions	
item	Symbol	Min.	Max.	Min.	Max.	Unit	1 CSt Conditions	
Address delay time	t _{AD}	_	12.5	_	12.5	ns	Figure 2.18 to	
Byte control delay time	t _{BCD}	_	12.5	_	12.5	ns	Figure 2.23	
CS# delay time	t _{CSD}	_	12.5	_	12.5	ns		
ALE delay time	t _{ALED}	_	12.5	_	12.5	ns		
RD# delay time	t _{RSD}	_	12.5	_	12.5	ns		
Read data setup time	t _{RDS}	12.5	_	12.5	_	ns		
Read data hold time	t _{RDH}	0	_	0	_	ns		
WR# delay time	t _{WRD}	_	12.5	_	12.5	ns		
Write data delay time	t _{WDD}	_	12.5	_	12.5	ns		
Write data hold time	t _{WDH}	0	_	0	_	ns		
WAIT# setup time	t _{WTS}	12.5	_	12.5	_	ns	Figure 2.24	
WAIT# hold time	t _{WTH}	0	_	0	_	ns		
Address delay time 2 (SDRAM)	t _{AD2}	1	12.5	1	10.0	ns	Figure 2.25 to	
CS# delay time 2 (SDRAM)	t _{CSD2}	1	12.5	1	10.0	ns	Figure 2.31	
DQM delay time (SDRAM)	t _{DQMD}	1	12.5	1	10.0	ns		
CKE delay time (SDRAM)	t _{CKED}	1	12.5	1	10.0	ns		
Read data setup time 2 (SDRAM)	t _{RDS2}	10	_	6.0	_	ns		
Read data hold time 2 (SDRAM)	t _{RDH2}	0	_	0	_	ns		
Write data delay time 2 (SDRAM)	t _{WDD2}	_	12.5	_	10.0	ns		
Write data hold time 2 (SDRAM)	t _{WDH2}	1	_	1	_	ns		
WE# delay time (SDRAM)	t _{WED}	1	12.5	1	10.0	ns		
RAS# delay time (SDRAM)	t _{RASD}	1	12.5	1	10.0	ns		
CAS# delay time (SDRAM)	t _{CASD}	1	12.5	1	10.0	ns		

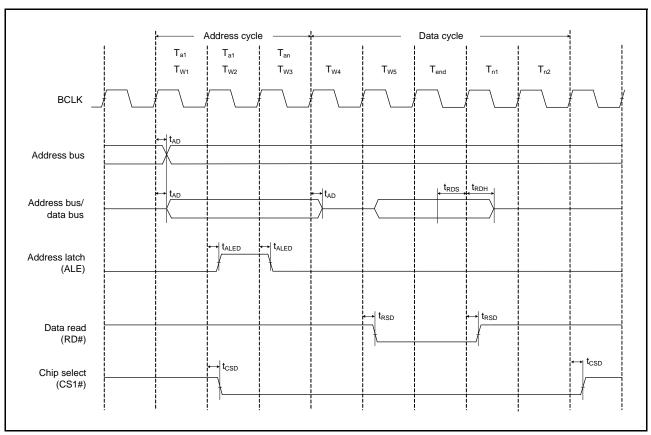


Figure 2.18 Address/Data Multiplexed Bus Read Access Timing

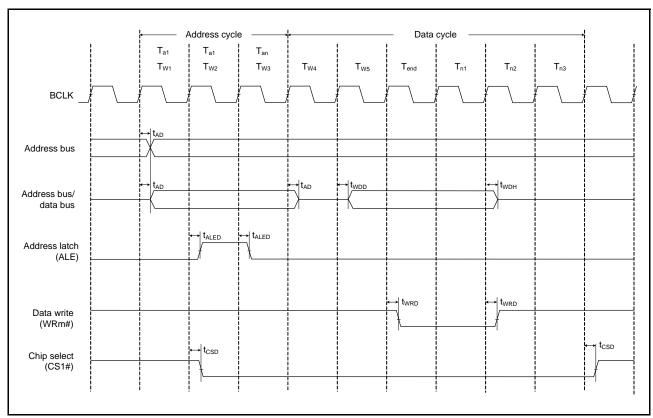


Figure 2.19 Address/Data Multiplexed Bus Write Access Timing

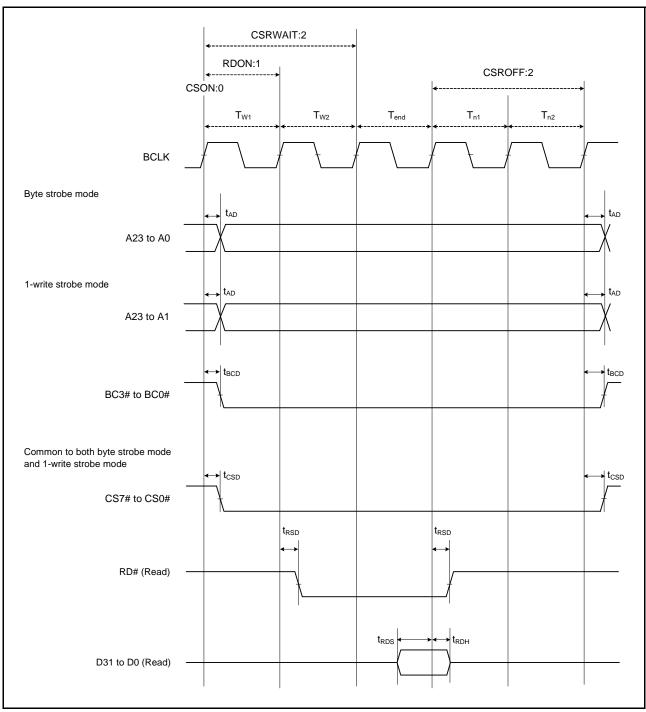


Figure 2.20 External Bus Timing/Normal Read Cycle (Bus Clock Synchronized)

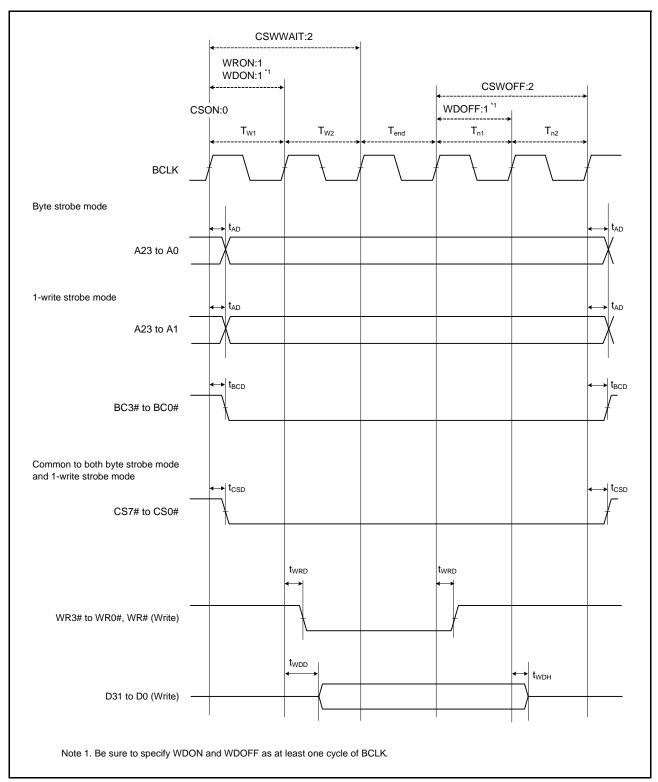


Figure 2.21 External Bus Timing/Normal Write Cycle (Bus Clock Synchronized)

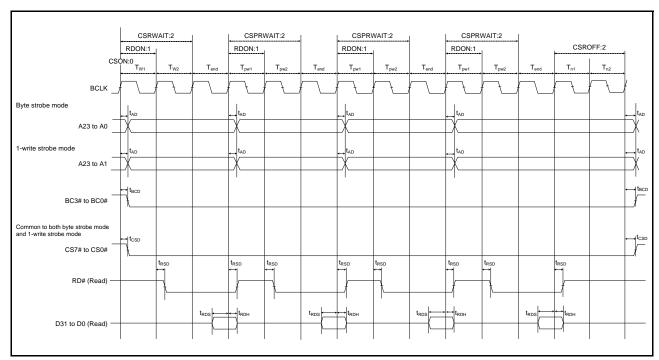


Figure 2.22 External Bus Timing/Page Read Cycle (Bus Clock Synchronized)

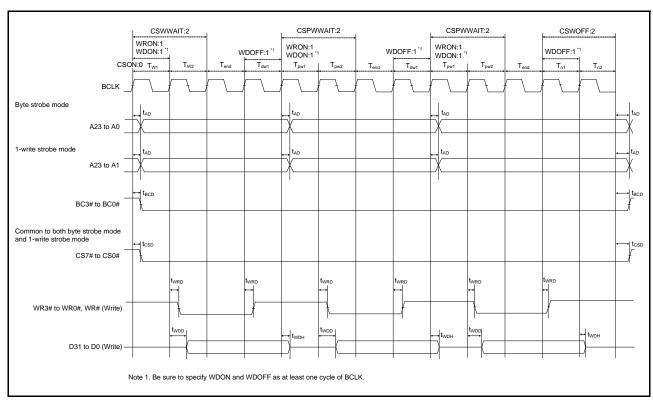


Figure 2.23 External Bus Timing/Page Write Cycle (Bus Clock Synchronized)

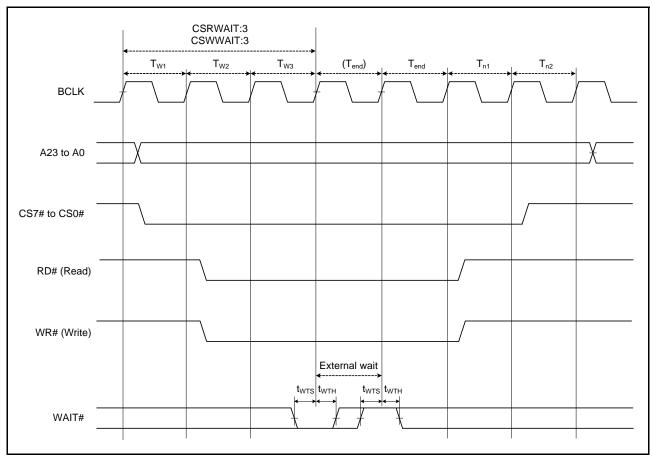


Figure 2.24 External Bus Timing/External Wait Control

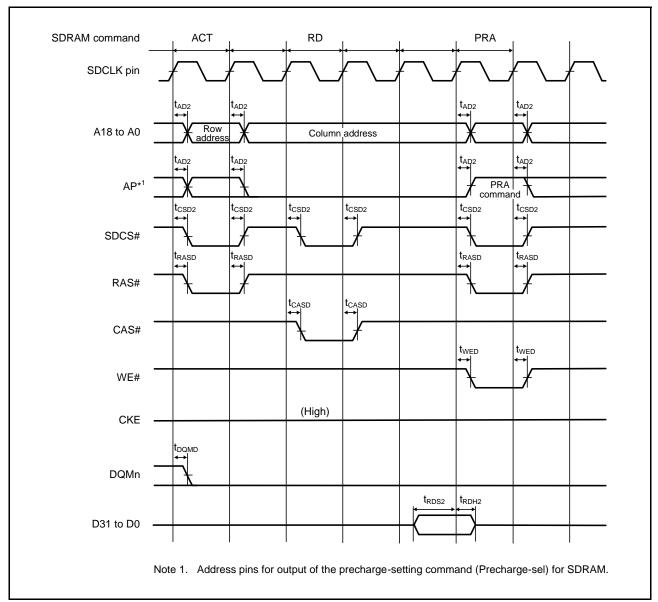


Figure 2.25 SDRAM Space Single Read Bus Timing

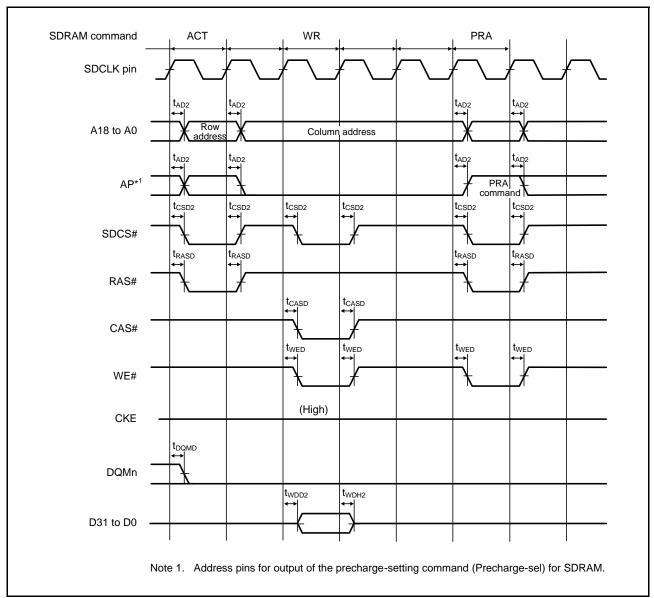


Figure 2.26 SDRAM Space Single Write Bus Timing

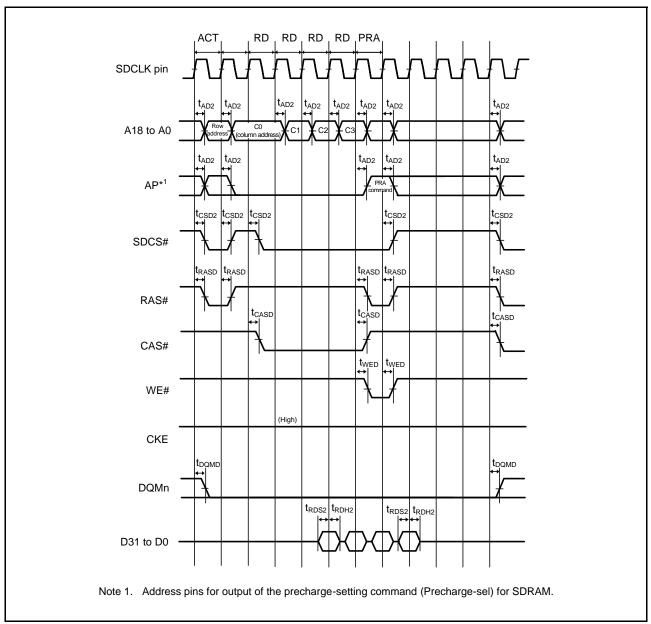


Figure 2.27 SDRAM Space Multiple Read Bus Timing

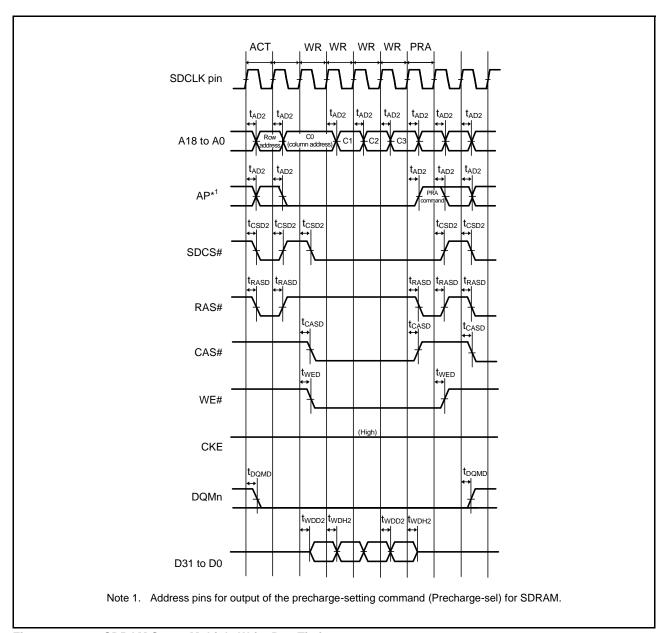


Figure 2.28 SDRAM Space Multiple Write Bus Timing

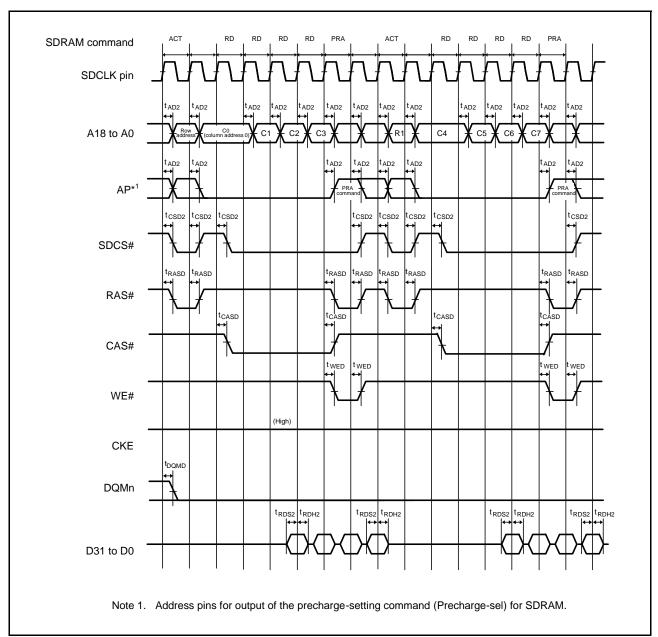


Figure 2.29 SDRAM Space Multiple Read Line Stride Bus Timing

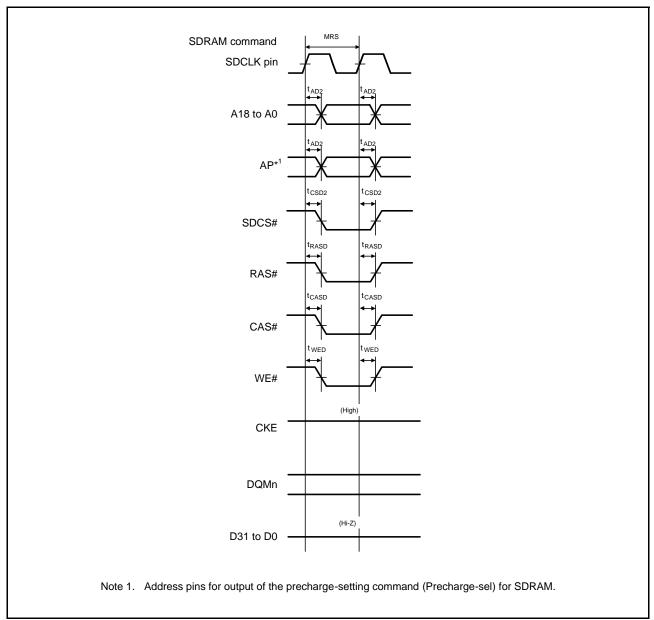


Figure 2.30 SDRAM Space Mode Register Set Bus Timing

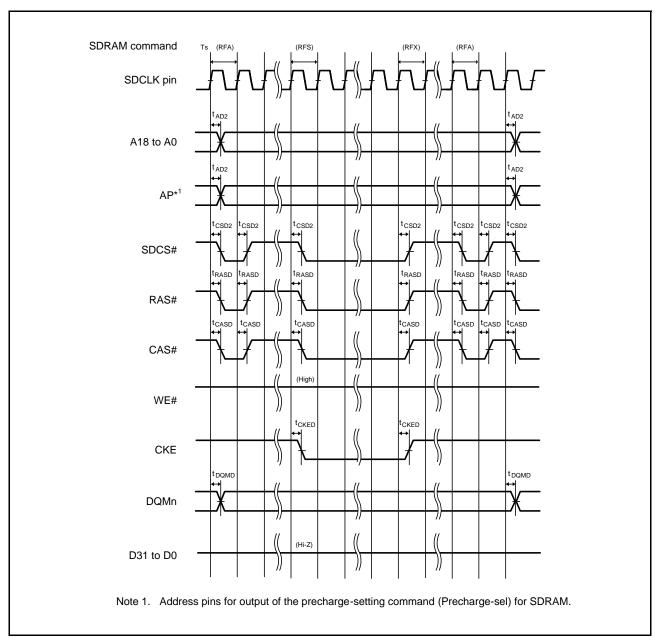


Figure 2.31 SDRAM Space Self-Refresh Bus Timing

2.4.6 EXDMAC Timing

Table 2.27 EXDMAC Timing

Conditions: $VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 \text{ to } 3.6 \text{ V}, 2.7 \text{ V} \le VREFH0 \le AVCC0, The second se$

VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = 0 V,

 $ICLK = 8 \text{ to } 240 \text{ MHz}, PCLKA = 8 \text{ to } 120 \text{ MHz}, PCLKB = 8 \text{ to } 60 \text{ MHz}, BCLK = SDCLK = 8 \text{ to } 80 \text{ MHz}, T_a = T_{opr}, T_$

Output load conditions: $V_{OH} = 0.5 \times VCC$, $V_{OL} = 0.5 \times VCC$, C = 30 pF, High-drive output is selected by the driving ability control register.

	Item	Symbol	Min.	Max.	Unit	Test Conditions
EXDMAC	EDREQ setup time	t _{EDRQS}	13	_	ns	Figure 2.32
	EDREQ hold time	t _{EDRQH}	2	_	ns	
	EDACK delay time	t _{EDACD}	_	13	ns	Figure 2.33, Figure 2.34

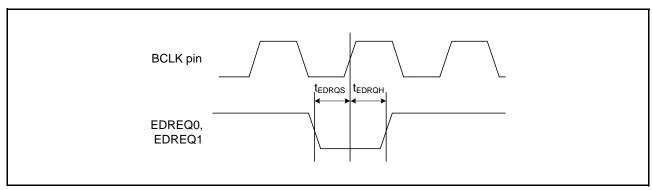


Figure 2.32 EDREQ0 and EDREQ1 Input Timing

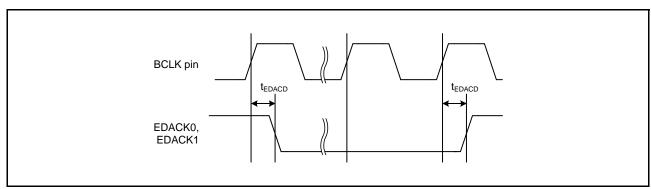


Figure 2.33 EDACK0 and EDACK1 Single-Address Transfer Timing (for a CS Area)

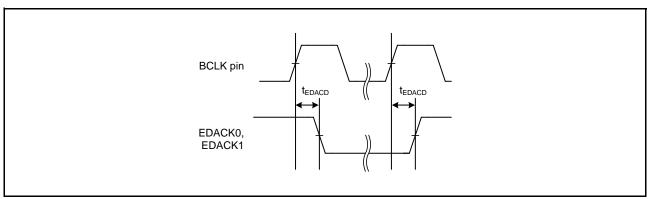


Figure 2.34 EDACK0 and EDACK1 Single-Address Transfer Timing (for SDRAM)

2. Electrical Characteristics RX72N Group

Timing of On-Chip Peripheral Modules 2.4.7

2.4.7.1 I/O Port

Table 2.28 I/O Port Timing

Conditions: $VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 \text{ to } 3.6 \text{ V}, 2.7 \text{ V} \leq VREFH0 \leq AVCC0,$

VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = 0 V,

PCLKA = 8 to 120 MHz, PCLKB = 8 to 60 MHz, $T_a = T_{opr}$, Output load conditions: $V_{OH} = 0.5 \times VCC$, $V_{OL} = 0.5 \times VCC$, C = 30 pF, High-drive output is selected by the driving ability control register.

Item		Symbol	Min.	Max.	Unit*1	Test Conditions
I/O ports	Input data pulse width	t _{PRW}	1.5	_	t _{PBcyc}	Figure 2.35

Note 1. t_{PBcyc} : PCLKB cycle

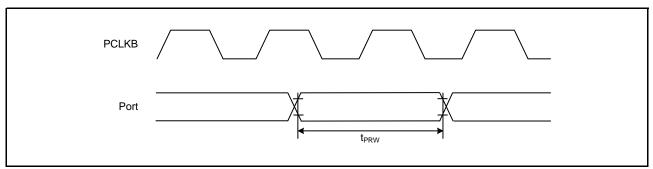


Figure 2.35 I/O Port Input Timing

2. Electrical Characteristics RX72N Group

TPU 2.4.7.2

Table 2.29 TPU Timing

Conditions: $VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 \text{ to } 3.6 \text{ V}, 2.7 \text{ V} \leq VREFH0 \leq AVCC0,}$

VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = 0 V,

PCLKA = 8 to 120 MHz, PCLKB = 8 to 60 MHz, $T_a = T_{opr}$, Output load conditions: $V_{OH} = 0.5 \times VCC$, $V_{OL} = 0.5 \times VCC$, C = 30 pF, High-drive output is selected by the driving ability control register.

Item			Symbol	Min.	Max.	Unit*1	Test Conditions
TPU	Input capture input pulse	Single-edge setting	t _{TICW}	1.5	_	t _{PBcyc}	Figure 2.36
	width	Both-edge setting		2.5	_		
	Timer clock pulse width	Single-edge setting	t _{TCKWH,}	1.5	_	t _{PBcyc}	Figure 2.37
		Both-edge setting	t _{TCKWL}	2.5	_		
		Phase counting mode		2.5	_		

Note 1. t_{PBcyc} : PCLKB cycle

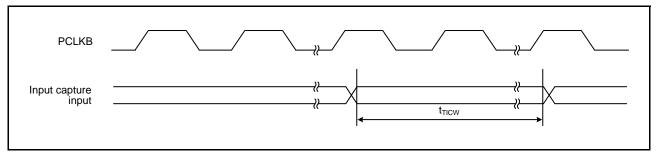
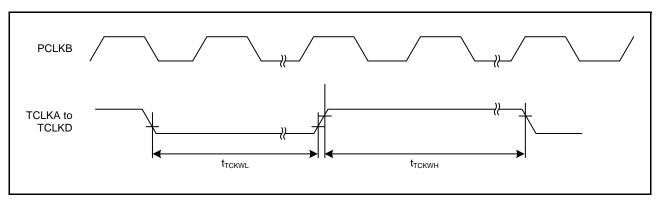


Figure 2.36 **TPU Input Capture Input Timing**



TPU Clock Input Timing Figure 2.37

2.4.7.3 **TMR**

Table 2.30 TMR Timing

Conditions: $VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 \text{ to } 3.6 \text{ V}, 2.7 \text{ V} \leq VREFH0 \leq AVCC0,}$

VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = 0 V, PCLKA = 8 to 120 MHz, PCLKB = 8 to 60 MHz, $T_a = T_{opr}$,

Output load conditions: $V_{OH} = 0.5 \times VCC$, $V_{OL} = 0.5 \times VCC$, C = 30 pF, High-drive output is selected by the driving ability control register.

Item		Symbol	Min.	Max.	Unit*1	Test Conditions	
TMR	Timer clock pulse width	Single-edge setting	t _{TMCWH} ,	1.5	_	t _{PBcyc}	Figure 2.38
		Both-edge setting	t _{TMCWL}	2.5	_		

Note 1. t_{PBcyc}: PCLKB cycle

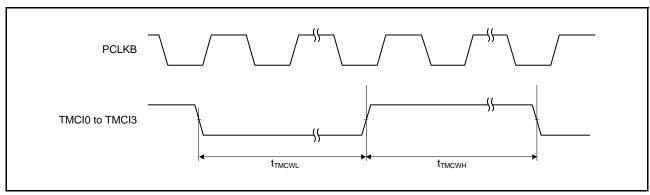


Figure 2.38 **TMR Clock Input Timing**

2.4.7.4 **CMTW**

Table 2.31 CMTW Timing

Conditions: $VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 \text{ to } 3.6 \text{ V}, 2.7 \text{ V} \le VREFH0 \le AVCC0,$

VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = 0 V,

PCLKA = 8 to 120 MHz, PCLKB = 8 to 60 MHz, $T_a = T_{opr}$, Output load conditions: $V_{OH} = 0.5 \times VCC$, $V_{OL} = 0.5 \times VCC$, C = 30 pF, High-drive output is selected by the driving ability control register.

Item		Symbol	Min.	Max.	Unit*1	Test Conditions	
CMTW	Input capture input pulse	Single-edge setting	t _{CMTWTICW}	1.5	_	t _{PBcyc}	Figure 2.39
	width	Both-edge setting		2.5	_		

Note 1. t_{PBcyc} : PCLKB cycle

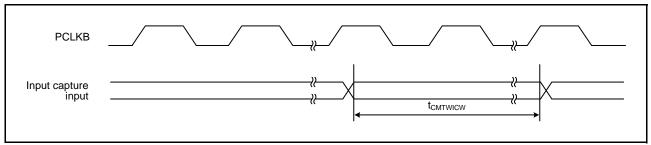


Figure 2.39 **CMTW Input Capture Input Timing**

2.4.7.5 MTU

Table 2.32 MTU Timing

Conditions: $VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 \text{ to } 3.6 \text{ V}, 2.7 \text{ V} \leq VREFH0 \leq AVCC0,}$

VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = 0 V, PCLKA = 8 to 120 MHz. PCLKB = 8 to 60 MHz. T₂ = T₂₂

PCLKA = 8 to 120 MHz, PCLKB = 8 to 60 MHz, $T_a = T_{opr}$, Output load conditions: $V_{OH} = 0.5 \times VCC$, $V_{OL} = 0.5 \times VCC$, C = 30 pF, High-drive output is selected by the driving ability control register.

Item		Symbol	Min.	Max.	Unit*1	Test Conditions	
MTU	Input capture input pulse	Single-edge setting	t _{MTICW}	1.5	_	t _{PAcyc}	Figure 2.40
width		Both-edge setting		2.5	_		
	Timer clock pulse width	Single-edge setting	t _{MTCKWH,}	1.5	_	t _{PAcyc}	Figure 2.41
		Both-edge setting	tMTCKWL	2.5	_		
		Phase counting mode		2.5	_		

Note 1. t_{PAcyc}: PCLKA cycle

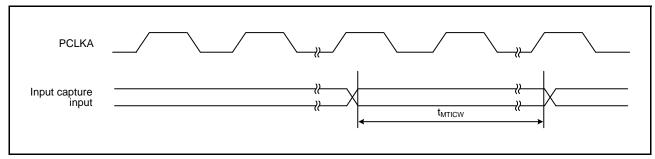


Figure 2.40 MTU Input Capture Input Timing

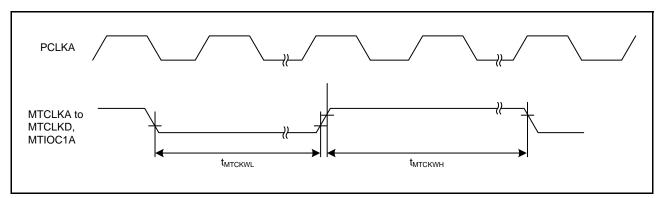


Figure 2.41 MTU Clock Input Timing

2.4.7.6 POE

Table 2.33 POE Timing

Conditions: $VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 \text{ to } 3.6 \text{ V}, 2.7 \text{ V} \leq VREFH0 \leq AVCC0,}$

$$\label{eq:VSS} \begin{split} \text{VSS} = \text{AVSS0} = \text{AVSS1} = \text{VREFL0} = \text{VSS_USB} = 0 \text{ V}, \\ \text{PCLKA} = 8 \text{ to } 120 \text{ MHz}, \text{ PCLKB} = 8 \text{ to } 60 \text{ MHz}, \text{ } \text{T}_{a} = \text{T}_{\text{opr}}, \end{split}$$

Output load conditions: $V_{OH} = 0.5 \times VCC$, $V_{OL} = 0.5 \times VCC$, C = 30 pF, High-drive output is selected by the driving ability control register.

		Item	Symbol	Min.	Тур.	Max.	Unit*1	Test Conditions
POE	POEn# input (n = 0, 4, 8, 1	•	t _{POEW}	1.5	_	_	t _{PBcyc}	Figure 2.42
	Output disable time	Transition of the POEn# signal level	t _{POEDI}	_	_	5 PCLKB + 0.24	μs	Figure 2.43 When detecting falling edges (ICSRm.POEnM[3:0] = 0000 (m = 1 to 5; n = 0, 4, 8, 10, 11))
		Simultaneous conduction of output pins	t _{POEDO}	_	_	3 PCLKB + 0.2	μs	Figure 2.44
		Register setting t _{POED}		_	_	1 PCLKB + 0.2	μs	Figure 2.45 Time for access to the register is not included.
		Oscillation stop detection	t _{POEDOS}	_	_	21	μs	Figure 2.46

Note 1. t_{PBcyc}: PCLKB cycle

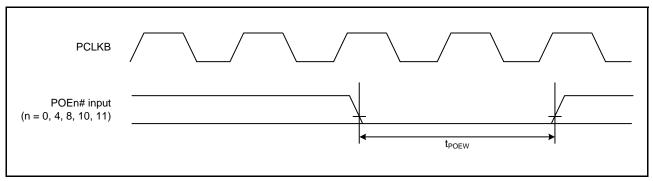


Figure 2.42 POE# Input Timing

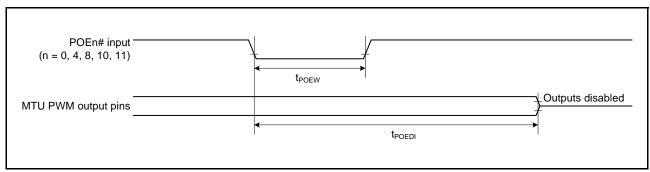


Figure 2.43 Output Disable Time for POE in Response to Transition of the POEn# Signal Level

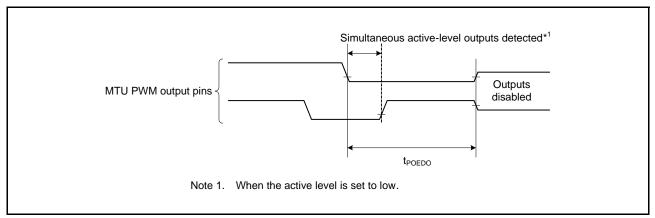


Figure 2.44 Output Disable Time for POE in Response to the Simultaneous Conduction of Output Pins

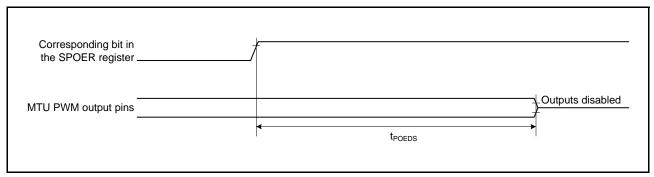


Figure 2.45 Output Disable Time for POE in Response to the Register Setting

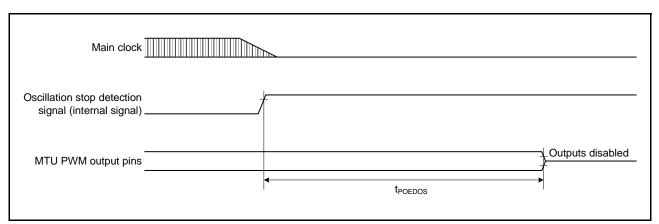


Figure 2.46 Output Disable Time for POE in Response to the Oscillation Stop Detection

2.4.7.7 POEG

Table 2.34 POEG Timing

Conditions: $VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 \text{ to } 3.6 \text{ V}, 2.7 \text{ V} \le VREFH0 \le AVCC0,}$

$$\label{eq:VSS} \begin{split} \text{VSS} = \text{AVSS0} = \text{AVSS1} = \text{VREFL0} = \text{VSS_USB} = 0 \text{ V}, \\ \text{PCLKA} = 8 \text{ to } 120 \text{ MHz}, \text{ PCLKB} = 8 \text{ to } 60 \text{ MHz}, \text{ } \text{T}_{a} = \text{T}_{\text{opr}}, \end{split}$$

Output load conditions: $V_{OH} = 0.5 \times VCC$, $V_{OL} = 0.5 \times \dot{V}CC$, C = 30 pF, High-drive output is selected by the driving ability control register.

		Item	Symbol	Min.	Тур.	Max.	Unit*1	Test Conditions
POEG	GTETRGn inp	out pulse width (n = A to D)	t _{POEGW}	1.5		_	t _{PBcyc}	Figure 2.47
	Output disable time	Input level detection of the GTETRGn pin (via flag)	^t POEGDI	_		3 PCLKB + 0.34	μs	Figure 2.48 When the digital noise filter is not in use (POEGGn.NFEN = 0 (n = A to D))
		Detection of the output stopping signal from GPTW (deadtime error, simultaneous high output, or simultaneous low output)	t _{POEGDE}	_	_	0.5	μs	Figure 2.49
		Register setting	t _{POEGDS}	_	_	1 PCLKB + 0.3	μs	Figure 2.50 Time for access to the register is not included.
		Oscillation stop detection	t _{POEGDOS}			21	μs	Figure 2.51

Note 1. t_{PBcyc} : PCLKB cycle

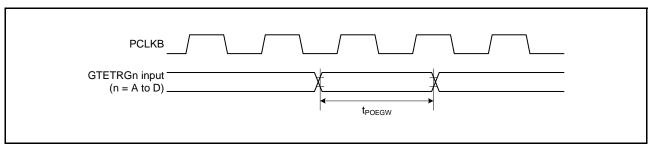


Figure 2.47 POEG Input Timing

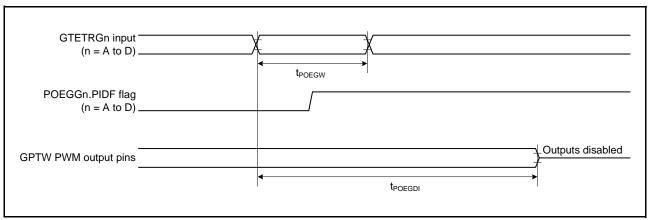


Figure 2.48 Output Disable Time for POEG via Detection Flag in Response to the Input Level Detection of the GTETRGn pin

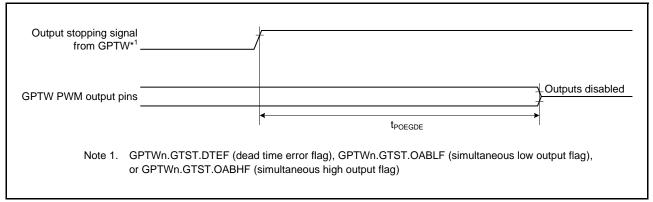


Figure 2.49 Output Disable Time for POEG in Response to Detection of the Output Stopping Signal from GPTW

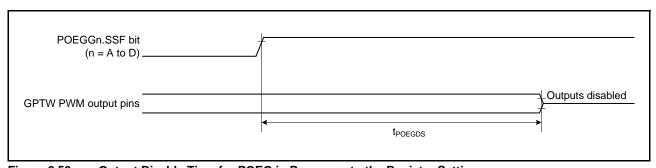


Figure 2.50 Output Disable Time for POEG in Response to the Register Setting

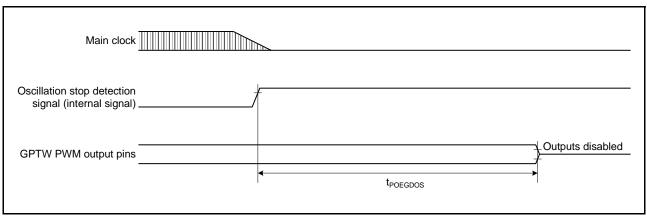


Figure 2.51 Output Disable Time of POEG in Response to the Oscillation Stop Detection

2.4.7.8 GPTW

Table 2.35 GPTW Timing

Conditions: $VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 \text{ to } 3.6 \text{ V}, 2.7 \text{ V} \leq VREFH0 \leq AVCC0,}$

VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = 0 V, PCLKA = 8 to 120 MHz, PCLKB = 8 to 60 MHz, $T_a = T_{opr}$

Output load conditions: $V_{OH} = 0.5 \times VCC$, $V_{OL} = 0.5 \times VCC$, C = 30 pF, High-drive output is selected by the driving ability control register.

Item			Symbol	Min.	Max.	Unit*1, *2	Test Conditions
GPTW	Input capture input pulse width	Single-edge setting	t _{GTICW}	1.5	_	t _{PAcyc}	Figure 2.52
		Both-edge setting		2.5	_		
	External trigger input pulse width	Single-edge setting	t _{GTEW}	1.5	_	t _{PBcyc}	Figure 2.53
		Both-edge setting		2.5	_		

Note 1. t_{PAcyc} : PCLKA cycle Note 2. t_{PBcyc} : PCLKB cycle

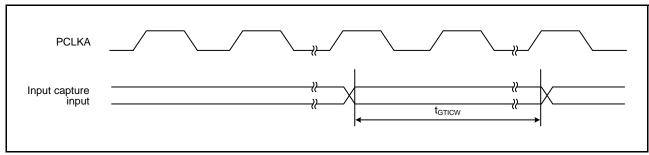


Figure 2.52 GPTW Input Capture Input Timing

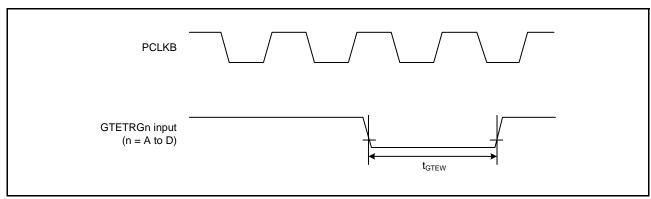


Figure 2.53 GPTW External Trigger Input Timing

SCI 2.4.7.9

Table 2.36 SCI Timing

Conditions: $VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 \text{ to } 3.6 \text{ V}, 2.7 \text{ V} \le VREFH0 \le AVCC0,}$

 $VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = 0 V,$

PCLKA = 8 to 120 MHz, PCLKB = 8 to 60 MHz, $T_a = T_{opr}$, Output load conditions: $V_{OH} = 0.5 \times VCC$, $V_{OL} = 0.5 \times VCC$, C = 30 pF, High-drive output is selected by the driving ability control register.

	Item		Symbol	Min.	Max.	Unit*1	Test Conditions
SCIh, SCIj	Input clock cycle	Asynchronous	t _{Scyc}	4	_	t _{PBcyc}	Figure 2.54
		Clock synchronous		6	_		
	Input clock pulse width	•	t _{SCKW}	0.4	0.6	t _{Scyc}	
	Input clock rise time		t _{SCKr}	_	5	ns	
	Input clock fall time		t _{SCKf}	_	5	ns	
	Output clock cycle	Asynchronous*2	t _{Scyc}	8	_	t _{PBcyc}	
		Clock synchronous		4	_		
	Output clock pulse width		t _{SCKW}	0.4	0.6	t _{Scyc}	
	Output clock rise time		t _{SCKr}	_	5	ns	
	Output clock fall time		t _{SCKf}	_	5	ns	
	Transmit data delay time	Clock synchronous	t _{TXD}	_	28	ns	Figure 2.5
	Receive data setup time	Clock synchronous	t _{RXS}	15	_	ns	
	Receive data hold time	Clock synchronous	t _{RXH}	5	_	ns	
SCIi	Input clock cycle	Asynchronous	t _{Scyc}	4	_	t _{PAcyc}	Figure 2.54
		Clock synchronous		12	_		
	Input clock pulse width		t _{SCKW}	0.4	0.6	t _{Scyc}	
	Input clock rise time		t _{SCKr}	_	5	ns	
	Input clock fall time		t _{SCKf}	_	5	ns	
	Output clock cycle	Asynchronous*2	t _{Scyc}	8	_	t _{PAcyc}	
		Clock synchronous		8	_		
	Output clock pulse width		t _{SCKW}	0.4	0.6	t _{Scyc}	
	Output clock rise time		t _{SCKr}	_	5	ns	
	Output clock fall time		t _{SCKf}	_	5	ns	
-	Transmit data delay time	Master	t _{TXD}	_	15	ns	Figure 2.5
		Slave		_	28		
	Receive data setup time	Clock synchronous	t _{RXS}	20	_	ns	
	Receive data hold time	Clock synchronous	t _{RXH}	5	_		

Note 1. t_{PBcyc}: PCLKB cycle; t_{PAcyc}: PCLKA cycle

Note 2. When the SEMR.ABCS and SEMR.BGDM bits are set to 1

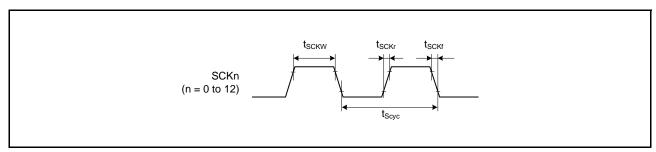


Figure 2.54 SCK Clock Input Timing

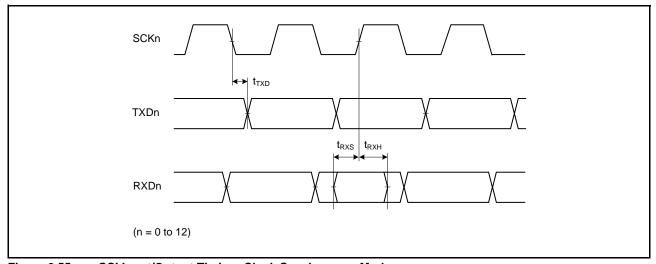


Figure 2.55 SCI Input/Output Timing: Clock Synchronous Mode

Table 2.37 Simple IIC Timing

Conditions: $VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 \text{ to } 3.6 \text{ V}, 2.7 \text{ V} \leq VREFH0 \leq AVCC0,$

$$\label{eq:VSS} \begin{split} \text{VSS} &= \text{AVSS0} = \text{AVSS1} = \text{VREFL0} = \text{VSS_USB} = 0 \text{ V}, \\ \text{PCLKA} &= 8 \text{ to } 120 \text{ MHz}, \text{ PCLKB} = 8 \text{ to } 60 \text{ MHz}, \text{ T}_{a} = \text{T}_{opr}, \\ \text{High-drive output is selected by the driving ability control register.} \end{split}$$

	Item	Symbol	Min.	Max.	Unit	Test Conditions
Simple IIC	SSDA input rise time	t _{Sr}	_	1000	ns	Figure 2.56
(Standard-mode)	SSDA input fall time	t _{Sf}	_	300	ns	
	SSDA input spike pulse removal time	t _{SP}	0	4 × t _{PBcyc}	ns	
	Data input setup time	t _{SDAS}	250	_	ns	
	Data input hold time	t _{SDAH}	0	_	ns	
	SSCL, SSDA capacitive load	C _b *1	_	400	pF	-
Simple IIC	SSCL, SSDA input rise time	t _{Sr}	_	300	ns	1
(Fast-mode)	SSCL, SSDA input fall time	t _{Sf}	_	300	ns	
	SSCL, SSDA input spike pulse removal time	t _{SP}	0	4 × t _{PBcyc}	ns	
	Data input setup time	t _{SDAS}	100	_	ns	
	Data input hold time	t _{SDAH}	0	_	ns	
	SSCL, SSDA capacitive load	C _b *1	_	400	pF	

Note: t_{PBcyc}: PCLKB cycle

Note 1. Cb is the total capacitance of the bus lines.

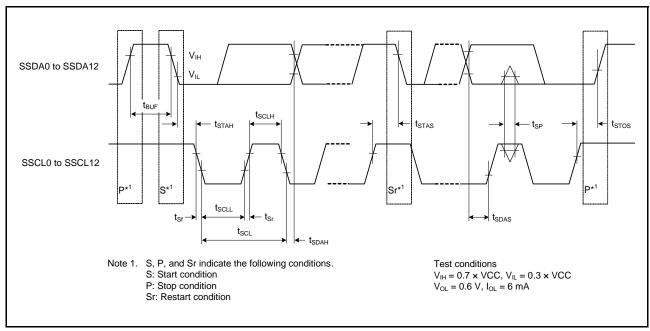


Figure 2.56 Simple IIC Bus Interface Input/Output Timing

Table 2.38 Simple SPI Timing

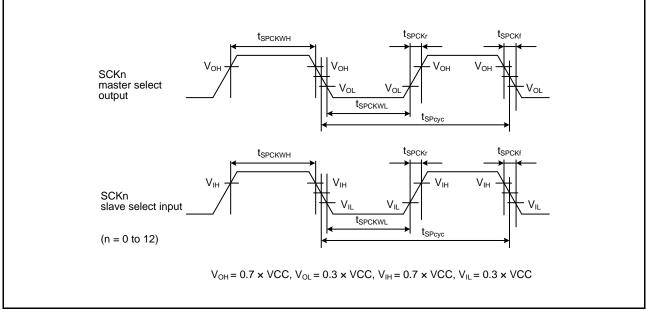
Conditions: $VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 \text{ to } 3.6 \text{ V}, 2.7 \text{ V} \leq VREFH0 \leq AVCC0, The second se$

VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = 0 V,

PCLKA = 8 to 120 MHz, PCLKB = 8 to 60 MHz, $T_a = T_{opr}$, Output load conditions: $V_{OH} = 0.5 \times VCC$, $V_{OL} = 0.5 \times VCC$, C = 30 pF, High-drive output is selected by the driving ability control register.

	Item	Symbol	Min.	Max.	Unit*1	Test Conditions
Simple	SCK clock cycle output (master)	t _{SPcyc}	4	65536	t _{PAcyc}	Figure 2.57
SPI	SCK clock cycle input (slave)		8	65536		
	SCK clock high pulse width	t _{SPCKWH}	0.4	0.6	t _{SPcyc}	
	SCK clock low pulse width	t _{SPCKWL}	0.4	0.6	t _{SPcyc}	
	SCK clock rise/fall time	t _{SPCKr} , t _{SPCKf}	_	20	ns	
	Data input setup time	t _{SU}	33.3	_	ns	Figure 2.58 to
	Data input hold time	t _H	33.3	_	ns	Figure 2.61
	SS input setup time	t _{LEAD}	1	_	t _{SPcyc}	
	SS input hold time	t _{LAG}	1	_	t _{SPcyc}	
	Data output delay time	t _{OD}	_	33.3	ns	
	Data output hold time	t _{OH}	-10	_	ns	
	Data rise/fall time	t _{Dr,} t _{Df}	_	16.6	ns	
	SS input rise/fall time	t _{SSLr} , t _{SSLf}	_	16.6	ns	
	Slave access time	t _{SA}	_	5	t _{PBcyc}	Figure 2.60,
	Slave output release time	t _{REL}	_	5	t _{PBcyc}	Figure 2.61

Note 1. t_{PAcyc}: PCLKA cycle, t_{PBcyc}: PCLKB cycle



Simple SPI Clock Timing Figure 2.57

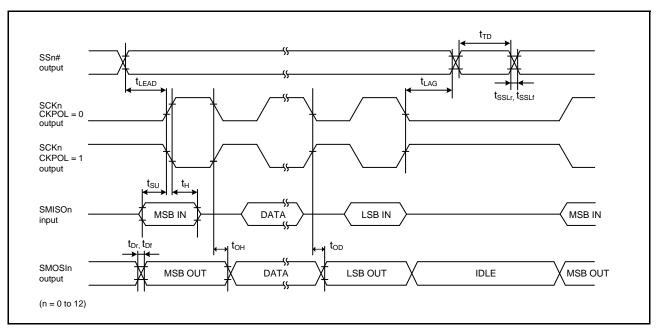


Figure 2.58 Simple SPI Timing (Master, CKPH = 1)

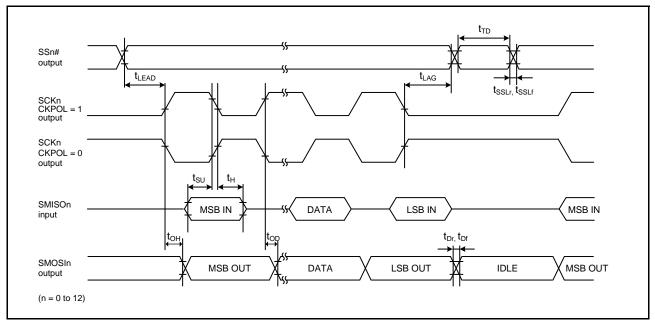


Figure 2.59 Simple SPI Timing (Master, CKPH = 0)

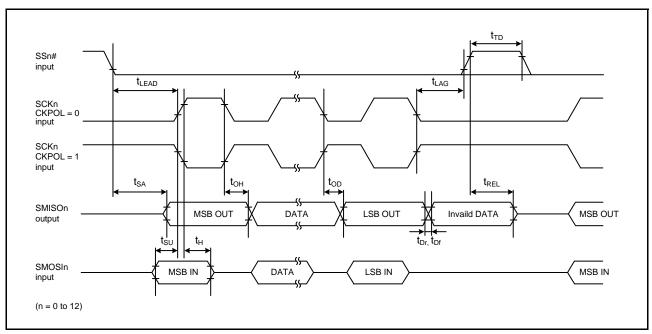


Figure 2.60 Simple SPI Timing (Slave, CKPH = 1)

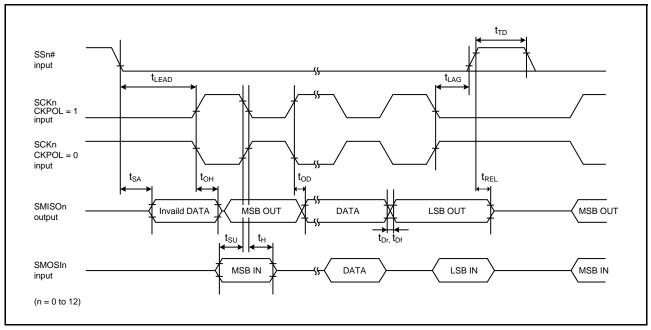


Figure 2.61 Simple SPI Timing (Slave, CKPH = 0)

2.4.7.10 RIIC

Table 2.39 RIIC Timing

Conditions: $VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 \text{ to } 3.6 \text{ V}, 2.7 \text{ V} \le VREFH0 \le AVCC0}, VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = 0 \text{ V}, PCLKA = 8 \text{ to } 120 \text{ MHz}, PCLKB = 8 \text{ to } 60 \text{ MHz}, T_a = T_{opr}, VSS_USB = 0 \text{ V}, PCLKB =$ High-drive output is selected by the driving ability control register.

	Item	Symbol	Min.*1	Max.	Unit	Test Conditions
RIIC	SCL input cycle time	t _{SCL}	6(12) × t _{IICcyc} + 1300	_	ns	Figure 2.62
(Standard-mode, SMBus)	SCL input high pulse width	t _{SCLH}	3(6) × t _{IICcyc} + 300	_	ns	
ICFER.FMPE = 0	SCL input low pulse width	t _{SCLL}	3(6) × t _{IICcyc} + 300	_	ns	
	SCL, SDA input rise time	t _{Sr}	_	1000	ns	
	SCL, SDA input fall time	t _{Sf}	_	300	ns	
	SCL, SDA input spike pulse removal time	t _{SP}	0	1(4) × t _{IICcyc}	ns	
	SDA input bus free time	t _{BUF}	3(6) × t _{IICcyc} + 300	_	ns	
	Start condition input hold time	t _{STAH}	t _{IICcyc} + 300	_	ns	
	Restart condition input setup time	t _{STAS}	1000	_	ns	
	Stop condition input setup time	t _{STOS}	1000	_	ns	
	Data input setup time	t _{SDAS}	t _{IICcyc} + 50	_	ns	1
	Data input hold time	t _{SDAH}	0	_	ns	
	SCL, SDA capacitive load	C _b *2	_	400	pF	1
RIIC	SCL input cycle time	t _{SCL}	6(12) × t _{IICcyc} + 600	_	ns	
(Fast-mode) ICFER.FMPE = 0	SCL input high pulse width	t _{SCLH}	3(6) × t _{IICcyc} + 300	_	ns	
ICPER.FIMPE = 0	SCL input low pulse width	t _{SCLL}	3(6) × t _{IICcyc} + 300	_	ns	
	SCL, SDA input rise time	t _{Sr}	20 x (External pull-up voltage/5.5V)	300	ns	
	SCL, SDA input fall time	t _{Sf}	20 x (External pull-up voltage/5.5V)	300 ns		
	SCL, SDA input spike pulse removal time	t _{SP}	0	1(4) × t _{IICcyc}	ns	
	SDA input bus free time	t _{BUF}	$3(6) \times t_{IICcyc} + 300$	_	ns	
	Start condition input hold time	t _{STAH}	t _{IICcyc} + 300	_	ns	
	Restart condition input setup time	t _{STAS}	300	_	ns	
	Stop condition input setup time	t _{STOS}	300	_	ns	
	Data input setup time	t _{SDAS}	t _{IICcyc} + 50	_	ns	
	Data input hold time	t _{SDAH}	0	_	ns	
	SCL, SDA capacitive load	C _b *2	_	400	pF	
RIIC	SCL input cycle time	t _{SCL}	6(12) × t _{IICcyc} + 240	_	ns	
(Fast-mode+)	SCL input high pulse width	t _{SCLH}	3(6) × t _{IICcyc} + 120	_	ns	
ICFER.FMPE = 1	SCL input low pulse width	t _{SCLL}	3(6) × t _{IICcyc} + 120	_	ns	
	SCL, SDA input rise time	t _{Sr}	_	120	ns	1
	SCL, SDA input fall time	t _{Sf}	_	120	ns	1
	SCL, SDA input spike pulse removal time	t _{SP}	0	1(4) × t _{IICcyc}	ns	1
	SDA input bus free time	t _{BUF}	3(6) × t _{IICcyc} + 120	_	ns	1
	Start condition input hold time	t _{STAH}	t _{IICcyc} + 120	_	ns	1
	Restart condition input setup time	t _{STAS}	120	_	ns	1
	Stop condition input setup time	t _{STOS}	120	_	ns	1
	Data input setup time	t _{SDAS}	t _{IICcyc} + 20	_	ns	1
	Data input hold time	t _{SDAH}	0	_	ns	1
	SCL, SDA capacitive load	C _b *2	_	550	pF	1

Note: t_{IICcyc} : RIIC internal reference clock (IIC ϕ) cycle

Note 1. The value within parentheses is applicable when the value of the ICMR3.NF[1:0] bits is 11b while the digital filter is enabled by the setting ICFER.NFE = 1.

Note 2. Cb is the total capacitance of the bus lines.

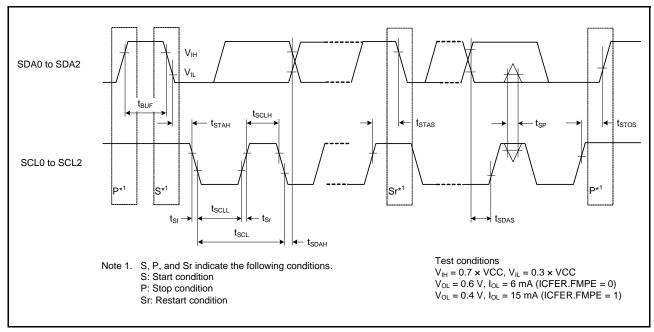


Figure 2.62 RIIC Bus Interface Input/Output Timing

2.4.7.11 **RSPI**

Table 2.40 RSPI Timing

Conditions: $VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 \text{ to } 3.6 \text{ V}, 2.7 \text{ V} \le VREFH0 \le AVCC0, The substitution of the substitution o$

VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = 0 V,

PCLKA = 8 to 120 MHz, PCLKB = 8 to 60 MHz, $T_a = T_{opr}$, Output load conditions: $V_{OH} = 0.5 \times VCC$, $V_{OL} = 0.5 \times VCC$, C = 30 pF, High-drive output is selected by the driving ability control register.

	Item			Symbol	Min.*1	Max.*1	Unit*1	Test Conditions*
	RSPCK clock cycle	Master		t _{SPcyc}	2	_	t _{PAcyc}	Figure 2.63
		Slave			4	_		
•	RSPCK clock high pulse width		Master		$ (t_{SPcyc} - t_{SPCKr} - t_{SPCKf}) / 2 - 3 $	_	ns	_
		Slave	Slave		(t _{SPcyc} – t _{SPCKr} – t _{SPCKf}) / 2	_		
	RSPCK clock low pulse width	K clock low pulse Master		t _{SPCKWL}	(t _{SPcyc} - t _{SPCKr} - t _{SPCKf}) / 2 - 3	t _{SPCKr} —		
		Slave			(t _{SPcyc} – t _{SPCKr} – t _{SPCKf}) / 2	_		
	RSPCK clock rise/fall time	Output		t _{SPCKr,}	_	5 ns		
		Input		t _{SPCKf}	_	1	μs	1
=	Data input setup time	Master Slave		t _{SU}	6	_	ns	Figure 2.64 to Figure 2.69
					8.3	_		
	Data input hold time	Master	PCLKA division ratio set to 1/2	t _{HF}	0	_	ns	
		sion ratio	PCLKA division ratio set to a value other than 1/2	t _H	t _{PAcyc}	_		
		Slave	ı		8.3	_		
İ	SSL setup time Mast		Master		1	8	t _{SPcyc}	
		Slave			6	_	t _{PAcyc}	
	SSL hold time	Master Slave		t _{LAG}	1	8	t _{SPcyc}	
					6	_	t _{PAcyc}	
İ	Data output delay time	Master		t _{OD}	_	6.3	ns	
		Slave			_	28		
İ	Data output hold time	Master		t _{OH}	0	_	ns	
		Slave			0	_		
	Successive transmission delay time	Master		t _{TD}	$t_{SPcyc} + 2 \times t_{PAcyc}$	8 × t _{SPcyc} + 2 × t _{PAcyc}	ns	
		Slave	Slave		6 × t _{PAcyc}	_		
	MOSI and MISO	Output	Output		_	5	ns	
	rise/fall time	Input		t _{Dr,} t _{Df}	_	1	μs	
	SSL	Output Input		t _{SSLr,}	_	5	ns	
	rise/fall time				_	1	μs	
	Slave access time	•		t _{SA}	_	2 × t _{PAcyc} + 28	ns	Figure 2.68, Figure 2.69
	Slave output release time			t _{REL}	_	2 × t _{PAcyc} + 28	ns	

Note 1. t_{PAcyc} : PCLKA cycle

Note 2. We recommend using pins that have a letter ("-A", "-B", etc.) to indicate group membership appended to their names as groups. For the RSPI interface, the AC portion of the electrical characteristics is measured for each group.

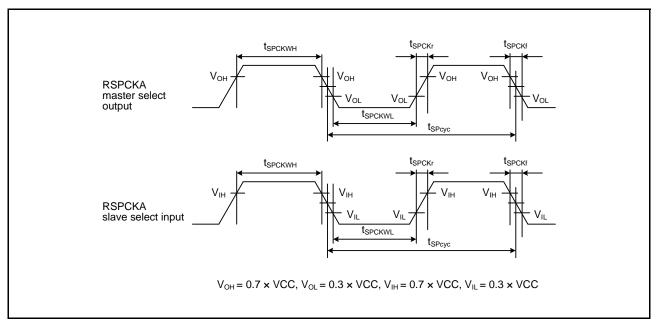


Figure 2.63 RSPI Clock Timing

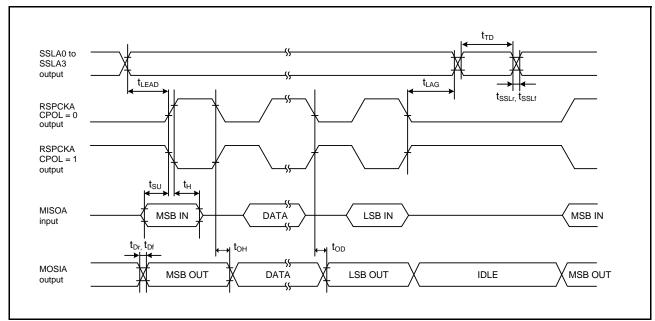


Figure 2.64 RSPI Timing (Master, CPHA = 0) (Bit Rate: PCLKA Division Ratio Set to a Value Other Than 1/2)

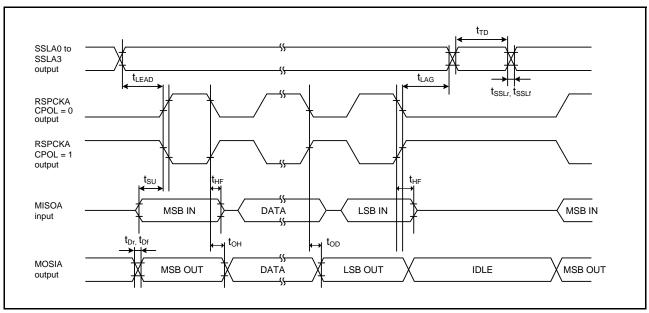


Figure 2.65 RSPI Timing (Master, CPHA = 0) (Bit Rate: PCLKA Division Ratio Set to 1/2)

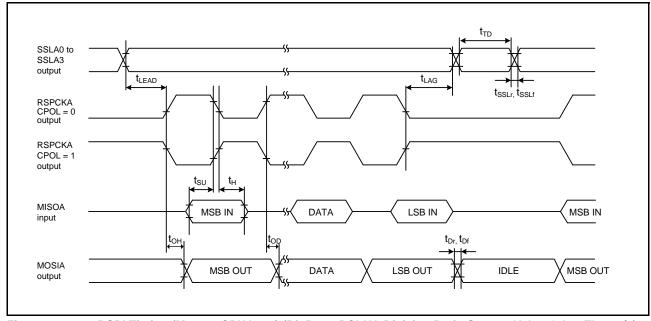


Figure 2.66 RSPI Timing (Master, CPHA = 1) (Bit Rate: PCLKA Division Ratio Set to a Value Other Than 1/2)

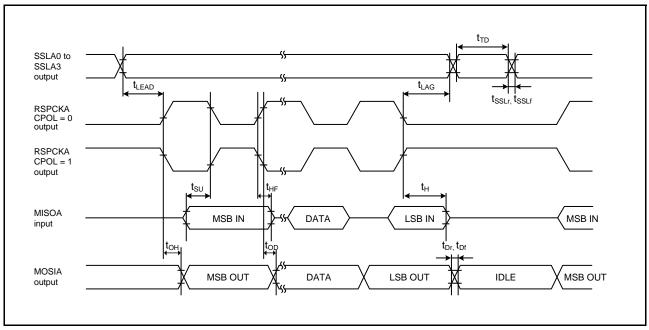


Figure 2.67 RSPI Timing (Master, CPHA = 1) (Bit Rate: PCLKA Division Ratio Set to 1/2)

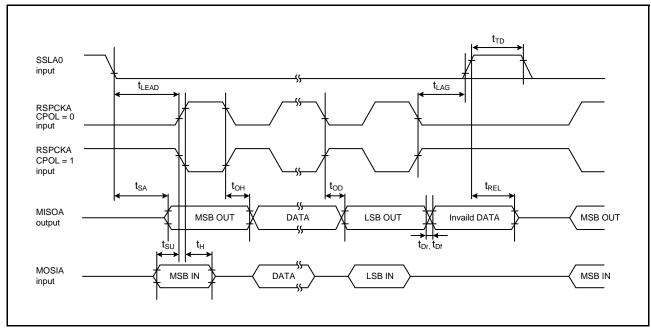


Figure 2.68 RSPI Timing (Slave, CPHA = 0)

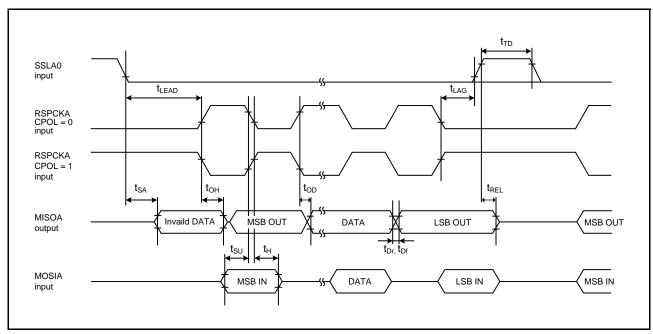


Figure 2.69 RSPI Timing (Slave, CPHA = 1)

2.4.7.12 QSPI

Table 2.41 QSPI Timing

Conditions: $VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 \text{ to } 3.6 \text{ V}, 2.7 \text{ V} \le VREFH0 \le AVCC0, The second se$

 $\label{eq:VSS} VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = 0 \ V, \\ PCLKA = 8 \ to \ 120 \ MHz, \ PCLKB = 8 \ to \ 60 \ MHz, \ T_a = T_{opr}, \\ \\$

Output load conditions: $V_{OH} = 0.5 \times VCC$, $V_{OL} = 0.5 \times VCC$, C = 30 pF,

High-drive output is selected by the driving ability control register.

	Item	Symbol	Min.	Max.	Unit*1	Test Conditions*2
QSPI	QSPCLK clock cycle	t _{QScyc}	2	4080	t _{PBcyc}	Figure 2.70
	Data input setup time	t _{Su}	6.5	_	ns	Figure 2.71,
	Data input hold time	t _{IH}	5	_	ns	Figure 2.72
	SS setup time	t _{LEAD}	1.5	8.5	t _{QScyc}	
	SS hold time	t _{LAG}	1	8	t _{QScyc}	
	Data output delay time	t _{OD}	_	10.0	ns	
	Data output hold time	tон	- 5	_	ns	
	Successive transmission delay time	t _{TD}	1	8	t _{QScyc}	

Note 1. t_{PBcyc}: PCLKB cycle

Note 2. We recommend using pins that have a letter ("-A", "-B", etc.) to indicate group membership appended to their names as groups. For the QSPI interface, the AC portion of the electrical characteristics is measured for each group.

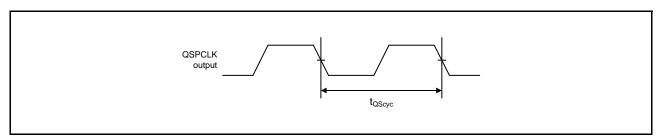


Figure 2.70 QSPI Clock Timing

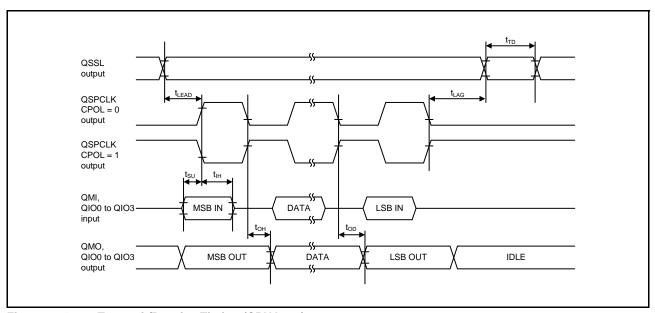


Figure 2.71 Transmit/Receive Timing (CPHA = 0)

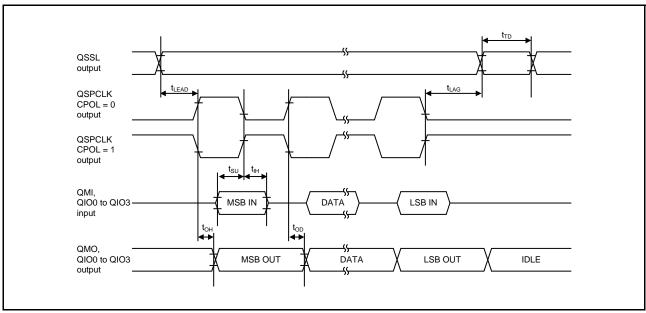


Figure 2.72 Transmit/Receive Timing (CPHA = 1)

2.4.7.13 SSIE

Table 2.42 Expansion Serial Sound Interface Timing

Conditions: $VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 \text{ to } 3.6 \text{ V}, VREFH0 = 2.7 \text{ V to } AVCC0,$

VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = 0 V,

PCLKB = 8 to 60 MHz, $T_a = T_{opr}$,

Output load conditions: $V_{OH} = 0.5 \times VCC$, $V_{OL} = 0.5 \times VCC$, C = 30 pF, High-drive output is selected by the driving ability control register.

	Item		Symbol	Min.	Max.	Unit	Test Conditions
AUDIO_CLK	Cycle High/low level		t _{EXcyc}	20	_	ns	Figure 2.73
			t _{EXL} /t _{EXH}	0.4	0.6	t _{EXcyc}	
SSIBCKn	Cycle	Master	t _O	80	_	ns	Figure 2.74
		Slave	t _l	80	_	ns	1
	Output clock high level	Master	t _{HC}	0.35	_	t _O	
	Output clock low level		t _{LC}	0.35	_	t _O	1
	Input clock high level	Slave	t _{HC}	0.35	_	t _l	
	Input clock low level		t _{LC}	0.35	_	t _l	
	Output clock rise time	Master	t _{RC}	_	0.15	t _O	
	Output clock fall time		t _{FC}	_	0.15	t _O	
	Input clock rise time	Slave	t _{RC}	_	0.15	t _l	
	Input clock fall time		t _{FC}	_	0.15	t _l	
SSILRCKn,SSITXD0,	· ·	Master	t _{SR}	12	_	ns	Figure 2.75,
SSIRXD0, SSIDATA1		Slave		12	_	ns	Figure 2.76
	Input hold time	Master	t _{HR}	8	_	ns	
		Slave	1	15	_	ns	
	Output delay time	Master	t _{DTR}	-10	5	ns	1
		Slave	1	0	20	ns	1
	Output delay time from when an SSILRCK0 signal is changed*1	Slave	t _{DTRW}	_	20	ns	Figure 2.77

n = 0, 1

Note 1. The SSIE has a single path for transmission in slave mode. To generate the data for transmission, the signals input through the SSILRCKn pin through the abovementioned path are used. After that, the data for transmission proceed to be used as the logical outputs to the SSITXD0 or SSIDATA1 pin.

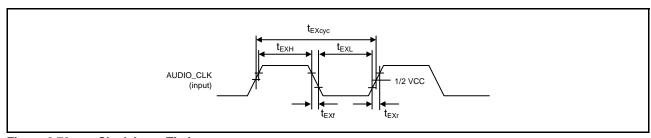


Figure 2.73 Clock Input Timing

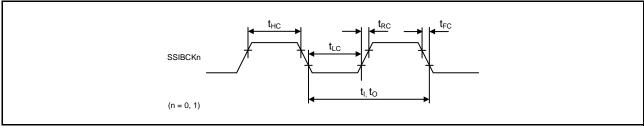


Figure 2.74 SSIE Clock Input/Output Timing

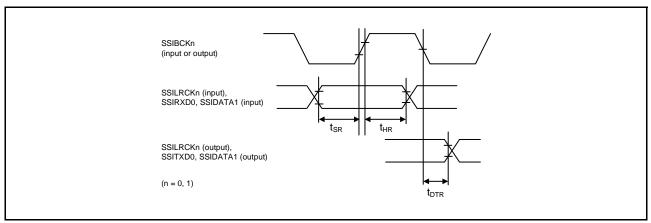


Figure 2.75 Transmission and Reception Timing for the SSIE Data When the SSICR.BCKP Bit is 0

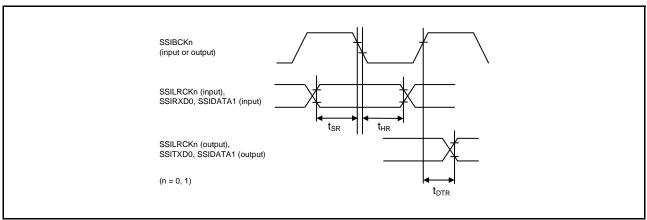


Figure 2.76 Transmission and Reception Timing for the SSIE Data When the SSICR.BCKP Bit is 1

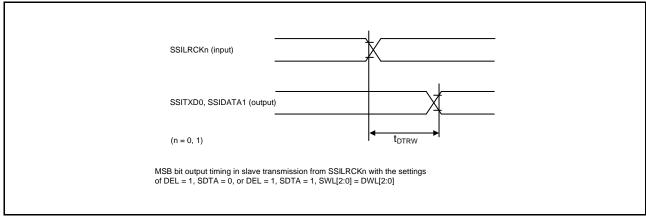


Figure 2.77 Output Delay of the SSIE Data from When an SSILRCKn Signal is Changed

2.4.7.14 PMGI

Table 2.43 PMGI Timing

Conditions: $VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 \text{ to } 3.6 \text{ V}, 2.7 \text{ V} \leq VREFH0 \leq AVCC0,}$

VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = 0 V,

ICLK = PCLKA = 8 to 120 MHz, PCLKB = BCLK = SDCLK = 8 to 60 MHz, $T_a = T_{opr}$,

Output load conditions: V_{OH} = 0.5 × VCC, V_{OL} = 0.5 × VCC, C = 30 pF, High-drive output is selected by the driving ability control register.

	Item	Symbol	Min.	Max.	Unit	Test Conditions
PMGI	PMGIn_MDC output cycle	t _{MDC}	80	_	ns	Figure 2.78
	PMGIn_MDIO setup time (relative to PMGIn_MDC↑)	t _{SMDIO}	20	_	ns	
	PMGIn_MDIO hold time (relative to PMGIn_MDC↑)	t _{HMDIO}	0	_	ns	
	PMGIn_MDIO output delay time (relative to PMGIn_MDC↑)	t _{DMDIO}	0	20	ns	

n = 0, 1

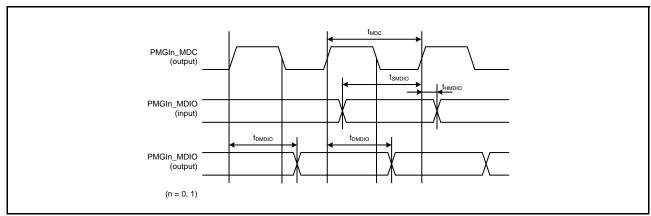


Figure 2.78 Timing of Serial Management Access

2.4.7.15 MMC

Table 2.44 MMC Host Interface Timing

Conditions: $VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 \text{ to } 3.6 \text{ V}, 2.7 \text{ V} \leq VREFH0 \leq AVCC0,}$

$$\label{eq:VSS} \begin{split} \text{VSS} &= \text{AVSS0} = \text{AVSS1} = \text{VREFL0} = \text{VSS_USB} = 0 \text{ V}, \\ \text{PCLKA} &= 8 \text{ to } 120 \text{ MHz}, \text{PCLKB} = 8 \text{ to } 60 \text{ MHz}, \text{T}_{a} = \text{T}_{opr}, \end{split}$$

Output load conditions: $V_{OH} = 0.5 \times VCC$, $V_{OL} = 0.5 \times \dot{V}CC$, C = 30 pF, High-drive output is selected by the driving ability control register.

	Item	Symbol	Min.*1	Max.	Unit	Test Conditions*2	
MMCIF	MMC_CLK clock cycle	t _{MMCPP}	2 × t _{PBcyc}	_	ns	Figure 2.79	
	MMC_CLK clock high level width	t _{MMCWH}	6.5	_	ns		
	MMC_CLK clock low level width	t _{MMCWL}	6.5	_	ns		
	MMC_CLK clock rising time	t _{MMCLH}	_	3	ns		
	MMC_CLK clock falling time	t _{MMCHL}	_	3	ns		
	MMC_CMD, MMC_D7 to MMC_D0 output data delay (data transfer mode)	t _{MMCODLY}	-6.6	6.6	ns		
	MMC_CMD, MMC_D7 to MMC_D0 input data setup	t _{MMCISU}	8	_	ns		
	MMC_CMD, MMC_D7 to MMC_D0 input data hold	t _{MMCIH}	2.5	_	ns		

Note 1. t_{PBcyc}: PCLKB cycle

Note 2. We recommend using pins that have a letter ("-A", "-B", etc.) to indicate group membership appended to their names as groups. For the MMC interface, the AC portion of the electrical characteristics is measured for each group.

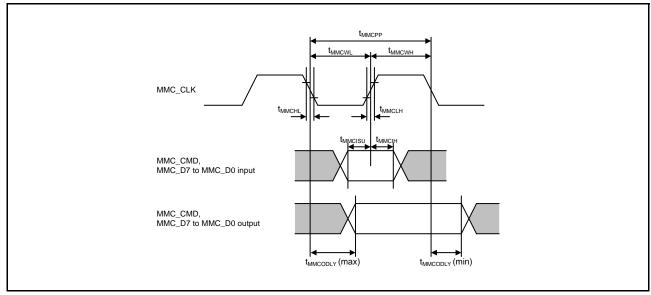


Figure 2.79 MMC Interface

2.4.7.16 SDHI

Table 2.45 SDHI Timing

Conditions: VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 to 3.6V, 2.7V \leq VREFH0 \leq AVCC0,

$$\label{eq:VSS} \begin{split} \text{VSS} = \text{AVSS0} = \text{AVSS1} = \text{VREFL0} = \text{VSS_USB} = \text{0V}, \\ \text{PCLKA} = \text{8 to 120 MHz}, \text{PCLKB} = \text{8 to 60 MHz}, \text{Ta} = \text{T}_{\text{opr}}, \end{split}$$

Output load conditions: $V_{OH} = 0.5 \times VCC$, $V_{OL} = 0.5 \times VCC$, C = 30pF High-drive output is selected by the driving ability control register.

	Item	Symbol	Min.	Max.	Unit	Test Conditions*1
SDHI	SDHI_CLK output cycle time	t _{PP(SD)}	20	_	ns	Figure 2.80
	SDHI_CLK output width at high level	t _{WH(SD)}	0.4 × t _{PP(SD)}	_	ns	
	SDHI_CLK output width at low level	t _{WL(SD)}	0.4 × t _{PP(SD)}	_	ns	
	SDHI_CLK output rising time	t _{TLH(SD)}	_	3	ns	
	SDHI_CLK output falling time	t _{THL(SD)}	_	3	ns	
	SDHI_CMD, SDHI_D3 to SDHI_D0 output data delay (data transfer mode)	t _{ODLY(SD)}	-6.5	4	ns	
	SDHI_CMD, SDHI_D3 to SDHI_D0 input data setup time	t _{ISU(SD)}	6	_	ns	
	SDHI_CMD, SDHI_D3 to SDHI_D0 input data hold time	t _{IH(SD)}	2	_	ns	

Note 1. We recommend using pin names that have a letter ("-A", "-B", etc.) to indicate group membership per group in the test. For the SDHI, the AC portion of the electrical characteristics is measured per group.

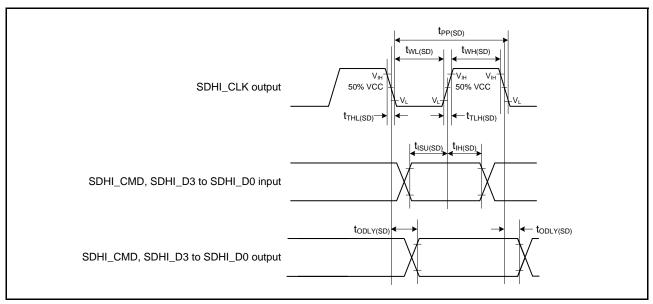


Figure 2.80 SD Host Interface Input/Output Signal Timing

2.4.7.17 ETHERC

Table 2.46 ETHERC Timing

Conditions: $VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 \text{ to } 3.6 \text{ V}, 2.7 \text{ V} \leq VREFH0 \leq AVCC0,}$

VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = 0 V, PCLKA = 8 to 120 MHz, PCLKB = 8 to 60 MHz, T_a = T_{opr},

Output load conditions: $V_{OH} = 0.5 \times VCC$, $V_{OL} = 0.5 \times VCC$, C = 30 pF,

RMII: High-drive output for the high-speed interface is selected in the drive capacity selection control register.

MII: High-drive output is selected by the driving ability control register.

	Item	Symbol	Min.	Max.	Unit	Test Conditions	
ETHERC	REF50CK cycle time	T _{ck}	20	_	ns	Figure 2.81 to	
(RMII)	REF50CK frequency Typ. 50 MHz	_	_	50 + 100 ppm	MHz	Figure 2.84	
	REF50CK duty	_	35	65	%		
	REF50CK rise/fall time	T _{ckr/ckf}	0.5	3.5	ns		
	RMIIn_xxxx*1 output delay time	T _{co}	2.5	15.0	ns		
	RMIIn_xxxx*2 setup time	T _{su}	3	_	ns		
	RMIIn_xxxx*2 hold time	T _{hd}	1	_	ns		
	RMIIn_xxxx*1, *2 rise/fall time	T_r/T_f	_	5	ns		
	ETn_WOL output delay time	t _{WOLd}	1	23.5	ns	Figure 2.85	
ETHERC	ETn_TX_CLK cycle time	t _{Tcyc}	40	_	ns	_	
(MII)	ETn_TX_EN output delay time	t _{TENd}	1	20	ns	Figure 2.86	
	ETn_ETXD0 to ETn_ETXD3 output delay time	t _{MTDd}	1	20	ns		
	ETn_CRS setup time	t _{CRSs}	10	_	ns		
	ETn_CRS hold time	t _{CRSh}	10	_	ns		
	ETn_COL setup time	t _{COLs}	10	_	ns	Figure 2.87	
	ETn_COL hold time	t _{COLh}	10	_	ns		
	ETn_RX_CLK cycle time	t _{TRcyc}	40	_	ns	_	
	ETn_RX_DV setup time	t _{RDVs}	10	_	ns	Figure 2.88	
	ETn_RX_DV hold time	t _{RDVh}	10	_	ns		
	ETn_ERXD0 to ETn_ERXD3 setup time	t _{MRDs}	10	_	ns		
	ETn_ERXD0 to ETn_ERXD3 hold time	t _{MRDh}	10	_	ns		
	ETn_RX_ER setup time	t _{RERs}	10	_	ns	Figure 2.89	
	ETn_RX_ER hold time	t _{RERh}	10	_	ns	1	
	ETn_WOL output delay time	t _{WOLd}	1	23.5	ns	Figure 2.90	

n = 0, 1

Note 1. RMIIn_TXD_EN, RMIIn_TXD1, RMIIn_TXD0

Note 2. $RMIIn_CRS_DV, RMIIn_RXD1, RMIIn_RXD0, RMIIn_RX_ER$

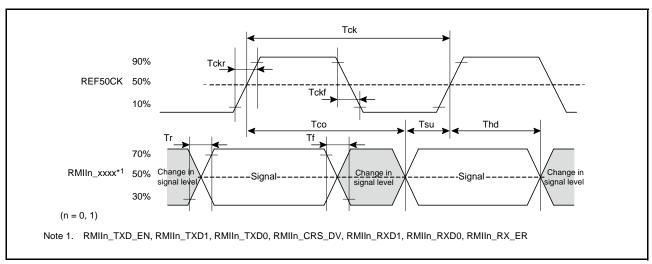


Figure 2.81 Timing with the REF50CK and RMII Signals

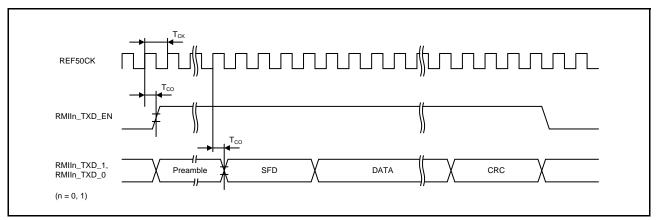


Figure 2.82 RMII Transmission Timing

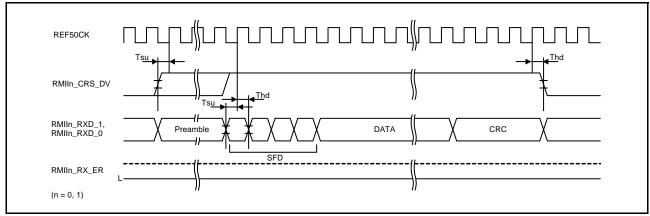


Figure 2.83 RMII Reception Timing (Normal Operation)

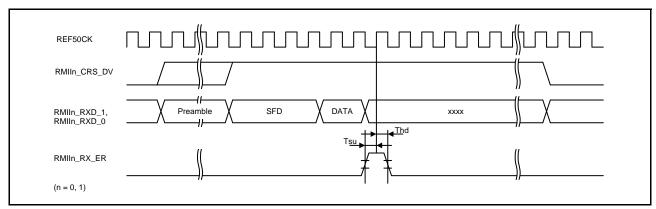


Figure 2.84 RMII Reception Timing (Error Occurrence)

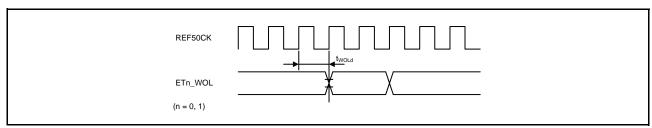


Figure 2.85 WOL Output Timing (RMII)

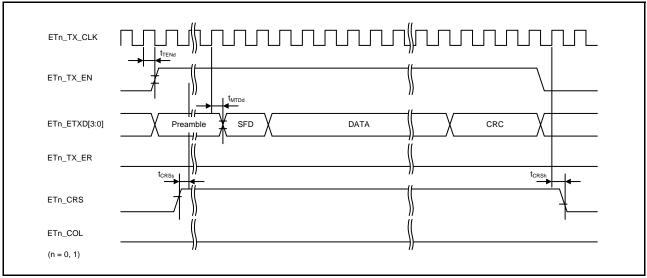


Figure 2.86 MII Transmission Timing (Normal Operation)

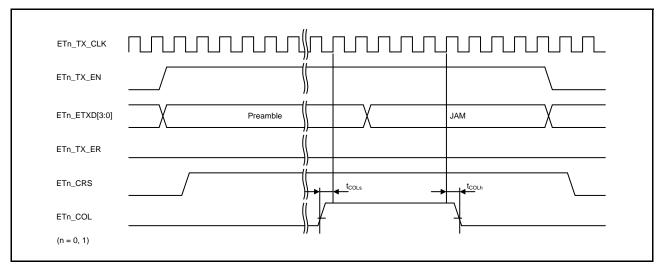


Figure 2.87 MII Transmission Timing (Conflict Occurrence)

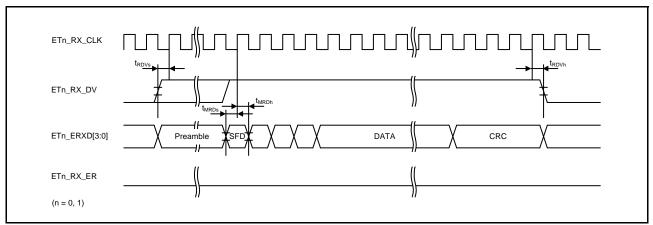


Figure 2.88 MII Reception Timing (Normal Operation)

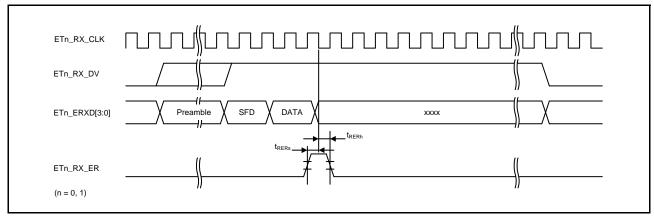


Figure 2.89 MII Reception Timing (Error Occurrence)

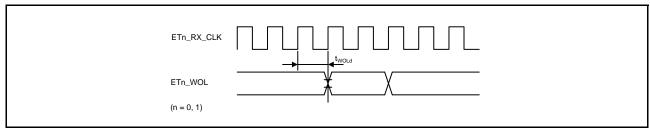


Figure 2.90 WOL Output Timing (MII)

PDC 2.4.7.18

Table 2.47 PDC Timing

Conditions: $VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 \text{ to } 3.6 \text{ V}, 2.7 \text{ V} \leq VREFH0 \leq AVCC0,}$

VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = 0 V,

PCLKA = 8 to 120 MHz, PCLKB = 8 to 60 MHz, $T_a = T_{opr}$, Output load conditions: $V_{OH} = 0.5 \times VCC$, $V_{OL} = 0.5 \times VCC$, C = 30 pF, High-drive output is selected by the driving ability control register.

	Item	Symbol	Min.*1	Max.	Unit	Test Conditions
PDC	PIXCLK input cycle time	t _{PIXcyc}	37	_	ns	Figure 2.91
	PIXCLK input high pulse width	t _{PIXH}	10	_	ns	
	PIXCLK input low pulse width	t _{PIXL}	10	_	ns	
	PIXCLK rising time	t _{PIXr}	_	5	ns	
	PIXCLK falling time	t _{PIXf}	_	5	ns	
	PCKO output cycle time	t _{PCKcyc}	2 x t _{PBcyc}	_	ns	Figure 2.92
	PCKO output high pulse width	t _{PCKH}	(t _{PCKcyc} - t _{PCKr} - t _{PCKf})/2 - 3	_	ns	
	PCKO output low pulse width	t _{PCKL}	(t _{PCKcyc} - t _{PCKr} - t _{PCKf})/2 - 3	_	ns	
	PCKO rising time	t _{PCKr}	_	5	ns	
	PCKO falling time	t _{PCKf}	_	5	ns	
	VSYNC/HSYNC input setup time	t _{SYNCS}	10	_	ns	Figure 2.93
	VSYNC/HSYNC input hold time	t _{SYNCH}	5	_	ns	
	PIXD input setup time	t _{PIXDS}	10	_	ns	
	PIXD input hold time	t _{PIXDH}	5	_	ns	

Note 1. t_{PBcyc} : PCLKB cycle

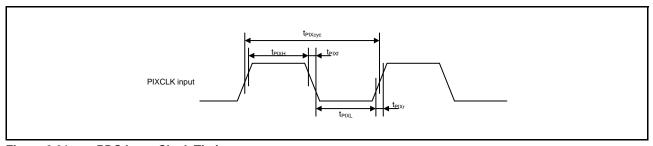


Figure 2.91 **PDC Input Clock Timing**

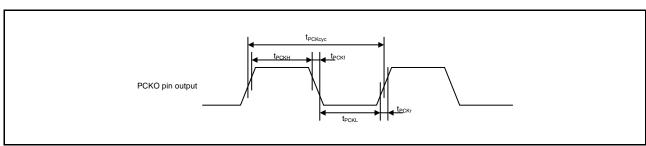


Figure 2.92 **PDC Output Clock Timing**

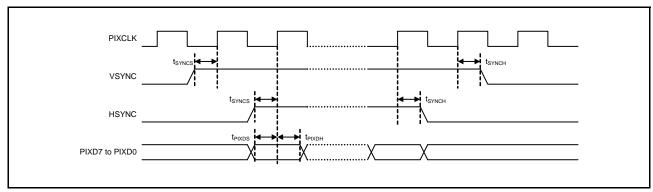


Figure 2.93 PDC AC Timing

2.4.7.19 GLCDC

Table 2.48 GLCDC Timing

Conditions: $VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 \text{ to } 3.6 \text{ V}, 2.7 \text{ V} \le VREFH0 \le AVCC0,}$

 $VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = 0 V, \\ PCLKA = 8 \text{ to } 120 \text{ MHz}, PCLKB = 8 \text{ to } 60 \text{ MHz}, T_a = T_{opr}, \\ \\$

Output load conditions: $V_{OH} = 0.5 \times VCC$, $V_{OL} = 0.5 \times VCC$, C = 30 pF

Item	Symbol	Min.	Тур.	Max.	Unit	Test Conditions
LCD_EXTCLK Input clock frequency	t _{Ecyc}	_	_	30* ¹	MHz	Figure 2.94
LCD_EXTCLK Input clock Low pulse width	t _{WL}	0.45	_	0.55	t _{Ecyc}	
LCD_EXTCLK Input clock High pulse width	t _{WH}	0.45	_	0.55	t _{Ecyc}	
LCD_CLK Output clock frequency	t _{Lcyc}	_	_	30* ¹	MHz	Figure 2.95
LCD_CLK Output clock Low pulse width	t _{LOL}	0.4	_	0.6	t _{Lcyc}	
LCD_CLK Output clock High pulse width	t _{LOH}	0.4	_	0.6	t _{Lcyc}	
LCD_CLK Output clock rise time	t _{LOR}	_	_	5	ns	
LCD_CLK Output clock fall time	t _{LOF}	_	_	5	ns	
LCD data output Delay timing	t _{DD}	-3.5* ²	_	4*2	ns	Figure 2.96

Note 1. Parallel RGB888,666,565: Max. 27 MHz Serial RGB888: Max. 30 MHz (4x speed)

Note 2. We recommend using pins that have a letter ("-A", "-B", etc) to indicate group membership appended to their names as groups. For the GLCDC interface, the AC portion of the electrical characteristics is measured for each group.

If we use group "-A" and "-B" combination, "LCD data output Delay timing (t_{DD})" is Min = -5.0 ns, Max = 5.5 ns.

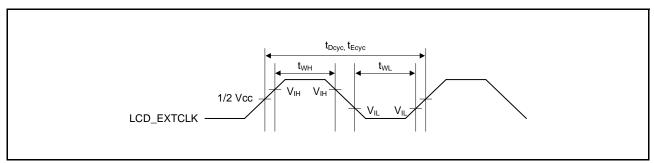


Figure 2.94 LCD_EXTCLK Clock Input Timing

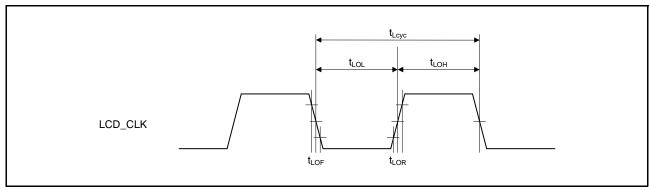


Figure 2.95 LCD_CLK Clock Output Timing

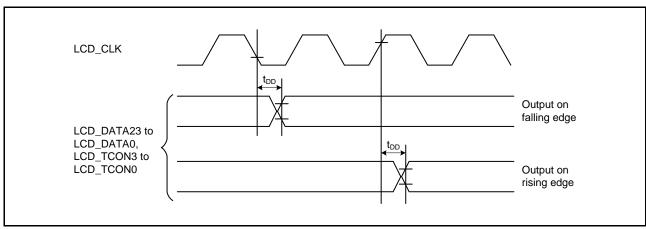


Figure 2.96 LCD Output Data Timing

2.4.7.20 A/D Converter Trigger

Table 2.49 A/D Converter Trigger Timing

Conditions: VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 to 3.6 V, 2.7 V \leq VREFH0 \leq AVCC0, VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = 0 V, PCLKA = 8 to 120 MHz, PCLKB = 8 to 60 MHz, $T_a = T_{opr}$, Output load conditional VOH = 0.5 \times VCC, VOL = 0.5 \times VCC, C = 30 pF, High-drive output is selected by the driving ability control register.

	Item	Symbol	Min.	Max.	Unit*1	Test Conditions
A/D converter	A/D converter trigger input pulse width	t _{TRGW}	1.5	_	t _{PBcyc}	Figure 2.97

Note 1. t_{PBcyc}: PCLKB cycle

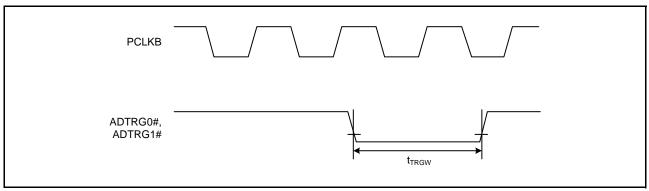


Figure 2.97 A/D Converter Trigger Input Timing

2. Electrical Characteristics RX72N Group

CAC 2.4.7.21

Table 2.50 CAC Timing

Conditions: $VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 \text{ to } 3.6 \text{ V}, 2.7 \text{ V} \leq VREFH0 \leq AVCC0,}$

 $VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = 0 \ V,$

PCLKA = 8 to 120 MHz, PCLKB = 8 to 60 MHz, $T_a = T_{opr}$, Output load conditions: $V_{OH} = 0.5 \times VCC$, $V_{OL} = 0.5 \times VCC$, C = 30 pF, High-drive output is selected by the driving ability control register.

	Item*1, *2		Symbol	Min.* ^{1,} * ²	Max.	Unit	Test Conditions
CAC	CACREF input pulse width	t _{PBcyc} ≤ t _{cac}	t _{CACREF}	4.5 t _{cac} + 3 t _{PBcyc}	_	ns	
		$t_{PBcyc} > t_{cac}$		5 t _{cac} + 6.5 t _{PBcyc}	_		

 $\begin{array}{ll} \mbox{Note 1.} & \mbox{$t_{\mbox{\footnotesize{PBcyc}}}$: PCLKB cycle} \\ \mbox{Note 2.} & \mbox{$t_{\mbox{\footnotesize{cac}}$: CAC count clock source cycle} \\ \end{array}$

2.5 USB Characteristics

Table 2.51 On-Chip USB Low Speed (Host Only) Characteristics (DP and DM Pin Characteristics)

Conditions: $VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 3.0 \text{ to } 3.6 \text{ V}, 3.0 \text{ V} \leq VREFH0 \leq AVCC0,$

VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = 0 V,

UCLK = 48 MHz, PCLKA = 8 to 120 MHz,

PCLKB = 8 to 60 MHz, $T_a = T_{opr}$

	Item	Symbol	Min.	Тур.	Max.	Unit	Test Conditions
Input characteristics	Input high level voltage	V _{IH}	2.0	_	_	V	
	Input low level voltage	V _{IL}	_	_	0.8	V	
	Differential input sensitivity	V _{DI}	0.2	_	_	V	DP – DM
	Differential common mode range	V _{CM}	0.8	_	2.5	V	
Output characteristics	Output high level voltage	V _{OH}	2.8	_	3.6	V	I _{OH} = -200 μA
	Output low level voltage	V _{OL}	0.0	_	0.3	V	I _{OL} = 2 mA
	Cross-over voltage	V _{CRS}	1.3	_	2.0	V	Figure 2.98
	Rise time	t _{LR}	75	_	300	ns	
	Fall time	t _{LF}	75	_	300	ns	
	Rise/fall time ratio	t _{LR} / t _{LF}	80	_	125	%	t _{LR} / t _{LF}
Pull-down characteristics	DP/DM pull-down resistance (when the host controller function is selected)	R _{pd}	14.25	_	24.80	kΩ	

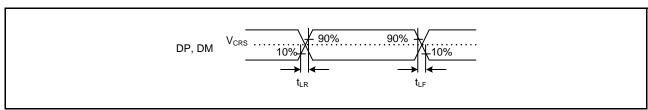


Figure 2.98 DP and DM Output Timing (Low Speed)

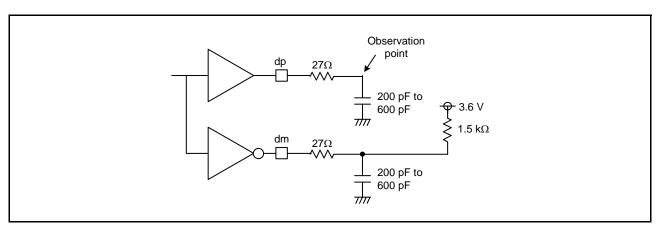


Figure 2.99 Test Circuit (Low Speed)

2. Electrical Characteristics RX72N Group

Table 2.52 On-Chip USB Full-Speed Characteristics (DP and DM Pin Characteristics)

Conditions: VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 3.0 to 3.6 V, 3.0 V \leq VREFH0 \leq AVCC0, VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = 0 V,

UCLK = 48 MHz, PCLKA = 8 to 120 MHz,

PCLKB = 8 to 60 MHz, $T_a = T_{opr}$

	Item	Symbol	Min.	Тур.	Max.	Unit	Test Conditions
Input	Input high level voltage	V _{IH}	2.0	_	_	V	
characteristics	Input low level voltage	V _{IL}	_	_	0.8	V	
	Differential input sensitivity	V _{DI}	0.2	_	_	V	DP – DM
	Differential common mode range	V _{CM}	0.8	_	2.5	V	
Output	Output high level voltage	V _{OH}	2.8	_	3.6	V	I _{OH} = -200 μA
characteristics	Output low level voltage	V _{OL}	0.0	_	0.3	V	I _{OL} = 2 mA
	Cross-over voltage	V _{CRS}	1.3	_	2.0	V	Figure 2.100
	Rise time	t _{FR}	4	_	20	ns	
	Fall time	t _{FF}	4	_	20	ns	
	Rise/fall time ratio	t _{FR} / t _{FF}	90	_	111.11	%	t _{FR} / t _{FF}
	Output resistance	Z _{DRV}	28	_	44	Ω	Rs = 27Ω included
Pull-up and	DP pull-up resistance	R _{pu}	0.900	_	1.575	kΩ	Idle state
oull-down characteristics	(when the function controller function is selected)		1.425	_	3.090		At transmission and reception
	DP/DM pull-down resistance (when the host controller function is selected)	R _{pd}	14.25	_	24.80	kΩ	

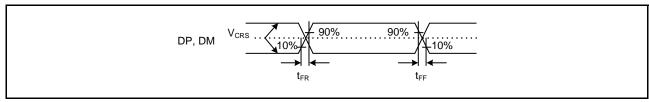


Figure 2.100 DP and DM Output Timing (Full-Speed)

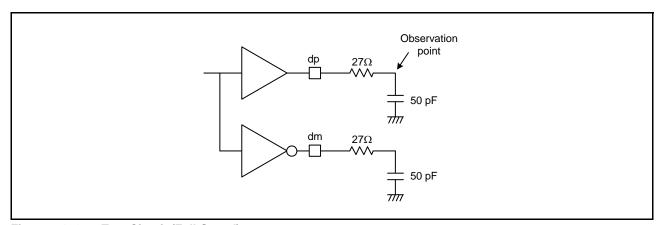


Figure 2.101 Test Circuit (Full-Speed)

2.6 A/D Conversion Characteristics

Table 2.53 12-Bit A/D (Unit 0) Conversion Characteristics

Conditions: $VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 \text{ to } 3.6 \text{ V}, 2.7 \text{ V} \leq VREFH0 \leq AVCC0,}$

 $VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = 0 V,$

PCLKB = PCLKC = 1 MHz to 60 MHz, $T_a = T_{opr}$, Source impedance = 1.0 k Ω

	Item	Min.	Тур.	Max.	Unit	Test Conditions
Resolution		8	_	12	Bit	
Analog input capac	itance	_	_	30	pF	
Channel-dedi- cated sample-and- hold circuits in use (AN000 to AN002)	Conversion time*1 (Operation at PCLKC = 60 MHz)	1.06 (0.4 + 0.25) *2	_	_	μs	Sampling of channel- dedicated sample-and- hold circuits in 24 states Sampling in 15 states
	Offset error	_	±1.5	±3.5	LSB	AN000 to AN002 = 0.25 V
	Full-scale error	_	±1.5	±3.5	LSB	AN000 to AN002 = VREFH0 - 0.25 V
	Quantization error	_	±0.5	_	LSB	
	Absolute accuracy	_	±3.0	±5.5	LSB	
	DNL differential nonlinearity error	_	±1.0	±2.0	LSB	
	INL integral nonlinearity error	_	±1.5	±3.0	LSB	
	Holding characteristics of sample-and-hold circuits	_	_	20	μs	
	Dynamic range	0.25	_	VREFH0 - 0.25	V	
Channel-dedi- cated sample-and-	Conversion time*1 (Operation at PCLKC = 60 MHz)	0.48 (0.267)*2	_	_	μs	Sampling in 16 states
hold circuits not in use	Offset error	_	±1.0	±2.5	LSB	
(AN000 to AN007)	Full-scale error	_	±1.0	±2.5	LSB	
	Quantization error	_	±0.5	_	LSB	
	Absolute accuracy	_	±2.5	±4.5	LSB	
	DNL differential nonlinearity error	_	±0.5	±1.5	LSB	
	INL integral nonlinearity error	_	±1.0	±2.5	LSB	

Note: The above specification values apply when there is no access to the external bus during A/D conversion. If access proceeds during A/D conversion, values may not fall within the above ranges.

Note 1. The conversion time includes the sampling time and the comparison time. As the test conditions, the number of sampling states is indicated.

Note 2. The value in parentheses indicates the sampling time.

Table 2.54 12-Bit A/D (Unit 1) Conversion Characteristics

Conditions: $VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 \text{ to } 3.6 \text{ V}, 2.7 \text{ V} \leq VREFH0 \leq AVCC0, The second state of the second state o$

VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = 0 V,

PCLKB = PCLKD = 1 MHz to 60 MHz, $T_a = T_{opr}$, Source impedance = 1.0 k Ω

Item	Min.	Тур.	Max.	Unit	Test Conditions
Resolution	8	_	12	Bit	
Conversion time*1 (Operation at PCLKD = 60 MHz)	0.88 (0.633)*2	_	_	μs	Sampling in 38 states (ADSAM.SAM = 1)
Conversion time* ¹ (Operation at PCLKD = 30 MHz)	1 (0.500)*2	_	_	μs	Sampling in 15 states (ADSAM.SAM = 1)
Analog input capacitance	_	_	30	pF	
Offset error	_	±2.0	±3.5	LSB	
Full-scale error	_	±2.0	±3.5	LSB	
Quantization error	_	±0.5	_	LSB	
Absolute accuracy	_	±4.0	±6.0	LSB	
DNL differential nonlinearity error (Operation at PCLKD = 60 MHz)	_	±1.5	±4.0	LSB	
DNL differential nonlinearity error (Operation at PCLKD = 30 MHz)	_	±1.5	±2.5	LSB	
INL integral nonlinearity error (Operation at PCLKD = 60 MHz)	_	±2.0	±4.0	LSB	
INL integral nonlinearity error (Operation at PCLKD = 30 MHz)	_	±2.0	±3.5	LSB	

The above specification values apply when there is no access to the external bus during A/D conversion. If access proceeds Note: during A/D conversion, values may not fall within the above ranges.

Note 1. The conversion time includes the sampling time and the comparison time. As the test conditions, the number of sampling states is indicated.

Note 2. The value in parentheses indicates the sampling time.

A/D Internal Reference Voltage Characteristics **Table 2.55**

Conditions: $VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 \text{ to } 3.6 \text{ V}, 2.7 \text{ V} \le VREFH0 \le AVCC0}, VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = 0 \text{ V},$

 $PCLKB = PCLKD = 60 MHz, T_a = T_{opr}$

Item	Min.	Тур.	Max.	Unit	Test Conditions
A/D internal reference voltage	1.13	1.18	1.23	V	

D/A Conversion Characteristics 2.7

Table 2.56 D/A Conversion Characteristics

Conditions: VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 to 3.6 V, 2.7 V \leq VREFH0 \leq AVCC0, VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = 0 V,

 $T_a = T_{opr}$

	Item	Symbol	Min.	Тур.	Max.	Unit	Test Conditions
Resolution		_	12	12	12	Bit	
Unbuffered output	Absolute accuracy	_	_	_	±6.0	LSB	2-MΩ resistive load 10-bit conversion
	Differential nonlinearity error	DNL	_	±1.0	±2.0	LSB	2-MΩ resistive load
	Output resistance	R _O	_	8.6	_	kΩ	
	Setting time	t _S	_	_	3	μs	20-pF capacitive load
Buffered output	Load resistance	R _L	5	_	_	kΩ	
	Load capacitance	C _L	_	_	50	pF	
	Output voltage	V _O	0.2	_	AVCC1 - 0.2	V	
	Differential nonlinearity error	DNL		±1.0	±2.0	LSB	
	Integral nonlinearity error	INL	_	±2.0	±4.0	LSB	
	Setting time	t _S	_	_	4	μs	

2.8 **Temperature Sensor Characteristics**

Table 2.57 Temperature Sensor Characteristics

Conditions: VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 to 3.6 V, 2.7 V \leq VREFH0 \leq AVCC0, VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = 0 V,

 $T_a = T_{opr}$

ltem	Min.	Тур.	Max.	Unit	Test Conditions
Relative accuracy	_	±1	_	°C	
Temperature slope	_	4	_	mV/°C	
Output voltage	_	1.21	_	V	T _a = 25°C
Temperature sensor start time	_	_	30	μs	
Sampling time*1	4.15	_	_	μs	

Note 1. Set the S12AD1.ADSSTRT register such that the sampling time of the 12-bit A/D converter satisfies this specification.

2.9 Power-on Reset Circuit and Voltage Detection Circuit Characteristics

Table 2.58 Power-on Reset Circuit and Voltage Detection Circuit Characteristics

Conditions: $VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 \text{ to } 3.6 \text{ V}, 2.7 \text{ V} \leq VREFH0 \leq AVCC0,}$

VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = 0 V,

 $T_a = T_{opr}$

	Item	Symbol	Min.	Тур.	Max.	Unit	Test Conditions	
Voltage detection level	Power-on reset (POR)	Low power consumption function disabled*1	V _{POR}	2.5	2.6	2.7	V	Figure 2.102
		Low power consumption function enabled*2		1.8	2.25	2.7		
	Voltage detection	on circuit (LVD0)	V _{det0_1}	2.84	2.94	3.04		Figure 2.103
			V _{det0_2}	2.77	2.87	2.97		
		V _{det0_3}	2.70	2.80	2.90			
	Voltage detection	V _{det1_1}	2.89	2.99	3.09		Figure 2.104	
		V _{det1_2}	2.82	2.92	3.02			
		V _{det1_3}	2.75	2.85	2.95			
	Voltage detection	V _{det2_1}	2.89	2.99	3.09		Figure 2.105	
		V _{det2_2}	2.82	2.92	3.02			
		V _{det2_3}	2.75	2.85	2.95			
Internal reset time	Power-on reset	t _{POR}	_	4.6	_	ms	Figure 2.102	
	LVD0 reset time	t _{LVD0}	_	0.70	_		Figure 2.103	
	LVD1 reset time	t _{LVD1}	_	0.57	_		Figure 2.104	
	LVD2 reset time	t _{LVD2}	_	0.57	_		Figure 2.105	
Minimum VCC down time			t _{VOFF}	200	_	_	μs	Figure 2.102, Figure 2.103
Response delay time			t _{det}	_	_	200	μs	Figure 2.102 to Figure 2.105
LVD operation stab	ilization time (afte	er LVD is enabled)	t _{d(E-A)}	_	_	10	μs	Figure 2.104,
Hysteresis width (L	Hysteresis width (LVD1 and LVD2)				70	_	mV	Figure 2.105

Note: The minimum VCC down time indicates the time when VCC is below the minimum value of voltage detection levels V_{POR} , $V_{det1,}$ and V_{det2} for the POR/ LVD.

Note 1. The low power consumption function is disabled and DEEPCUT[1:0] = 00b or 01b.

Note 2. The low power consumption function is enabled and DEEPCUT[1:0] = 11b.

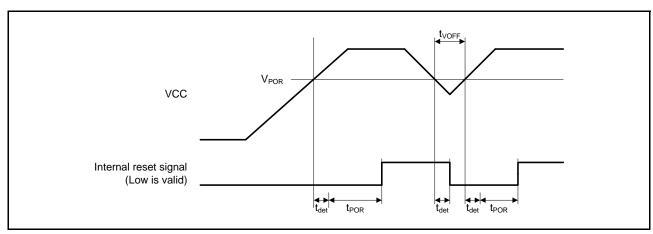


Figure 2.102 Power-on Reset Timing

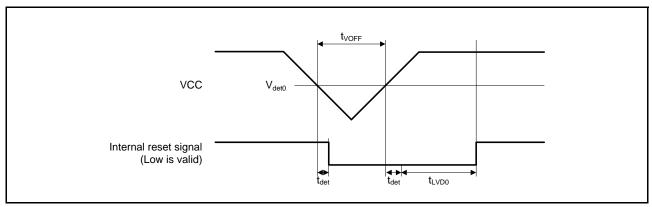


Figure 2.103 Voltage Detection Circuit Timing (V_{det0})

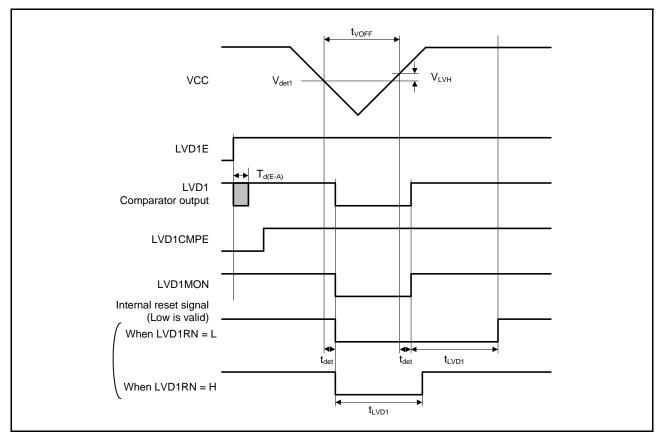


Figure 2.104 Voltage Detection Circuit Timing (V_{det1})

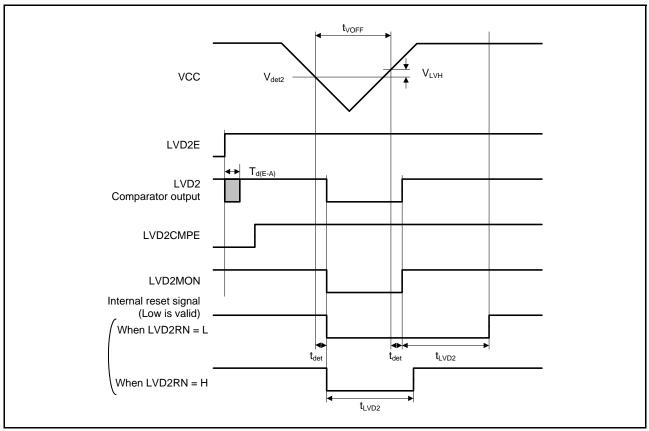


Figure 2.105 Voltage Detection Circuit Timing (V_{det2})

2. Electrical Characteristics RX72N Group

2.10 Oscillation Stop Detection Timing

Table 2.59 Oscillation Stop Detection Circuit Characteristics

Conditions: VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 to 3.6 V, 2.7 V \leq VREFH0 \leq AVCC0, VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = 0 V,

 $T_a = T_{opr}$

Item	Symbol	Min.	Тур.	Max.	Unit	Test Conditions
Detection time	t _{dr}	_	_	1	ms	Figure 2.106

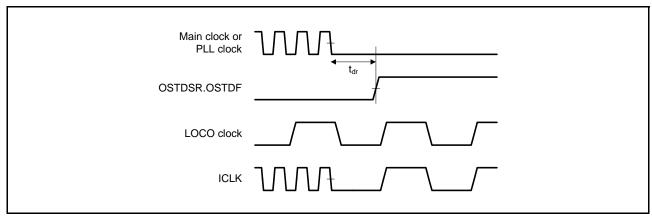


Figure 2.106 **Oscillation Stop Detection Timing**

2.11 Battery Backup Function Characteristics

Table 2.60 Battery Backup Function Characteristics

Conditions: VCC = AVCC0 = AVCC1 = VCC_USB = 2.7 to 3.6 V, 2.7 V ≤ VREFH0 ≤ AVCC0,

VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = 0 V,

 $V_{BATT} = 2.0 \text{ to } 3.6 \text{ V}, T_a = T_{opr}$

Item	Symbol	Min.	Тур.	Max.	Unit	Test Conditions
Voltage level for switching to battery backup	V _{DETBATT}	2.50	2.60	2.70	V	Figure 2.107
Lower-limit $V_{\mbox{\footnotesize{BATT}}}$ voltage for power supply switching due to VCC voltage drop	V _{BATTSW}	2.70		_		
VCC-off period for starting power supply switching	t _{VOFFBATT}	200	_	_	μs	

Note: The VCC-off period for starting power supply switching indicates the period in which VCC is below the minimum value of the voltage level for switching to battery backup (V_{DETBATT}).

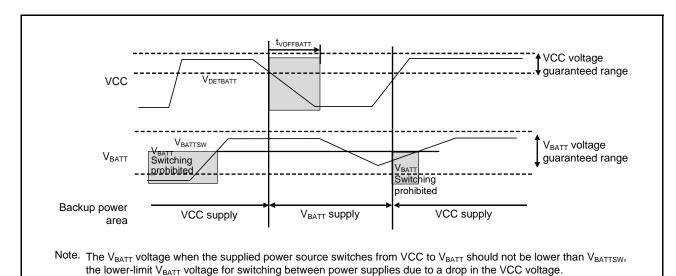


Figure 2.107 Battery Backup Function Characteristics

2.12 Flash Memory Characteristics

Table 2.61 Code Flash Memory Characteristics

Conditions: $VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 \text{ to } 3.6 \text{ V}, 2.7 \text{ V} \le VREFH0 \le AVCC0, The second se$

VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = 0 V, Temperature range for programming/erasure: $T_a = T_{opr}$

Item		Symbol	FCLK = 4 MHz		FCLK = 15 MHz			20 MHz ≤ FCLK ≤ 60 MHz			Unit	
	10111		Min.	Тур.	Max.	Min.	Тур.	Max.	Min.	Тур.	Max.	Offic
Programming time	128 bytes	t _{P128}	_	0.75	13.2	_	0.38	6.6	_	0.34	6	ms
N _{PEC} ≤ 100 times	8 Kbytes	t _{P8K}	_	49	176	_	25	88	_	22	80	ms
	32 Kbytes	t _{P32K}	_	194	704	_	97	352	_	88	320	ms
Programming time	128 bytes	t _{P128}		0.91	15.8	_	0.46	8	_	0.41	7.2	ms
N _{PEC} > 100 times	8 Kbytes	t _{P8K}		60	212	_	30	106	_	27	96	ms
	32 Kbytes	t _{P32K}		234	848	_	117	424	_	106	384	ms
Erasure time	8 Kbytes	t _{E8K}		78	216	_	48	132	_	43	120	ms
N _{PEC} ≤ 100 times	32 Kbytes	t _{E32K}	_	283	864	_	173	528	_	157	480	ms
Erasure time	8 Kbytes	t _{E8K}		94	260	_	58	158	_	52	144	ms
N _{PEC} > 100 times	32 Kbytes	t _{E32K}	_	341	1040	_	208	632	_	189	576	ms
Reprogramming/erasure cycle*1		N _{PEC}	10000 *2	-	-	10000 *2	_	_	10000 *2	_	-	Times
Suspend delay time programming	during	t _{SPD}	_	_	264	_	_	132	_	_	120	μs
erasing	First suspend delay time during erasing (in suspend priority mode)		_	_	216	_	_	132	_	_	120	μs
Second suspend delay time during erasure (in suspend priority mode)		t _{SESD2}			1.7	_	_	1.7	_	_	1.7	ms
Suspend delay time during erasure (in erasure priority mode)		t _{SEED}	_	_	1.7	_	_	1.7	_	_	1.7	ms
Forced stop comma	and	t _{FD}			32	_		22	_	_	20	μs
Data hold time*3		t _{DRP}	10	_	_	10	_	_	10	_	_	Year

Note 1. Definition of reprogram/erase cycle:

The program/erase cycle is the number of erasing for each block. When the number of program/erase cycles is n, each block can be erased n times. For instance, when 128-byte program is performed 64 times for different addresses in 8-Kbyte block and then the block is erased, the program/erase cycle is counted as one. However, the same address cannot be programmed more than once before the next erase cycle (overwriting is prohibited).

Note 2. Characteristics are degraded as the number of program/erase increases. This is the minimum value of program/erase cycles to guarantee all characteristics listed in this table.

Note 3. This shows the characteristics when the program/erase cycle does not exceed the specified value.

Table 2.62 Data Flash Memory Characteristics

Conditions: $VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 \text{ to } 3.6 \text{ V}, 2.7 \text{ V} \le VREFH0 \le AVCC0, VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = 0 V,$

Temperature range for programming/erasure: $T_a = T_{opr}$

ltem		Cumbal	FCL	K = 4 M	Hz	FCLK = 15 MHz			20 MHz ≤ FCLK ≤ 60 MHz			Unit
		Symbol	Min.	Тур.	Max.	Min.	Тур.	Max.	Min.	Тур.	Max.	Unit
Programming time	4 bytes	t _{DP4}	_	0.36	3.8	_	0.18	1.9	_	0.16	1.7	ms
Erasure time	64 bytes	t _{DP64}	_	3.1	18	_	1.9	11	_	1.7	10	ms
	128 bytes	t _{DP128}	_	4.7	27	_	2.9	16	_	2.6	15	ms
	256 bytes	t _{DP256}	_	8.9	50	_	5.4	31	_	4.9	28	ms
Blank check time	4 bytes	t _{DBC4}	_	_	84	_	_	33	_		30	μs
	64 bytes	t _{DBC64}	_	_	280	_	_	110	_		100	μs
	2 Kbytes	t _{DBC2K}	_	_	6160	_	_	2420	_	-	2200	μs
Reprogramming/era	Reprogramming/erasure cycle*1		100000	_	_	100000	_	_	100000 *2	_	_	Times
Suspend delay time programming	during	t _{DSPD}	_	_	264	_	_	132	_	_	120	μs
First suspend	64 bytes	_	_	_	216	_	_	132	_	_	120	μs
delay time during erasure	128 bytes	_	_	_	216	_	_	132	_	_	120	μs
(in suspend prior- ity mode)	256 bytes			_	216	_	_	132	_	_	120	μs
Second suspend	64 bytes	_	_	_	300	_	_	300	_	-	300	μs
delay time during erasure	128 bytes	_	_	_	390	_	_	390	_	_	390	μs
(in suspend prior- ity mode)	256 bytes	_	_	_	570	_	_	570	_	_	570	μs
Suspend delay	64 bytes	_	_	_	300	_	_	300	_		300	μs
time during erasing (in suspend prior-	128 bytes	_	_	_	390	_	_	390	_	_	390	μs
ity mode)	256 bytes	_	_	_	570	_	_	570	_		570	μs
Forced stop comma	nd	t _{FD}	_	_	32	_	_	22	_	_	20	μs
Data hold time*3		t _{DDRP}	10	_	_	10	_	_	10		_	Year

Note 1. Definition of reprogram/erase cycle:

The program/erase cycle is the number of erasing for each block. When the number of program/erase cycles is n, each block can be erased n times. For instance, when 4-byte program is performed 512 times for different addresses in 2-Kbyte block and then the block is erased, the program/erase cycle is counted as one. However, the same address cannot be programmed more than once before the next erase cycle (overwriting is prohibited).

Note 2. Characteristics are degraded as the number of program/erase increases. This is the minimum value of program/erase cycles to guarantee all characteristics listed in this table.

Note 3. This shows the characteristics when the program/erase cycle does not exceed the specified value.

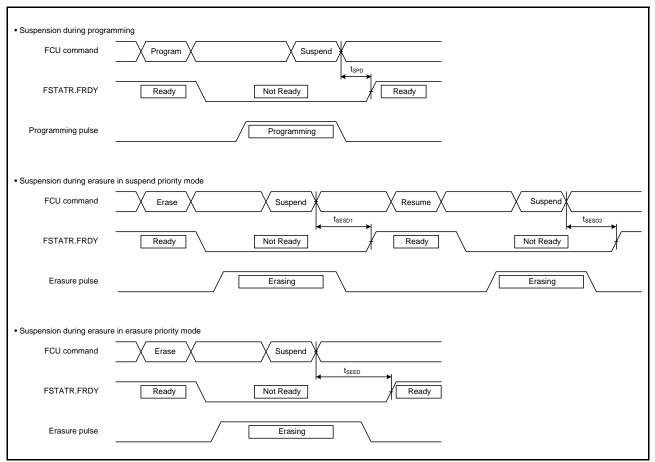


Figure 2.108 Flash Memory Programming/Erasure Suspension Timing

2.13 Boundary Scan

Table 2.63 Boundary Scan Characteristics

Conditions: $VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 \text{ to } 3.6 \text{ V}, 2.7 \text{ V} \leq VREFH0 \leq AVCC0,}$

VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = 0 V,

 $T_a = T_{opr}$

Output load conditions: $V_{OH} = 0.5 \times VCC$, $V_{OL} = 0.5 \times VCC$, C = 30 pF, High-drive output is selected by the driving ability control register.

ltem	Symbol	Min.	Тур.	Max.	Unit	Test Conditions
TCK clock cycle time	t _{TCKcyc}	100	_	_	ns	Figure 2.109
TCK clock high pulse width	t _{TCKH}	45	_	_	ns	
TCK clock low pulse width	t _{TCKL}	45	_	_	ns	
TCK clock rise time	t _{TCKr}	_	_	5	ns	
TCK clock fall time	t _{TCKf}	_	_	5	ns	
TRST# pulse width	t _{TRSTW}	20	_	_	t _{TCKcyc}	Figure 2.110
TMS setup time	t _{TMSS}	20	_	_	ns	Figure 2.111
TMS hold time	t _{TMSH}	20	_	_	ns	
TDI setup time	t _{TDIS}	20	_	_	ns	
TDI hold time	t _{TDIH}	20	_	_	ns	
TDO data delay time	t _{TDOD}	_	_	40	ns	

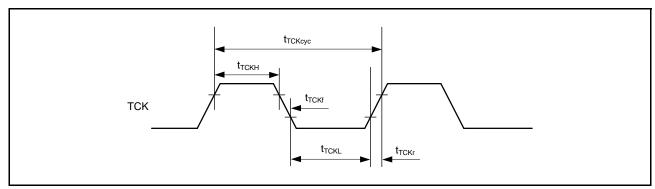


Figure 2.109 Boundary Scan TCK Timing

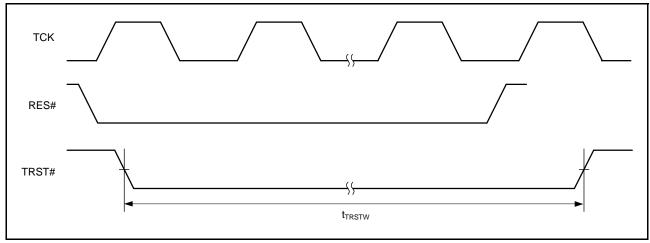


Figure 2.110 Boundary Scan TRST# Timing

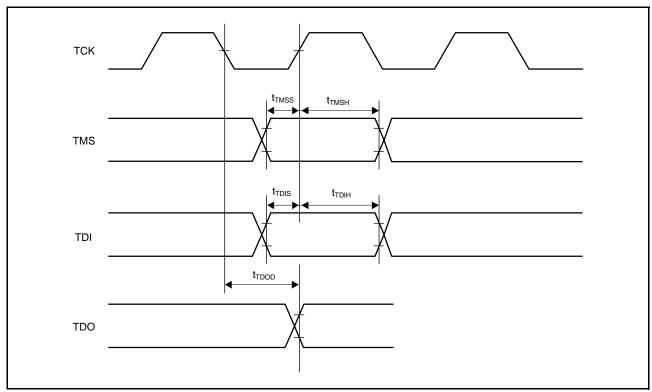


Figure 2.111 Boundary Scan Input/Output Timing

Appendix 1. Package Dimensions

Information on the latest version of the package dimensions or mountings has been displayed in "Packages" on Renesas Electronics Corporation website.

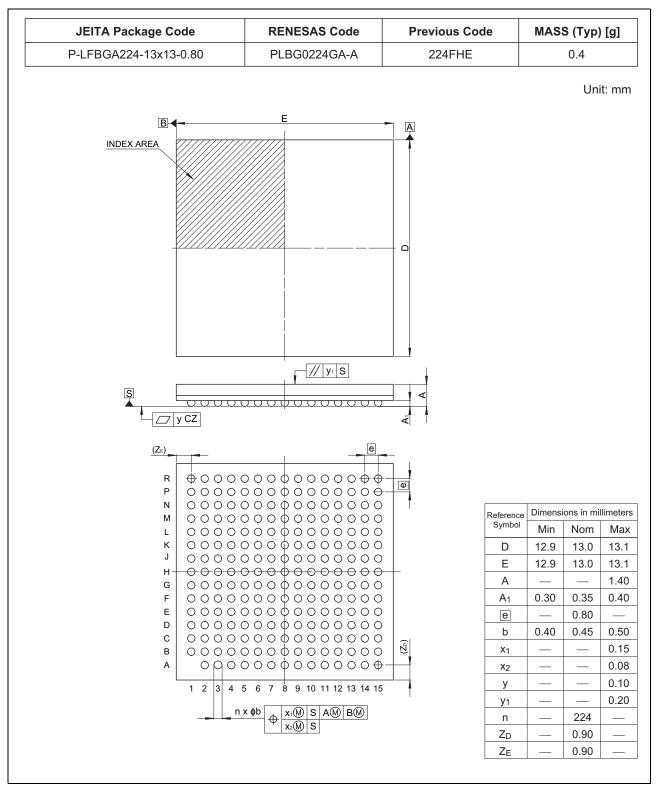


Figure A 224-Pin LFBGA (PLBG0224GA-A)

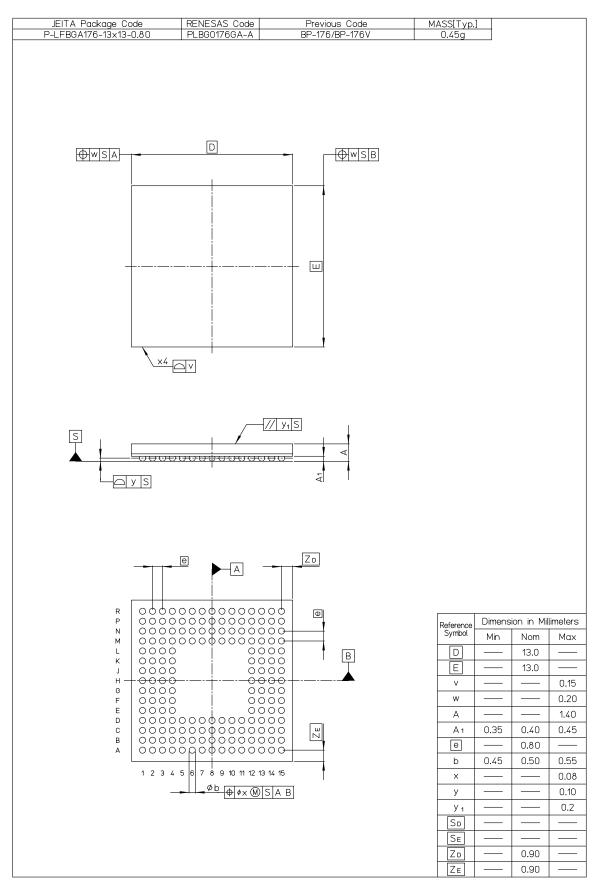


Figure B 176-Pin LFBGA (PLBG0176GA-A)

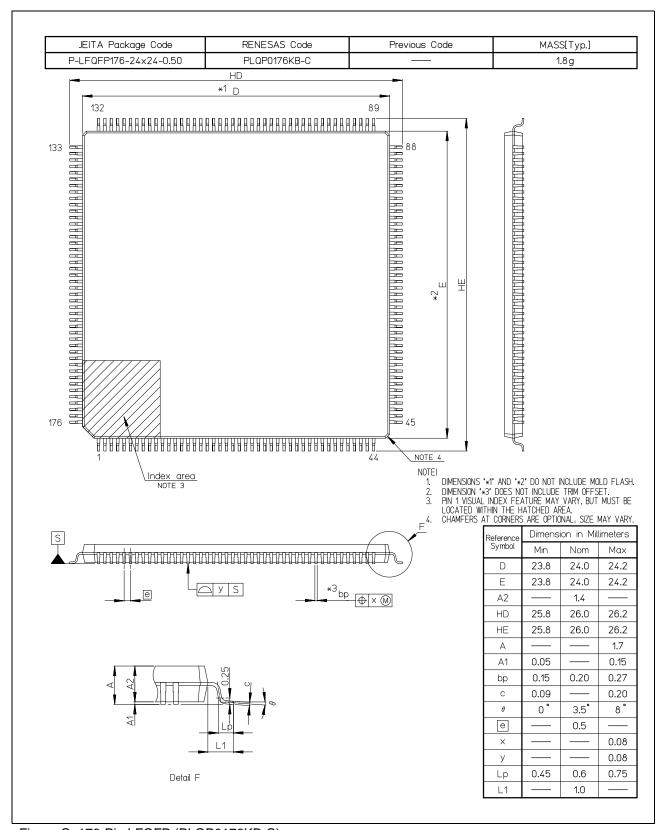


Figure C 176-Pin LFQFP (PLQP0176KB-C)

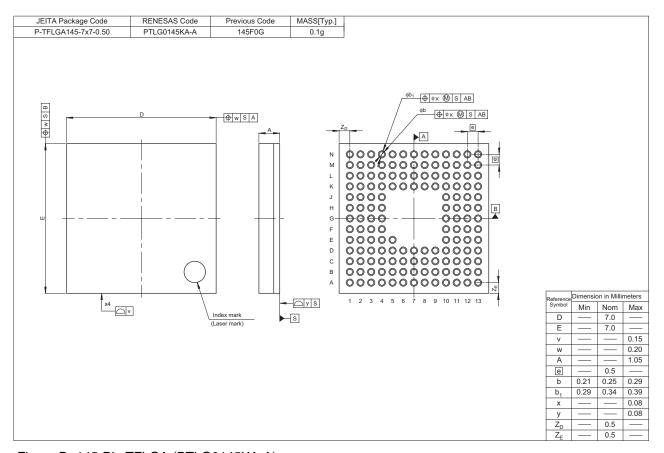


Figure D 145-Pin TFLGA (PTLG0145KA-A)

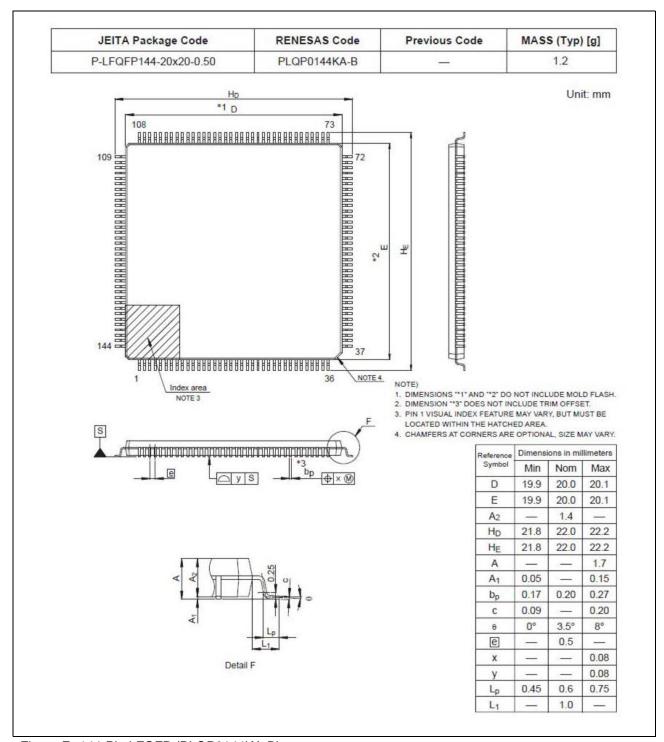


Figure E 144-Pin LFQFP (PLQP0144KA-B)

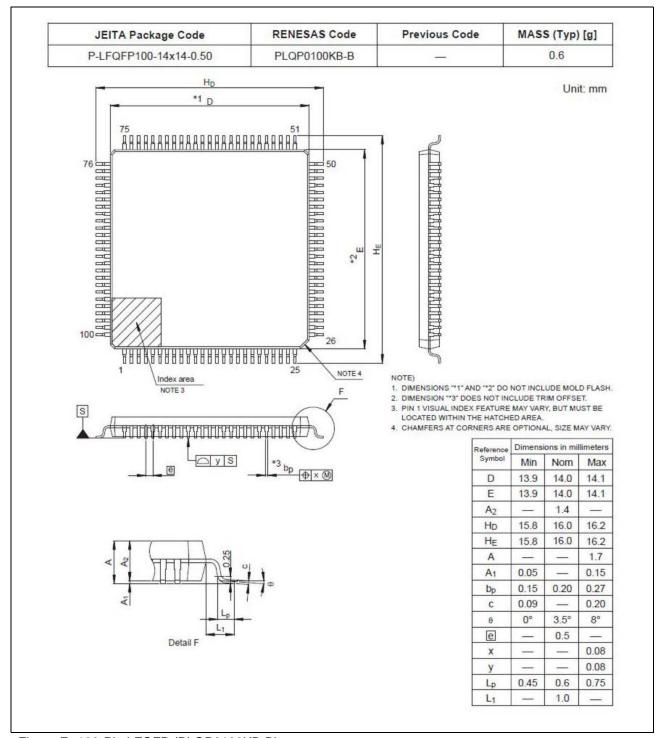


Figure F 100-Pin LFQFP (PLQP0100KB-B)

RX72N Group REVISION HISTORY

REVISION HISTORY	RX72N Group Datasheet
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Classifications

- Items with Technical Update document number: Changes according to the corresponding issued Technical Update
- Items without Technical Update document number: Minor changes that do not require Technical Update to be issued

Rev. Date		Description		Classification		
Kev.	Date	Page	Summary	Classification		
1.00	May 31, 2019	_	First edition, issued			
1.11	Feb 26, 2021	1. Overview				
		15, 16	Table 1.3 List of Products, changed			
		62, 63, 65	Table 1.8 List of Pin and Pin Functions (145-Pin TFLGA), changed	TN-RX*-A0222A/E		
		70, 75	Table 1.9 List of Pin and Pin Functions (144-Pin LFQFP), changed			
		2. Electrical C	Characteristics			
		86, 87	Table 2.6 DC Characteristics (3), Note 3, changed	TN-RX*-A0222A/E		
		95	Table 2.18 HOCO Clock Timing, changed			
		102	Table 2.26 Bus Timing, Conditions 1, Conditions 2, changed			
		105	Figure 2.21 External Bus Timing/Normal Write Cycle (Bus Clock			
			Synchronized), changed			
		106	Figure 2.23 External Bus Timing/Page Write Cycle (Bus Clock			
			Synchronized), changed			
		115	Table 2.27 EXDMAC Timing, Conditions, changed	TN-RX*-A0243A/E		
		116 to 155	2.4.7 Timing of On-Chip Peripheral Modules, order of tables changed			
		119	Figure 2.41 MTU Clock Input Timing, changed	TN-RX*-A0243A/E		
		123	Figure 2.51 Output Disable Time of POEG in Response to the Oscillation Stop Detection, changed			
		127	Figure 2.56 Simple IIC Bus Interface Input/Output Timing, added			
	152 Table 2.48 GLCDC Timing, changed					

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General Precautions in the Handling of Microprocessing Unit and Microcontroller Unit Products

The following usage notes are applicable to all Microprocessing unit and Microcontroller unit products from Renesas. For detailed usage notes on the products covered by this document, refer to the relevant sections of the document as well as any technical updates that have been issued for the products.

1. Precaution against Electrostatic Discharge (ESD)

A strong electrical field, when exposed to a CMOS device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop the generation of static electricity as much as possible, and quickly dissipate it when it occurs. Environmental control must be adequate. When it is dry, a humidifier should be used. This is recommended to avoid using insulators that can easily build up static electricity. Semiconductor devices must be stored and transported in an anti-static container, static shielding bag or conductive material. All test and measurement tools including work benches and floors must be grounded. The operator must also be grounded using a wrist strap. Semiconductor devices must not be touched with bare hands. Similar precautions must be taken for printed circuit boards with mounted semiconductor devices.

2. Processing at power-on

The state of the product is undefined at the time when power is supplied. The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the time when power is supplied. In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the time when power is supplied until the reset process is completed. In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the time when power is supplied until the power reaches the level at which resetting is specified.

3. Input of signal during power-off state

Do not input signals or an I/O pull-up power supply while the device is powered off. The current injection that results from input of such a signal or I/O pull-up power supply may cause malfunction and the abnormal current that passes in the device at this time may cause degradation of internal elements. Follow the guideline for input signal during power-off state as described in your product documentation.

4. Handling of unused pins

Handle unused pins in accordance with the directions given under handling of unused pins in the manual. The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of the LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible.

5. Clock signals

After applying a reset, only release the reset line after the operating clock signal becomes stable. When switching the clock signal during program execution, wait until the target clock signal is stabilized. When the clock signal is generated with an external resonator or from an external oscillator during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Additionally, when switching to a clock signal produced with an external resonator or by an external oscillator while program execution is in progress, wait until the target clock signal is stable.

6. Voltage application waveform at input pin

Waveform distortion due to input noise or a reflected wave may cause malfunction. If the input of the CMOS device stays in the area between V_{IL} (Max.) and V_{IH} (Min.) due to noise, for example, the device may malfunction. Take care to prevent chattering noise from entering the device when the input level is fixed, and also in the transition period when the input level passes through the area between V_{II} (Max.) and V_{IH} (Min.).

7. Prohibition of access to reserved addresses

Access to reserved addresses is prohibited. The reserved addresses are provided for possible future expansion of functions. Do not access these addresses as the correct operation of the LSI is not guaranteed.

8. Differences between products

Before changing from one product to another, for example to a product with a different part number, confirm that the change will not lead to problems. The characteristics of a microprocessing unit or microcontroller unit products in the same group but having a different part number might differ in terms of internal memory capacity, layout pattern, and other factors, which can affect the ranges of electrical characteristics, such as characteristic values, operating margins, immunity to noise, and amount of radiated noise. When changing to a product with a different part number, implement a system-evaluation test for the given product.

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(Rev.5.0-1 October 2020)

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